1 PRODUCT OVERVIEW

The KS57C0502/C0504 single-chip CMOS microcontroller has been designed for high-performance using Samsung's newest 4-bit CPU core, SAM47 (Samsung Arrangeable Microcontrollers).

The KS57P0504 is the microcontroller which has 4 Kbyte one-time-programmable ROM and the functions are the same to KS57C0502/C0504. With a four-channel comparator, eight LED direct drive pins, serial I/O interface, and its versatile 8-bit timer/counter, the KS57C0502/C0504 offers an excellent design solution for a wide variety of general-purpose applications.

Up to 24 pins of the 30-pin SDIP package can be dedicated to I/O. Five vectored interrupts provide fast response to internal and external events. In addition, the KS57C0502/C0504's advanced CMOS technology provides for very low power consumption and a wide operating voltage range — all at a very low cost.

FEATURES SUMMARY

MEMORY

512 × 4-bit data memory (RAM)
2048 × 8-bit program memory (ROM):KS57C0502
4096 × 8-bit program memory (ROM):KS57C0504

24 I/O PINS

I/O: 18 pins, including 8 high current pins
Input only: 6 pins

COMPARATOR

4-channel mode:
    Internal reference (4-bit resolution)
    16-step variable reference voltage
3-channel mode:
    External reference
150 mV resolution (worst case)

8-BIT BASIC TIMER

Programmable interval timer
Watch-dog timer

8-BIT TIMER/COUNTER

Programmable interval timer
External event counter function
Timer/counter clock output to TCLO0 pin

WATCH TIMER

Time interval generation: 0.5 s, 3.9 ms at 4.19 MHz
4 frequency outputs to BUZ pin

8-BIT SERIAL I/O INTERFACE

8-bit transmit/receive mode
8-bit receive-only mode
LSB-first or MSB-first transmission selectable

Internal or external clock source

BIT SEQUENTIAL CARRIER

Supports 16-bit serial data transfer in arbitrary format

INTERRUPTS

Two external interrupt vectors
Three internal interrupt vectors
Two quasi-interrupts

MEMORY-MAPPED I/O STRUCTURE

Data memory bank 15

TWO POWER-DOWN MODES

Idle mode: Only CPU clock stops
Stop mode: System clock stops

OSCILLATION SOURCES

Crystal, Ceramic for system clock
Crystal/ceramic: 0.4 - 6.0 MHz
CPU clock divider circuit (by 4. 8, or 64)

INSTRUCTION EXECUTION TIMES

0.95, 1.91, 15.3 µs at 4.19 MHz
0.67, 1.33, 10.7 µs at 6.0 MHz

OPERATING TEMPERATURE

– 40 °C to 85 °C

OPERATING VOLTAGE RANGE

1.8 V to 5.5 V

PACKAGE TYPE

30 SDIP, 32 SOP

FUNCTION OVERVIEW

SAM47 CPU

All KS57-series microcontrollers have the advanced SAM47 CPU core. The SAM47 CPU can directly address up to 32 K bytes of program memory. The arithmetic logic unit (ALU) performs 4-bit addition, subtraction, logical, and shift-and-rotate operations in one instruction cycle and most 8-bit arithmetic and logical operations in two cycles.

CPU REGISTERS

Program Counter

A 11-bit program counter (PC) stores addresses for instruction fetch during program execution. Usually, the PC is incremented by the number of bytes of the instruction being fetched. An exception is the 1-byte instruction REF which is used to reference instructions stored in a look-up table in the ROM. Whenever a reset operation or an interrupt occurs, bits PC11 through PC0 are set to the vector address. Bit PC13–12 is reserved to support future expansion of the device's ROM size.

Stack Pointer

An 8-bit stack pointer (SP) stores addresses for stack operations. The stack area is located in the general-purpose data memory bank 0. The SP is read or written by 8-bit instructions and SP bit 0 must always be set to logic zero.

During an interrupt or a subroutine call, the PC value and the PSW are saved to the stack area in RAM. When the service routine has completed, the values referenced by the stack pointer are restored. Then, the next instruction is executed.

The stack pointer can access the stack regardless of data memory access enable flag status. Since the reset value of the stack pointer is not defined in firmware, it is recommended that the stack pointer be initialized to 00H by program code. This sets the first register of the stack area to data memory location 0FFH.

PROGRAM MEMORY

In its standard configuration, the 4096 × 8-bit ROM is divided into three functional areas:

— 16-byte area for vector addresses

— 96-byte instruction reference area

— 1920-byte general purpose area (KS57C0502)

— 3968-byte general purpose area (KS57C0504)

The vector address area is used mostly during reset operations and interrupts. These 16 bytes can also be used as general-purpose ROM.

The REF instruction references 2 × 1-byte and 2-byte instructions stored in locations 0020H–007FH. The REF instruction can also reference three-byte instructions such as JP or CALL. In order for REF to be able to reference these instructions, however, JP or CALL must be shortened to a 2-byte format. To do this, JP or CALL is is written to the reference area with the format TJP or TCALL instead of the normal instruction name. Unused locations in the instruction reference area can be allocated to general-purpose use.

DATA MEMORY

Overview

Data memory is organized into three areas:

— 32 × 4-bit working registers

— 224 × 4-bit general-purpose area in bank 0

— 256 × 4-bit general-purpose area in bank 1

— 128 × 4-bit area in bank 15 for memory-mapped I/O addresses

Data stored in data memory can be manipulated by 1-, 4-, and 8-bit instructions.

Data memory is organized into two memory banks — bank 0, bank 1 and bank 15. The select memory bank instruction (SMB) selects the bank to be used as working data memory. After power-on reset operation, initialization values for data memory must be redefined by code.

Data Memory Addressing Modes

The enable memory bank (EMB) flag controls the addressing mode for data memory banks 0, 1 or 15.

When the EMB flag is logic zero, restricted area can be accessed. When the EMB flag is set to logic one, all two data memory banks can be accessed according to the current SMB value. The EMB = "0" addressing mode is used for normal program execution, whereas the EMB = "1" mode is commonly used for interrupts, subroutines, mapped I/O, and repetitive access of specific RAM addresses.

Working Registers

The RAM's working register area in data memory bank 0 is further divided into four *register* banks. Each register bank has eight 4-bit registers that are addressable either by 1-bit or 4-bit instructions. Paired 4-bit registers can be addressed as double registers by 8-bit instructions.

Register A is the 4-bit accumulator and double register EA is the 8-bit extended accumulator. Double registers WX, WL, and HL are used as data pointers for indirect addressing. Unused working registers can be used as general-purpose memory.

To limit the possibility of data corruption due to incorrect register bank addressing, register bank 0 is usually used by the main program and banks 1, 2, and 3 for interrupt service routines.

CONTROL REGISTERS

Program Status Word

The 8-bit program status word (PSW) controls ALU operations and instruction execution sequencing. It is also used to restore a program's execution environment when an interrupt has been serviced. Program instructions can always address the PSW regardless of the current value of data memory enable flags.

Before an interrupt or subroutine is processed, the PSW is pushed onto the stack in data memory bank 0. When the service routine is completed, the PSW values are restored.

IS1	IS0	EMB	ERB
C	SC2	SC1	SC0

Interrupt status flags (IS1, IS0), the enable memory bank and enable register bank flags (EMB, ERB), and the carry flag (C) are 1- and 4-bit read/write or 8-bit read-only addressable. You can address the skip condition flags (SC0–SC2) using 8-bit read instructions only.

Select Bank (SB) Register

Two 4-bit registers store address values used to access specific memory and register banks: the select memory bank register, SMB, and the select register bank register, SRB.

'SMB n' instruction selects a data memory bank (0 or 15) and stores the upper four bits of the 12-bit data memory address in the SMB register. To select register bank 0, 1, 2, or 3, and store the address data in the SRB, you use the instruction 'SRB n'.

The instructions "PUSH SB" and "POP SB" move SRB and SMB values to and from the stack for interrupts and subroutines.

CLOCK CIRCUITS

System oscillation circuit generates the internal clock signals for the CPU and peripheral hardware.

The system clock can use a crystal, or ceramic oscillation source, or an externally-generated clock signal. To drive KS57C0502/C0504 using an external clock source, the external clock signal should be input to X_{in}, and its inverted signal to X_{out}.

4-bit power control register controls the oscillation on/off, and select the CPU clock. The internal system clock signal (fx) can be divided internally to produce three CPU clock frequencies — fx/4, fx/8, or fx/64.

INTERRUPTS

Interrupt requests may be generated internally by on-chip processes (INTB, INTT0, and INTS) or externally by peripheral devices (INT0 and INT1). There are two quasi-interrupts: INTK and INTW. INTK (KS0–KS2) detects falling edges of incoming signals and INTW detects time intervals of 0.5 seconds or 3.91 milliseconds. The following components support interrupt processing:

— Interrupt enable flags

— Interrupt request flags

— Interrupt priority registers

— Power-down termination circuit

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POWER-DOWN

To reduce power consumption, there are two power-down modes: idle and stop. The IDLE instruction initiates idle mode; the STOP instruction initiates stop mode.

In idle mode, the CPU clock stops while peripherals continue to operate normally. In stop mode, system clock oscillation stops completely, halting all operations except for a few basic peripheral functions. A power-down is terminated either by a RESET or by an interrupt (with exception of the external interrupt INT0).

RESET

When RESET is input during normal operation or during power-down mode, a reset operation is initiated and the CPU enters idle mode. When the standard oscillation stabilization time interval (31.3 ms at 4.19 MHz) has elapsed, normal CPU operation resumes.

I/O PORTS

The KS57C0502/C0504 has seven I/O ports. Pin addresses for all I/O ports are mapped to locations FF0H–FF6H in bank 15 of the RAM. There are 6 input pins and 18 configurable I/O pins including 8 high current I/O pins for a total of 24 I/O pins. The contents of I/O port pin latches can be read, written, or tested at the corresponding address using bit manipulation instructions.

TIMERS and TIMER/COUNTER

The timer function has three main components: an 8-bit basic timer, an 8-bit timer/counter, and a watch timer.

The 8-bit basic timer generates interrupt requests at precise intervals, based on the selected internal clock frequency.

The programmable 8-bit timer/counter is used for counting events, modifying internal clock frequencies, and dividing external clock signals. The 8-bit timer/counter generates a clock signal (SCK) for the serial I/O interface.

The watch timer consists of an 8-bit watch timer mode register, a clock selector, and a frequency divider circuit. Its functions include real-time, watch-time measurement, and clock generation for frequency output for buzzer sound.

SERIAL I/O INTERFACE

The serial I/O interface supports the transmission or reception of 8-bit serial data with an external device. The serial interface has the following functional components:

— 8-bit mode register

— Clock selector circuit

— 8-bit buffer register

— 3-bit serial clock counter

The serial I/O circuit can be set to transmit-and-receive, or to receive-only mode. MSB-first or LSB-first transmission is also selectable.

The serial interface can operate with an internal or an external clock source, or using the clock signal generated by the 8-bit timer/counter. Transmission frequency can be modified by setting the appropriate bits in the SIO mode register.

BIT SEQUENTIAL CARRIER

The bit sequential carrier (BSC) is a 16-bit register that can be manipulated using 1-, 4-, and 8-bit instructions. Using 1-bit indirect addressing, addresses and bit locations can be specified sequentially. In this way, programs can process 16-bit data by moving the bit location sequentially and then incrementing or decrementing the value of the L register. BSC data can also be manipulated using direct addressing.

COMPARATOR

The KS57C0502/C0504 contains a 4-channel comparator which can be multiplexed to normal input port.

— Conversion time: 15.2 µs, 121.6 µs at 4.19 MHz

— Two operation modes:

  Three channels for analog input and one channel for external reference voltage input

  Four channels for analog input and internal reference voltage level

— 16-level internal reference voltage generator

— 150 mV accuracy for input voltage level difference detection (maximum)

— Comparator enable and disable

The comparison results are read from the 4-bit CMPREG register after the specified conversion time.

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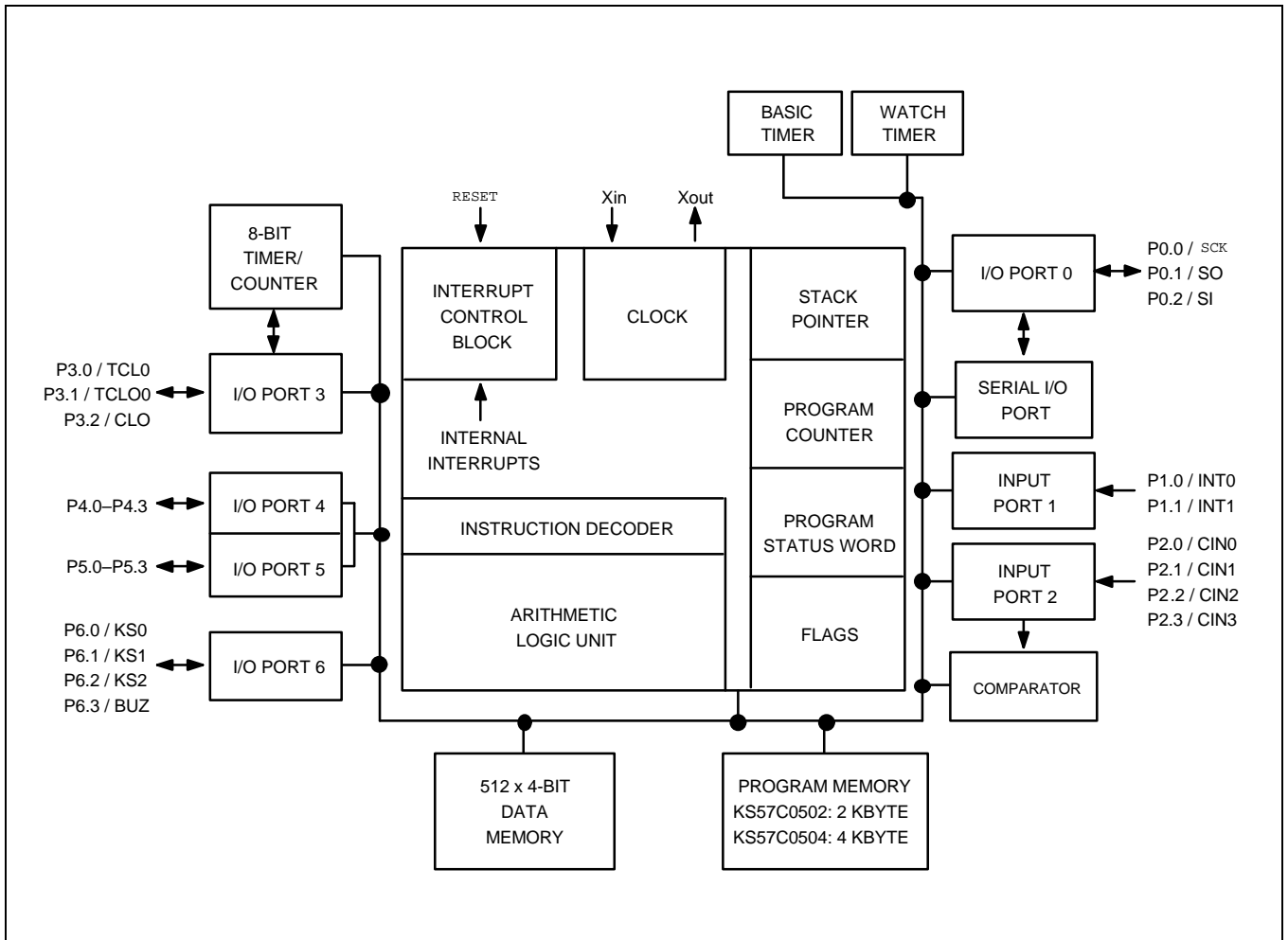
BLOCK DIAGRAM

Figure 1–1. KS57C0502/C0504 Simplified Block Diagram

PIN ASSIGNMENTS


```
              VSS  ┤1         30├  VDD
              Xout ┤2         29├  P6.3 / BUZ
              Xin  ┤3         28├  P6.2 / KS2
              TEST ┤4         27├  P6.1 / KS1
          P1.0 / INT0 ┤5      26├  P6.0 / KS0
          P1.1 / INT1 ┤6      25├  P5.3
              RESET ┤7        24├  P5.2
          P0.0 / SCK ┤8  KS57C0502/0504  23├  P5.1
          P0.1 / SO ┤9   (Top View)  22├  P5.0
          P0.2 / SI ┤10        21├  P4.3
          P2.0 / CIN0 ┤11      20├  P4.2
          P2.1 / CIN1 ┤12      19├  P4.1
          P2.2 / CIN2 ┤13      18├  P4.0
          P2.3 / CIN3 ┤14      17├  P3.2 / CLO
          P3.0 / TCL0 ┤15      16├  P3.1 / TCLO0
```

30-pin SDIP

```
              VSS  ┤1         32├  VDD
              Xout ┤2         31├  P6.3 / BUZ
              Xin  ┤3         30├  P6.2 / KS2
              TEST ┤4         29├  P6.1 / KS1
          P1.0 / INT0 ┤5      28├  P6.0 / KS0
          P1.1 / INT1 ┤6      27├  P5.3
              RESET ┤7        26├  P5.2
               NC  ┤8  KS57C0502/0504  25├  P5.1
          P0.0 / SCK ┤9   (Top View)  24├  P5.0
          P0.1 / SO ┤10        23├  P4.3
          P0.2 / SI ┤11        22├  P4.2
          P2.0 / CIN0 ┤12      21├  P4.1
          P2.1 / CIN1 ┤13      20├  P4.0
          P2.2 / CIN2 ┤14      19├  NC
          P2.3 / CIN3 ┤15      18├  P3.2 / CLO
          P3.0 / TCL0 ┤16      17├  P3.1 / TCLO0
```

32-pin SOP

Figure 1–2. KS57C0502/C0504 Pin Assignment Diagram

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PIN DESCRIPTIONS

Table 1–2. KS57C0502/C0504 Pin Descriptions

Pin Name	Pin Type	Description	Number	Share Pin
P0.0 P0.1 P0.2	I/O	3-bit I/O port. 1-bit or 3-bit read/write and test is possible. Pull-up resistors are assignable to input pins by software and are automatically disabled for output pins. Pins are individually configurable as input or output.	8(9) 9(10) 10(11)	SCK SO SI
P1.0 P1.1	I	2-bit input port. 1-bit or 2-bit read and test is possible. Pull-up resistors are assignable by software.	5(5) 6(6)	INT0 INT1
P2.0–P2.3	I	4-bit input port. 1-bit or 4-bit read and test is possible.	11-14 (12-15)	CIN0–CIN3
P3.0 P3.1 P3.2	I/O	Same as port 0	15(16) 16(17) 17(18)	TCL0 TCLO0 CLO
P4.0–P4.3 P5.0–P5.3	I/O	4-bit I/O ports. 1-, 4-, or 8-bit read/write and test is possible. Pins are individually configurable as input or output. 4-bit pull-up resistors are software assignable to input pins and are automatically disabled for output pins. The N-channel open-drain or push-pull output can be selected by software (1-bit unit)	18-21(20-23) 22-25(24-27)	—
P6.0 P6.1 P6.2 P6.3	I/O	4-bit I/O port. 1-bit or 4-bit read/write and test is possible. Pull-up resistors are assignable to input pins by software and are automatically disabled for output pins. Pins are individually configurable as input or output.	26(28) 27(29) 28(30) 29(31)	KS0 KS1 KS2 BUZ
INT0	I	External interrupts with detection of rising and falling edges	5(5)	P1.0
INT1	I	External interrupts with detection of rising or falling edges	6(6)	P1.1
CIN0–CIN3	I	4-channel comparator input. CIN0–CIN2: comparator input only. CIN3: comparator input or external reference input	11-14(12-15)	P2.0–P2.3
SCK	I/O	Serial interface clock signal	8(9)	P0.0
SO	I/O	Serial data output	9(10)	P0.1
SI	I/O	Serial data input	10(11)	P0.2
TCL0	I/O	External clock input for timer/counter	15(16)	P3.0
TCLO0	I/O	Timer/counter clock output	16(17)	P3.1
CLO	I/O	CPU clock output	17(18)	P3.2
BUZ	I/O	2 kHz, 4 kHz, 8 kHz, or 16 kHz frequency output at 4.19 MHz for buzzer sound	29(31)	P6.3

NOTE: Pin numbers shown in parentheses '( )' are for 32-pin SOP package; other pin numbers are for the 30-pin SDIP.

Table 1–2. KS57C0502/C0504 Pin Descriptions (Continued)

Pin Name	Pin Type	Description	Number	Share Pin
KS0–KS2	I/O	Quasi-interrupt input with falling edge detection	26-28(28-30)	P6.0–P6.2
V_{DD}	—	Main power supply	30(32)	—
V_{SS}	—	Ground	1(1)	—
RESET	I	Reset signal	7(7)	—
TEST	I	Test signal input (must be connected to V_{SS})	4(4)	—
X_{in}, X_{out}	—	Crystal or ceramic oscillator signal for system clock	3,2(3,2)	—

NOTE: Pin numbers shown in parentheses '( )' are for 32-pin SOP package; other pin numbers are for the 30-pin SDIP.

Table 1–3. Overview of KS57C0502/C0504 Pin Data

SDIP Pin Numbers	Pin Names	Share Pins	I/O Type	Reset Value	Circuit Type
1	V_{SS}	—	—	—	—
2,3	Xout, Xin	—	—	—	—
4	TEST	—	I	—	—
5,6	P1.0, P1.1	INT0, INT1	I	Input	A-3
7	RESET	—	I	—	B
8-10	P0.0 - P0.2	SCK, SO, SI	I/O	Input	D-1
11-14	P2.0 - P2.3	CIN0 - CIN3	I	Input	F-1, F-2 (note)
15-17	P3.0 - P3.2	TCL0, TCLO0, CLO	I/O	Input	D-1
18-21	P4.0 - P4.3	—	I/O	Input	E
22-25	P5.0 - P5.3	—	I/O	Input	E
26-29	P6.0 - P6.3	KS0, KS1, KS2, BUZ	I/O	Input	D-1
30	V_{DD}	—	—	—	—

NOTE: I/O circuit type F-2 is implemented for P2.3 only.
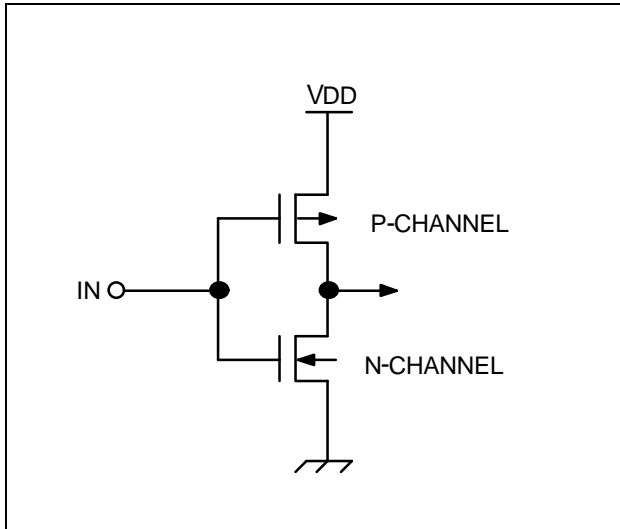
PIN CIRCUIT DIAGRAMS

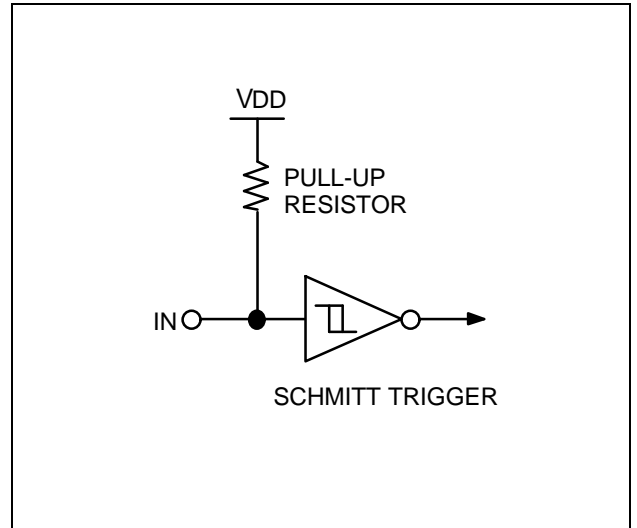
Figure 1–3. Pin Circuit Type A
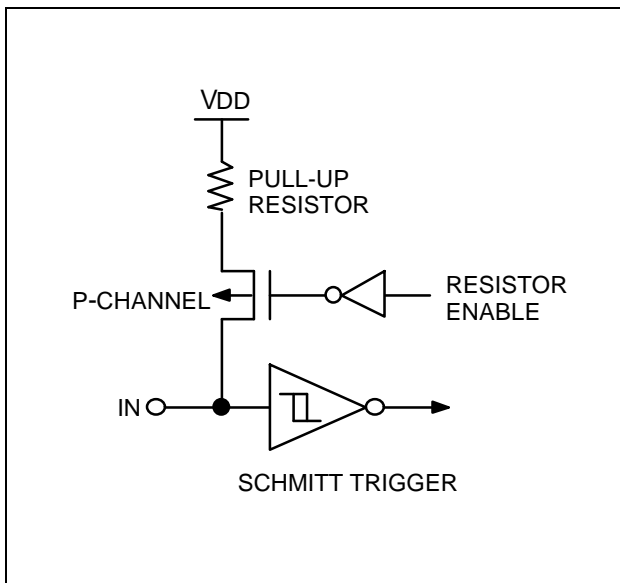

Figure 1–5. Pin Circuit Type B

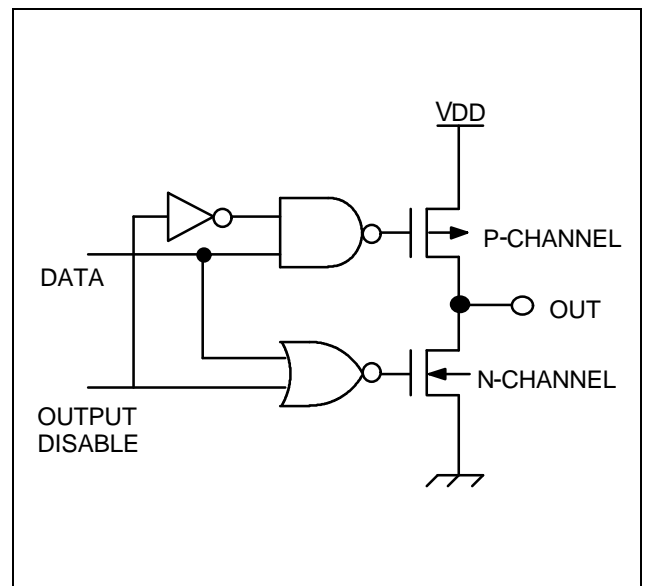
Figure 1–4. Pin Circuit Type A-3
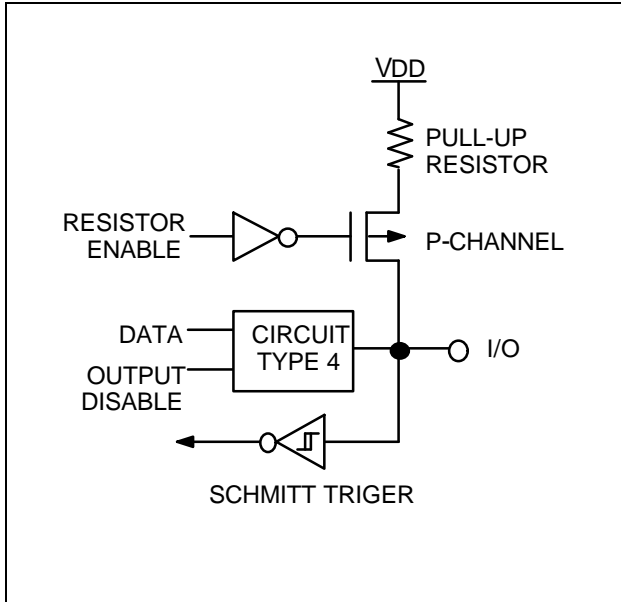

Figure 1–6. Pin Circuit Type C

Figure 1–7. Pin Circuit Type D-1
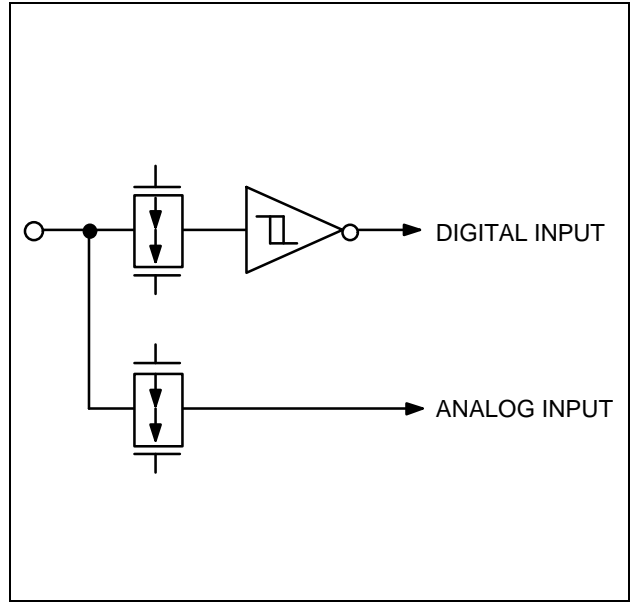
Figure 1–9. Pin Circuit Type F-1
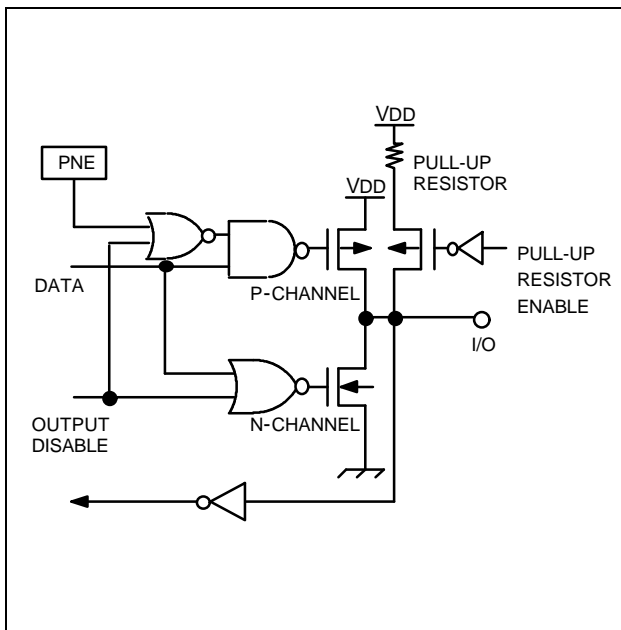
Figure 1–8. Pin Circuit Type E
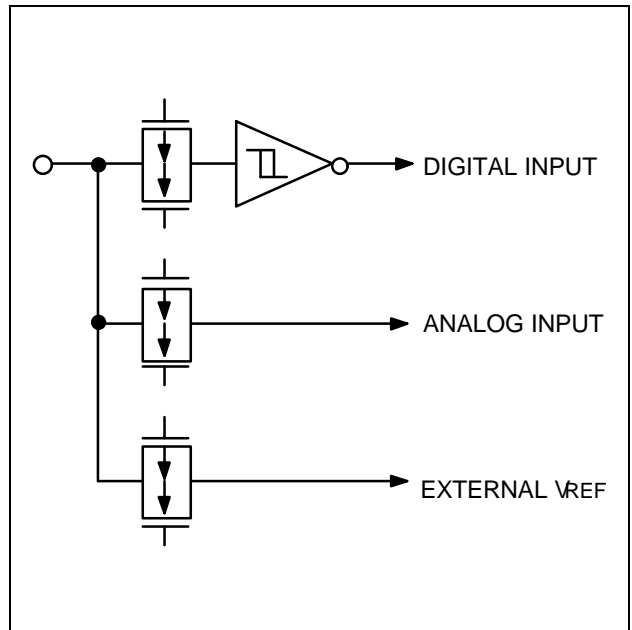
Figure 1–10. Pin Circuit Type F-2

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2 ADDRESS SPACES

PROGRAM MEMORY (ROM)

OVERVIEW

ROM maps for KS57C0502/C0504 devices are mask programmable at the factory. In its standard configuration, the device's 4096 × 8-bit program memory has three areas that are directly addressable by the program counter (PC):

— 16-byte area for vector addresses

— 16-byte general-purpose area

— 96-byte instruction reference area

— 1920-byte general-purpose area: KS57C0502

— 3968-byte general-purpose area: KS57C0504

General-Purpose Memory

Two program memory areas are allocated for general-purpose use: One area is 16 bytes in size and the other is 1920 bytes (KS57C0502) or 3968 bytes (KS57C0504).

Vector Addresses

You use the 16-byte vector address area to store the vector addresses required to execute system resets and interrupts. Start addresses for interrupt service routines are stored in this area, along with the values of the enable memory bank (EMB) and enable register bank (ERB) flags that are used to set their initial value for the corresponding service routines. The 16-byte area can be used alternately as general-purpose ROM.

REF Instructions

Locations 0020H–007FH are used as a reference area (look-up table) for 1-byte REF instructions. Using REF instructions, you can reduce the byte size of instruction operands. REF can reference either one 2-byte or two 1-byte instructions stored in the look-up table. Unused look-up table addresses can be used as general-purpose ROM.

Table 2–1. Program Memory Address Ranges

ROM Area Function	Address Ranges	Area Size (in Bytes)
Vector address area	0000H–000FH	16
General-purpose program memory	0010H–001FH	16
REF instruction look-up table area	0020H–007FH	96
General-purpose program memory	0080H–07FFH 0080H–0FFFH	1920 (KS57C0502) 3968 (KS57C0504)

GENERAL-PURPOSE MEMORY AREAS

The 16-byte area at ROM locations 0010H–001FH and the 3968-byte area at ROM locations 0080H–0FFFH are used as general-purpose program memory.

You can also use vacant locations in the vector address area and REF instruction look-up table areas as general-purpose program memory. But please be careful not to overwrite live data when writing programs that use special-purpose areas of the ROM.

VECTOR ADDRESS AREA

Use the 16-byte vector address area of the ROM to store the vector addresses for executing system resets and interrupts. The starting addresses of interrupt service routines are stored in this area, along with the enable memory bank (EMB) and enable register bank (ERB) flag values that are needed to set EMB and ERB's initial values for the service routines. A 16-byte vector address is organized as follows:

EMB	ERB	0	0	PC11	PC10	PC9	PC8
PC7	PC6	PC5	PC4	PC3	PC2	PC1	PC0

To set up the vector address area for specific programs, you use the instruction VENTn. The programming tips on the next page explain how to do this.
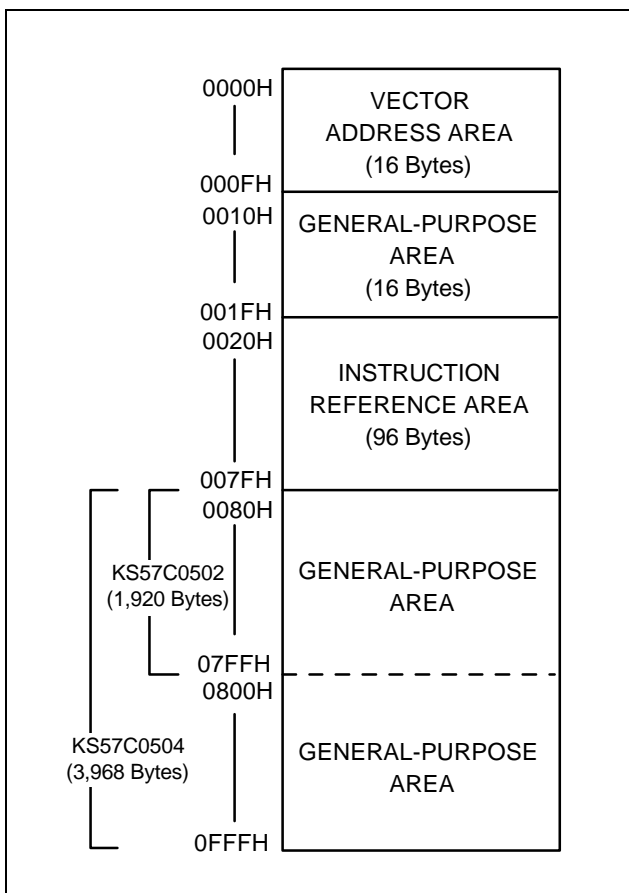
Figure 2–1. ROM Structure
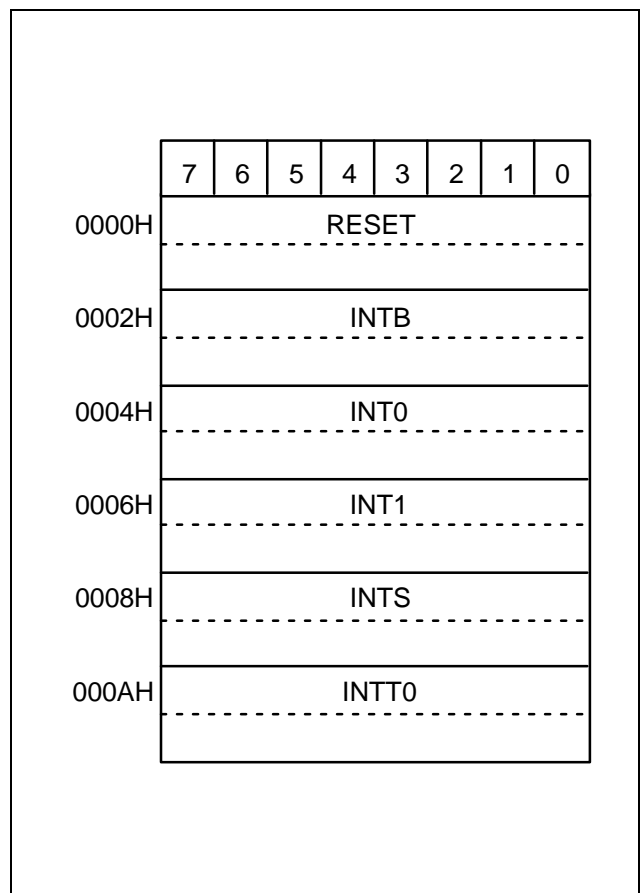
Figure 2–2. Vector Address Map

☞ PROGRAMMING TIP — Defining Vectored Interrupt Areas

The following examples show you several ways you can define the vectored interrupt and instruction reference areas in program memory:

1. When all vector interrupts are used:

```
        ORG     0000H
;
        VENT0   1,0,RESET       ;   EMB ← 1, ERB ← 0; Jump to RESET address
        VENT1   0,0,INTB        ;   EMB ← 0, ERB ← 0; Jump to INTB address
        VENT2   0,0,INT0        ;   EMB ← 0, ERB ← 0; Jump to INT0 address
        VENT3   0,0,INT1        ;   EMB ← 0, ERB ← 0; Jump to INT1 address
        VENT4   0,0,INTS        ;   EMB ← 0, ERB ← 0; Jump to INTS address
        VENT5   0,0,INTT0       ;   EMB ← 0, ERB ← 0; Jump to INTT0 address
```

2. When a specific vectored interrupt such as INT0, and INTT0 is not used, the unused vector interrupt locations must be skipped with the assembly instruction ORG so that jumps will address the correct locations:

```
        ORG     0000H
;
        VENT0   1,0,RESET       ;   EMB ← 1, ERB ← 0; Jump to RESET address
        VENT1   0,0,INTB        ;   EMB ← 0, ERB ← 0; Jump to INTB address
        ORG     0006H           ;   INT0 interrupt not used
        VENT3   0,0,INT1        ;   EMB ← 0, ERB ← 0; Jump to INT1 address
        VENT4   0,0,INTS        ;   EMB ← 0, ERB ← 0; Jump to INTS address
;
        ORG     0010H           ;   INTT0 interrupt not used
```

3. If an INT0 interrupt is not used and if its corresponding vector interrupt area is not fully utilized, or if it is not written by a ORG instruction as in Example 2, a CPU malfunction will occur:

```
        ORG     0000H
;
        VENT0   1,0,RESET       ;   EMB ← 1, ERB ← 0; Jump to RESET address
        VENT1   0,0,INTB        ;   EMB ← 0, ERB ← 0; Jump to INTB address
        VENT3   0,0,INT1        ;   EMB ← 0, ERB ← 0; Jump to INT0 address
        VENT4   0,0,INTS        ;   EMB ← 0, ERB ← 0; Jump to INT1 address
        VENT5   0,0,INTT0       ;   EMB ← 0, ERB ← 0; Jump to INTS address
;
        ORG     0010H
;
        General-purpose ROM area
;
```

In this example, when an INTS interrupt is generated, the corresponding vector area is not VENT4 INTS, but VENT5 INTT0. This causes an INTS interrupt to jump incorrectly to the INTT0 address and causes a CPU malfunction to occur.

INSTRUCTION REFERENCE AREA

Using 1-byte REF instructions, you can easily reference instructions with larger byte sizes that are stored in addresses 0020H–007FH of program memory. This 96-byte area is called the REF instruction reference area, or look-up table. Locations in the REF look-up table may contain two one-byte instructions, a single two-byte instruction, or three-byte instructions such as a JP or CALL. The starting address of the instruction you are referencing must always be an even number. To reference a JP or CALL instruction, it must be written to the reference area in a two-byte format: for JP, this format is TJP; for CALL, it is TCALL. In summary, there are three ways to the REF instruction:

— Using the 1-byte REF instruction to execute one 2-byte or two 1-byte instructions,

— Branching to any location by referencing a branch instruction stored in the look-up table,

— Calling subroutines at any location by referencing a call instruction stored in the look-up table.

☞ PROGRAMMING TIP — Using the REF Look-Up Table

Here is one example of how to use the REF instruction look-up table:

```
            ORG     0020H
;
JMAIN       TJP     MAIN              ;    0, MAIN
KEYCK       BTSF    KEYFG             ;    1, KEYFG CHECK
WATCH       TCALL   CLOCK             ;    2, CALL CLOCK
INCHL       LD      @HL,A             ;    3, (HL) ← A
            INCS    HL
              •
              •
              •
ABC         LD      EA,#00H           ;    47, EA  ← #00H
            ORG     0080
;
MAIN        NOP
            NOP
              •
              •
              •
            REF     KEYCK             ;    BTSF   KEYFG (1-byte instruction)
            REF     JMAIN             ;    KEYFG  = 1, jump to MAIN (1-byte instruction)
            REF     WATCH             ;    KEYFG  = 0, CALL   CLOCK (1-byte instruction)
            REF     INCHL             ;    LD   @HL,A
                                      ;    INCS   HL
            REF     ABC               ;    LD   EA,#00H (1-byte instruction)
              •
              •
              •
```

DATA MEMORY (RAM)

OVERVIEW

In its standard configuration, the 512×4-bit data memory has five areas:

— 32×4-bit working register area

— 224×4-bit general-purpose area in bank 0 (also used as stack area)

— 256×4-bit general-purpose area in bank 1

— 128×4-bit area for memory-mapped I/O addresses

To simplify referencing, the data memory area has two memory banks — bank 0, bank 1 and bank 15. You use the select memory bank instruction (SMB) to select the bank you want to use as working data memory. Data stored in RAM locations are 1-, 4-, and 8-bit addressable. Initialization values for the data memory area are not defined by hardware and must therefore be initialized by program software following RESET. When RESET signal is generated in power-down mode, the data memory contents are maintained.
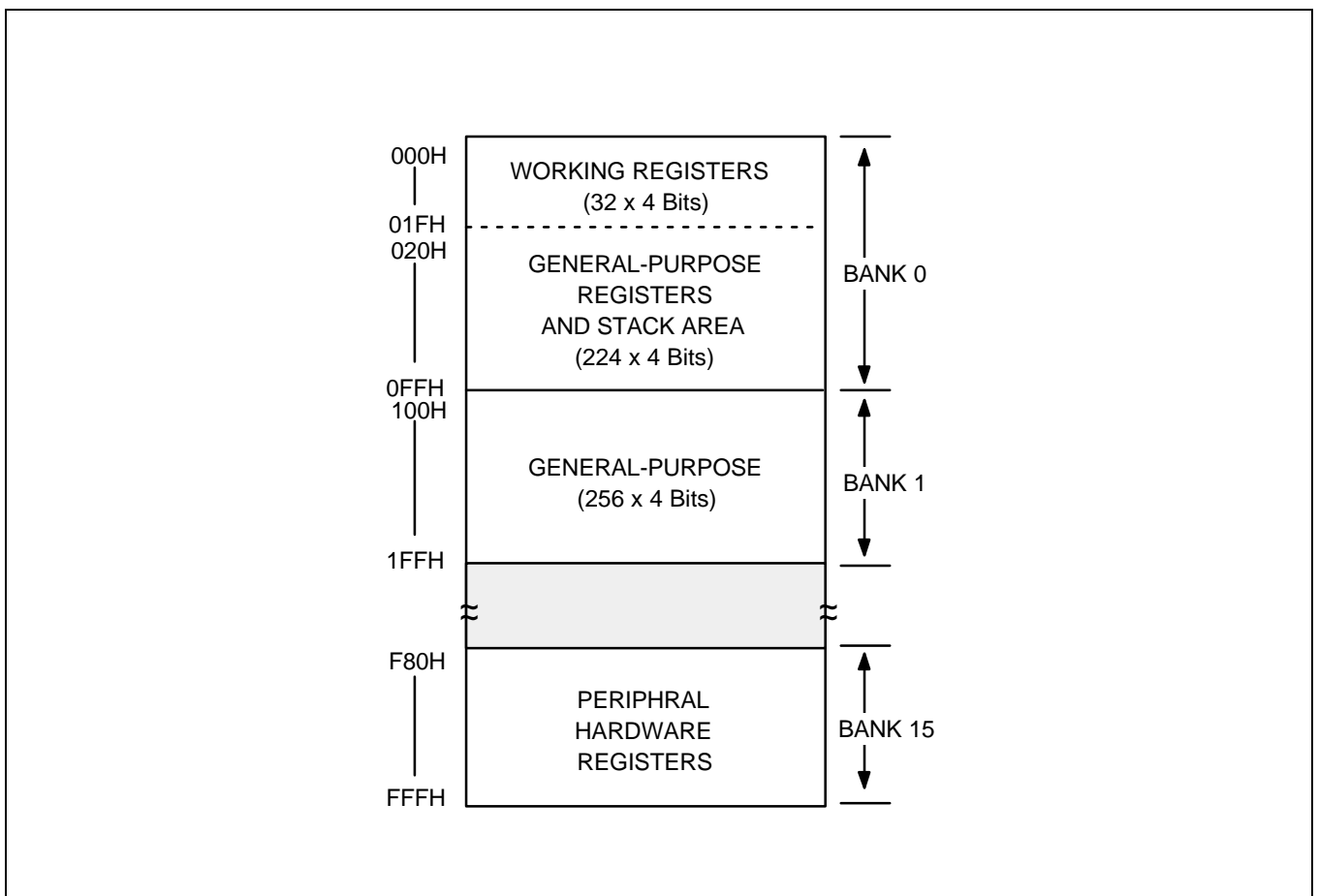
Figure 2–3. Data Memory (RAM) Map

Memory Banks 0, 1 and 15

Bank 0   (000H–0FFH)   The lowest 32 nibbles of bank 0 (000H–01FH) are used as working registers; the next 224 nibbles (020H–0FFH) can be used both as stack area and as general-purpose data memory. Use the stack area for implementing subroutine calls and returns, and for interrupt processing.

Bank 1   (100H–1FFH)   This area is used as general-purpose data memory.

Bank 15   (F80H–FFFH)   The microcontroller uses bank 15 for memory-mapped peripheral I/O. Fixed RAM locations for each peripheral hardware address are mapped into this area.

Data Memory Addressing Modes

The enable memory bank (EMB) flag controls the addressing mode for data memory banks 0 or 15. When the EMB flag is logic zero, the addressable area is restricted to specific locations, depending on whether direct or indirect addressing is used. With direct addressing, you can access locations 000H–07FH of bank 0, bank 1 and bank 15. With indirect addressing, only bank 0 (000H–0FFH) can be accessed. When the EMB flag is set to logic one, all two data memory banks can be accessed according to the current SMB value.

For 8-bit addressing, two 4-bit registers are addressed as a register pair. When using 8-bit instructions to address RAM locations, remember to use the even-numbered register address as the instruction operand.

Working Registers

The RAM working register area in data memory bank 0 is further divided into four *register* banks (bank 0, 1, 2, and 3). Each register bank has eight 4-bit registers and paired 4-bit registers are 8-bit addressable.

Register A is used as a 4-bit accumulator and register pair EA is an 8-bit extended accumulator. The carry flag bit can also be used as a 1-bit accumulator. Register pairs WX, WL, and HL are used as address pointers for indirect addressing. To limit the possibility of data corruption due to incorrect register addressing, it is advisable to use register bank 0 for the main program and banks 1, 2, and 3 for interrupt service routines.

Bit Sequential Carrier (BSC)

The bit sequential carrier (BSC) is a 16-bit general register mapped to RAM addresses FC0H–FC3H that can be manipulated by 1-, 4-, and 8-bit RAM control instructions. RESET clears all bit values to logic zero.

You can specify addresses and bit locations sequentially using a 1-bit indirect addressing instruction. In this way, a program can process 16-bit data by moving the bit location sequentially, incrementing or decrementing the value of the L register. BSC data can also be manipulated by direct addressing. For 8-bit manipulations, you must address the upper and lower 8 bits separately.

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Table 2–2. Data Memory Organization and Addressing

Addresses	Register Areas	Bank	EMB Value	SMB Value
000H–01FH	Working registers	0	0, 1	0
020H–0FFH	Stack and general-purpose registers			
100H–1FFH	General-purpose registers	1	1	1
F80H–FFFH	I/O-mapped hardware registers	15	0, 1	15

☞ **PROGRAMMING TIP — Clearing Data Memory Banks 0 and 1**

Clear bank 0 of the data memory area:

```
RAMCLR    BITS      EMB
          SMB       0
          LD        HL,#10H
          LD        A,#0H
RMCL0     LD        @HL,A              ;    RAM (010H–0FFH) clear
          INCS      HL
          JR        RMCL0
;
```

WORKING REGISTERS

Working registers, mapped to RAM address 000H-01FH in data memory bank 0, are used to temporarily store intermediate results during program execution, as well as pointer values used for indirect addressing. Unused registers may be used as general-purpose memory. Working register data can be manipulated as 1-bit units, 4-bit units or, using paired registers, as 8-bit units.
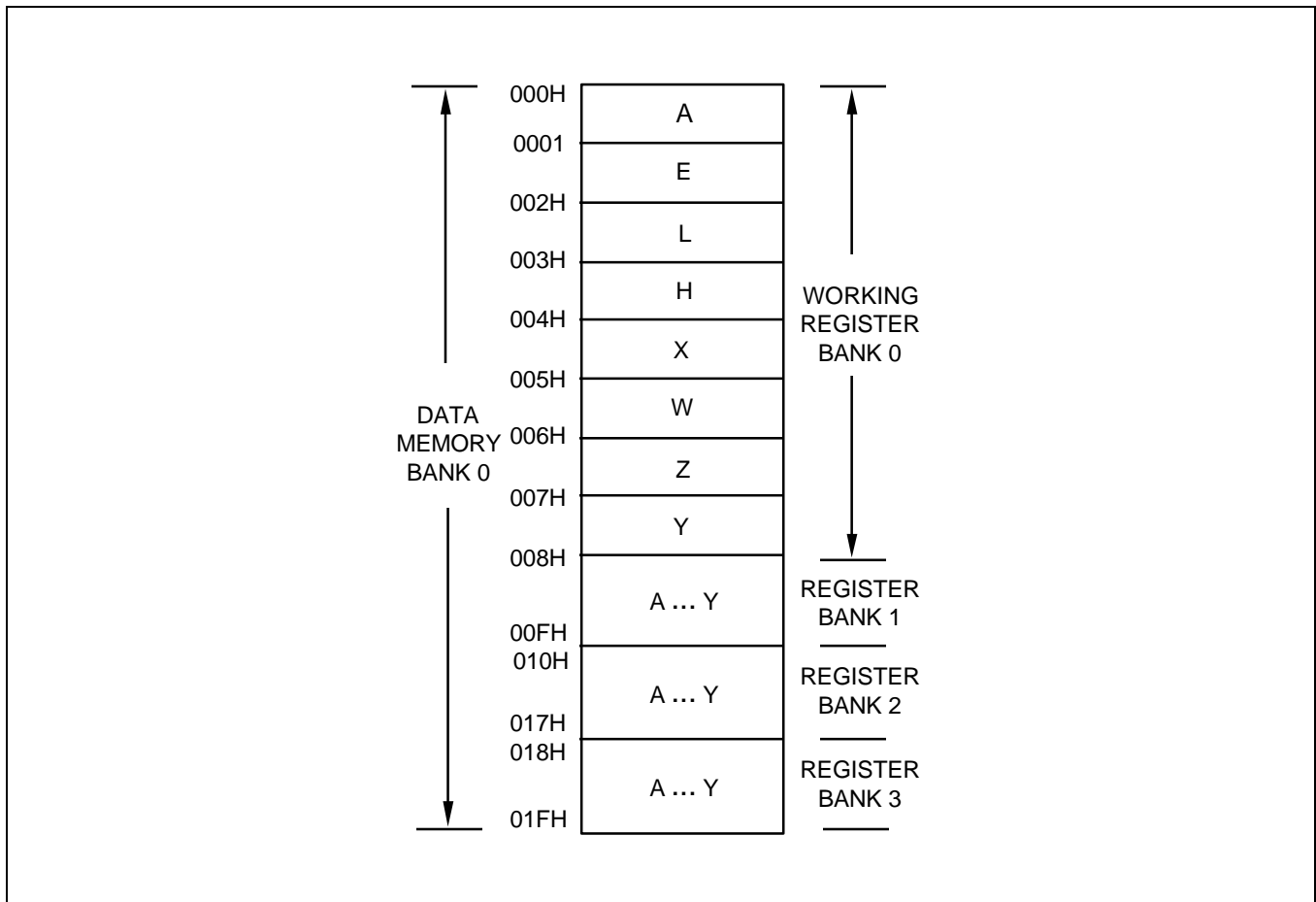
Figure 2–4. Working Register Map

Working Register Banks

For addressing purposes, the working register area is divided into four register banks — bank 0, bank 1, bank 2, and bank 3. Any one of these banks can be selected as the working register bank by the register bank selection instruction (SRBn) and by setting the status of the register bank enable flag (ERB).

Generally, working register bank 0 is used for the main program, and banks 1, 2, and 3 for interrupt service routines. Following this convention helps to prevent possible data corruption during program execution due to contention in register bank addressing.

Table 2–3. Working Register Organization and Addressing

ERB Setting	SRB Settings				Selected Register Bank
	3	**2**	**1**	**0**	
0	0	0	x	x	Always set to bank 0
1	0	0	0	0	Bank 0
			0	1	Bank 1
			1	0	Bank 2
			1	1	Bank 3

NOTE: 'x' means don't care.

Paired Working Registers

Each of the register banks is subdivided into eight 4-bit registers. These registers are named Y, Z, W, X, H, L, E and A. You can manipulate them individually using 4-bit instructions, or as register pairs for 8-bit data manipulation.

The names of the 8-bit register pairs in each register bank are EA, HL, WX, YZ and WL. Registers A, L, X and Z always become the lower nibble when registers are addressed as 8-bit pairs. This makes a total of eight 4-bit registers or four 8-bit double registers in each of the four working register banks.
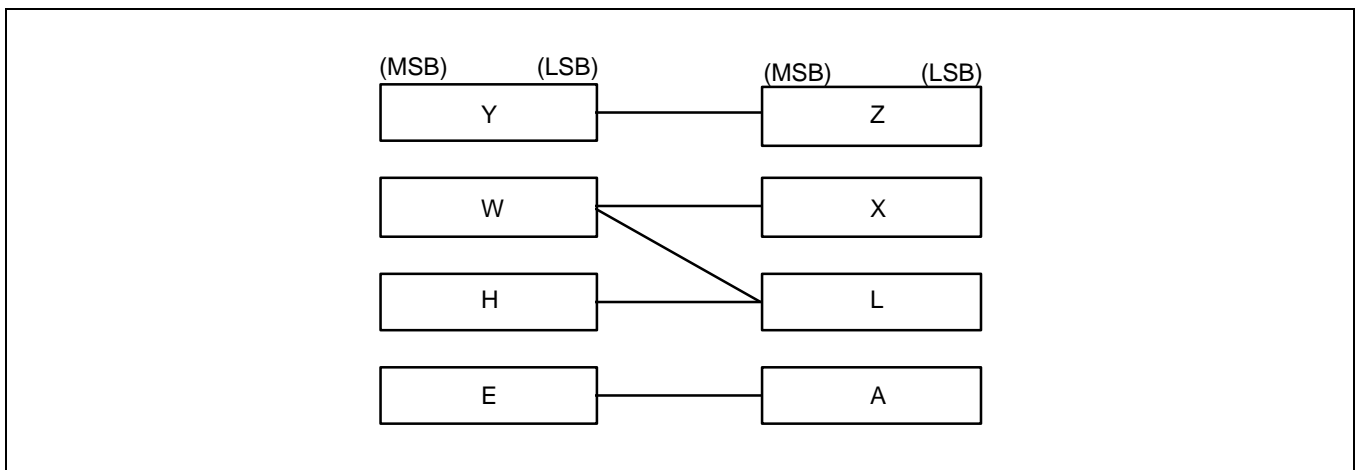
Figure 2–5. Register Pair Configuration

Special-Purpose Working Registers

You use register A as a 4-bit accumulator and double register EA as an 8-bit accumulator. You can use the carry flag as a 1-bit accumulator.

8-bit double registers WX, WL and HL are used as data pointers for indirect addressing. When the HL register serves as a data pointer, the instructions LDI, LDD, XCHI, and XCHD can make very efficient use of working registers as program loop counters by letting you transfer a value and increment or decrement L register value using a single instruction.
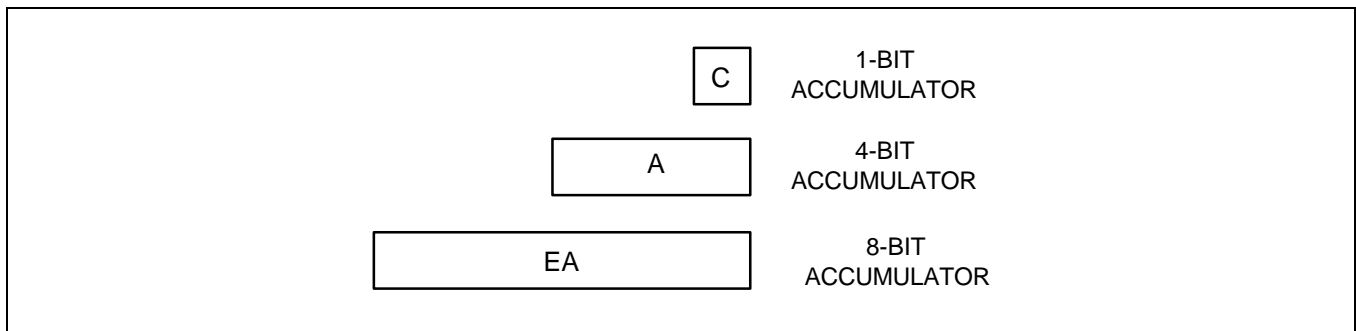
Figure 2–6. 1-Bit, 4-Bit, and 8-Bit Accumulator

Recommendation for Multiple Interrupt Processing

If more than four interrupts are being processed at one time, you can avoid possible loss of working register data by using the PUSH RR instruction to save register contents to the stack before the service routines are executed in the same register bank. When the routines have executed successfully, you can restore the register contents from the stack to working memory using the POP instruction.

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☞ PROGRAMMING TIP — Selecting Your Working Register Area

The following examples show the correct programming method for selecting working register area:

1. When ERB = "0":

```
VENT2       1,0,INT0                   ;   EMB ← 1, ERB ← 0, Jump to INT0 address
;
INT0        PUSH    SB                 ;   PUSH current SMB, SRB
            SRB     2                  ;   Non-essential instruction, since ERB = "0"
            PUSH    HL                 ;   PUSH HL register to stack
            PUSH    WX                 ;   PUSH WX register to stack
            PUSH    YZ                 ;   PUSH YZ register to stack
            PUSH    EA                 ;   PUSH EA register to stack
            SMB     0
            LD      EA,#00H
            LD      80H,EA
            LD      HL,#40H
            INCS    HL
            LD      WX,EA
            LD      YZ,EA
            POP     EA                 ;   POP EA register from stack
            POP     YZ                 ;   POP YZ register from stack
            POP     WX                 ;   POP WX register from stack
            POP     HL                 ;   POP HL register from stack
            POP     SB                 ;   POP current SMB, SRB
            IRET
```

The POP instructions execute alternately with the PUSH instructions. If an SMB ninstruction is used in an interrupt service routine, a PUSH and POP SB instruction must be used to store and restore the current SMB and SRB values, as shown in Example 2 below.

2. When ERB = "1":

```
VENT2       1,1,INT0                   ;   EMB ← 1, ERB ← 1, Jump to INT0 address
;
INT0        PUSH    SB                 ;   Store current SMB, SRB
            SRB     2                  ;   Select register bank 2
            SMB     0
            LD      EA,#00H
            LD      80H,EA
            LD      HL,#40H
            INCS    HL
            LD      WX,EA
            LD      YZ,EA
            POP     SB                 ;   Restore SMB, SRB
            IRET
;
```

STACK OPERATIONS

STACK POINTER (SP)

The stack pointer (SP) is an 8-bit register that stores the address used to access the stack, an area of data memory set aside for temporary storage of data and addresses. The SP is mapped to RAM addresses F80H-F81H, and can be read or written by 8-bit control instructions. When addressing the SP, bit 0 must always remain cleared to logic zero.

F80H	SP3	SP2	SP1	"0"
F81H	SP7	SP6	SP5	SP4

There are two basic stack operations: writing to the top of the stack (push), and reading from the top of the stack (pop). A push decrements the SP and a pop increments it so that the SP always points to the top address of the last data to be written to the stack.

The program counter contents and program status word are stored in the stack area prior to the execution of a CALL or a PUSH instruction, or during interrupt service routines. Stack operation is a LIFO (Last In-First Out) type. The stack area is located in general-purpose data memory bank 0.

During an interrupt or a subroutine, the PC value and the PSW are saved to the stack area. When the routine has completed, the stack pointer is referenced to restore the PC and PSW, and the next instruction is executed.

The SP can address stack registers in bank 0 (addresses 000H-0FFH) regardless of the current value of the enable memory bank (EMB) flag and the select memory bank (SMB) flag.

Since the reset value of the stack pointer is not defined in firmware, we recommend that you initialize the stack pointer by program code to location 00H. This sets the first register of the stack area to 0FFH.

NOTE

A subroutine call occupies six nibbles in the stack; an interrupt requires six. When subroutine nesting or interrupt routines are used continuously, the stack area should be set in accordance with the maximum number of subroutine levels. To do this, estimate the number of nibbles that will be used for the subroutines or interrupts and set the stack area correspondingly.

Although you may use general-purpose register areas for stack operations, be careful to avoid data loss due to simultaneous use of the same register(s).

☞ **PROGRAMMING TIP — Initializing the Stack Pointer**

To initialize the stack pointer (SP):

1. When EMB = "1":

```
        SMB     15              ;   Select memory bank 15
        LD      EA,#00H          ;   Bit 0 of accumulator A is always cleared to "0"
        LD      SP,EA            ;   Stack area initial address (0FFH) ← (SP) – 1
```

2. When EMB = "0":

```
        LD      EA,#00H
        LD      SP,EA            ;   Memory addressing area  (00H–7FH, F80H–FFFH)
```

PUSH OPERATIONS

Three kinds of push operations reference the stack pointer (SP) to write data from the source register to the stack: PUSH instructions, CALL instructions, and interrupts. In each case, the SP is *decremented* by a number determined by the type of push operation and then points to the next available stack location.

PUSH Instructions

A PUSH instruction references the SP to write two 4-bit data nibbles from the PC to the stack. Two 4-bit stack addresses are referenced by the stack pointer: one for the upper register value and another for the lower register. After the PUSH has executed, the SP is decremented *by two* and points to the next available stack location.

CALL Instructions

When a subroutine call is issued, the CALL instruction references the SP to write the PC's contents to four 4-bit stack locations. Current values for the enable memory bank (EMB) flag and the enable register bank (ERB) flag are also pushed to the stack. After the CALL has executed, the SP is decremented *by six* and points to the next available stack location. Since six 4-bit stack locations are used per CALL, you may nest subroutine calls up to the number of levels permitted in the stack.

Interrupt Routines

An interrupt routine references the SP to push the contents of the PC, as well as current values for the program status word (PSW) to the stack. Six 4-bit stack locations are used to store this data. After the interrupt has executed, the SP is decremented *by six* and points to the next available stack location. During an interrupt sequence, subroutines may be nested up to the number of levels which are permitted in the stack area.
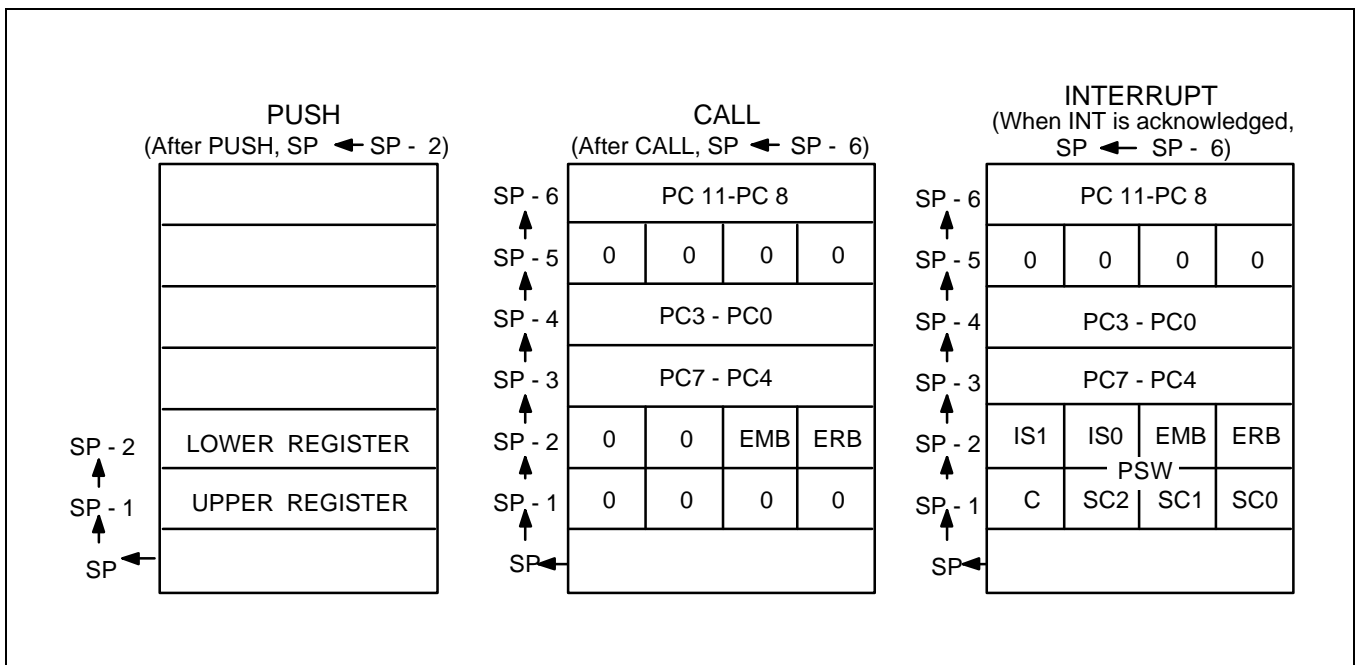
Figure 2–7. Push-Type Stack Operations

POP OPERATIONS

For each push operation there is a corresponding pop operation to write data from the stack back to the source register or registers: for the PUSH instruction it is the POP instruction; for CALL, the instruction RET or SRET; for interrupts, the instruction IRET. When a pop operation occurs, the SP is *incremented* by a number determined by the type of operation and points to the next free stack location.

POP Instructions

A POP instruction references the SP to write data stored in two 4-bit stack locations back to the register pairs and SB register. The value for the lower 4-bit register is popped first, followed by the value for the upper 4-bit register. After the POP has executed, the SP is incremented *by two* and points to the next free stack location.

RET and SRET Instructions

The end of a subroutine call is signaled by the return instruction, RET or SRET. The RET or SRET uses the SP to reference the four 4-bit stack locations used for the CALL and to write this data back to the PC, the EMB, and ERB. After the RET or SRET has executed, the SP is incremented *by six* and points to the next free stack location.

IRET Instructions

The end of an interrupt sequence is signaled by the instruction IRET. IRET references the SP to locate the six 4-bit stack addresses used for the interrupt and to write this data back to the PC and the PSW. After the IRET has executed, the SP is incremented *by six* and points to the next free stack location.
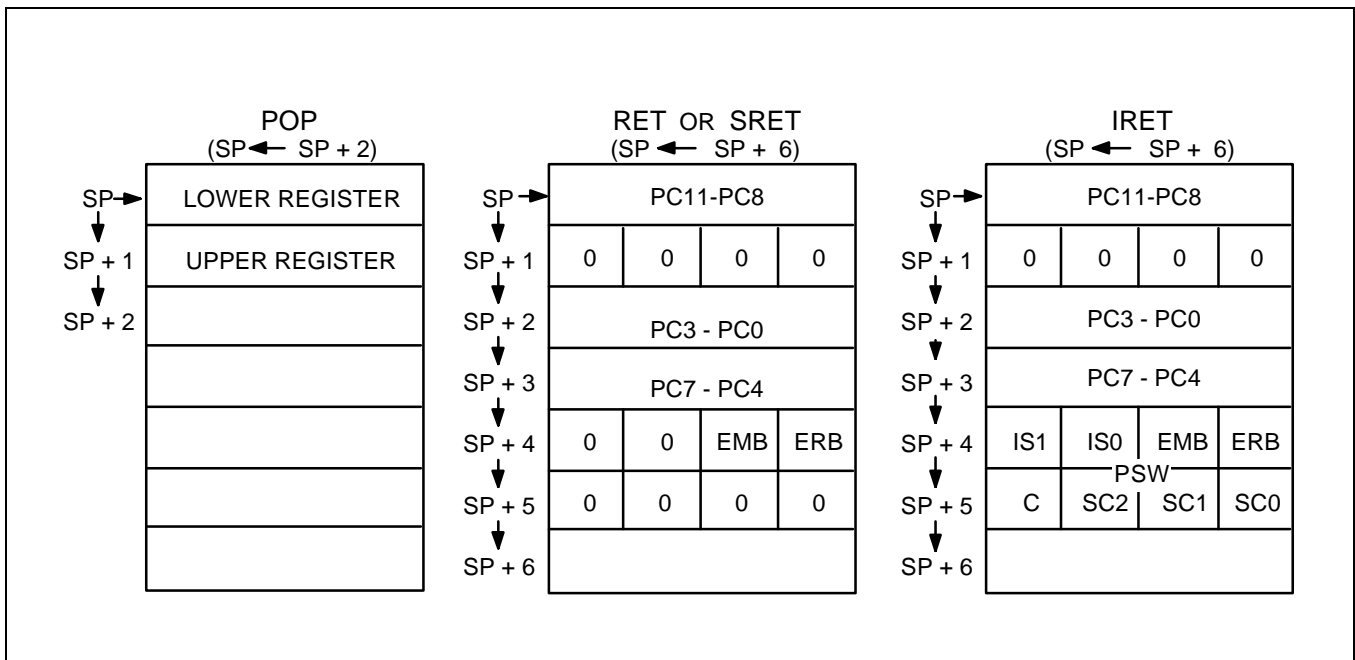
Figure 2–8. Pop-Type Stack Operations

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BIT SEQUENTIAL CARRIER (BSC)

The bit sequential carrier (BSC) is a 16-bit register that is mapped to RAM addresses FC0H–FC3H. You can manipulate the BSC register using 1-, 4-, and 8-bit RAM control instructions. RESET clears all BSC bit values to logic zero.

Using the BSC, you can specify addresses and bit locations sequentially using 1-bit indirect addressing (memb.@L). Bit addressing is independent of the current EMB value. In this way, programs can process 16-bit data by moving the bit location sequentially and then incrementing or decrementing the value of the L register.

BSC data can also be manipulated using direct addressing. For 8-bit manipulations, specify the 4-bit register names BSC0 and BSC2 and manipulate the upper and lower 8 bits manipulated separately.

If the values of the L register are 0H at BSC0.@L, the address and bit location assignment is FC0H.0. If the L register content is FH at BSC0.@L, the address and bit location assignment is FC3H.3.

Table 2–4. BSC Register Organization

Name	Address	Bit 3	Bit 2	Bit 1	Bit 0
BSC0	FC0H	BSC0.3	BSC0.2	BSC0.1	BSC0.0
BSC1	FC1H	BSC1.3	BSC1.2	BSC1.1	BSC1.0
BSC2	FC2H	BSC2.3	BSC2.2	BSC2.1	BSC2.0
BSC3	FC3H	BSC3.3	BSC3.2	BSC3.1	BSC3.0

☞ **PROGRAMMING TIP — Using the BSC Register to Output 16-Bit Data**

To use the bit sequential carrier (BSC) register to output 16-bit data (5937H) to the P3.0 pin:

```
            BITS     EMB
            SMB      15
            LD       EA,#37H          ;
            LD       BSC0,EA          ;   BSC0 ← A, BSC1 ← E
            LD       EA,#59H          ;
            LD       BSC2,EA          ;   BSC2 ← A, BSC3 ← E
            SMB      0
            LD       L,#0H            ;
AGN         LDB      C,BSC0.@L        ;
            LDB      P3.0,C           ;   P3.0 ← C
            INCS     L
            JR       AGN
            RET
```

PROGRAM COUNTER (PC)

A 12-bit program counter (PC) stores addresses for instruction fetches during program execution. Whenever a reset operationor an interrupt occurs, bits PC11 through PC0 are set to the vector address. Bit PC12–PC13 is re-served to support future expansion of the device's ROM size.

Usually, the PC is incremented by the number of bytes of the instruction being fetched. One exception is the 1-byte REF instruction which is used to reference instructions stored in the ROM.

PROGRAM STATUS WORD (PSW)

The program status word (PSW) is an 8-bit word, mapped to RAM locations FB0H–FB1H, that defines system status and program execution status and which permits an interrupted process to resume operation after an inter-rupt request has been serviced. PSW values are mapped as follows:

FB0H	IS1	IS0	EMB	ERB
FB1H	C	SC2	SC1	SC0

The PSW can be manipulated by 1-bit or 4-bit read/write and by 8-bit read instructions, depending on the spe-cific bit or bits being addressed. The PSW can be addressed during program execution regardless of the current value of the enable memory bank (EMB) flag.

Part or all of the PSW is saved to stack prior to execution of a subroutine call or hardware interrupt. After the interrupt has been processed, the PSW values are popped from the stack back to the PSW address.

When a RESET is generated, the EMB and ERB values are set according to the RESET vector address, and the carry flag is left undefined (or the current value is retained). PSW bits IS0, IS1, SC0, SC1, and SC2 are all cleared to logic zero.

Table 2–5. Program Status Word Bit Descriptions

PSW Bit Identifier	Description	Bit Addressing	Read/Write
IS1, IS0	Interrupt status flags	1, 4	R/W
EMB	Enable memory bank flag	1	R/W
ERB	Enable register bank flag	1	R/W
C	Carry flag	1	R/W
SC2, SC1, SC0	Program skip flags	8	R

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INTERRUPT STATUS FLAGS (IS0, IS1)

PSW bits IS0 and IS1 contain the current interrupt execution status values. They are mapped to RAM bit locations FB0H.2 and FB0H.3, respectively. You can manipulate IS0 and IS1 flags directly using 1-bit RAM control instructions

By manipulating interrupt status flags in conjunction with the interrupt priority register (IPR), you can process multiple interrupts by anticipating the next interrupt in an execution sequence. The interrupt priority control circuit determines the IS0 and IS1 settings in order to control multiple interrupt processing. When both interrupt status flags are set to "0", all interrupts are allowed. The priority with which interrupts are processed is then determined by the IPR.

When an interrupt occurs, IS0 and IS1 are pushed to the stack as part of the PSW and are automatically incremented to the next higher priority level. Then, when the interrupt service routine ends with an IRET instruction, IS0 and IS1 values are restored to the PSW. Table 2–6 shows the effects of IS0 and IS1 flag settings.

Table 2–6. Interrupt Status Flag Bit Settings

IS1 Value	IS0 Value	Status of Currently Executing Process	Effect of IS0 and IS1 Settings on Interrupt Request Control
0	0	0	All interrupt requests are serviced
0	1	1	Only high-priority interrupt(s) as determined in the interrupt priority register (IPR) are serviced
1	0	2	No more interrupt requests are serviced
1	1	—	Not applicable; these bit settings are undefined

Since interrupt status flags can be addressed by write instructions, programs can exert direct control over interrupt processing status. Before interrupt status flags can be addressed, however, you must first execute a DI instruction to inhibit additional interrupt routines. When the bit manipulation has been completed, execute an EI instruction to re-enable interrupt processing.

☞ **PROGRAMMING TIP — Setting ISx Flags for Interrupt Processing**

The following instruction sequence shows how to use the IS0 and IS1 flags to control interrupt processing:

```
INTB   DI                 ;  Disable interrupt
       BITR  IS1           ;  IS1 ← 0
       BITS  IS0           ;  Allow interrupts according to IPR priority level
       EI                  ;  Enable interrupt
```

EMB FLAG (EMB)

The enable memory bank flag EMB is mapped to registers FB0H–FB1H in bank 15 of the RAM. The EMB flag occupies bit location 1 in register FB0H.

The EMB flag is used to allocate specific address locations in the RAM by modifying the upper 4 bits of 12-bit data memory addresses. In this way, it controls the addressing mode for data memory banks 0, bank 1 or 15.

When the EMB flag is "0", the data memory address space is restricted to bank 15 and addresses 000H–07FH of memory bank 0, regardless of the SMB register contents. When the EMB flag is set to "1", you can access general-purpose areas of bank 0, bank 1, and bank 15 by using the appropriate SMB value.

☞ **PROGRAMMING TIP — Using the EMB Flag to Select Memory Banks**

EMB flag settings for memory bank selection:

1. When EMB = "0":

```
            SMB      0                ;   Non-essential instruction, since EMB = "0"
            LD       90H,A            ;   (F90H) ← A, bank 15 is selected
            LD       34H,A            ;   (034H) ← A, bank 0 is selected
            SMB      15               ;   Non-essential instruction, since EMB = "0"
            LD       20H,A            ;   (020H) ← A, bank 0 is selected
            LD       90H,A            ;   (F90H) ← A, bank 15 is selected
;
```

2. When EMB = "1":

```
            SMB      0                ;   Select memory bank 0
            LD       90H,A            ;   (090H) ← A, bank 0 is selected
            LD       34H,A            ;   (034H) ← A, bank 0 is selected
            SMB      15               ;   Select memory bank 15
            LD       20H,A            ;   Program error, but assembler does not detect it
            LD       90H,A            ;   (F90H) ← A, bank 15 is selected
;
```

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ERB FLAG (ERB)

The 1-bit register bank enable flag (ERB) determines the range of addressable working register area. When the ERB flag is "1", you select the working register area from register banks 0 to 3 according to the register bank selection register (SRB). When the ERB flag is "0", you select register bank 0 as the working register area, regardless of the current value of the register bank selection register (SRB).

When an internal RESET is generated, bit 6 of program memory address 0000H is written to the ERB flag. This automatically initializes the flag. When a vectored interrupt is generated, bit 6 of the respective vector address table in program memory is written to the ERB flag, setting the correct flag status before the interrupt service routine is executed.

During the interrupt routine, the ERB value is automatically pushed to the stack area along with the other PSW bits. Afterwards, it is popped back to the FB0H.0 bit location. The initial ERB flag settings for each vectored interrupt are defined using VENTn instructions.

☞ **PROGRAMMING TIP — Using the ERB Flag to Select Register Banks**

ERB flag settings for register bank selection:

1. When ERB = "0":

```
            SRB     1               ;   Register bank 0 is selected (since ERB = "0", the
                                    ;   SRB is configured to bank 0)
            LD      EA,#34H         ;   Bank 0 EA ← #34H
            LD      HL,EA           ;   Bank 0 HL ← EA
            SRB     2               ;   Register bank 0 is selected
            LD      YZ,EA           ;   Bank 0 YZ ← EA
            SRB     3               ;   Register bank 0 is selected
            LD      WX,EA           ;   Bank 0 WX ← EA
;
```

2. When ERB = "1":

```
            SRB     1               ;   Register bank 1 is selected
            LD      EA,#34H         ;   Bank 1 EA ← #34H
            LD      HL,EA           ;   Bank 1 HL ← Bank 1 EA
            SRB     2               ;   Register bank 2 is selected
            LD      YZ,EA           ;   Bank 2 YZ ← BANK 2 EA
            SRB     3               ;   Register bank 3 is selected
            LD      WX,EA           ;   Bank 3 WX ← Bank 3 EA
;
```

SKIP CONDITION FLAGS (SC2, SC1, SC0)

The skip condition flags SC2, SC1, and SC0 indicate the current program skip conditions and are set and reset automatically during program execution. These flags are mapped to RAM bit locations FB1H.0, FB1H.1, and FB1H.2 of the PSW.

Skip condition flags can only be addressed by 8-bit read instructions. Direct manipulation of the SC2, SC1, and SC0 bits is not allowed.

CARRY FLAG (C)

The carry flag is mapped to bit location FB1H.3 in the PSW. It is used to save the result of an overflow or borrow when executing arithmetic instructions involving a carry (ADC, SBC). The carry flag can also be used as a 1-bit accumulator for performing Boolean operations involving bit-addressed data memory.

If an overflow or borrow condition occurs when executing arithmetic instructions with carry (ADC, SBC), the carry flag is set to "1". Otherwise, its value is "0". When a RESET occurs, the current value of the carry flag is retained during power-down mode, but when normal operating mode resumes, its value is undefined.

The carry flag can be directly manipulated by predefined set of 1-bit read/write instructions, independent of other bits in the PSW. Only the ADC and SBC instructions, and the instructions listed in Table 2–7, affect the carry flag.

Table 2–7. Valid Carry Flag Manipulation Instructions

Operation Type	Instructions	Carry Flag Manipulation
Direct manipulation	SCF	Set carry flag to "1"
	RCF	Clear carry flag to "0" (reset carry flag)
	CCF	Invert carry flag value (complement carry flag)
	BTST C	Test carry and skip if C = "1"
Bit transfer	LDB (operand) [1],C	Load carry flag value to the specified bit
	LDB C,(operand) [1]	Load contents of the specified bit to carry flag
Data transfer	RRC A	Rotate right with carry flag
Boolean manipulation	BAND C,(operand) [1]	AND the specified bit with contents of carry flag and save the result to the carry flag
	BOR C,(operand) [1]	OR the specified bit with contents of carry flag and save the result to the carry flag
	BXOR C,(operand) [1]	XOR the specified bit with contents of carry flag and save the result to the carry flag
Interrupt routine	INTn [2]	Save carry flag to stack with other PSW bits
Return from interrupt	IRET	Restore carry flag from stack with other PSW bits

NOTES:
1. The operand has three bit addressing formats: mema.a, memb.@L, and @H + DA.b.
2. INTn refers to the specific interrupt being executed and is not an instruction.

☞ **PROGRAMMING TIP — Using the Carry Flag as a 1-Bit Accumulator**

1. Set the carry flag to logic one:

SCF		;	C ← 1
LD	EA,#0C3H	;	EA ← #0C3H
LD	HL,#0AAH	;	HL ← #0AAH
ADC	EA,HL	;	EA ← #0C3H + #0AAH + #1H, C ← 1

2. Logical-AND bit 3 of address 3FH with P3.3 and output the result to P5.0:

LD	H,#3H	;	Set the upper four bits of the address to the H register value
LDB	C,@H+0FH.3	;	C ← bit 3 of 3FH
BAND	C,P3.3	;	C ← C AND P3.3
LDB	P5.0,C	;	Output result from carry flag to P5.0

NOTES

3 ADDRESSING MODES

OVERVIEW

The enable memory bank flag, EMB, controls the two addressing modes for data memory. When you enable the EMB flag, you can address the entire RAM area. When you clear the EMB flag to logic zero, the addressable RAM is restricted to specific areas.

The EMB flag works in connection with the select memory bank instruction, SMB n. You will recall that the SMB n instruction is used to select RAM bank 0, bank 1 or 15. The SMB setting is always contained in the upper four bits of a 12-bit RAM address. For this reason, both addressing modes (EMB = "0" and EMB = "1") apply specifically to the memory bank indicated by the SMB instruction, and any restrictions to the addressable area within banks 0, 1 or 15. Direct and indirect 1-bit, 4-bit, and 8-bit addressing methods can be used.

In addition, there are several RAM locations that can always be addressed using specific addressing methods, regardless of the current EMB flag setting.

Here are a few things to remember about addressing data memory areas:

— When you address peripheral hardware locations in bank 15, you can use the mnemonic for the memory-mapped hardware component as the operand in place of the actual address location.

— Always use an even-numbered RAM address as the operand in 8-bit direct and indirect addressing.

— With direct addressing, use the RAM address as the instruction operand; with indirect addressing, the insttruction specifies a register which contains the operand's address.

ADDRESSING MODE RAM AREAS	DA DA.b		@HL @H + DA.b		@WX @WL	mema.b	memb.@L
	EMB = 0	EMB = 1	EMB = 0	EMB = 1	X	X	X
000H WORKING REGISTERS		SMB = 0		SMB = 0			
01FH / 020H							
07FH / 080H BANK 0 (GENERAL REGISTERS AND STACK) 0FFH							
100H BANK 1: (GENERAL REGISTERS) 1FFH		SMB =1		SMB = 1			
F80H BANK 15 (PERIPHERAL HARDWARE REGISTERS) FFFH		SMB = 15		SMB = 15	FB0H FBFH FC0H FF0H		

NOTES: 1. 'X' means don't care.

2. Blank columns indicate RAM areas that are not addressable, given the addressing method and enable memory bank (EMB) flag setting shown in the column headers.

Figure 3–1. RAM Address Structure

EMB AND ERB INITIALIZATION VALUES

The EMB and ERB flag bits are set automatically by the values of the RESET vector address and the interrupt vector address.

When a RESET is generated internally, bit 7 of program memory address 0000H is written to the EMB flag, initializing it automatically. When a vectored interrupt is generated, bit 7 of the respective vector address table is written to the EMB. This automatically sets the EMB flag status for the interrupt service routine. When the interrupt is serviced, the EMB value is automatically saved to stack and then restored when the interrupt routine has completed.

At the beginning of a program, the initial EMB flag value for each vectored interrupt must be set by using VENT instruction. The EMB can be set or reset by bit manipulation instructions (BITS, BITR) despite the current SMB setting.

☞ **PROGRAMMING TIP — Initializing the EMB and ERB Flags**

The following assembly instructions show how to initialize the EMB and ERB flag settings:

```
            ORG     0000H         ;  ROM address assignment
            VENT0   1,0,RESET     ;  EMB ← 1, ERB ← 0, branch RESET
            VENT1   0,1,INTB      ;  EMB ← 0, ERB ← 1, branch INTB
            VENT2   0,1,INT0      ;  EMB ← 0, ERB ← 1, branch INT0
            VENT3   0,1,INT1      ;  EMB ← 0, ERB ← 1, branch INT1
            VENT4   0,1,INTS      ;  EMB ← 0, ERB ← 1, branch INTS
            VENT5   0,1,INTT0     ;  EMB ← 0, ERB ← 1, branch INTT0
                •
                •
                •
RESET       BITR    EMB
```

ENABLE MEMORY BANK SETTINGS

EMB = "1"

When you set the enable memory bank flag, EMB, to logic one, you can address the data memory bank specified by the select memory bank (SMB) value (0,1 or 15) using 1-, 4-, or 8-bit instructions. You can use both direct and indirect addressing modes. The addressable RAM areas when the EMB flag is set to logic one are as follows:

If SMB = 0,   000H–0FFH

If SMB = 1   100H–1FFH

If SMB = 15,   F80H–FFFH

EMB = "0"

When the enable memory bank flag EMB is set to logic zero, the addressable area is defined independently of the SMB value, and is restricted to specific locations depending on whether a direct or indirect address mode is used.

If EMB = "0", the addressable area is restricted to locations 000H–07FH in bank 0 and to locations F80H–FFFH in bank 15 for direct addressing. For indirect addressing, only locations 000H–0FFH in bank 0 are addressable, regardless of SMB value.

To address the peripheral hardware register (bank 15) using indirect addressing, the EMB flag must first be set to "1" and the SMB value to "15". When a RESET occurs, the EMB flag is set to the value contained in bit 7 of ROM address 0000H.

EMB-Independent Addressing

You can address several areas of the data memory at any time, despite the status of the EMB flag. These exceptions are described in Table 3–1.

Table 3–1. RAM Addressing Not Affected by the EMB Value

Address	Addressing Method	Affected Hardware	Program Examples
000H–0FFH	4-bit indirect addressing using WX and WL register pairs; 8-bit indirect addressing using SP	Not applicable	LD A,@WX PUSH POP
FB0H–FBFH FF0H–FFFH	1-bit direct addressing	PSW, IEx, IRQx, I/O	BITS EMB BITR IE1
FC0H–FFFH	1-bit indirect addressing using the L register	BSC, I/O	BTST FC3H.@L BAND C,P3.@L

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SELECT BANK REGISTER (SB)

The select bank register (SB) is used to assign the memory bank and register bank. The 8-bit SB register consists of the 4-bit select register bank register (SRB) and the 4-bit select memory bank register (SMB), as shown in Figure 3–2.

	←	─SMB─	→	←	─SRB─	→		
SB REGISTER	SMB 3	SMB 2	SMB 1	SMB 0	0	0	SRB 1	SRB 0
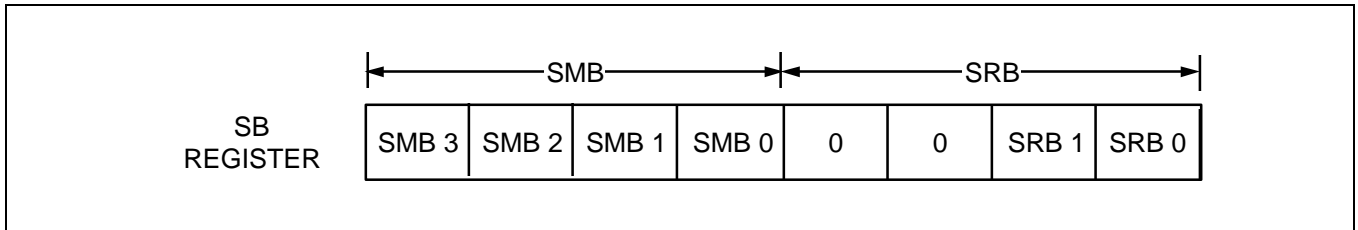
Figure 3–2. 4-Bit SMB and SRB Values in the SB Register

During interrupts and subroutine calls, SB register contents can be saved to stack in 8-bit units by the PUSH SB instruction. You later restore the value to the SB using the POP SB instruction.

Select Register Bank (SRB) Instruction

The select register bank (SRB) value specifies which register bank is to be used as a working register bank. The SRB value is set by the 'SRB n' instruction, where n = 0, 1, 2, 3. One of the four register banks is selected by the combination of ERB flag status and the SRB value that you set using the 'SRB n' instruction. The current SRB value is retained until another register is requested by program software.

PUSH SB and POP SB instructions are used to save and restore the contents of SRB during interrupts and subroutine calls. RESET clears the 4-bit SRB value to logic zero.

Select Memory Bank (SMB) Instruction

To select one of the two available data memory banks, you must execute an SMB n instruction specifying the number of the memory bank you want (0, 1 or 15). For example, the instruction 'SMB 1' selects bank 1 and 'SMB 15' selects bank 15. You must also remember to enable the memory bank you select by the appropriate enable memory bank flag (EMB) setting.

The upper four bits of the 12-bit data memory address are stored in the SMB register. If the SMB value is not specified by software (or if a RESET does not occur) the current value is retained. RESET clears the 4-bit SMB value to logic zero.

PUSH SB and POP SB instructions save and restore the contents of the SMB register to and from the stack area during interrupts and subroutine calls.

DIRECT AND INDIRECT ADDRESSING

You can directly address 1-bit, 4-bit, and 8-bit data stored in data memory locations using a specific register or bit address as the instruction operand.

In indirect addressing the instruction specifies a specfic register pair which contain the address of the operand. The KS57 instruction set supports 1-bit, 4-bit, and 8-bit indirect addressing. For 8-bit indirect addressing, an even-numbered RAM address must always be used as the instruction operand, and the address register can be HL, WX, or WL of the selected register bank.

1-BIT ADDRESSING

Table 3–2. 1-Bit Direct and Indirect RAM Addressing

Instruction Notation	Addressing Mode Description	EMB Flag Setting	Addressable Area	Memory Bank	Hardware I/O Mapping
DA.b	Direct: bit is indicated by the RAM address (DA), memory bank selection, and specified bit number (b).	0	000H–07FH	Bank 0	—
			F80H–FFFH	Bank15	All 1-bit addressable peripherals (SMB = 15)
		1	000H–FFFH	SMB = 0, 1, 15	
mema.b	Direct: bit is indicated by ad-dressable area (mema) and bit number (b).	x	FB0H–FBFH FF0H–FFFH	Bank 15	IS0, IS1, EMB, ERB, IEx, IRQx, Pn.n
memb.@L	Indirect: lower two bits of reg-ister L as indicated by the up-per 10 bits of RAM area (memb) and the upper two bits of register L.	x	FC0H–FFFH	Bank 15	BSCn.x Pn.n
@H + DA.b	Indirect: bit indicated by the lower four bits of the address (DA), memory bank selection, and the H register identifier.	0	000H–0FFH	Bank 0	—
		1	000H–FFFH	SMB = 0, 1, 15	All 1-bit addressable peripherals (SMB = 15)

NOTE： 'x' means don't care.

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☞ **PROGRAMMING TIP — 1-Bit Addressing Modes**

1-Bit Direct Addressing

1. If EMB = "0":

```
AFLAG       EQU      34H.3
BFLAG       EQU      85H.3
CFLAG       EQU      0BAH.0
            SMB      0           ;   Non-essential instruction, since EMB = "0"
            BITS     AFLAG       ;   34H.3 ← 1
            BITS     BFLAG       ;   F85H.3 (BMOD.3) ← 1
            BTST     CFLAG       ;   If FBAH.0 (IRQW) = 1, skip
            BITS     BFLAG       ;   Else if FBAH.0 (IRQW) = 0, F85H.3 (BMOD.3) ← 1
            BITS     P3.0        ;   FF3H.0 (P3.0) ← 1
;
```

2. If EMB = "1":

```
AFLAG       EQU      34H.3
BFLAG       EQU      85H.3
CFLAG       EQU      0BAH.0
            SMB      0           ;   Select memory bank 0
            BITS     AFLAG       ;   34H.3 ← 1
            BITS     BFLAG       ;   85H.3 ← 1
            BTST     CFLAG       ;   If 0BAH.0 = 1, skip
            BITS     BFLAG       ;   Else if 0BAH.0 = 0, 085H.3 ← 1
            BITS     P3.0        ;   FF3H.0 (P3.0) ← 1
;
```

☞ **PROGRAMMING TIP — 1-Bit Addressing Modes (Continued)**

1-Bit Indirect Addressing

1. If EMB = "0":

```
AFLAG     EQU     34H.3
BFLAG     EQU     85H.3
CFLAG     EQU     0BAH.0
          SMB     0              ;   Non-essential instruction, since EMB = "0"
          LD      H,#0BH         ;   H ← #0BH
          BTSTZ   @H+CFLAG       ;   If 0BAH.0 = 1, 0BAH.0 ← 0 and skip
          BITS    CFLAG          ;   Else if 0BAH.0 = 0, FBAH.0 (IRQW) ← 1
;
```

2. If EMB = "1":

```
AFLAG     EQU     34H.3
BFLAG     EQU     85H.3
CFLAG     EQU     0BAH.0
          SMB     0              ;   Select memory bank 0
          LD      H,#0BH         ;   H ← #0BH
          BTSTZ   @H+CFLAG       ;   If 0BAH.0 = 1, 0BAH.0 ← 0 and skip
          BITS    CFLAG          ;   Else if 0BAH.0 = 0, 0BAH.0 ← 1
;
```

4-BIT ADDRESSING

Table 3–3. 4-Bit Direct and Indirect RAM Addressing

Instruction Notation	Addressing Mode Description	EMB Flag Setting	Addressable Area	Memory Bank	Hardware I/O Mapping
DA	Direct: 4-bit address indicated by the RAM address (DA) and the memory bank selection	0	000H–07FH	Bank 0	—
			F80H–FFFH	Bank15	All 4-bit addressable peripherals (SMB = 15)
		1	000H–FFFH	SMB = 0, 1,15	
@HL	Direct: 4-bit address indicated by the memory bank selection and register HL	0	000H–0FFH	Bank 0	—
		1	000H–FFFH	SMB = 0, 15	All 4-bit addressable peripherals (SMB = 15)
@WX	Indirect: 4-bit address indicated by register WX	x	000H–0FFH	Bank 0	—
@WL	Indirect: 4-bit address indicated by register WL	x	000H–0FFH	Bank 0	

NOTE: 'x' means don't care.

☞ **PROGRAMMING TIP — 4-Bit Addressing Modes**

4-Bit Direct Addressing

1. If EMB = "0":

```
ADATA      EQU      46H
BDATA      EQU      8EH
           SMB      15           ;   Non-essential instruction, since EMB  =  "0"
           LD       A,P3         ;   A ← (P3)
           SMB      0            ;   Non-essential instruction, since EMB  =  "0"
           LD       ADATA,A      ;   (046H) ← A
           LD       BDATA,A      ;   (F8EH) ← A
;
```

2. If EMB = "1":

```
ADATA      EQU      46H
BDATA      EQU      8EH
           SMB      15           ;   Select memory bank 15
           LD       A,P3         ;   A ← (P3)
           SMB      0            ;   Select memory bank 0
           LD       ADATA,A      ;   (046H) ← A
           LD       BDATA,A      ;   (08EH) ← A
;
```

☞ **PROGRAMMING TIP — 4-Bit Addressing Modes (Continued)**

4-Bit Indirect Addressing

1. If EMB = "0", compare bank 0, locations 040H–046H with 060H–066H:

```
ADATA      EQU     46H
BDATA      EQU     66H
           SMB     15          ;   Non-essential instruction, since EMB = "0"
           LD      HL,#BDATA
           LD      WX,#ADATA
COMP       LD      A,@WL       ;   A ← bank 0 (040H–046H)
           CPSE    A,@HL       ;   If bank 0 (060H–066H) = A, skip
           SRET
           DECS    L
           JR      COMP
           RET
;
```

2. If EMB = "1", exchange bank 0, 040H–046H with 060H–066H:

```
ADATA      EQU     46H
BDATA      EQU     66H
           SMB     0           ;   Select memory bank 0
           LD      HL,#BDATA
           LD      WX,#ADATA
TRANS      LD      A,@WL       ;   A ← bank 0 (040H–046H)
           XCHD    A,@HL       ;   Bank 0 (060H–066H) ← A
           JR      TRANS
;
```

8-BIT ADDRESSING

Table 3–4. 8-Bit Direct and Indirect RAM Addressing

Instruction Notation	Addressing Mode Description	EMB Flag Setting	Addressable Area	Memory Bank	Hardware I/O Mapping
DA	Direct: 8-bit address indicated by the RAM address (*DA = even number*) and memory bank selection	0	000H–07FH	Bank 0	—
			F80H–FFFH	Bank15	All 8-bit addressable peripherals (SMB = 15)
		1	000H–FFFH	SMB = 0, 1, 15	
@HL	Indirect: the 8-bit address indicated by the memory bank selection and register HL; (the 4-bit L register value must be an even number)	0	000H–0FFH	Bank 0	—
		1	000H–FFFH	SMB = 0, 1, 15	All 8-bit addressable peripherals (SMB = 15)

☞ **PROGRAMMING TIP — 8-Bit Addressing Modes**

8-Bit Direct Addressing:

1. If EMB = "0":

```
ADATA       EQU       46H
BDATA       EQU       8EH
            SMB       15            ;   Non-essential instruction, since EMB = "0"
            LD        EA,P4         ;   E  ←  (P5), A  ←  (P4)
            LD        ADATA,EA      ;   (046H)  ←  A, (047H)  ←  E
            LD        BDATA,EA      ;   (F8EH)  ←  A, (F8FH)  ←  E
;
```

2. If EMB = "1":

```
ADATA       EQU       46H
BDATA       EQU       8EH
            SMB       15            ;   Select memory bank 15
            LD        EA,P4         ;   E  ←  (P5), A  ←  (P4)
            SMB       0             ;   Select memory bank 0
            LD        ADATA,EA      ;   (046H)  ←  A, (047H)  ←  E
            LD        BDATA,EA      ;   (08EH)  ←  A, (08FH)  ←  E
;
```

☞ **PROGRAMMING TIP — 8-Bit Addressing Modes (Continued)**

8-Bit Indirect Addressing

1. If EMB = "0":

```
ADATA       EQU     8EH
    LD      HL,#ADATA
    LD      EA,@HL                    ;   A ← (08EH), E ← (08FH)
;
```

2. If EMB = "1":

```
ADATA       EQU     46H
    SMB     0
    LD      HL,#ADATA
    LD      EA,@HL                    ;   A ← (046H), E ← (047H)
;
```

4 MEMORY MAP

OVERVIEW

To support program control of peripheral hardware, I/O addresses for peripherals are memory-mapped to bank 15 of the RAM. Memory mapping lets you use a mnemonic as the operand of an instruction in place of the specific memory location.

Access to bank 15 is controlled by the select memory bank (SMB) instruction and by the enable memory bank flag (EMB) setting.If the EMB flag is "0", bank 15 can be addressed using direct addressing, regardless of the current SMB value. You can use 1-bit direct and indirect addressing, however, for specific locations in bank 15, regardless of the current EMB value.

I/O MAP FOR HARDWARE REGISTERS

Table 4–1 contains detailed information about I/O mapping for peripheral hardware in bank 15 (register locations F80H–FFFH). Use the I/O map as a quick-reference source when writing application programs. The I/O map gives you the following information:

— Register address

— Register name (mnemonic for program addressing)

— Bit values (both addressable and non-manipulable)

— Read-only, write-only, or read and write addressability

— 1-bit, 4-bit, or 8-bit data manipulation characteristics

Table 4–1. I/O Map for Memory Bank 15

Memory Bank 15							Addressing Mode		
Address	**Register**	**Bit 3**	**Bit 2**	**Bit 1**	**Bit 0**	**R/W**	**1-Bit**	**4-Bit**	**8-Bit**
F80H	SP	.3	.2	.1	"0"	R/W	No	No	Yes
F81H		.7	.6	.5	.4				
•									
•									
F85H	BMOD	.3	.2	.1	.0	W	.3	Yes	No
F86H	BCNT					R	No	No	Yes
F87H									
F88H	WMOD	"0"	.2	.1	"0" (1)	W	No	No	Yes
F89H		.7	"0"	.5	.4				
•									
•									
F90H	TMOD0	.3	.2	"0"	"0"	W	.3	No	Yes
F91H		"0"	.6	.5	.4				
F92H		"0"	TOE0	"0"	"0"	R/W	Yes	Yes	No
F93H									
F94H	TCNT0					R	No	No	Yes
F95H									
F96H	TREF0					W	No	No	Yes
F97H									
F98H	WDMOD	.3	.2	.1	.0	W	No	No	Yes
F99H		.7	.6	.5	.4				
F9AH	WDTCF	.3	"0"	"0"	"0"	W	Yes	No	No
•									
•									
FB0H	PSW	IS1	IS0	EMB	ERB	R/W	Yes	Yes	Yes
FB1H		C (2)	SC2	SC1	SC0	R	No	No	
FB2H	IPR	IME	.2	.1	.0	W	IME	Yes	No
FB3H	PCON	.3	.2	.1	.0	W	No	Yes	No
FB4H	IMOD0	.3	"0"	.1	.0	W	No	Yes	No
FB5H	IMOD1	"0"	"0"	"0"	.0	W	No	Yes	No
FB6H	IMODK	"0"	.2	.1	.0	W	N o	Yes	No
FB7H									

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Table 4–1. I/O Map for Memory Bank 15 (Continued)

Memory Bank 15							Addressing Mode		
Address	Register	Bit 3	Bit 2	Bit 1	Bit 0	R/W	1-Bit	4-Bit	8-Bit
FB8H		"0"	"0"	IEB	IRQB	R/W	Yes	Yes	No
FB9H									
FBAH		"0"	"0"	IEW	IRQW	R/W	Yes	Yes	No
FBBH									
FBCH		"0"	"0"	IET0	IRQT0	R/W	Yes	Yes	No
FBDH		"0"	"0"	IES	IRQS				
FBEH		IE1	IRQ1	IE0	IRQ0				
FBFH		"0"	"0"	IEK	IRQK				
FC0H	BSC0					R/W	Yes	Yes	Yes
FC1H	BSC1					R/W		Yes	
FC2H	BSC2					R/W		Yes	Yes
FC3H	BSC3					R/W		Yes	
•									
•									
FD0H	CLMOD	.3	"0"	.1	.0	W	No	Yes	No
•									
•									
FD4H	CMPREG					R	No	Yes	No
FD5H									
FD6H	CMOD	.3	.2	.1	.0	R/W	No	No	Yes
FD7H		.7	.6	.5	"0"				
•									
•									
FDAH	PNE	PNE4.3	PNE4.2	PNE4.1	PNE4.0	W	No	No	Yes
FDBH		PNE5.3	PNE5.2	PNE5.1	PNE5.0				
FDCH	PUMOD	.3	"0"	.1	.0	W	No	No	Yes
FDDH		"0"	.6	.5	.4				
FDEH									
FDFH									
FE0H	SMOD	.3	.2	.1	.0	W	.3	No	Yes
FE1H		.7	.6	.5	"0"				

Table 4–1. I/O Map for Memory Bank 15 (Concluded)

Memory Bank 15							Addressing Mode		
Address	**Register**	**Bit 3**	**Bit 2**	**Bit 1**	**Bit 0**	**R/W**	**1-Bit**	**4-Bit**	**8-Bit**
FE2H	P2MOD	.3	.2	.1	.0	W	No	Yes	No
FE3H									
FE4H	SBUF					R/W	No	No	Yes
FE5H									
FE6H									
FE7H									
FE8H	PMG1	"0"	PM0.2	PM0.1	PM0.0	W	No	No	Yes
FE9H		"0"	PM3.2	PM3.1	PM3.0				
FEAH	PMG2	PM4.3	PM4.2	PM4.1	PM4.0	W	No	No	Yes
FEBH		"0"	"0"	"0"	"0"				
FECH	PMG3	PM5.3	PM5.2	PM5.1	PM5.0	W	No	No	Yes
FEDH		PM6.3	PM6.2	PM6.1	PM6.0				
FEEH									
FEFH									
FF0H	Port 0	—	.2	.1	.0	R/W	Yes	Yes	No
FF1H	Port 1	—	—	.1	.0	R			No
FF2H	Port 2	.3	.2	.1	.0	R			No
FF3H	Port 3	—	.2	.1	.0	R/W			No
FF4H	Port 4	.3	.2	.1	.0	R/W			Yes
FF5H	Port 5	.3 / .7	.2 / .6	.1 / .5	.0 / .4	R/W			
FF6H	Port 6	.3	.2	.1	.0	R/W			No
•									
•									
•									
FFFH									

NOTES:
1. Bit 0 in the WMOD register must be set to logic "0".
2. The carry flag can be read or written by specific bit manipulation instructions only.

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REGISTER DESCRIPTIONS

In this section, register descriptions are presented in a consistent format to familiarize you with the memory-mapped I/O locations in bank 15 of the RAM. Figure 4–1 describes features of the register description format. Register descriptions are arranged in alphabetical order.

Counter registers, buffer registers, and reference registers, as well as the stack pointer and port I/O latches, are not included in these descriptions.

This section can be used as a quick-reference source when writing application programs.

More detailed information about each of these registers is included in Part II of this manual, "Hardware Descriptions," in the context of the corresponding peripheral hardware module descriptions.

Bit identifiers used
for bit addressing

Name of individual
bit or related bits

Register location
in RAM bank 15

Register ID   Register name

IPR — Interrupt Priority Register   **FB2H**

Bit   3   2   1   0
Identifier | IME | .2 | .1 | .0 |
RESET Value   0   0   0   0
Read/Write   W   W   W   W
Bit Addressing   1/4   4   4   4

IME

Global Interrupt Enable Bit

| 0 | Disable interrupt processing globally |
| 1 | Enable interrupt processing globally |

.2 – .0

Interrupt Priority Assignment Bits

0	0	0	Process all interrupt requests at low priority
0	0	1	Process INTB interrupts only
0	1	0	Process INT0 interrupts only
1	0	1	Process INT1 interrupts only
1	1	1	Process INTT interrupts only

R   = Read-only
W   = Write-only
R/W = Read/write
'–' =   Not used

Bit value immediately
following a reset

Bit number in
MSB to LSB order

Type of addressing
that must be used to
address the bit
(1-bit, 4-bit, or 8-bit)

Description of the
effect of specific bit
settings

Bit identifier used
for bit addressing

Figure 4–1. Register Description Format

BMOD — Basic Timer Mode Register   F85H

Bit	3	2	1	0
Identifier	**.3**	**.2**	**.1**	**.0**
RESET **Value**	0	0	0	0
Read/Write	W	W	W	W
Bit Addressing	1/4	4	4	4

BMOD.3   **Basic Timer Restart Bit**

1	Restart basic timer, then clear IRQB flag, BCNT and BMOD.3 to logic zero

BMOD.2 – .0   **Input Clock Frequency and Signal Stabilization Interval Control Bits**

0	0	0	Input clock frequency: Signal stabilization interval:	$fx / 2^{12}$ (1.02 kHz) $2^{20} / fx$ (250 ms)
0	1	1	Input clock frequency: Signal stabilization interval:	$fx / 2^{9}$ (8.18 kHz) $2^{17} / fx$ (31.3 ms)
1	0	1	Input clock frequency: Signal stabilization interval:	$fx / 2^{7}$ (32.7 kHz) $2^{15} / fx$ (7.82 ms)
1	1	1	Input clock frequency: Signal stabilization interval:	$fx / 2^{5}$ (131 kHz) $2^{13} / fx$ (1.95 ms)

NOTES:
1. Signal stabilization interval is the time required to stabilize clock signal oscillation after stop mode is terminated by an interrupt.
2. When a RESET occurs, the oscillation stabilization time is 31.3 ms at 4.19 MHz.
3. 'fx' is the system clock rate given a clock frequency of 4.19 MHz.

CMOD — Comparator Mode Register   FD7H, FD6H

Bit	7	6	5	4	3	2	1	0
Identifier	**.7**	**.6**	**.5**	**"0"**	**.3**	**.2**	**.1**	**.0**
RESET Value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Bit Addressing	8	8	8	8	8	8	8	8

CMOD.7   **Comparator Enable/Disable Bit**

1	Comparator operation enable
0	Comparator operation disable

CMOD.5   **External/Internal Reference Selection Bit**

1	External reference at CIN3, CIN0–2: analog input
0	Internal reference, CIN0–3: analog input

CMOD.6   **Conversion Time Control Bit**

1	4×2^4 / fx, 15.2 µs @4.19 MHz
0	4×2^7 / fx, 121.6 µs @4.19 MHz

CMOD.4   **Bit 4**

0	Always logic zero

CMOD.3 – .0   **Reference Voltage Selection Bits**

Selected V_{REF}
$V_{DD} \times \dfrac{(n + 0.5)}{16}$, n = 0 to 15

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CLMOD — Clock Output Mode Register   FD0H

Bit	3	2	1	0
Identifier	**.3**	**"0"**	**.1**	**.0**
RESET **Value**	0	0	0	0
Read/Write	W	W	W	W
Bit Addressing	4	4	4	4

CLMOD.3   **Enable/Disable Clock Output Control Bit**

0	Disable clock output
1	Enable clock output

CLMOD.2   **Bit 2**

0	Always logic zero

CLMOD.1 – .0   **Clock Source and Frequency Selection Control Bits**

0	0	Select CPU clock source fx/4, fx/8, or fx/64 (1.05 MHz, 524 kHz, or 65.6 kHz)
0	1	Select system clock fx/8 (524 kHz)
1	0	Select system clock fx/16 (262 kHz)
1	1	Select system clock fx/64 (65.5 kHz)

NOTE: fx' is the system clock given a clock frequency of 4.19 MHz.

IE0, 1, IRQ0, 1 — INT0, 1 Interrupt Enable/Request Flags   FBEH

Bit	3	2	1	0
Identifier	IE1	IRQ1	IE0	IRQ0
RESET Value	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W
Bit Addressing	1/4	1/4	1/4	1/4

IE1   **INT1 Interrupt Enable Flag**

0	Disable interrupt requests at the INT1 pin
1	Enable interrupt requests at the INT1 pin

IRQ1   **INT1 Interrupt Request Flag**

–	Generate INT1 interrupt (bit is set and cleared by hardware when rising or falling edge detected at INT1 pin.)

IE0   **INT0 Interrupt Enable Flag**

0	Disable interrupt requests at the INT0 pin
1	Enable interrupt requests at the INT0 pin

IRQ0   **INT0 Interrupt Request Flag**

–	Generate INT0 interrupt (bit is set and cleared by hardware when rising or falling edge detected at INT0 pin.)

IEK, IRQK — Key Interrupt Enable/Request Register   FBFH

Bit	3	2	1	0
Identifier	**0**	**0**	**IEK**	**IRQK**
RESET Value	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W
Bit Addressing	1/4	1/4	1/4	1/4

.3 – .2   **Bits 3–2**

0	Always logic zero

IEK   **Key Interrupt Request Enable Flag**

0	Disable INTK interrupt requests at the KS0–KS2 pins
1	Enable INTK interrupt requests at the KS0–KS2 pin

IRQK   **Key Interrupt Request Flag**

–	Generate INTK interrupt. (This bit is set when falling edge detected any at one of the KS0–KS2 pins. INTK is a quasi-interrupt and IRQK must be cleared by software.)

IEB, IRQB — INTB Interrupt Enable/Request Flags   **FB8H**

Bit	3	2	1	0
Identifier	**0**	**0**	**IEB**	**IRQB**
RESET Value	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W
Bit Addressing	1/4	1/4	1/4	1/4

.3 – .2   **Bits 3–2**

0	Always logic zero

IEB   **INTB Interrupt Enable Flag**

0	Disable INTB interrupt requests
1	Enable INTB interrupt requests

IRQB   **INTB Interrupt Request Flag**

–	Generate INTB interrupt (bit is set and cleared automatically by hardware when reference interval signal received from basic timer.)

IES, IRQS — INTS Interrupt Enable/Request Flags   FBDH

Bit	3	2	1	0
Identifier	**0**	**0**	**IES**	**IRQS**
RESET Value	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W
Bit Addressing	1/4	1/4	1/4	1/4

.3 – .2   **Bits 3–2**

0	Always logic zero

IES   **INTS Interrupt Enable Flag**

0	Disable INTS interrupt requests
1	Enable INTS interrupt requests

IRQS   **INTS Interrupt Request Flag**

–	Generate INTS interrupt (bit is set and cleared automatically by hardware when transmit or receive operation is completed.)

IET0, IRQT0 — INTT0 Interrupt Enable/Request Flags   FBCH

Bit	3	2	1	0
Identifier	**0**	**0**	**IET0**	**IRQT0**
RESET Value	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W
Bit Addressing	1/4	1/4	1/4	1/4

.3 – .2   **Bits 3–2**

0	Always logic zero

IET0   **INTT0 Interrupt Enable Flag**

0	Disable INTT0 interrupt requests
1	Enable INTT0 interrupt requests

IRQT0   **INTT0 Interrupt Request Flag**

–	Generate INTT0 interrupt (bit is set and cleared automatically by hardware when contents of TCNT0 and TREF0 registers match.)

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IEW, IRQW — INTW Interrupt Enable/Request Flags   FBAH

Bit	3	2	1	0
Identifier	0	0	IEW	IRQW
RESET Value	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W
Bit Addressing	1/4	1/4	1/4	1/4

.3 – .2   **Bits 3–2**

0	Always logic zero

IEW   **INTW Interrupt Enable Flag**

0	Disable INTW interrupt requests
1	Enable INTW interrupt requests

IRQW   **INTW Interrupt Request Flag**

–	Generate INTW interrupt (bit is set when timer interval = 0.5 s or 3.19 ms)

NOTE: INTW is a quasi-interrupt and its request flag must be cleared by software.

IMOD0 — External Interrupt 0 (INT0) Mode Register FB4H

Bit	3	2	1	0
Identifier	**.3**	**"0"**	**.1**	**.0**
RESET Value	0	0	0	0
Read/Write	W	W	W	W
Bit Addressing	4	4	4	4

IMOD0.3 **Interrupt Sampling Clock Selection Bit**

0	Select CPU clock as a sampling clock
1	Select sampling clock frequency of the system clock (fx)/64

IMOD0.2 **Bit 2**

0	Always logic zero

IMOD0.1 – .0 **External Interrupt Mode Control Bits**

0	0	Interrupt requests are triggered by a rising signal edge
0	1	Interrupt requests are triggered by a falling signal edge
1	0	Interrupt requests are triggered by both rising and falling signal edges
1	1	Interrupt request flag (IRQ0) cannot be set to logic one

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IMOD1 — External Interrupt 1 (INT1) Mode Register   FB5H

Bit	3	2	1	0
Identifier	"0"	"0"	"0"	.0
RESET Value	0	0	0	0
Read/Write	W	W	W	W
Bit Addressing	4	4	4	4

IMOD1.3 – .1   **Bits 3–1**

0	Always logic zero

IMOD1.0   **External Interrupt 1 Edge Detection Control Bit**

0	Rising edge detection
1	Falling edge detection

IMODK — Key Interrupt Mode Register   FB6H

Bit	3	2	1	0
Identifier	"0"	.2	.1	.0
RESET Value	0	0	0	0
Read/Write	W	W	W	W
Bit Addressing	4	4	4	4

IMODK.3   **Bits 3**

0	Always logic zero

IMODK.2 – .0   **Key Interrupt Edge Detection Selection Bit**

0	0	0	Interrupt request is disabled
0	0	1	Interrupt request at KS0 triggered by falling edge
0	1	0	Interrupt request at KS1 triggered by falling edge
0	1	1	Interrupt request at KS0–KS1 triggered by falling edge
1	0	0	Interrupt request at KS2 triggered by falling edge
1	0	1	Interrupt request at KS0, KS2 triggered by falling edge
1	1	0	Interrupt request at KS1.–KS2 triggered by falling edge
1	1	1	Interrupt request at KS0–KS2 triggered by falling edge

IPR — Interrupt Priority Register   FB2H

Bit	3	2	1	0
Identifier	**IME**	**.2**	**.1**	**.0**
RESET Value	0	0	0	0
Read/Write	W	W	W	W
Bit Addressing	1/4	4	4	4

IME   **Interrupt Master Enable Bit**

0	Inhibit all interrupt processing
1	Enable processing for all interrupt service requests

IPR.2 – .0   **Interrupt Priority Assignment Bits**

0	0	0	Process all interrupt requests at low priority
0	0	1	Process INTB interrupt only
0	1	0	Process INT0 interrupts only
0	1	1	Process INT1 interrupts only
1	0	0	Process INTS interrupts only
1	0	1	Process INTT0 interrupts only

PCON — Clock Power Control Register   FB3H

Bit	3	2	1	0
Identifier	.3	.2	.1	.0
RESET Value	0	0	0	0
Read/Write	W	W	W	W
Bit Addressing	4	4	4	4

PCON.3 – .2   **CPU Operating Mode Control Bits**

0	0	Enable normal CPU operating mode
0	1	Initiate idle power-down mode
1	0	Initiate stop power-down mode

PCON.1 – .0   **CPU Clock Frequency Selection Bits**

0	0	Select (fx)/64
1	0	Select fx/8
1	1	Select fx/4

*   fx = system clock

PMG1 — Port I/O Mode Flags (Group 1: Ports 0, 3)　　　FE9H, FE8H

Bit	7	6	5	4	3	2	1	0
Identifier	"0"	PM3.2	PM3.1	PM3.0	"0"	PM0.2	PM0.1	PM0.0
RESET Value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W
Bit Addressing	8	8	8	8	8	8	8	8

.7　　　　　　　　　　**Bit 7**

0	Always logic zero

PM3.2　　　　　　　　**P3.2 I/O Mode Selection Flag**

0	Set P3.2 to input mode
1	Set P3.2 to output mode

PM3.1　　　　　　　　**P3.1 I/O Mode Selection Flag**

0	Set P3.1 to input mode
1	Set P3.1 to output mode

PM3.0　　　　　　　　**P3.0 I/O Mode Selection Flag**

0	Set P3.0 to input mode
1	Set P3.0 to output mode

.4　　　　　　　　　　**Bit 4**

0	Always logic zero

PM0.2　　　　　　　　**P0.2 I/O Mode Selection Flag**

0	Set P0.2 to input mode
1	Set P0.2 to output mode

PM0.1　　　　　　　　**P0.1 I/O Mode Selection Flag**

0	Set P0.1 to input mode
1	Set P0.1 to output mode

PM0.0　　　　　　　　**P0.0 I/O Mode Selection Flag**

0	Set P0.0 to input mode
1	Set P0.0 to output mode

PMG2 — Port I/O Mode Flags (Group 2: Port 4)   FEBH, FEAH

Bit	7	6	5	4	3	2	1	0
Identifier	"0"	"0"	"0"	"0"	PM4.3	PM4.2	PM4.1	PM4.0
RESET Value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W
Bit Addressing	8	8	8	8	8	8	8	8

.7   **Bit 7**

0	Always logic zero

.6   **Bit 6**

0	Always logic zero

.5   **Bit 5**

0	Always logic zero

.4   **Bit 4**

0	Always logic zero

PM4.3   **P4.3 I/O Mode Selection Flag**

0	Set P4.3 to input mode
1	Set P4.3 to output mode

PM4.2   **P4.2 I/O Mode Selection Flag**

0	Set P4.2 to input mode
1	Set P4.2 to output mode

PM4.1   **P4.1 I/O Mode Selection Flag**

0	Set P4.1 to input mode
1	Set P4.1 to output mode

PM4.0   **P4.0 I/O Mode Selection Flag**

0	Set P4.0 to input mode
1	Set P4.0 to output mode

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PMG3 — Port I/O Mode Flags (Group 3: Port 5, 6)   FEDH, FECH

Bit	7	6	5	4	3	2	1	0
Identifier	PM6.3	PM6.2	PM6.1	PM6.0	PM5.3	PM5.2	PM5.1	PM5.0
RESET Value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W
Bit Addressing	8	8	8	8	8	8	8	8

PM6.3   **P6.3 I/O Mode Selection Flag**

0	Set P6.3 to input mode
1	Set P6.3 to output mode

PM6.2   **P6.2 I/O Mode Selection Flag**

0	Set P6.2 to input mode
1	Set P6.2 to output mode

PM6.1   **P6.1 I/O Mode Selection Flag**

0	Set P6.1 to input mode
1	Set P6.1 to output mode

PM6.0   **P6.0 I/O Mode Selection Flag**

0	Set P6.0 to input mode
1	Set P6.0 to output mode

PM5.3   **P5.3 I/O Mode Selection Flag**

0	Set P5.3 to input mode
1	Set P5.3 to output mode

PM5.2   **P5.2 I/O Mode Selection Flag**

0	Set P5.2 to input mode
1	Set P5.2 to output mode

PM5.1   **P5.1 I/O Mode Selection Flag**

0	Set P5.1 to input mode
1	Set P5.1 to output mode

PM5.0   **P5.0 I/O Mode Selection Flag**

0	Set P5.0 to input mode
1	Set P5.0 to output mode

PNE — N-channel Open-drain Enable Register   FDAH

Bit	7	6	5	4	3	2	1	0
Identifier	PNE5.3	PNE5.2	PNE5.1	PNE5.0	PNE4.3	PNE4.2	PNE4.1	PNE4.0
RESET Value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W
Bit Addressing	8	8	8	8	8	8	8	8

.7   **P5.3 N-channel Open-drain Enable Bit**

0	Set P5.3 Open-drain Disabled
1	Set P5.3 Open-drain Enabled

.6   **P5.2 N-channel Open-drain Enable Bit**

0	Set P5.2 Open-drain Disabled
1	Set P5.2 Open-drain Enabled

.5   **P5.1 N-channel Open-drain Enable Bit**

0	Set P5.1 Open-drain Disabled
1	Set P5.1 Open-drain Enabled

.4   **P5.0 N-channel Open-drain Enable Bit**

0	Set P5.0 Open-drain Disabled
1	Set P5.0 Open-drain Enabled

.3   **P4.3 N-channel Open-drain Enable Bit**

0	Set P4.3 Open-drain Disabled
1	Set P4.3 Open-drain Enabled

.2   **P4.2 N-channel Open-drain Enable Bit**

0	Set P4.2 Open-drain Disabled
1	Set P4.2 Open-drain Enabled

.1   **P4.1 N-channel Open-drain Enable Bit**

0	Set P4.1 Open-drain Disabled
1	Set P4.1 Open-drain Enabled

.0   **P4.0 N-channel Open-drain Enable Bit**

0	Set P4.0 Open-drain Disabled
1	Set P4.0 Open-drain Enabled

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PSW — Program Status Word   FB1H, FB0H

Bit	7	6	5	4	3	2	1	0
Identifier	C	SC2	SC1	SC0	IS1	IS0	EMB	ERB
RESET Value	(NOTE 1)	0	0	0	0	0	0	0
Read/Write	R/W	R	R	R	R/W	R/W	R/W	R/W
Bit Addressing	(NOTE 2)	8	8	8	1/4	1/4	1	1

C   **Carry Flag**

0	No overflow or borrow condition exists
1	An overflow or borrow condition does exist

SC2 – SC0   **Skip Condition Flags**

0	No skip condition exists; no direct manipulation of these bits is allowed
1	A skip condition exists; no direct manipulation of these bits is allowed

IS1, IS0   **Interrupt Status Flags**

0	0	Service all interrupt requests
0	1	Service only the high-priority interrupt(s) as determined in the interrupt priority register (IPR)
1	0	Do not service any more interrupt requests
1	1	Undefined

EMB   **Enable Data Memory Bank Flag**

0	Restrict program access to data memory to bank 15 (F80H–FFFH) and to the locations 000H–07FH in the bank 0 only
1	Enable full access to data memory banks 0, 1, and 15

ERB   **Enable Register Bank Flag**

0	Select register bank 0 as working register area
1	Select register banks 0, 1, 2, or 3 as working register area in accordance with the select register bank (SRB) instruction operand

NOTES:
1. The value of the carry flag after a RESET occurs during normal operation is undefined. If a RESET occurs during power-down mode (IDLE or STOP), the current value of the carry flag is retained.
2. The carry flag can only be addressed by a specific set of 1-bit manipulation instructions. See Section 2 for detailed information.

P2MOD — **Port 2 Mode Register** **FE2H**

Bit	3	2	1	0
Identifier	.3	.2	.1	.0
RESET Value	0	0	0	0
Read/Write	W	W	W	W
Bit Addressing	4	4	4	4

P2MOD.3 **P2.3 Analog/digital Selection Bit**

0	Configure P2.3 as an analog input pin
1	Configure P2.3 as an digital input pin

P2MOD.2 **P2.2 Analog/digital Selection Bit**

0	Configure P2.2 as an analog input pin
1	Configure P2.2 as an digital input pin

P2MOD.1 **P2.1 Analog/digital Selection Bit**

0	Configure P2.1 as an analog input pin
1	Configure P2.1 as an digital input pin

P2MOD.0 **P2.0 Analog/digital Selection Bit**

0	Configure P2.0 as an analog input pin
1	Configure P2.0 as an digital input pin

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PUMOD — Pull-Up Register Mode Register

FDCH, FDDH

Bit	7	6	5	4	3	2	1	0
Identifier	"0"	.6	.5	.4	.3	"0"	.1	.0
RESET Value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W
Bit Addressing	8	8	8	8	8	8	8	8

.7 **Bit 7**

0	Always cleared to logic zero

.6 **Connect/Disconnect Port 6 Pull-Up Resistor Control Bit**

0	Disconnect port 6 pull-up resistor
1	Connect port 6 pull-up resistor

.5 **Connect/Disconnect Port 5 Pull-Up Resistor Control Bit**

0	Disconnect port 5 pull-up resistor
1	Connect port 5 pull-up resistor

.4 **Connect/Disconnect Port 4 Pull-Up Resistor Control Bit**

0	Disconnect port 4 pull-up resistor
1	Connect port 4 pull-up resistor

.3 **Connect/Disconnect Port 3 Pull-Up Resistor Control Bit**

0	Disconnect port 3 pull-up resistor
1	Connect port 3 pull-up resistor

.2 **Bit 2**

0	Always cleared to logic zero

.1 **Connect/Disconnect Port 1 Pull-Up Resistor Control Bit**

0	Disconnect port 1 pull-up resistor
1	Connect port 1 pull-up resistor

.0 **Connect/Disconnect Port 0 Pull-Up Resistor Control Bit**

0	Disconnect port 0 pull-up resistor
1	Connect port 0 pull-up resistor

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SMOD — Serial I/O Mode Register   FE1H, FE0H

Bit	7	6	5	4	3	2	1	0
Identifier	.7	.6	.5	"0"	.3	.2	.1	.0
RESET Value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	R/W	W	W	W
Bit Addressing	8	8	8	8	1	8	8	8

SMOD.7 – .5   **Serial I/O Clock Selection and SBUF R/W Status Control Bits**

0	0	0	Use an external clock at the SCK pin; Enable SBUF when SIO operation is halted or when SCK goes high
0	0	1	Use the TOL0 clock from timer/counter 0; Enable SBUF when SIO operation is halted or when SCK goes high
0	1	x	Use the selected CPU clock (fx/4, 8, or 64; 'fx' is the system clock) then, enable SBUF read/write operation. 'x' means 'don't care.'
1	0	0	4.09 kHz clock ($fx/2^{10}$)
1	1	1	262 kHz clock ($fx/2^4$); Note: You cannot select a $fx/2^4$ clock frequency if you have selected a CPU clock of fx/64

NOTE: All kHz frequency ratings assume a system clock of 4.19 MHz.

SMOD.4   **Bit 4**

0	Always logic zero

SMOD.3   **Initiate Serial I/O Operation Bit**

1	Clear IRQS flag and 3-bit clock counter to logic zero; then initiate serial transmission. When SIO transmission starts, this bit is cleared by hardware to logic zero

SMOD.2   **Enable/Disable SIO Data Shifter and Clock Counter Bit**

0	Disable the data shifter and clock counter; retain contents of IRQS flag when serial transmission is completed
1	Enable the data shifter and clock counter; The IRQS flag is set to logic one when serial transmission is completed

SMOD.1   **Serial I/O Transmission Mode Selection Bit**

0	Receive-only mode
1	Transmit-and-receive mode

SMOD.0   **LSB/MSB Transmission Mode Selection Bit**

0	Transmit the most significant bit (MSB) first
1	Transmit the least significant bit (LSB) first

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TMOD0 — Timer/Counter 0 Mode Register   F91H, F90H

Bit	3	2	1	0	3	2	1	0
Identifier	"0"	.6	.5	.4	.3	.2	"0"	"0"
RESET Value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W
Bit Addressing	8	8	8	8	1	8	8	8

.7   **Bit 7**

0	Always logic zero

.6 – .4   **Timer/Counter 0 Input Clock Selection Bits**

0	0	0	External clock input at TCL0 pin on rising edge
0	0	1	External clock input at TCL0 pin on falling edge
1	0	0	Internal system clock (fx) of 4.19 MHz / 2^{10} (4.09 kHz)
1	0	1	Selected clock: $fx/2^6$ (65.5 kHz)
1	1	0	Selected clock: $fx/2^4$ (262 kHz)
1	1	1	Selected clock: fx (4.19 MHz)

.3   **Clear Counter and Resume Counting Control Bit**

1	Clear TCNT0, IRQT0, and TOL0 and resume counting immediately. (This bit is cleared automatically when counting starts.)

.2   **Enable/Disable Timer/Counter 0 Bit**

0	Disable timer/counter 0; retain TCNT0 contents
1	Enable timer/counter 0

.1   **Bit 1**

0	Always logic zero

.0   **Bit 0**

0	Always logic zero

NOTE: System clock frequency (fx) is assumed to be 4.19 MHz.

TOE0 — Timer Output Enable Flag   F92H

Bit	3	2	1	0
Identifier	**0**	**TOE0**	**0**	**0**
RESET Value	0	0	0	0
Read/Write	R/W	R/W	R/W	W
Bit Addressing	1/4	1/4	1/4	1/4

.3   **Bit 3**

0	Always logic zero

TOE0   **Timer/Counter 0 Output Enable Flag**

0	Disable timer/counter 0 output to the TCLO0 pin
1	Enable timer/counter 0 output to the TCLO0 pin

.1   **Bit 1**

0	Always logic zero

.0   **Bit 0**

0	Always logic zero

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WDMOD — Watch-Dog Timer Mode Register   F98H, F99H

Bit	7	6	5	4	3	2	1	0
Identifier	.7	.6	.5	.4	.3	.2	.1	.0
RESET Value	1	0	1	0	0	1	0	1
Read/Write	W	W	W	W	W	W	W	W
Bit Addressing	8	8	8	8	8	8	8	8

.7 - .0   **Watch-Dog Timer Enable/Disable Control**

5AH	Disable watch-dog timer function
Any other value	Enable watch-dog timer function

WDTCF — Watch-Dog Timer Flag   F9AH

Bit	3	2	1	0
Identifier	WDTCF	"0"	"0"	"0"
RESET Value	0	0	0	0
Read/Write	W	—	—	—
Bit Addressing	1	—	—	—

.3   **Watch-dog timer's counter clear bit**

1	Clear and restart the watch-dog timer's counter

NOTE: Instruction that clear the watch-dog timer ("BITS WDTCF") should be executed at proper points in a program within a given period. If not executed within a given period and watch-dog timer overflows, RESET signal is generated and system is restarted with reset status.

WMOD — Watch Timer Mode Register   F89H, F88H

Bit	7	6	5	4	3	2	1	0
Identifier	**.7**	**"0"**	**.5**	**.4**	**"0"**	**.2**	**.1**	**"0"**
RESET Value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	R	W	W	W
Bit Addressing	8	8	8	8	1	8	8	8

WMOD.7   **Enable/Disable Buzzer Output Bit**

0	Disable buzzer (BUZ) signal output
1	Enable buzzer (BUZ) signal output

WMOD.6   **Bit 6**

0	Always logic zero

WMOD.5 – .4   **Output Buzzer Frequency Selection Bits**

0	0	2 kHz buzzer (BUZ) signal output
0	1	4 kHz buzzer (BUZ) signal output
1	0	8 kHz buzzer (BUZ) signal output
1	1	16 kHz buzzer (BUZ) signal output

WMOD.3   **Bit 3**

0	Always logic zero

WMOD.2   **Enable/Disable Watch Timer Bit**

0	Disable watch timer and clear frequency dividing circuits
1	Enable watch timer

WMOD.1   **Watch Timer Speed Control Bit**

0	Normal speed; set IRQW to 0.5 seconds
1	High-speed operation; set IRQW to 3.91 ms

WMOD.0   **Bit 0**

0	Always logic zero (must be set to zero)

5 SAM47 INSTRUCTION SET

OVERVIEW

The KS57 instruction set includes 1-bit, 4-bit, and 8-bit instructions for data manipulation, logical and arithmetic operations, program control, and CPU control. I/O instructions for peripheral hardware devices are flexible and easy to use. You can substitute symbolic hardware names as the instruction operand in place of the actual address. Other important features of the KS57 instruction set include:

— 1-byte referencing of long instructions (REF instruction)

— Redundant instruction reduction (string effect)

— Skip feature for ADC and SBC instructions

Instruction operands conform to the operand format defined for each instruction. Several instructions have multiple operand formats.

Predefined values or labels can be used as instruction operands when addressing immediate data. Many of the symbols for specific registers and flags may also be substituted as labels for operations such DA, mema, memb, b, and so on. Using instruction labels can greatly simplify program writing and debugging tasks.

INSTRUCTION SET FEATURES

In this section, the following KS57 instruction set features are described in detail:

— Instruction reference area

— Instruction redundancy reduction

— Flexible bit manipulation

— ADC and SBC instruction skip condition

Instruction Reference Area

Using the 1-byte REF (REFerence) instruction, you can reference instructions stored in addresses 0020H–007FH of program memory (the REF instruction look-up table). The location referenced by REF may contain either two 1-byte instructions or a single 2-byte instruction. The starting address of the instruction being referenced must always be an even number.

3-byte instructions such as JP or CALL may also be referenced using REF. To reference these 3-byte instructions, the 2-byte pseudo commands TJP and TCALL must be written to the reference area instead of the normal JP or CALL instruction.

The PC is not incremented when a REF instruction is executed. After it executes, the program's instruction execution sequence resumes at the address immediately following the REF instruction. By using REF instructions to execute instructions larger than one byte, as well as branches and subroutines, you can reduce the total number of program steps. To summarize, the REF instruction can be used in three ways:

— Using the 1-byte REF instruction to execute one 2-byte or two 1-byte instructions;

— Branching to any location by referencing a branch address that is stored in the look-up table;

— Calling subroutines at any location by referencing a call address that is stored in the look-up table.

Instruction Reference Area (Continued)

If necessary, a REF instruction can be circumvented by means of a skip operation prior to the REF in the execution sequence. In addition, the instruction immediately following a REF can also be skipped by using an appropriate reference instruction or instructions.

Two-byte instructions that you can reference using a REF instruction are limited to instructions with an execution time of two machine cycles. (An exception to this rule is XCH A,DA.) In addition, when you use REF to reference two 1-byte instructions stored in the reference area, you must meet specific conditions for the first and second 1-byte instruction. These combinations are described in Table 5–1.

Table 5–1. Valid 1-Byte Instruction Combinations for REF Look-Ups

First 1-Byte Instruction		Second 1-Byte Instruction	
Instruction	Operand	Instruction	Operand
LD	A,@HL	INCS	L
LD	@HL,A	DECS	L
		INCS	H
		DECS	H
		INCS	HL
LD	A,@WX	INCS	X
		DECS	X
		INCS	W
		DECS	W
		INCS	WX
LD	A,@WL	INCS	L
		DECS	L
		INCS	W
		DECS	W

NOTE: If the MSB value of the first one-byte instruction is "0", the instruction cannot be referenced by a REF instruction.

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Reducing Instruction Redundancy

When redundant instructions such as LD A,#im and LD EA,#imm are used consecutively in a program sequence, only the first instruction is executed. The redundant instructions which follow are ignored, that is, they are handled like a NOP instruction. When LD HL,#imm instructions are used consecutively, redundant instructions are also ignored.

In the following example, only the 'LD A, #im' instruction will be executed. The 8-bit load instruction which follows it is interpreted as redundant and is ignored:

```
LD        A,#im       ;       Load 4-bit immediate data (#im) to accumulator
LD        EA,#imm     ;       Load 8-bit immediate data (#imm) to extended accumulator
```

In this example, the statements 'LD A,#2H' and 'LD A,#3H' are ignored:

```
BITR      EMB
LD        A,#1H       ;       Execute instruction
LD        A,#2H       ;       Ignore, redundant instruction
LD        A,#3H       ;       Ignore, redundant instruction
LD        23H,A       ;       Execute instruction, 023H ← #1H
```

If consecutive LD HL, #imm instructions (load 8-bit immediate data to the 8-bit memory pointer pair, HL) are detected, only the first LD is executed and the LDs which immediately follow are ignored. For example,

```
LD        HL,#10H     ;       HL ← 10H
LD        HL,#20H     ;       Ignore, redundant instruction
LD        A,#3H       ;       A ← 3H
LD        EA,#35H     ;       Ignore, redundant instruction
LD        @HL,A       ;       (10H) ← 3H
```

If an instruction reference with a REF instruction has a redundancy effect, the following conditions apply:

— If the instruction *preceding* the REF has a redundancy effect, this effect is cancelled and the referenced instruction is not skipped.

— If the instruction *following* the REF has a redundancy effect, the instruction following the REF is skipped.

☞ **PROGRAMMING TIP — Example of the Instruction Redundancy Effect**

```
          ORG    0020H
ABC       LD     EA,#30H     ;  Stored in REF instruction reference area
          ORG    0080H
          •
          •
          •
          LD     EA,#40H     ;  Redundancy effect is encountered
          REF    ABC         ;  No skip (EA ← #30H)
          •
          •
          •
          REF    ABC         ;  EA  ← #30H
          LD     EA,#50H     ;  Skip
```

Flexible Bit Manipulation

In addition to normal bit manipulation instructions like set and clear, the KS57 instruction set can also perform bit tests, bit transfers, and bit Boolean operations. Bits can also be addressed and manipulated by special bit addressing modes. Three types of bit addressing are supported:

— mema.b

— memb.@L

—   @H+DA.b

The parameters of these bit addressing modes are described in more detail in Table 5–2.

Table 5–2. Bit Addressing Modes and Parameters

Addressing Mode	Addressable Peripherals	Address Range
mema.b	ERB, EMB, IS1, IS0, IEx, IRQx	FB0H–FBFH
	Ports 0–6	FF0H–FFFH
memb.@L	Ports 0–6 and BSC	FC0H–FFFH
@H+DA.b	All bit-manipulable peripheral hardware	All bits of the memory bank specified by EMB and SMB that are bit-manipulable

Instructions Which Have Skip Conditions

The following instructions have a skip function when an overflow or borrow occurs:

XCHI	INCS
XCHD	DECS
LDI	ADS
LDD	SBS

If there is an overflow or borrow from the result of an increment or decrement, a skip signal is generated and a skip is executed. However, the carry flag value is unaffected.

The instructions BTST, BTSF, and CPSE also generate a skip signal and execute a skip when they meet a skip condition, and the carry flag value is also unaffected.

Instructions Which Affect the Carry Flag

The only instructions which do not generate a skip signal, but which do affect the carry flag are as follows:

ADC	LDB	C,(operand)
SBC	BAND	C,(operand)
SCF	BOR	C,(operand)
RCF	BXOR	C,(operand)
CCF	RRC	
IRET		

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ADC and SBC Instruction Skip Conditions

The instructions 'ADC A,@HL' and 'SBC A,@HL' can generate a skip signal, and set or clear the carry flag, when they are executed in combination with the instruction 'ADS A,#im'.

If an 'ADS A,#im' instruction immediately follows an 'ADC A,@HL' or 'SBC A,@HL' instruction in a program sequence, the ADS instruction does not skip the instruction following ADS, even if it has a skip function. If, however, an 'ADC A,@HL' or 'SBC A,@HL' instruction is immediately followed by an 'ADS A,#im' instruction, the ADC (or SBC) skips on overflow (or if there is no borrow) to the instruction immediately following the ADS, and program execution continues. Table 5–3 contains additional information and examples of the 'ADC A,@HL' and 'SBC A,@HL' skip feature.

Table 5–3. Skip Conditions for ADC and SBC Instructions

Sample Instruction Sequences		If the result of instruction 1 is:	Then, the execution sequence is:	Reason
ADC A,@HL	1	Overflow	1, 3, 4	ADS cannot skip instruction 3, even if it has a skip function.
ADS A,#im	2			
xxx	3	No overflow	1, 2, 3, 4	
xxx	4			
SBC A,@HL	1	Borrow	1, 2, 3, 4	ADS cannot skip instruction 3, even if it has a skip function.
ADS A,#im	2			
xxx	3	No borrow	1, 3, 4	
xxx	4			

SYMBOLS AND CONVENTIONS

Table 5–4. Data Type Symbols

Symbol	Data Type
d	Immediate data
a	Address data
b	Bit data
r	Register data
f	Flag data
i	Indirect addressing data
t	memc x 0.5 immediate data

Table 5–5. Register Identifiers

Full Register Name	ID
4-bit accumulator	A
4-bit working registers	E, L, H, X, W, Z, Y
8-bit extended accumulator	EA
8-bit memory pointer	HL
8-bit working registers	WX, YZ, WL
Select register bank 'n'	SRB n
Select memory bank 'n'	SMB n
Carry flag	C
Program status word	PSW
Port 'n'	Pn
'm'-th bit of port 'n'	Pn.m
Interrupt priority register	IPR
Enable memory bank flag	EMB
Enable register bank flag	ERB

Table 5–6. Instruction Operand Notation

Symbol	Definition
DA	Direct address
@	Indirect address prefix
src	Source operand
dst	Destination operand
(R)	Contents of register R
.b	Bit location
im	4-bit immediate data (number)
imm	8-bit immediate data (number)
#	Immediate data prefix
ADR	000H–1FFFH immediate address
ADRn	'n' bit address
R	A, E, L, H, X, W, Z, Y
Ra	E, L, H, X, W, Z, Y
RR	EA, HL, WX, YZ
RRa	HL, WX, WL
RRb	HL, WX, YZ
RRc	WX, WL
mema	FB0H–FBFH, FF0H–FFFH
memb	FC0H–FFFH
memc	Code direct addressing: 0020H–007FH
SB	Select bank register (8 bits)
XOR	Logical exclusive-OR
OR	Logical OR
AND	Logical AND
[(RR)]	Contents addressed by RR

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OPCODE DEFINITIONS

Table 5–7. Opcode Definitions (Direct)

Register	r2	r1	r0
A	0	0	0
E	0	0	1
L	0	1	0
H	0	1	1
X	1	0	0
W	1	0	1
Z	1	1	0
Y	1	1	1
EA	0	0	0
HL	0	1	0
WX	1	0	0
YZ	1	1	0

r = Immediate data for register

Table 5–8. Opcode Definitions (Indirect)

Register	i2	i1	i0
@HL	1	0	1
@WX	1	1	0
@WL	1	1	1

i = Immediate data for indirect addressing

CALCULATING ADDITIONAL MACHINE CYCLES FOR SKIPS

A machine cycle is defined as one cycle of the selected CPU clock. Three different clock rates can be selected using the PCON register.

In this document, the letter 'S' is used in tables when describing the number of additional machine cycles required for an instruction to execute, given that the instruction has a skip function ('S' = skip). The addition number of machine cycles that will be required to perform the skip usually depends on the size of the instruction being skipped — whether it is a 1-byte, 2-byte, or 3-byte instruction. A skip is also done for SMB and SRB instructions.

The possible values in additional machine cycles for 'S' for the three cases in which skip conditions occur are as follows:

   Case 1: No skip   S = 0 cycles

   Case 2: Skip is 1-byte or 2-byte instruction   S = 1 cycle

Case 3:   Skip is 3-byte instruction   S = 2 cycles

Please note that REF instructions are skipped in one machine cycle.

HIGH-LEVEL SUMMARY

This section contains a high-level summary of the KS57 instruction set in table format. The tables are designed to familiarize you with the range of instructions that are available in each instruction category. You can also use these tables as a quick-reference source when writing application programs. The following general information is provided for each instruction:

— Instruction name

— Operand(s)

— Brief operation description

— Number of bytes of the instruction and operand(s)

— Number of machine cycles required to execute the instruction

The tables in this section are arranged according to the following instruction categories:

— CPU control instructions

— Program control instructions

— Data transfer instructions

— Logic instructions

— Arithmetic instructions

— Bit manipulation instructions

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Table 5–9. CPU Control Instructions — High-Level Summary

Name	Operand	Operation Description	Bytes	Cycles
SCF		Set carry flag to logic one	1	1
RCF		Reset carry flag to logic zero	1	1
CCF		Complement carry flag	1	1
EI		Enable all interrups	2	2
DI		Disable all interrupts	2	2
IDLE		Engage CPU idle mode	2	2
STOP		Engage CPU stop mode	2	2
NOP		No operation	1	1
SMB	n	Select memory bank	2	2
SRB	n	Select register bank	2	2
REF	memc	Reference code	1	3
VENTn	EMB (0,1) ERB (0,1) ADR	Load enable memory bank flag (EMB) and the enable register bank flag (ERB) and program counter to vector address, then branch to the corresponding location	2	2

Table 5–10. Program Control Instructions — High-Level Summary

Name	Operand	Operation Description	Bytes	Cycles
CPSE	R,#im	Compare and skip if register equals #im	2	2 + S
	@HL,#im	Compare and skip if indirect data memory equals #im	2	2 + S
	A,R	Compare and skip if A equals R	2	2 + S
	A,@HL	Compare and skip if A equals indirect data memory	1	1 + S
	EA,@HL	Compare and skip if EA equals indirect data memory	2	2 + S
	EA,RR	Compare and skip if EA equals RR	2	2 + S
JP	ADR14	Jump to direct address (14 bits)	3	3
JPS	ADR12	Jump direct in page (12 bits)	2	2
JR	#im	Jump to immediate address	1	2
	@WX	Branch relative to WX register	2	3
	@EA	Branch relative to EA	2	3
CALL	ADR14	Call direct in page (14 bits)	3	4
CALLS	ADR11	Call direct in page (11 bits)	2	3
RET	—	Return from subroutine	1	3
IRET	—	Return from interrupt	1	3
SRET	—	Return from subroutine and skip	1	3 + S

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Table 5–11. Data Transfer Instructions — High-Level Summary

Name	Operand	Operation Description	Bytes	Cycles
XCH	A,DA	Exchange A and direct data memory contents	2	2
	A,Ra	Exchange A and register (Ra) contents	1	1
	A,@RRa	Exchange A and indirect data memory	1	1
	EA,DA	Exchange EA and direct data memory contents	2	2
	EA,RRb	Exchange EA and register pair (RRb) contents	2	2
	EA,@HL	Exchange EA and indirect data memory contents	2	2
XCHI	A,@HL	Exchange A and indirect data memory contents; increment contents of register L and skip on carry	1	2 + S
XCHD	A,@HL	Exchange A and indirect data memory contents; decrement contents of register L and skip on carry	1	2 + S
LD	A,#im	Load 4-bit immediate data to A	1	1
	A,@RRa	Load indirect data memory contents to A	1	1
	A,DA	Load direct data memory contents to A	2	2
	A,Ra	Load register contents to A	2	2
	Ra,#im	Load 4-bit immediate data to register	2	2
	RR,#imm	Load 8-bit immediate data to register	2	2
	DA,A	Load contents of A to direct data memory	2	2
	Ra,A	Load contents of A to register	2	2
	EA,@HL	Load indirect data memory contents to EA	2	2
	EA,DA	Load direct data memory contents to EA	2	2
	EA,RRb	Load register contents to EA	2	2
	@HL,A	Load contents of A to indirect data memory	1	1
	DA,EA	Load contents of EA to data memory	2	2
	RRb,EA	Load contents of EA to register	2	2
	@HL,EA	Load contents of EA to indirect data memory	2	2
LDI	A,@HL	Load indirect data memory to A; increment register L contents and skip on carry	1	2 + S
LDD	A,@HL	Load indirect data memory contents to A; decrement register L contents and skip on carry	1	2 + S
LDC	EA,@WX	Load code byte from WX to EA	1	3
	EA,@EA	Load code byte from EA to EA	1	3
RRC	A	Rotate right through carry bit	1	1
PUSH	RR	Push register pair onto stack	1	1
	SB	Push SMB and SRB values onto stack	2	2
POP	RR	Pop to register pair from stack	1	1
	SB	Pop SMB and SRB values from stack	2	2

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Table 5–12. Logic Instructions — High-Level Summary

Name	Operand	Operation Description	Bytes	Cycles
AND	A,#im	Logical-AND A immediate data to A	2	2
	A,@HL	Logical-AND A indirect data memory to A	1	1
	EA,RR	Logical-AND register pair (RR) to EA	2	2
	RRb,EA	Logical-AND EA to register pair (RRb)	2	2
OR	A, #im	Logical-OR immediate data to A	2	2
	A, @HL	Logical-OR indirect data memory contents to A	1	1
	EA,RR	Logical-OR double register to EA	2	2
	RRb,EA	Logical-OR EA to double register	2	2
XOR	A,#im	Exclusive-OR immediate data to A	2	2
	A,@HL	Exclusive-OR indirect data memory to A	1	1
	EA,RR	Exclusive-OR register pair (RR) to EA	2	2
	RRb,EA	Exclusive-OR register pair (RRb) to EA	2	2
COM	A	Complement accumulator (A)	2	2

Table 5–13. Arithmetic Instructions — High-Level Summary

Name	Operand	Operation Description	Bytes	Cycles
ADC	A,@HL	Add indirect data memory to A with carry	1	1
	EA,RR	Add register pair (RR) to EA with carry	2	2
	RRb,EA	Add EA to register pair (RRb) with carry	2	2
ADS	A, #im	Add 4-bit immediate data to A and skip on carry	1	1 + S
	EA,#imm	Add 8-bit immediate data to EA and skip on carry	2	2 + S
	A,@HL	Add indirect data memory to A and skip on carry	1	1 + S
	EA,RR	Add register pair (RR) contents to EA and skip on carry	2	2 + S
	RRb,EA	Add EA to register pair (RRb) and skip on carry	2	2 + S
SBC	A,@HL	Subtract indirect data memory from A with carry	1	1
	EA,RR	Subtract register pair (RR) from EA with carry	2	2
	RRb,EA	Subtract EA from register pair (RRb) with carry	2	2
SBS	A,@HL	Subtract indirect data memory from A; skip on borrow	1	1 + S
	EA,RR	Subtract register pair (RR) from EA; skip on borrow	2	2 + S
	RRb,EA	Subtract EA from register pair (RRb); skip on borrow	2	2 + S
DECS	R	Decrement register (R); skip on borrow	1	1 + S
	RR	Decrement register pair (RR); skip on borrow	2	2 + S
INCS	R	Increment register (R); skip on carry	1	1 + S
	DA	Increment direct data memory; skip on carry	2	2 + S
	@HL	Increment indirect data memory; skip on carry	2	2 + S
	RRb	Increment register pair (RRb); skip on carry	1	1 + S

Table 5–14. Bit Manipulation Instructions — High-Level Summary

Name	Operand	Operation Description	Bytes	Cycles
BTST	C	Test specified bit and skip if carry flag is set	1	1 + S
	DA.b	Test specified bit and skip if memory bit is set		
	mema.b			
	memb.@L			
	@H+DA.b			
BTSF	DA.b	Test specified memory bit and skip if bit equals "0"	2	2 + S
	mema.b			
	memb.@L			
	@H+DA.b			
BTSTZ	mema.b	Test specified bit; skip and clear if memory bit is set		
	memb.@L			
	@H+DA.b			
BITS	DA.b	Set specified memory bit		
	mema.b			
	memb.@L			
	@H+DA.b			
BITR	DA.b	Clear specified memory bit to logic zero		
	mema.b			
	memb.@L			
	@H+DA.b			
BAND	C,mema.b	Logical-AND carry flag with specified memory bit	2	2
	C,memb.@L			
	C,@H+DA.b			
BOR	C,mema.b	Logical-OR carry with specified memory bit		
	C,memb.@L			
	C,@H+DA.b			
BXOR	C,mema.b	Exclusive-OR carry with specified memory bit		
	C,memb.@L			
	C,@H+DA.b			
LDB	mema.b,C	Load carry bit to a specified memory bit		
	memb.@L,C	Load carry bit to a specified indirect memory bit		
	@H+DA.b,C			
	C,mema.b	Load specified memory bit to carry bit		
	C,memb.@L	Load specified indirect memory bit to carry bit		
	C,@H+DA.b			

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BINARY CODE SUMMARY

This section contains binary code values and operation notation for each instruction in the SAM47 instruction set in an easy-to-read, tabular format. It is intended to be used as a quick-reference source for programmers who are experienced with the SAM47 instruction set. The same binary values and notation are also included in the detailed descriptions of individual instructions later in Section 5.

If you are reading this user's manual for the first time, please just scan this very detailed information briefly. Most of the general information you will need to write application programs can be found in the high-level summary tables in the previous section. The following information is provided for each instruction:

— Instruction name

— Operand(s)

— Binary values

— Operation notation

The tables in this section are arranged according to the following instruction categories:

— CPU control instructions

— Program control instructions

— Data transfer instructions

— Logic instructions

— Arithmetic instructions

— Bit manipulation instructions

Table 5–15. CPU Control Instructions — Binary Code Summary

Name	Operand	Binary Code								Operation Notation
SCF		1	1	1	0	0	1	1	1	$C \leftarrow 1$
RCF		1	1	1	0	0	1	1	0	$C \leftarrow 0$
CCF		1	1	0	1	0	1	1	0	$C \leftarrow C$
EI		1	1	1	1	1	1	1	1	$IME \leftarrow 1$
		1	0	1	1	0	0	1	0	
DI		1	1	1	1	1	1	1	0	$IME \leftarrow 0$
		1	0	1	1	0	0	1	0	
IDLE		1	1	1	1	1	1	1	1	$PCON.2 \leftarrow 1$
		1	0	1	0	0	0	1	1	
STOP		1	1	1	1	1	1	1	1	$PCON.3 \leftarrow 1$
		1	0	1	1	0	0	1	1	
NOP		1	0	1	0	0	0	0	0	No operation
SMB	n	1	1	0	1	1	1	0	1	$SMB \leftarrow n$ (n = 0, 1, 15)
		0	1	0	0	d3	d2	d1	d0	
SRB	n	1	1	0	1	1	1	0	1	$SRB \leftarrow n$ (n = 0, 1, 2, 3)
		0	1	0	1	0	0	d1	d0	
REF	memc	t7	t6	t5	t4	t3	t2	t1	t0	PC13–0 = memc7–4, memc3–0 <1
VENTn	EMB (0,1) ERB (0,1) ADR	EMB	ERB	a13	a12	a11	a10	a9	a8	ROM (2 x n) 7–6 $\leftarrow$ EMB, ERB ROM (2 x n) 5–4 $\leftarrow$ 0, PC13, PC12 ROM (2 x n) 3–0 $\leftarrow$ PC12–8 ROM (2 x n + 1) 7–0 $\leftarrow$ PC7–0 (n = 0, 1, 2, 3, 4, 5, 6, 7)
		a7	a6	a5	a4	a3	a2	a1	a0	

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Table 5–16. Program Control Instructions — Binary Code Summary

Name	Operand	Binary Code								Operation Notation
CPSE	R,#im	1	1	0	1	1	0	0	1	Skip if R = im
		d3	d2	d1	d0	0	r2	r1	r0	
	@HL,#im	1	1	0	1	1	1	0	1	Skip if (HL) = im
		0	1	1	1	d3	d2	d1	d0	
	A,R	1	1	0	1	1	1	0	1	Skip if A = R
		0	1	1	0	1	r2	r1	r0	
	A,@HL	0	0	1	1	1	0	0	0	Skip if A = (HL)
	EA,@HL	1	1	0	1	1	1	0	0	Skip if A = (HL), E = (HL+1)
		0	0	0	0	1	0	0	1	
	EA,RR	1	1	0	1	1	1	0	0	Skip if EA = RR
		1	1	1	0	1	r2	r1	0	
JP	ADR14	1	1	0	1	1	0	1	1	PC13–0 ← ADR14
		0	0	a13	a12	a11	a10	a9	a8	
		a7	a6	a5	a4	a3	a2	a1	a0	
JPS	ADR12	1	0	0	1	a11	a10	a9	a8	PC13–0 ← PC13–12 + ADR11–0
		a7	a6	a5	a4	a3	a2	a1	a0	
JR	#im *									PC13–0 ← ADR (PC–15 to PC+16)
	@WX	1	1	0	1	1	1	0	1	PC13–0 ← PC13–8 + (WX)
		0	1	1	0	0	1	0	0	
	@EA	1	1	0	1	1	1	0	1	PC13–0 ← PC13–8 + (EA)
		0	1	1	0	0	0	0	0	
CALL	ADR14	1	1	0	1	1	0	1	1	[(SP–1) (SP–2)] ← EMB, ERB
		0	1	a13	a12	a11	a10	a9	a8	[(SP–3) (SP–4)] ← PC7–0
		a7	a6	a5	a4	a3	a2	a1	a0	[(SP–5) (SP–6)] ← PC13–8
CALLS	ADR11	1	1	1	0	1	a10	a9	a8	[(SP–1) (SP–2)] ← EMB, ERB
		a7	a6	a5	a4	a3	a2	a1	a0	[(SP–3) (SP–4)] ← PC7–0 [(SP–5) (SP–6)] ← PC10–8

	First Byte								Condition
* JR #im	0	0	0	1	a3	a2	a1	a0	PC ← PC+2 to PC+16
	0	0	0	0	a3	a2	a1	a0	PC ← PC–1 to PC–15

Table 5–16. Program Control Instructions — Binary Code Summary (Continued)

Name	Operand	Binary Code								Operation Notation
RET	–	1	1	0	0	0	1	0	1	PC13–8 ← (SP + 1) (SP) PC7–0 ← (SP + 2) (SP + 3) EMB,ERB ← (SP + 5) (SP + 4) SP ← SP + 6
IRET	–	1	1	0	1	0	1	0	1	PC13–8 ← (SP + 1) (SP) PC7–0 ← (SP + 2) (SP + 3) PSW ← (SP + 4) (SP + 5) SP ← SP + 6
SRET	–	1	1	1	0	0	1	0	1	PC13–8 ← (SP + 1) (SP) PC7–0 ← (SP + 3) (SP + 2) EMB,ERB ← (SP + 5) (SP + 4) SP ← SP + 6

Table 5–17. Data Transfer Instructions — Binary Code Summary

Name	Operand	Binary Code								Operation Notation
XCH	A,DA	0	1	1	1	1	0	0	1	A ↔ DA
		a7	a6	a5	a4	a3	a2	a1	a0	
	A,Ra	0	1	1	0	1	r2	r1	r0	A ↔ Ra
	A,@RRa	0	1	1	1	1	i2	i1	i0	A ↔ (RRa)
	EA,DA	1	1	0	0	1	1	1	1	A ↔ DA,E ↔ DA + 1
		a7	a6	a5	a4	a3	a2	a1	a0	
	EA,RRb	1	1	0	1	1	1	0	0	EA ↔ RRb
		1	1	1	0	0	r2	r1	0	
	EA,@HL	1	1	0	1	1	1	0	0	A ↔ (HL), E ↔ (HL + 1)
		0	0	0	0	0	0	0	1	
XCHI	A,@HL	0	1	1	1	1	0	1	0	A ↔ (HL), then L ← L+1; skip if L = 0H
XCHD	A,@HL	0	1	1	1	1	0	1	1	A ↔ (HL), then L ← L-1; skip if L = 0FH
LD	A,#im	1	0	1	1	d3	d2	d1	d0	A ← im
	A,@RRa	1	0	0	0	1	i2	i1	i0	A ← (RRa)
	A,DA	1	0	0	0	1	1	0	0	A ← DA
		a7	a6	a5	a4	a3	a2	a1	a0	
	A,Ra	1	1	0	1	1	1	0	1	A ← Ra
		0	0	0	0	1	r2	r1	r0	

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Table 5–17. Data Transfer Instructions — Binary Code Summary (Continued)

Name	Operand	Binary Code								Operation Notation
LD	Ra,#im	1	1	0	1	1	0	0	1	Ra ← im
		d3	d2	d1	d0	1	r2	r1	r0	
	RR,#imm	1	0	0	0	0	r2	r1	1	RR ← imm
		d7	d6	d5	d4	d3	d2	d1	d0	
	DA,A	1	0	0	0	1	0	0	1	DA ← A
		a7	a6	a5	a4	a3	a2	a1	a0	
	Ra,A	1	1	0	1	1	1	0	1	Ra ← A
		0	0	0	0	0	r2	r1	r0	
	EA,@HL	1	1	0	1	1	1	0	0	A ← (HL), E ← (HL + 1)
		0	0	0	0	1	0	0	0	
	EA,DA	1	1	0	0	1	1	1	0	A ← DA, E ← DA + 1
		a7	a6	a5	a4	a3	a2	a1	a0	
	EA,RRb	1	1	0	1	1	1	0	0	EA ← RRb
		1	1	1	1	1	r2	r1	0	
	@HL,A	1	1	0	0	0	1	0	0	(HL) ← A
	DA,EA	1	1	0	0	1	1	0	1	DA ← A, DA + 1 ← E
		a7	a6	a5	a4	a3	a2	a1	a0	
	RRb,EA	1	1	0	1	1	1	0	0	RRb ← EA
		1	1	1	1	0	r2	r1	0	
	@HL,EA	1	1	0	1	1	1	0	0	(HL) ← A, (HL + 1) ← E
		0	0	0	0	0	0	0	0	
LDI	A,@HL	1	0	0	0	1	0	1	0	A ← (HL), then L ← L+1; skip if L = 0H
LDD	A,@HL	1	0	0	0	1	0	1	1	A ← (HL), then L ← L–1; skip if L = 0FH
LDC	EA,@WX	1	1	0	0	1	1	0	0	EA ← [PC13–8 + (WX)]
	EA,@EA	1	1	0	0	1	0	0	0	EA ← [PC13–8 + (EA)]
RRC	A	1	0	0	0	1	0	0	0	C ← A.0, A3 ← C A.n–1 ← A.n (n = 1, 2, 3)
PUSH	RR	0	0	1	0	1	r2	r1	1	((SP–1)) ((SP–2)) ← (RR), (SP) ← (SP)–2
	SB	1	1	0	1	1	1	0	1	((SP–1)) ← (SMB), ((SP–2)) ← (SRB), (SP) ← (SP)–2
		0	1	1	0	0	1	1	1	

Table 5–17. Data Transfer Instructions — Binary Code Summary (Concluded)

Name	Operand	Binary Code								Operation Notation
POP	RR	0	0	1	0	1	r2	r1	0	$RR_L \leftarrow (SP)$, $RR_H \leftarrow (SP + 1)$ $SP \leftarrow SP + 2$
	SB	1	1	0	1	1	1	0	1	$(SRB) \leftarrow (SP)$, $SMB \leftarrow (SP + 1)$, $SP \leftarrow SP + 2$
		0	1	1	0	0	1	1	0	

Table 5–18. Logic Instructions — Binary Code Summary

Name	Operand	Binary Code								Operation Notation
AND	A,#im	1	1	0	1	1	1	0	1	$A \leftarrow A$ AND im
		0	0	0	1	d3	d2	d1	d0	
	A,@HL	0	0	1	1	1	0	0	1	$A \leftarrow A$ AND (HL)
	EA,RR	1	1	0	1	1	1	0	0	$EA \leftarrow EA$ AND RR
		0	0	0	1	1	r2	r1	0	
	RRb,EA	1	1	0	1	1	1	0	0	$RRb \leftarrow RRb$ AND EA
		0	0	0	1	0	r2	r1	0	
OR	A, #im	1	1	0	1	1	1	0	1	$A \leftarrow A$ OR im
		0	0	1	0	d3	d2	d1	d0	
	A, @HL	0	0	1	1	1	0	1	0	$A \leftarrow A$ OR (HL)
	EA,RR	1	1	0	1	1	1	0	0	$EA \leftarrow EA$ OR RR
		0	0	1	0	1	r2	r1	0	
	RRb,EA	1	1	0	1	1	1	0	0	$RRb \leftarrow RRb$ OR EA
		0	0	1	0	0	r2	r1	0	
XOR	A,#im	1	1	0	1	1	1	0	1	$A \leftarrow A$ XOR im
		0	0	1	1	d3	d2	d1	d0	
	A,@HL	0	0	1	1	1	0	1	1	$A \leftarrow A$ XOR (HL)
	EA,RR	1	1	0	1	1	1	0	0	$EA \leftarrow EA$ XOR (RR)
		0	0	1	1	1	r2	r1	0	
	RRb,EA	1	1	0	1	1	1	0	0	$RRb \leftarrow RRb$ XOR EA
		0	0	1	1	0	r2	r1	0	
COM	A	1	1	0	1	1	1	0	1	$A \leftarrow \overline{A}$
		0	0	1	1	1	1	1	1	

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Table 5–19. Arithmetic Instructions — Binary Code Summary

Name	Operand	Binary Code								Operation Notation
ADC	A,@HL	0	0	1	1	1	1	1	0	C, A ← A + (HL) + C
	EA,RR	1	1	0	1	1	1	0	0	C, EA ← EA + RR + C
		1	0	1	0	1	r2	r1	0	
	RRb,EA	1	1	0	1	1	1	0	0	C, RRb ← RRb + EA + C
		1	0	1	0	0	r2	r1	0	
ADS	A, #im	1	0	1	0	d3	d2	d1	d0	A ← A + im; skip on carry
	EA,#imm	1	1	0	0	1	0	0	1	EA ← EA + imm; skip on carry
		d7	d6	d5	d4	d3	d2	d1	d0	
	A,@HL	0	0	1	1	1	1	1	1	A ← A + (HL); skip on carry
	EA,RR	1	1	0	1	1	1	0	0	EA ← EA + RR; skip on carry
		1	0	0	1	1	r2	r1	0	
	RRb,EA	1	1	0	1	1	1	0	0	RRb ← RRb + EA; skip on carry
		1	0	0	1	0	r2	r1	0	
SBC	A,@HL	0	0	1	1	1	1	0	0	C,A ← A − (HL) − C
	EA,RR	1	1	0	1	1	1	0	0	C, EA ← EA −RR − C
		1	1	0	0	1	r2	r1	0	
	RRb,EA	1	1	0	1	1	1	0	0	C,RRb ← RRb − EA − C
		1	1	0	0	0	r2	r1	0	
SBS	A,@HL	0	0	1	1	1	1	0	1	A ← A − (HL); skip on borrow
	EA,RR	1	1	0	1	1	1	0	0	EA ← EA − RR; skip on borrow
		1	0	1	1	1	r2	r1	0	
	RRb,EA	1	1	0	1	1	1	0	0	RRb ← RRb − EA; skip on borrow
		1	0	1	1	0	r2	r1	0	
DECS	R	0	1	0	0	1	r2	r1	r0	R ← R−1; skip on borrow
	RR	1	1	0	1	1	1	0	0	RR ← RR−1; skip on borrow
		1	1	0	1	1	r2	r1	0	
INCS	R	0	1	0	1	1	r2	r1	r0	R ← R + 1; skip on carry
	DA	1	1	0	0	1	0	1	0	DA ← DA + 1; skip on carry
		a7	a6	a5	a4	a3	a2	a1	a0	
	@HL	1	1	0	1	1	1	0	1	(HL) ← (HL) + 1; skip on carry
		0	1	1	0	0	0	1	0	
	RRb	1	0	0	0	0	r2	r1	0	RRb ← RRb + 1; skip on carry

Table 5–20. Bit Manipulation Instructions — Binary Code Summary

Name	Operand	Binary Code								Operation Notation
BTST	C	1	1	0	1	0	1	1	1	Skip if C = 1
	DA.b	1	1	b1	b0	0	0	1	1	Skip if DA.b = 1
		a7	a6	a5	a4	a3	a2	a1	a0	
	mema.b *	1	1	1	1	1	0	0	1	Skip if mema.b = 1
	memb.@L	1	1	1	1	1	0	0	1	Skip if [memb.7–2 + L.3–2]. [L.1–0] = 1
		0	1	0	0	a5	a4	a3	a2	
	@H+DA.b	1	1	1	1	1	0	0	1	Skip if [H + DA.3–0].b = 1
		0	0	b1	b0	a3	a2	a1	a0	
BTSF	DA.b	1	1	b1	b0	0	0	1	0	Skip if DA.b = 0
		a7	a6	a5	a4	a3	a2	a1	a0	
	mema.b *	1	1	1	1	1	0	0	0	Skip if mema.b = 0
	memb.@L	1	1	1	1	1	0	0	0	Skip if [memb.7–2 + L.3–2]. [L.1–0] = 0
		0	1	0	0	a5	a4	a3	a2	
	@H+DA.b	1	1	1	1	1	0	0	0	Skip if [H + DA.3–0].b = 0
		0	0	b1	b0	a3	a2	a1	a0	
BTSTZ	mema.b *	1	1	1	1	1	1	0	1	Skip if mema.b = 1 and clear
	memb.@L	1	1	1	1	1	1	0	1	Skip if [memb.7–2 + L.3–2]. [L.1–0] = 1 and clear
		0	1	0	0	a5	a4	a3	a2	
	@H+DA.b	1	1	1	1	1	1	0	1	Skip if [H + DA.3–0].b =1 and clear
		0	0	b1	b0	a3	a2	a1	a0	
BITS	DA.b	1	1	b1	b0	0	0	0	1	DA.b ← 1
		a7	a6	a5	a4	a3	a2	a1	a0	
	mema.b *	1	1	1	1	1	1	1	1	mema.b ← 1
	memb.@L	1	1	1	1	1	1	1	1	[memb.7–2 + L.3–2].b [L.1–0] ← 1
		0	1	0	0	a5	a4	a3	a2	
	@H+DA.b	1	1	1	1	1	1	1	1	[H + DA.3–0].b ← 1
		0	0	b1	b0	a3	a2	a1	a0	

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Table 5–20. Bit Manipulation Instructions — Binary Code Summary (Continued)

Name	Operand	Binary Code								Operation Notation
BITR	DA.b	1	1	b1	b0	0	0	0	0	DA.b $\leftarrow$ 0
		a7	a6	a5	a4	a3	a2	a1	a0	
	mema.b *	1	1	1	1	1	1	1	0	mema.b $\leftarrow$ 0
	memb.@L	1	1	1	1	1	1	1	0	[memb.7–2 + L3–2].[L.1–0] $\leftarrow$ 0
		0	1	0	0	a5	a4	a3	a2	
	@H+DA.b	1	1	1	1	1	1	1	0	[H + DA.3–0].b $\leftarrow$ 0
		0	0	b1	b0	a3	a2	a1	a0	
BAND	C,mema.b *	1	1	1	1	0	1	0	1	C $\leftarrow$ C AND mema.b
	C,memb.@L	1	1	1	1	0	1	0	1	C $\leftarrow$ C AND [memb.7–2 + L.3–2].[L.1–0]
		0	1	0	0	a5	a4	a3	a2	
	C,@H+DA.b	1	1	1	1	0	1	0	1	C $\leftarrow$ C AND [H + DA.3–0].b
		0	0	b1	b0	a3	a2	a1	a0	
BOR	C,mema.b *	1	1	1	1	0	1	1	0	C $\leftarrow$ C OR mema.b
	C,memb.@L	1	1	1	1	0	1	1	0	C $\leftarrow$ C OR [memb.7–2 + L.3–2].[L.1–0]
		0	1	0	0	a5	a4	a3	a2	
	C,@H+DA.b	1	1	1	1	0	1	1	0	C $\leftarrow$ C OR [H + DA.3–0].b
		0	0	b1	b0	a3	a2	a1	a0	
BXOR	C,mema.b *	1	1	1	1	0	1	1	1	C $\leftarrow$ C XOR mema.b
	C,memb.@L	1	1	1	1	0	1	1	1	C $\leftarrow$ C XOR [memb.7–2 + L.3–2].[L.1–0]
		0	1	0	0	a5	a4	a3	a2	
	C,@H+DA.b	1	1	1	1	0	1	1	1	C $\leftarrow$ C XOR [H + DA.3–0].b
		0	0	b1	b0	a3	a2	a1	a0	

	Second Byte								Bit Addresses
* mema.b	1	0	b1	b0	a3	a2	a1	a0	FB0H–FBFH
	1	1	b1	b0	a3	a2	a1	a0	FF0H–FFFH

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Table 5–20. Bit Manipulation Instructions — Binary Code Summary (Concluded)

Name	Operand	Binary Code								Operation Notation
LDB	mema.b,C *	1	1	1	1	1	1	0	0	mema.b ← C
	memb.@L,C	1	1	1	1	1	1	0	0	memb.7–2 + [L.3–2]. [L.1–0] ← C
		0	1	0	0	a5	a4	a3	a2	
	@H+DA.b,C	1	1	1	1	1	1	0	0	H + [DA.3–0].b ← (C)
		0	b2	b1	b0	a3	a2	a1	a0	
	C,mema.b *	1	1	1	1	0	1	0	0	C ← mema.b
	C,memb.@L	1	1	1	1	0	1	0	0	C ← memb.7–2 + [L.3–2] . [L.1–0]
		0	1	0	0	a5	a4	a3	a2	
	C,@H+DA.b	1	1	1	1	0	1	0	0	C ← [H + DA.3–0].b
		0	b2	b1	b0	a3	a2	a1	a0	

	Second Byte								Bit Addresses
* mema.b	1	0	b1	b0	a3	a2	a1	a0	FB0H–FBFH
	1	1	b1	b0	a3	a2	a1	a0	FF0H–FFFH

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INSTRUCTION DESCRIPTIONS

The following section contains detailed information and programming examples for each instruction of the SAM47 instruction set. Information is arranged in a consistent format to improve readability and for use as a quick-reference resource for application programmers.

If you are reading this user's manual for the first time, please just scan this very detailed information in order to acquaint yourself with the basic features of the instruction set. The information elements of the instruction description format are as follows:

—   Instruction name (mnemonic)

—   Full instruction name

—   Source/destination format of the instruction operand

—   Operation overview (from the "High-Level Summary" table)

—   Textual description of the instruction's effect

—   Binary code overview (from the "Binary Code Summary" table)

—   Programming example(s) to show how the instruction is used

ADC — Add with Carry

ADC   dst,src

Operation:

Operand	Operation Summary	Bytes	Cycles
A,@HL	Add indirect data memory to A with carry	1	1
EA,RR	Add register pair (RR) to EA with carry	2	2
RRb,EA	Add EA to register pair (RRb) with carry	2	2

Description: The source operand, along with the setting of the carry flag, is added to the destination operand and the sum is stored in the destination. The contents of the source are unaffected. If there is an overflow from the most significant bit of the result, the carry flag is set; otherwise, the carry flag is cleared.

If 'ADC A,@HL' is followed by an 'ADS A,#im' instruction in a program, ADC skips the ADS instruction if an overflow occurs. If there is no overflow, the ADS instruction is executed normally. (This condition is valid only for 'ADC A,@HL' instructions. If an overflow occurs following an 'ADS A,#im' instruction, the next instruction will <u>not</u> be skipped.)

Operand	Binary Code								Operation Notation
A,@HL	0	0	1	1	1	1	1	0	C, A ← A + (HL) + C
EA,RR	1	1	0	1	1	1	0	0	C, EA ← EA + RR + C
	1	0	1	0	1	r2	r1	0	
RRb,EA	1	1	0	1	1	1	0	0	C, RRb ← RRb + EA + C
	1	0	1	0	0	r2	r1	0	

Examples: 1.   The extended accumulator contains the value 0C3H, register pair HL the value 0AAH, and the carry flag is set to "1":

```
SCF                      ;  C ← "1"
ADC     EA,HL            ;  EA ← 0C3H + 0AAH + 1H  =  6EH, C ← "1"
JPS     XXX              ;  Jump to XXX; no skip after ADC
```

2.   If the extended accumulator contains the value 0C3H, register pair HL the value 0AAH, and the carry flag is cleared to "0":

```
RCF                      ;  C ← "0"
ADC     EA,HL            ;  EA ← 0C3H + 0AAH + 0H  =  6EH, C ← "1"
JPS     XXX              ;  Jump to XXX;  no skip after ADC
```

ADC — Add with Carry

ADC   (Continued)

Examples: 3. If ADC A,@HL is followed by an ADS A,#im, the ADC skips on carry to the instruction
                    immediately after the ADS. An ADS instruction immediately after the ADC does not skip
                even   if an overflow occurs. This function is useful for decimal adjustment operations.

a. 8 + 9 decimal addition (the contents of the address specified by the HL register is 9H):

```
RCF                         ;  C ← "0"
LD          A,#8H           ;  A ← 8H
ADS         A,#6H           ;  A ← 8H + 6H = 0EH
ADC         A,@HL           ;  A ← 7H, C ← "1"
ADS         A,#0AH          ;  Skip this instruction because C = "1" after ADC result
JPS         XXX
```

b. 3 + 4 decimal addition (the contents of the address specified by the HL register is 4H):

```
RCF                         ;  C ← "0"
LD          A,#3H           ;  A ← 3H
ADS         A,#6H           ;  A ← 3H + 6H = 9H
ADC         A,@HL           ;  A ← 9H + 4H + C(0) = 0DH
ADS         A,#0AH          ;  No skip. A ← 0DH + 0AH = 7H
                            ;  (The skip function for 'ADS  A,#im' is inhibited after an
                            ;  'ADC  A,@HL' instruction even if an overflow occurs.)
JPS         XXX
```

ADS — Add and Skip on Overflow

ADS   dst,src

Operation:

Operand	Operation Summary	Bytes	Cycles
A, #im	Add 4-bit immediate data to A and skip on overflow	1	1 + S
EA,#imm	Add 8-bit immediate data to EA and skip on overflow	2	2 + S
A,@HL	Add indirect data memory to A and skip on overflow	1	1 + S
EA,RR	Add register pair (RR) contents to EA and skip on overflow	2	2 + S
RRb,EA	Add EA to register pair (RRb) and skip on overflow	2	2 + S

Description: The source operand is added to the destination operand and the sum is stored in the destination. The contents of the source are unaffected. If there is an overflow from the most significant bit of the result, the skip signal is generated and a skip is executed, but the carry flag value is unaffected.

If 'ADS A,#im' follows an 'ADC A,@HL' instruction in a program, ADC skips the ADS instruction if an overflow occurs. If there is no overflow, the ADS instruction is executed normally. This skip condition is valid only for 'ADC A,@HL' instructions, however. If an overflow occurs following an ADS instruction, the next instruction is not skipped.

Operand	Binary Code								Operation Notation
A, #im	1	0	1	0	d3	d2	d1	d0	A ← A + im; skip on overflow
EA,#imm	1	1	0	0	1	0	0	1	EA ← EA + imm; skip on overflow
	d7	d6	d5	d4	d3	d2	d1	d0	
A,@HL	0	0	1	1	1	1	1	1	A ← A + (HL); skip on overflow
EA,RR	1	1	0	1	1	1	0	0	EA ← EA + RR; skip on overflow
	1	0	0	1	1	r2	r1	0	
RRb,EA	1	1	0	1	1	1	0	0	RRb ← RRb + EA; skip on overflow
	1	0	0	1	0	r2	r1	0	

Examples: 1.   The extended accumulator contains the value 0C3H, register pair HL the value 0AAH, and the carry flag = "0":

ADS	EA,HL	;	EA ← 0C3H + 0AAH = 6DH, C ← "0"
		;	ADS skips on overflow, but carry flag value is not affected.
JPS	XXX	;	This instruction is skipped because ADS overflowed.
JPS	YYY	;	Jump to YYY.

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ADS — Add and Skip on Overflow

ADS   (Continued)

Examples: 2.   If the extended accumulator contains the value 0C3H, register pair HL the value 12H, and
                 the carry flag = "0":

ADS   EA,HL   ;   EA ← 0C3H + 12H = 0D5H, C ← "0"
JPS   XXX   ;   Jump to XXX; no skip after ADS.

3.   If 'ADC A,@HL' is followed by an 'ADS A,#im', the ADC skips on overflow to the instruction
     immediately after the ADS. An 'ADS A,#im' instruction immediately after the 'ADC A,@HL'
     does not skip even if overflow occurs. This function is useful for decimal adjustment
     operations.

a.   8 + 9 decimal addition (the contents of the address specified by the HL register is 9H):

RCF   ;   C ← "0"
LD   A,#8H   ;   A ← 8H
ADS   A,#6H   ;   A ← 8H + 6H = 0EH
ADC   A,@HL   ;   A ← 7H, C ← "1"
ADS   A,#0AH   ;   Skip this instruction because C = "1" after ADC result.
JPS   XXX

b.   3 + 4 decimal addition (the contents of the address specified by the HL register is 4H):

RCF   ;   C ← "0"
LD   A,#3H   ;   A ← 3H
ADS   A,#6H   ;   A ← 3H + 6H = 9H
ADC   A,@HL   ;   A ← 9H + 4H + C(0) = 0DH
ADS   A,#0AH   ;   No skip. A ← 0DH + 0AH = 7H
                                  ;   (The skip function for 'ADS A,#im' is inhibited after an
                                  ;   'ADC A,@HL' instruction even if an overflow occurs.)
JPS   XXX

AND — Logical AND

AND   dst,src

Operation:

Operand	Operation Summary	Bytes	Cycles
A,#im	Logical-AND A immediate data to A	2	2
A,@HL	Logical-AND A indirect data memory to A	1	1
EA,RR	Logical-AND register pair (RR) to EA	2	2
RRb,EA	Logical-AND EA to register pair (RRb)	2	2

Description: The source operand is logically ANDed with the destination operand. The result is stored in the destination. The logical AND operation results in a "1" bit being stored whenever the corresponding bits in the two operands are both "1"; otherwise a "0" bit is stored. The contents of the source are unaffected.

Operand	Binary Code								Operation Notation
A,#im	1	1	0	1	1	1	0	1	$A \leftarrow A$ AND im
	0	0	0	1	d3	d2	d1	d0	
A,@HL	0	0	1	1	1	0	0	1	$A \leftarrow A$ AND (HL)
EA,RR	1	1	0	1	1	1	0	0	$EA \leftarrow EA$ AND RR
	0	0	0	1	1	r2	r1	0	
RRb,EA	1	1	0	1	1	1	0	0	$RRb \leftarrow RRb$ AND EA
	0	0	0	1	0	r2	r1	0	

Example: If the extended accumulator contains the value 0C3H (11000011B) and register pair HL the value 55H (01010101B), the instruction

AND   EA,HL

leaves the value 41H (01000001B) in the extended accumulator EA .

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BAND —Bit Logical AND

BAND   C,src.b

Operation:

Operand	Operation Summary	Bytes	Cycles
C,mema.b	Logical-AND carry flag with memory bit	2	2
C,memb.@L		2	2
C,@H+DA.b		2	2

Description: The specified bit of the source is logically ANDed with the carry flag bit value. If the Boolean value of the source bit is a logic zero, the carry flag is cleared to "0"; otherwise, the current carry flag setting is left unaltered. The bit value of the source operand is not affected.

Operand	Binary Code								Operation Notation
C,mema.b *	1	1	1	1	0	1	0	1	$C \leftarrow C$ AND mema.b
C,memb.@L	1	1	1	1	0	1	0	1	$C \leftarrow C$ AND [memb.7–2 + L.3–2]. [L.1–0]
	0	1	0	0	a5	a4	a3	a2	
C,@H+DA.b	1	1	1	1	0	1	0	1	$C \leftarrow C$ AND [H + DA.3–0].b
	0	0	b1	b0	a3	a2	a1	a0	

	Second Byte								Bit Addresses
* mema.b	1	0	b1	b0	a3	a2	a1	a0	FB0H–FBFH
	1	1	b1	b0	a3	a2	a1	a0	FF0H–FFFH

Examples: 1.   The following instructions set the carry flag if P1.0 (port 1.0) is equal to "1" (and assuming the carry flag is already set to "1"):

```
SMB       15                    ;  C  ←  "1"
BAND      C,P1.0                ;  If P1.0  = "1", C  ←  "1"
                                ;  If P1.0  =  "0", C  ←  "0"
```

BAND — **Bit Logical AND**

BAND   (Continued)

Examples: 2. Assume the P1 address is FF1H and the value for register L is 9H (1001B). The address
                      (memb.7–2) is 111100B; (L.3–2) is 10B. The resulting address is 11110010B or FF2H,
                      specifying P2. The bit value for the BAND instruction, (L.1–0) is 01B which specifies bit 1.
                      Therefore, P1.@L = P2.1:

```
LD      L,#9H
BAND    C,P1.@L              ;  P1.@L is specified as P2.1
                            ;  C  AND  P2.1
```

3. Register H contains the value 2H and FLAG = 20H.3. The address of H is 0010B and
    FLAG(3–0) is 0000B. The resulting address is 00100000B or 20H. The bit value for the
    BAND instruction is 3. Therefore, @H+FLAG = 20H.3:

```
FLAG    EQU   20H.3
LD      H,#2H
BAND    C,@H+FLAG           ;  C  AND  FLAG (20H.3)
```

BITR — Bit Reset

BITR   dst.b

Operation:

Operand	Operation Summary	Bytes	Cycles
DA.b	Clear specified memory bit to logic zero	2	2
mema.b		2	2
memb.@L		2	2
@H+DA.b		2	2

Description: A BITR instruction clears to logic zero (resets) the specified bit within the destination operand. No other bits in the destination are affected.

Operand				Binary	Code				Operation Notation
DA.b	1	1	b1	b0	0	0	0	0	DA.b $\leftarrow$ 0
	a7	a6	a5	a4	a3	a2	a1	a0	
mema.b *	1	1	1	1	1	1	1	0	mema.b $\leftarrow$ 0
memb.@L	1	1	1	1	1	1	1	0	[memb.7–2 + L3–2].[L.1–0] $\leftarrow$ 0
	0	1	0	0	a5	a4	a3	a2	
@H+DA.b	1	1	1	1	1	1	1	0	[H + DA.3–0].b $\leftarrow$ 0
	0	0	b1	b0	a3	a2	a1	a0	

			Second	Byte				Bit Addresses
* mema.b	1	0	b1	b0	a3	a2	a1	a0	FB0H–FBFH
	1	1	b1	b0	a3	a2	a1	a0	FF0H–FFFH

Examples:

1. Bit location 30H.2 in the RAM has a current value of logic one. The following instruction clears the third bit in RAM location 30H (bit 2) to logic zero:

      BITR   30H.2   ;   30H.2 $\leftarrow$ "0"

2. You can use BITR in the same way to manipulate a port address bit:

      BITR   P2.0   ;   P2.0 $\leftarrow$ "0"

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BITR — Bit Reset

BITR   (Continued)

Examples: 3.   Assuming that P2.2, P2.3, and P3.0–P3.3 are cleared to "0":

                 LD   L,#0AH
         BP2   BITR   P0.@L   ;   First, P0.@0AH = P2.2
                                      ;   (111100B) + 10B.10B = 0F2H.2
                 INCS   L
                 JR   BP2

         4.   If bank 0, location 0A0H.0 is cleared (and regardless of whether the EMB value is logic
              zero), BITR has the following effect:

         FLAG   EQU   0A0H.0
                 •
                 •
                 •
                 BITR   EMB
                 •
                 •
                 •
                 LD   H,#0AH
                 BITR   @H+FLAG   ;   Bank 0 (AH + 0H).0 = 0A0H.0 ← "0"

NOTE

Because the BITR instruction is used for output functions, the pin names used in the examples
above may vary for different devices in the SAM47 product family.

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BITS — Bit Set

BITS   dst.b

Operation:

Operand	Operation Summary	Bytes	Cycles
DA.b	Set specified memory bit	2	2
mema.b		2	2
memb.@L		2	2
@H+DA.b		2	2

Description: This instruction sets the specified bit within the destination without affecting any other bits in the destination. BITS can manipulate any bit that is addressable using direct or indirect addressing modes.

Operand	Binary Code								Operation Notation
DA.b	1	1	b1	b0	0	0	0	1	DA.b ← 1
	a7	a6	a5	a4	a3	a2	a1	a0	
mema.b *	1	1	1	1	1	1	1	1	mema.b ← 1
memb.@L	1	1	1	1	1	1	1	1	[memb.7–2 + L.3–2].b [L.1–0] ← 1
	0	1	0	0	a5	a4	a3	a2	
@H+DA.b	1	1	1	1	1	1	1	1	[H + DA.3–0].b ← 1
	0	0	b1	b0	a3	a2	a1	a0	

	Second Byte								Bit Addresses
* mema.b	1	0	b1	b0	a3	a2	a1	a0	FB0H–FBFH
	1	1	b1	b0	a3	a2	a1	a0	FF0H–FFFH

Examples: 1. Assuming that bit location 30H.2 in the RAM has a current value of "0", the following instruction sets the second bit of location 30H to "1".

         BITS   30H.2   ;   30H.2 ← "1"

2. You can use BITS in the same way to manipulate a port address bit:

         BITS   P2.0   ;   P2.0 ← "1"

BITS — Bit Set

BITS   (Continued)

Examples: 3.   Given that P2.2, P2.3, and P3.0–P3.3 are set to "1":

```
        LD    L,#0AH
BP2     BITS  P0.@L       ;  First, P0.@0AH  =  P2.2
                          ;  (111100B) + 10B.10B  =  0F2H.2
        INCS  L
        JR    BP2
```

4.   If bank 0, location 0A0H.0, is set to "1" and the EMB = "0", BITS has the following effect:

```
FLAG    EQU   0A0H.0
        •
        •
        •
        BITR  EMB
        •
        •
        •
        LD    H,#0AH
        BITS  @H+FLAG  ;  Bank 0 (AH + 0H).0  =  0A0H.0 ← "1"
```

NOTE

Because the BITS instruction is used for output functions, pin names used in the examples above may vary for different devices in the SAM47 product family.

BOR — Bit Logical OR

BOR C,src.b

Operation:

Operand	Operation Summary	Bytes	Cycles
C,mema.b	Logical-OR carry with specified memory bit	2	2
C,memb.@L		2	2
C,@H+DA.b		2	2

Description: The specified bit of the source is logically ORed with the carry flag bit value. The value of the source is unaffected.

Operand	Binary Code								Operation Notation
C,mema.b *	1	1	1	1	0	1	1	0	$C \leftarrow C$ OR mema.b
C,memb.@L	1	1	1	1	0	1	1	0	$C \leftarrow C$ OR [memb.7–2 + L.3–2]. [L.1–0]
	0	1	0	0	a5	a4	a3	a2	
C,@H+DA.b	1	1	1	1	0	1	1	0	$C \leftarrow C$ OR [H + DA.3–0].b
	0	0	b1	b0	a3	a2	a1	a0	

	Second Byte								Bit Addresses
* mema.b	1	0	b1	b0	a3	a2	a1	a0	FB0H–FBFH
	1	1	b1	b0	a3	a2	a1	a0	FF0H–FFFH

Examples: 1. The carry flag is logically ORed with the P1.0 value:

```
RCF              ;  C ← "0"
BOR    C,P1.0    ;  If P1.0 = "1", then C ← "1"; if P1.0 = "0", then C ← "0"
```

2. The P1 address is FF1H and register L contains the value 9H (1001B). The address (memb.7–2) is 111100B and (L.3–2) = 10B. The resulting address is 11110010B or FF2H, specifying P2. The bit value for the BOR instruction, (L.1–0) is 01B which specifies bit 1. Therefore, P1.@L = P2.1:

```
LD     L,#9H
BOR    C,P1.@L    ;  P1.@L is specified as P2.1; C  OR  P2.1
```

BOR — Bit Logical OR

BOR   (Continued)

Examples: 3.   Register H contains the value 2H and FLAG = 20H.3. The address of H is 0010B and
                 FLAG(3–0) is 0000B. The resulting address is 00100000B or 20H. The bit value for the BOR
                 instruction is 3. Therefore, @H+FLAG = 20H.3:

                 FLAG   EQU   20H.3
                          LD   H,#2H
                          BOR   C,@H+FLAG   ;   C OR FLAG (20H.3)

BTSF — Bit Test Skip on False

BTSF   dst.b

Operation:

Operand	Operation Summary	Bytes	Cycles
DA.b	Test specified memory bit and skip if bit equals "0"	2	2 + S
mema.b		2	2 + S
memb.@L		2	2 + S
@H+DA.b		2	2 + S

Description: The specified bit within the destination operand is tested. If it is a "0", the BTSF instruction skips the instruction which immediately follows it; otherwise the instruction following the BTSF is executed. The destination bit value is not affected.

Operand				Binary Code					Operation Notation
DA.b	1	1	b1	b0	0	0	1	0	Skip if DA.b = 0
	a7	a6	a5	a4	a3	a2	a1	a0	
mema.b *	1	1	1	1	1	0	0	0	Skip if mema.b = 0
memb.@L	1	1	1	1	1	0	0	0	Skip if [memb.7–2 + L.3-2]. [L.1–0] = 0
	0	1	0	0	a5	a4	a3	a2	
@H + DA.b	1	1	1	1	1	0	0	0	Skip if [H + DA.3–0].b = 0
	0	0	b1	b0	a3	a2	a1	a0	

				Second Byte					Bit Addresses
* mema.b	1	0	b1	b0	a3	a2	a1	a0	FB0H–FBFH
	1	1	b1	b0	a3	a2	a1	a0	FF0H–FFFH

Examples: 1. If RAM bit location 30H.2 is set to logic zero, the following instruction sequence will cause the program to continue execution from the instruction identifed as LABEL2:

```
BTSF   30H.2        ;   If 30H.2 = "0", then skip
RET                 ;   If 30H.2 = "1", return
JP     LABEL2
```

2. You can use BTSF in the same way to manipulate a port pin address bit:

```
BTSF   P2.0         ;   If P2.0 = "0", then skip
RET                 ;   If P2.0 = "1", then return
JP     LABEL3
```

BTSF — **Bit Test and Skip on False**

BTSF   (Continued)

Examples: 3.   P2.2, P2.3 and P3.0–P3.3 are tested:

```
        LD     L,#0AH
BP2     BTSF   P0.@L     ;  First, P0.@0AH = P2.2
                        ;  (111100B) + 10B.10B = 0F2H.2
        RET
        INCS   L
        JR     BP2
```

4.   Bank 0, location 0A0H.0, is tested and (regardless of the current EMB value) BTSF has the
     following effect:

```
FLAG    EQU    0A0H.0
        •
        •
        •
        BITR   EMB
        •
        •
        •
        LD     H,#0AH
        BTSF   @H+FLAG   ;  If bank 0 (AH + 0H).0  =  0A0H.0  = "0", then skip
        RET
        •
        •
        •
```

BTST — Bit Test and Skip on True

BTST   dst.b

Operation:

Operand	Operation Summary	Bytes	Cycles
C	Test carry bit and skip if set (= "1")	1	1 + S
DA.b	Test specified bit and skip if memory bit is set	2	2 + S
mema.b		2	2 + S
memb.@L		2	2 + S
@H+DA.b		2	2 + S

Description: The specified bit within the destination operand is tested. If it is "1", the instruction that immediately follows the BTST instruction is skipped; otherwise the instruction following the BTST instruction is executed. The destination bit value is not affected.

Operand	Binary Code								Operation Notation
C	1	1	0	1	0	1	1	1	Skip if C = 1
DA.b	1	1	b1	b0	0	0	1	1	Skip if DA.b = 1
	a7	a6	a5	a4	a3	a2	a1	a0	
mema.b *	1	1	1	1	1	0	0	1	Skip if mema.b = 1
memb.@L	1	1	1	1	1	0	0	1	Skip if [memb.7–2 + L.3–2]. [L.1–0] = 1
	0	1	0	0	a5	a4	a3	a2	
@H+DA.b	1	1	1	1	1	0	0	1	Skip if [H + DA.3–0].b = 1
	0	0	b1	b0	a3	a2	a1	a0	

	Second Byte								Bit Addresses
* mema.b	1	0	b1	b0	a3	a2	a1	a0	FB0H–FBFH
	1	1	b1	b0	a3	a2	a1	a0	FF0H–FFFH

Examples: 1. If RAM bit location 30H.2 is set to logic zero, the following instruction sequence will execute the RET instruction:

```
BTST   30H.2        ;   If 30H.2 = "1", then skip
RET                 ;   If 30H.2 = "0", return
JP     LABEL2
```

BTST — **Bit Test and Skip on True**

BTST   (Continued)

Examples: 2.   You can use BTST in the same way to manipulate a port pin address bit:

```
                BTST   P2.0        ;   If P2.0 = "1", then skip
                RET                ;   If P2.0 = "0", then return
                JP     LABEL3
```

3.   Assume that P2.2, P2.3 and P3.0–P3.3 are cleared to "0":

```
                LD     L,#0AH
BP2             BTST   P0.@L       ;   First, P0.@0AH = P2.2
                                   ;   (111100B) + 10B.10B = 0F2H.2
                RET
                INCS   L
                JR     BP2
```

4.   Bank 0, location 0A0H.0, is tested and (regardless of the current EMB value) BTST has the
     following effect:

```
FLAG    EQU    0A0H.0
        •
        •
        •
        BITR   EMB
        •
        •
        •
        LD     H,#0AH
        BTST   @H+FLAG  ;   If bank 0 (AH + 0H).0  =  0A0H.0  = "1", then skip
        RET
        •
        •
        •
```

BTSTZ — Bit Test and Skip on True; Clear Bit

BTSTZ   dst.b

Operation:

Operand	Operation Summary	Bytes	Cycles
mema.b	Test specified bit; skip and clear if memory bit is set	2	2 + S
memb.@L		2	2 + S
@H+DA.b		2	2 + S

Description: The specified bit within the destination operand is tested. If it is a "1", the instruction immediately following the BTSTZ instruction is skipped; otherwise the instruction following the BTSTZ is executed. The destination bit value is cleared.

Operand	Binary Code								Operation Notation
mema.b *	1	1	1	1	1	1	0	1	Skip if mema.b = 1 and clear
memb.@L	1	1	1	1	1	1	0	1	Skip if [memb.7–2 + L.3–2]. [L.1–0] = 1 and clear
	0	1	0	0	a5	a4	a3	a2	
@H+DA.b	1	1	1	1	1	1	0	1	Skip if [H + DA.3–0].b =1 and clear
	0	0	b1	b0	a3	a2	a1	a0	

	Second Byte								Bit Addresses
* mema.b	1	0	b1	b0	a3	a2	a1	a0	FB0H–FBFH
	1	1	b1	b0	a3	a2	a1	a0	FF0H–FFFH

Examples: 1. Port pin P2.0 is toggled by checking the P2.0 value (level):

```
        BTSTZ   P2.0        ;  If P2.0 = "1", then P2.0 ← "0" and skip
        BITS    P2.0        ;  If P2.0 = "0", then P2.0 ← "1"
        JP      LABEL3
```

2. Assume that port pins P2.2, P2.3 and P3.0–P3.3 are toggled:

```
        LD      L,#0AH
BP2     BTSTZ   P0.@L       ;  First, P0.@0AH = P2.2
                            ;  (111100B) + 10B.10B = 0F2H.2
        RET
        INCS    L
        JR      BP2
```

BTSTZ — Bit Test and Skip on True; Clear Bit

BTSTZ   (Continued)

Examples: 3.   Bank 0, location 0A0H.0, is tested and EMB = "0":

FLAG   EQU   0A0H.0
                   •
                   •
                   •
                   BITR   EMB
                   •
                   •
                   •
                   LD   H,#0AH
                   BTSTZ   @H+FLAG   ;   If bank 0 (AH + 0H).0 = 0A0H.0 = "1", clear and skip
                   BITS   @H+FLAG   ;   If 0A0H.0 = "0", then 0A0H.0 ← "1"

BXOR — Bit Exclusive OR

BXOR   C,src.b

Operation:

Operand	Operation Summary	Bytes	Cycles
C,mema.b	Exclusive-OR carry with memory bit	2	2
C,memb.@L		2	2
C,@H+DA.b		2	2

Description: The specified bit of the source is logically XORed with the carry bit value. The resultant bit is written to the carry flag. The source value is unaffected.

Operand				Binary Code					Operation Notation
C,mema.b *	1	1	1	1	0	1	1	1	C ← C XOR mema.b
C,memb.@L	1	1	1	1	0	1	1	1	C ← C XOR [memb.7–2 + L.3-2]. [L.1–0]
	0	1	0	0	a5	a4	a3	a2	
C,@H+DA.b	1	1	1	1	0	1	1	1	C ← C XOR [H + DA.3–0].b
	0	0	b1	b0	a3	a2	a1	a0	

			Second Byte						Bit Addresses
* mema.b	1	0	b1	b0	a3	a2	a1	a0	FB0H–FBFH
	1	1	b1	b0	a3	a2	a1	a0	FF0H–FFFH

Examples:

1. The carry flag is logically XORed with the P1.0 value:

    ```
    RCF                ;  C ← "0"
    BXOR    C,P1.0     ;  If P1.0 = "1", then C ← "1"; if P1.0 = "0", then C ← "0"
    ```

2. The P1 address is FF1H and register L contains the value 9H (1001B). The address (memb.7–2) is 111100B and (L.3–2) = 10B. The resulting address is 11110010B or FF2H, specifying P2. The bit value for the BXOR instruction, (L.1–0) is 01B which specifies bit 1. Therefore, P1.@L = P2.1:

    ```
    LD      L,#9H
    BXOR    C,P1.@L    ;  P1.@L is specified as P2.1; C  XOR  P2.1
    ```

BXOR — Bit Exclusive OR

BXOR   (Continued)

Examples: 3.   Register H contains the value 2H and FLAG = 20H.3. The address of H is 0010B and
                  FLAG(3–0) is 0000B. The resulting address is 00100000B or 20H. The bit value for the BOR
                  instruction is 3. Therefore, @H+FLAG = 20H.3:

```
FLAG    EQU    20H.3
        LD     H,#2H
        BXOR   C,@H+FLAG    ;      C  XOR  FLAG (20H.3)
```

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CALL — Call Procedure

CALL   dst

Operation:

Operand	Operation Summary	Bytes	Cycles
ADR14	Call direct in page (14 bits)	3	4

Description: CALL calls a subroutine located at the destination address. The instruction adds three to the program counter to generate the return address and then pushes the result onto the stack, decrementing the stack pointer by six. The EMB and ERB are also pushed to the stack. Program execution continues with the instruction at this address. The subroutine may therefore begin anywhere in the full 16-Kbyte program memory address space.

Operand	Binary Code								Operation Notation
ADR14	1	1	0	1	1	0	1	1	$[(SP-1)\ (SP-2)] \leftarrow$ EMB, ERB
	0	1	a13	a12	a11	a10	a9	a8	$[(SP-3)\ (SP-4)] \leftarrow PC7-0$
	a7	a6	a5	a4	a3	a2	a1	a0	$[(SP-5)\ (SP-6)] \leftarrow PC13-8$

Example: The stack pointer value is 00H and the label 'PLAY' is assigned to program memory location 0E3FH. Executing the instruction

CALL   PLAY

at location 0123H generates the following values:

SP   =   0FAH
0FFH   =   0H
0FEH   =   EMB, ERB
0FDH   =   2H
0FCH   =   6H
0FBH   =   0H
0FAH   =   1H
PC   =   0E3FH

Data is written to stack locations 0FFH–0FAH as follows:

0FAH	PC11 – PC8			
0FBH	0	0	PC13 – PC12	
0FCH	PC3 – PC0			
0FDH	PC7 – PC4			
0FEH	0	0	EMB	ERB
0FFH	0	0	0	0

CALLS — Call Procedure (Short)

CALLS   dst

Operation:

Operand	Operation Summary	Bytes	Cycles
ADR11	Call direct in page (11 bits)	2	3

Description: The CALLS instruction unconditionally calls a subroutine located at the indicated address. The instruction increments the PC twice to obtain the address of the following instruction. Then, it pushes the result onto the stack, decrementing the stack pointer six times. The higher bits of the PC, with the exception of the lower 11 bits, are cleared. The subroutine call must therefore be located within the 2-Kbyte block (0000H–07FFH) of program memory.

Operand	Binary Code								Operation Notation
ADR11	1	1	1	0	1	a10	a9	a8	[(SP–1) (SP–2)] ← EMB, ERB
	a7	a6	a5	a4	a3	a2	a1	a0	[(SP–3) (SP–4)] ← PC7–0 [(SP–5) (SP–6)] ← PC10–8

Example: The stack pointer value is 00H and the label 'PLAY' is assigned to program memory location 0345H. Executing the instruction

CALLS   PLAY

at location 0123H will generate the following values:

```
SP     =   0FAH
0FFH   =   0H
0FEH   =   EMB, ERB
0FDH   =   2H
0FCH   =   5H
0FBH   =   0H
0FAH   =   1H
PC     =   0345H
```

Data is written to stack locations 0FFH–0FAH as follows:

0FAH	0	PC10 – PC8	
0FBH	0	0	0	0
0FCH	PC3 – PC0		
0FDH	PC7 – PC4		
0FEH	0	0	EMB	ERB
0FFH	0	0	0	0

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CCF — Complement Carry Flag

CCF

Operation:

Operand	Operation Summary	Bytes	Cycles
—	Complement carry flag	1	1

Description: The carry flag is complemented; if C = "1" it is changed to C = "0" and vice-versa.

Operand	Binary Code								Operation Notation
—	1	1	0	1	0	1	1	0	C ← C̄

Example: If the carry flag is logic zero, the instruction

CCF

changes the value to logic one.

COM — Complement Accumulator

COM   A

Operation:

Operand	Operation Summary	Bytes	Cycles
A	Complement accumulator (A)	2	2

Description: The accumulator value is complemented; if the bit value of A is "1", it is changed to "0" and vice versa.

Operand	Binary Code								Operation Notation
A	1	1	0	1	1	1	0	1	A ← Ā
	0	0	1	1	1	1	1	1	

Example: If the accumulator contains the value 4H (0100B), the instruction

COM   A

leaves the value 0BH (1011B) in the accumulator.

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CPSE — Compare and Skip if Equal

CPSE   dst,src

Operation:

Operand	Operation Summary	Bytes	Cycles
R,#im	Compare and skip if register equals #im	2	2 + S
@HL,#im	Compare and skip if indirect data memory equals #im	2	2 + S
A,R	Compare and skip if A equals R	2	2 + S
A,@HL	Compare and skip if A equals indirect data memory	1	1 + S
EA,@HL	Compare and skip if EA equals indirect data memory	2	2 + S
EA,RR	Compare and skip if EA equals RR	2	2 + S

Description: CPSE compares the source operand (subtracts it from) the destination operand, and skips the next instruction if the values are equal. Neither operand is affected by the comparison.

Operand	Binary Code								Operation Notation
R,#im	1	1	0	1	1	0	0	1	Skip if R = im
	d3	d2	d1	d0	0	r2	r1	r0	
@HL,#im	1	1	0	1	1	1	0	1	Skip if (HL) = im
	0	1	1	1	d3	d2	d1	d0	
A,R	1	1	0	1	1	1	0	1	Skip if A = R
	0	1	1	0	1	r2	r1	r0	
A,@HL	0	0	1	1	1	0	0	0	Skip if A = (HL)
EA,@HL	1	1	0	1	1	1	0	0	Skip if A = (HL), E = (HL+1)
	0	0	0	0	1	0	0	1	
EA,RR	1	1	0	1	1	1	0	0	Skip if EA = RR
	1	1	1	0	1	r2	r1	0	

Example: The extended accumulator contains the value 34H and register pair HL contains 56H. The second instruction (RET) in the instruction sequence

CPSE   EA,HL
RET

is not skipped. That is, the subroutine returns because the result of the comparison is 'not equal.'

DECS — Decrement and Skip on Borrow

DECS   dst

Operation:

Operand	Operation Summary	Bytes	Cycles
R	Decrement register (R); skip on borrow	1	1 + S
RR	Decrement register pair (RR); skip on borrow	2	2 + S

Description: The destination is decremented by one. An original value of 00H will underflow to 0FFH. If a borrow occurs, a skip is executed. The carry flag value is unaffected.

Operand	Binary Code								Operation Notation
R	0	1	0	0	1	r2	r1	r0	R ← R–1; skip on borrow
RR	1	1	0	1	1	1	0	0	RR ← RR–1; skip on borrow
	1	1	0	1	1	r2	r1	0	

Examples: 1.   Register pair HL contains the value 7FH (01111111B). The following instruction leaves the value 7EH in register pair HL:

        DECS   HL

2.   Register A contains the value 0H. The following instruction sequence leaves the value 0FFH in register A. Because a "borrow" occurs, the 'CALL PLAY1' instruction is skipped and the 'CALL PLAY2' instruction is executed:

DECS   A   ;   "Borrow" occurs
CALL   PLAY1   ;   Skipped
CALL   PLAY2   ;   Executed

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DI — Disable Interrupts

DI

Operation:

Operand	Operation Summary	Bytes	Cycles
—	Disable all interrupts	2	2

Description: Bit 3 of the interrupt priority register IPR, IME, is cleared to logic zero, disabling all interrupts. Interrupts can still set their respective interrupt status latches, but the CPU will not directly service them.

Operand	Binary Code								Operation Notation
—	1	1	1	1	1	1	1	0	IME ← 0
	1	0	1	1	0	0	1	0	

Example: If the IME bit (bit 3 of the IPR) is logic one (e.g., all instructions are enabled), the instruction

DI

sets the IME bit to logic zero, disabling all interrupts.

EI — Enable Interrupts

EI

Operation:

Operand	Operation Summary	Bytes	Cycles
—	Enable all interrupts	2	2

Description: Bit 3 of the interrupt priority register IPR (IME) is set to logic one. This allows all interrupts to be serviced when they occur, assuming they are enabled. If an interrupt's status latch was previously enabled by an interrupt, this interrupt can also be serviced.

Operand	Binary Code								Operation Notation
—	1	1	1	1	1	1	1	1	IME ← 1
	1	0	1	1	0	0	1	0	

Example: If the IME bit (bit 3 of the IPR) is logic zero (e.g., all instructions are disabled), the instruction

EI

sets the IME bit to logic one, enabling all interrupts.

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IDLE — Idle Operation

IDLE

Operation:

Operand	Operation Summary	Bytes	Cycles
—	Engage CPU idle mode	2	2

Description: IDLE causes the CPU clock to stop while the system clock continues oscillating by setting bit 2 of the power control register (PCON). After an IDLE instruction has been executed, peripheral hardware remains operative.

In application programs, an IDLE instruction should be immediately followed by at least three NOP instructions. This ensures an adequate time interval for the clock to stabilize before the next instruction is executed.

Operand	Binary Code								Operation Notation
—	1	1	1	1	1	1	1	1	PCON.2 ← 1
	1	0	1	0	0	0	1	1	

Example: The instruction sequence

IDLE
NOP
NOP
NOP

sets bit 2 of the PCON register to logic one, stopping the CPU clock. The three NOP instructions provide the necessary timing delay for clock stabilization before the next instruction in the program sequence is executed.

INCS — Increment and Skip on Carry

INCS dst

Operation:

Operand	Operation Summary	Bytes	Cycles
R	Increment register (R); skip on carry	1	1 + S
DA	Increment direct data memory; skip on carry	2	2 + S
@HL	Increment indirect data memory; skip on carry	2	2 + S
RRb	Increment register pair (RRb); skip on carry	1	1 + S

Description: The instruction INCS increments the value of the destination operand by one. An original value of 0FH will, for example, overflow to 00H. If a carry occurs, the next instruction is skipped. The carry flag value is unaffected.

Operand	Binary Code								Operation Notation
R	0	1	0	1	1	r2	r1	r0	R ← R + 1; skip on carry
DA	1	1	0	0	1	0	1	0	DA ← DA + 1; skip on carry
	a7	a6	a5	a4	a3	a2	a1	a0	
@HL	1	1	0	1	1	1	0	1	(HL) ← (HL) + 1; skip on carry
	0	1	1	0	0	0	1	0	
RRb	1	0	0	0	0	r2	r1	0	RRb ← RRb + 1; skip on carry

Example: Register pair HL contains the value 7EH (01111110B). RAM location 7EH contains 0FH. The instruction sequence

```
INCS     @HL              ;  7EH ← "0"
INCS     HL               ;  Skip
INCS     @HL              ;  7EH ← "1"
```

leaves the register pair HL with the value 7EH and RAM location 7EH with the value 1H. Because a carry occurred, the second instruction is skipped. The carry flag value remains unchanged.

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IRET — Return from Interrupt

IRET

Operation:

Operand	Operation Summary	Bytes	Cycles
—	Return from interrupt	1	3

Description: IRET is used at the end of an interrupt service routine. It pops the PC values successively from the stack and restores them to the program counter. The stack pointer is incremented by six and the PSW, enable memory bank (EMB) bit, and enable register bank (ERB) bit are also automatically restored to their pre-interrupt values. Program execution continues from the resulting address, which is generally the instruction immediately after the point at which the interrupt request was detected. If a lower-level or same-level interrupt was pending when the IRET was executed, IRET will be executed before the pending interrupt is processed.

Because the 'a14' bit of an interrupt return address is not stored in the stack, this bit location is always interpreted as a logic zero. The start address in the ROM must for this reason be 3FFFH.

Operand	Binary Code								Operation Notation
—	1	1	0	1	0	1	0	1	PC13–8 ← (SP + 1) (SP) PC7–0 ← (SP + 2) (SP + 3) PSW ← (SP + 4) (SP + 5) SP ← SP + 6

Example: The stack pointer contains the value 0FAH. An interrupt is detected in the instruction at location 0122H. RAM locations 0FDH, 0FCH, and 0FAH contain the values 2H, 3H, and 1H, respectively. The instruction

IRET

leaves the stack pointer with the value 00H and the program returns to continue execution at location 123H.

During a return from interrupt, data is popped from the stack to the program counter. The data in stack locations 0FFH–0FAH is organized as follows:

0FAH	PC11 – PC8		
0FBH	0	0	PC13 – PC12
0FCH	PC3 – PC0		
0FDH	PC7 – PC4		
0FEH	IS1	IS0	EMB	ERB
0FFH	C	SC2	SC1	SC0

JP — Jifferentiate

JP — Jump

JP   dst

Operation:

Operand	Operation Summary	Bytes	Cycles
ADR14	Jump to direct address (14 bits)	3	3

Description: JP causes an unconditional branch to the indicated address by replacing the contents of the program counter with the address specified in the destination operand. The destination can be anywhere in the 16-Kbyte program memory address space.

Operand	Binary Code								Operation Notation
ADR14	1	1	0	1	1	0	1	1	PC13–0 ← ADR14
	0	0	a13	a12	a11	a10	a9	a8	
	a7	a6	a5	a4	a3	a2	a1	a0	

Example: The label 'SYSCON' is assigned to the instruction at program location 07FFH. The instruction

JP   SYSCON

at location 0123H loads the program counter with the value 07FFH.

JPS — Jump (Short)

JPS   dst

Operation:

Operand	Operation Summary	Bytes	Cycles
ADR12	Jump direct in page (12 bits)	2	2

Description: JPS causes an unconditional branch to the indicated address within the 4-Kbyte program memory address space. Bits 0–11 of the program counter are replaced with the directly specified address. The destination address for this jump is specified to the assembler by a label or by an actual address in program memory.

Operand	Binary Code								Operation Notation
ADR12	1	0	0	1	a11	a10	a9	a8	$PC13{-}0 \leftarrow PC13{-}12 + ADR11{-}0$
	a7	a6	a5	a4	a3	a2	a1	a0	

Example: The label 'SUB' is assigned to the instruction at program memory location 00FFH. The instruction

JPS   SUB

at location 0EABH will load the program counter with the value 00FFH. Normally, the JPS instruction jumps to the address in the block in which the instruction is located. If the first byte of the instruction code is located at address xFFEH or xFFFH, the instruction will jump to the next block. If the instruction 'JPS SUB' were located instead at program memory address 0FFEH or 0FFFH, the instruction 'JPS SUB' would load the PC with the value 10FFH, causing a program malfunction.

JR — Jump Relative (Very Short)

JR   dst

Operation:

Operand	Operation Summary	Bytes	Cycles
#im	Branch to relative immediate address	1	2
@WX	Branch relative to contents of WX register	2	3
@EA	Branch relative to contents of EA	2	3

Description: JR causes the relative address to be added to the program counter and passes control to the instruction whose address is now in the PC. The range of the relative address is current PC – 15 to current PC + 16. The destination address for this jump is specified to the assembler by a label, an actual address, or by immediate data using a plus sign (+) or a minus sign (–).

For immediate addressing, the (+) range is from 2 to 16 and the (–) range is from –1 to –15. If a 0, 1, or any other number that is outside these ranges are used, the assembler interprets it as an error.

For JR @WX and JR @EA branch relative instructions, the valid range for the relative address is 0H–0FFH. The destination address for these jumps can be specified to the assembler by a label that lies anywhere within the current 256-byte block.

Normally, the 'JR @WX' and 'JR @EA' instructions jump to the address in the page in which the instruction is located. However, if the first byte of the instruction code is located at address xxFEH or xxFFH, the instruction will jump to the next page.

Operand	Binary Code								Operation Notation
#im *									PC13–0 ← ADR (PC–15 to PC+16)
@WX	1	1	0	1	1	1	0	1	PC13–0 ← PC13–8 + (WX)
	0	1	1	0	0	1	0	0	
@EA	1	1	0	1	1	1	0	1	PC13–0 ← PC13–8 + (EA)
	0	1	1	0	0	0	0	0	

	First Byte								Condition
* JR #im	0	0	0	1	a3	a2	a1	a0	PC ← PC+2 to PC+16
	0	0	0	0	a3	a2	a1	a0	PC ← PC–1 to PC–15

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JR — Jump Relative (Very Short)

JR   (Continued)

Examples: 1. A short form for a relative jump to label 'KK' is the instruction

       JR KK

where 'KK' must be within the allowed range of current PC–15 to current PC+16. The JR
instruction has in this case the effect of an unconditional JP instruction.

2. In the following instruction sequence, if the instruction 'LD WX, #02H' were to be executed in
place of 'LD WX,#00H', the program would jump to 1002H and 'JPS BBB' would be
executed. If 'LD EA,#04H' were to be executed, the jump would be to1004H and 'JPS CCC'
would be executed.

```
ORG    1000H
JPS    AAA
JPS    BBB
JPS    CCC
JPS    DDD
LD     WX,#00H        ;  WX ← 00H
LD     EA,WX
ADS    WX,EA          ;  WX ← (WX) + (WX)
JR     @WX            ;  Current PC13–8 (10H) + WX (00H) = 1000H
                      ;  Jump to address 1000H and execute JPS AAA
```

3. Here is another example:

```
          ORG    1100H
          LD     A,#0H
          LD     A,#1H
          LD     A,#2H
          LD     A,#3H
          LD     30H,A          ;  Address 30H ← A
          JPS    YYY
XXX       LD     EA,#00H        ;  EA ← 00H
          JR     @EA            ;  Jump to address 1100H
                                ;  Address 30H ← 00H
```

If 'LD EA,#01H' were to be executed in place of 'LD EA,#00H', the program would jump to
1001H and address 30H would contain the value 1H. If 'LD EA,#02H' were to be executed,
the jump would be to 1002H and address 30H would contain the value 2H.

LD — Load

LD   dst,src

Operation:

Operand	Operation Summary	Bytes	Cycles
A,#im	Load 4-bit immediate data to A	1	1
A,@RRa	Load indirect data memory contents to A	1	1
A,DA	Load direct data memory contents to A	2	2
A,Ra	Load register contents to A	2	2
Ra,#im	Load 4-bit immediate data to register	2	2
RR,#imm	Load 8-bit immediate data to register	2	2
DA,A	Load contents of A to direct data memory	2	2
Ra,A	Load contents of A to register	2	2
EA,@HL	Load indirect data memory contents to EA	2	2
EA,DA	Load direct data memory contents to EA	2	2
EA,RRb	Load register contents to EA	2	2
@HL,A	Load contents of A to indirect data memory	1	1
DA,EA	Load contents of EA to data memory	2	2
RRb,EA	Load contents of EA to register	2	2
@HL,EA	Load contents of EA to indirect data memory	2	2

Description: The contents of the source are loaded into the destination. The source's contents are unaffected.If an instruction such as 'LD A,#im' (LD EA,#imm) or 'LD HL,#imm' is written more than two times in succession, only the first LD will be executed; the other similar instructions that immediately follow the first LD will be treated like a NOP. This is called the 'redundancy effect' (see examples below).

Operand	Binary Code								Operation Notation
A,#im	1	0	1	1	d3	d2	d1	d0	A ← im
A,@RRa	1	0	0	0	1	i2	i1	i0	A ← (RRa)
A,DA	1	0	0	0	1	1	0	0	A ← DA
	a7	a6	a5	a4	a3	a2	a1	a0	
A,Ra	1	1	0	1	1	1	0	1	A ← Ra
	0	0	0	0	1	r2	r1	r0	
Ra,#im	1	1	0	1	1	0	0	1	Ra ← im
	d3	d2	d1	d0	1	r2	r1	r0	

LD — Load

LD   (Continued)

Description:

Operand	Binary Code								Operation Notation
RR,#imm	1	0	0	0	0	r2	r1	1	RR ← imm
	d7	d6	d5	d4	d3	d2	d1	d0	
DA,A	1	0	0	0	1	0	0	1	DA ← A
	a7	a6	a5	a4	a3	a2	a1	a0	
Ra,A	1	1	0	1	1	1	0	1	Ra ← A
	0	0	0	0	0	r2	r1	r0	
EA,@HL	1	1	0	1	1	1	0	0	A ← (HL), E ← (HL + 1)
	0	0	0	0	1	0	0	0	
EA,DA	1	1	0	0	1	1	1	0	A ← DA, E ← DA + 1
	a7	a6	a5	a4	a3	a2	a1	a0	
EA,RRb	1	1	0	1	1	1	0	0	EA ← RRb
	1	1	1	1	1	r2	r1	0	
@HL,A	1	1	0	0	0	1	0	0	(HL) ← A
DA,EA	1	1	0	0	1	1	0	1	DA ← A, DA + 1 ← E
	a7	a6	a5	a4	a3	a2	a1	a0	
RRb,EA	1	1	0	1	1	1	0	0	RRb ← EA
	1	1	1	1	0	r2	r1	0	
@HL,EA	1	1	0	1	1	1	0	0	(HL) ← A, (HL + 1) ← E
	0	0	0	0	0	0	0	0	

Examples: 1.   RAM location 30H contains the value 4H. The RAM location values are 40H, 41H and 0AH, 3H respectively. The following instruction sequence leaves the value 40H in point pair HL, 0AH in the accumulator and in RAM location 40H, and 3H in register E.

```
LD      HL,#30H          ;  HL ←  30H
LD      A,@HL            ;  A ←  4H
LD      HL,#40H          ;  HL ←  40H
LD      EA,@HL           ;  A ←  0AH, E ←  3H
LD      @HL,A            ;  RAM (40H) ←  0AH
```

LD — Load

LD   (Continued)

Examples: 2. If an instruction such as LD A,#im (LD EA,#imm) or LD HL,#imm is written more than two times in succession, only the first LD is executed; the next instructions are treated as NOPs. Here are two examples of this 'redundancy effect':

```
LD      A,#1H            ;  A ← 1H
LD      EA,#2H           ;  NOP
LD      A,#3H            ;  NOP
LD      23H,A            ;  (23H) ← 1H
LD      HL,#10H          ;  HL ← 10H
LD      HL,#20H          ;  NOP
LD      A,#3H            ;  A ← 3H
LD      EA,#35           ;  NOP
LD      @HL,A            ;  (10H) ← 3H
```

The following table contains descriptions of special characteristics of the LD instruction when used in different addressing modes:

Instruction	Operation Description and Guidelines
LD A,#im	Because the 'redundancy effect' occurs with instructions like LD EA,#imm, if this instruction is used consecutively, the second and additional instructions of the same type will be treated like NOPs.
LD A,@RRa	Load the data memory contents pointed to by 8-bit RRa register pairs (HL, WX, WL) to the A register.
LD A,DA	Load direct data memory contents to the A register.
LD A,Ra	Load 4-bit register Ra (E, L, H, X, W, Z, Y) to the A register.
LD Ra,#im	Load 4-bit immediate data into the Ra register (E, L, H, X, W, Y, Z).
LD RR,#imm	Load 8-bit immediate data into the Ra register (EA, HL, WX, YZ). There is a redundancy effect if the operation addresses the HL or EA registers.
LD DA,A	Load contents of register A to direct data memory address.
LD Ra,A	Load contents of register A to 4-bit Ra register (E, L, H, X, W, Z, Y).

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LD — Load

LD   (Concluded)

Examples:

Instruction	Operation Description and Guidelines
LD EA,@HL	Load data memory contents pointed to by 8-bit register HL to the A register, and the contents of HL+1 to the E register. The contents of register L must be an even number. If the number is odd, the LSB of register L is recognized as a logic zero (an even number), and it is not replaced with the true value. For example, 'LD HL,#36H' loads immediate 36H to HL and the next instruction 'LD EA,@HL' loads the contents of 36H to register A and the contents of 37H to register E.
LD EA,DA	Load direct data memory contents of DA to the A register, and the next direct data memory contents of DA + 1 to the E register. The DA value must be an even number. If it is an odd number, the LSB of DA is recognized as a logic zero (an even number), and it is not replaced with the true value. For example, 'LD EA,37H' loads the contents of 36H to the A register and the contents of 37H to the E register.
LD EA,RRb	Load 8-bit RRb register (HL, WX, YZ) to the EA register. H, W, and Y register values are loaded into the E register, and the L, X, and Z values into the A register.
LD @HL,A	Load A register contents to data memory location pointed to by the 8-bit HL register value.
LD DA,EA	Load the A register contents to direct data memory and the E register contents to the next direct data memory location. The DA value must be an even number. If it is an odd number, the LSB of the DA value is recognized as logic zero (an even number), and is not replaced with the true value.
LD RRb,EA	Load contents of EA to the 8-bit RRb register (HL, WX, YZ). The E register is loaded into the H, W, and Y register and the A register into the L, X, and Z register.
LD @HL,EA	Load the A register to data memory location pointed to by the 8-bit HL register, and the E register contents to the next location, HL + 1. The contents of the L register must be an even number. If the number is odd, the LSB of the L register is recognized as logic zero (an even number), and is not replaced with the true value. For example, 'LD HL,#36H' loads immediate 36H to register HL; the instruction 'LD @HL,EA' loads the contents of A into address 36H and the contents of E into address 37H.

LDB — Load Bit

LDB   dst,src.b

LDB   dst.b,src

Operation:

Operand	Operation Summary	Bytes	Cycles
mema.b,C	Load carry bit to a specified memory bit	2	2
memb.@L,C	Load carry bit to a specified indirect memory bit	2	2
@H+DA.b,C		2	2
C,mema.b	Load memory bit to a specified carry bit	2	2
C,memb.@L	Load indirect memory bit to a specified carry bit	2	2
C,@H+DA.b		2	2

Description: The Boolean variable indicated by the first or second operand is copied into the location specified by the second or first operand. One of the operands must be the carry flag; the other can be any directly or indirectly addressable bit. The source is unaffected.

Operand	Binary Code								Operation Notation
mema.b,C *	1	1	1	1	1	1	0	0	mema.b ← C
memb.@L,C	1	1	1	1	1	1	0	0	memb.7–2 + [L.3–2]. [L.1–0] ← C
	0	1	0	0	a5	a4	a3	a2	
@H+DA.b,C	1	1	1	1	1	1	0	0	H + [DA.3–0].b ← (C)
	0	b2	b1	b0	a3	a2	a1	a0	
C,mema.b*	1	1	1	1	0	1	0	0	C ← mema.b
C,memb.@L	1	1	1	1	0	1	0	0	C ← memb.7–2 + [L.3–2] . [L.1–0]
	0	1	0	0	a5	a4	a3	a2	
C,@H+DA.b	1	1	1	1	0	1	0	0	C ← [H + DA.3–0].b
	0	b2	b1	b0	a3	a2	a1	a0	

	Second Byte								Bit Addresses
* mema.b	1	0	b1	b0	a3	a2	a1	a0	FB0H–FBFH
	1	1	b1	b0	a3	a2	a1	a0	FF0H–FFFH

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LDB — Load Bit

LDB (Continued)

Examples: 1. The carry flag is set and the data value at input pin P1.0 is logic zero. The following instruction clears the carry flag to logic zero.

        LDB   C,P1.0

2. The P1 address is FF1H and the L register contains the value 9H (1001B). The address (memb.7–2) is 111100B and (L.3–2) is 10B. The resulting address is 11110010B or FF2H and P2 is addressed. The bit value (L.1–0) is specified as 01B (bit 1).

        LD   L,#9H
        LDB   C,P1.@L ; P1.@L specifies P2.1 and C ← P2.1

3. The H register contains the value 2H and FLAG = 20H.3. The address for H is 0010B and for FLAG(3–0) the address is 0000B. The resulting address is 00100000B or 20H. The bit value is 3. Therefore, @H+FLAG = 20H.3.

FLAG   EQU   20H.3
        LD   H,#2H
        LDB   C,@H+FLAG ;   C ← FLAG (20H.3)

4. The following instruction sequence sets the carry flag and the loads the "1" data value to the output pin P2.0, setting it to output mode:

        SCF   ;   C ← "1"
        LDB   P2.0,C   ;   P2.0 ← "1"

5. The P1 address is FF1H and L = 9H (1001B). The address (memb.7–2) is 111100B and (L.3–2) is 10B. The resulting address, 11110010B specifies P2. The bit value (L.1–0) is specified as 01B (bit 1). Therefore, P1.@L = P2.1.

        SCF   ;   C ← "1"
        LD   L,#9H
        LDB   P1.@L,C   ;   P1.@L specifies P2.1
                         ;   P2.1 ← "1"

6. In this example, H = 2H and FLAG = 20H.3 and the address 20H is specified. Because the bit value is 3, @H+FLAG = 20H.3:

        FLAG   EQU 20H.3
        RCF   ;   C ← "0"
        LD   H,#2H
        LDB@H+FLAG,C   ;   FLAG(20H.3) ← "0"

NOTE

Port pin names used in examples 4 and 5 may vary with different SAM47 devices.

LDC — Load Code Byte

LDC   dst,src

Operation:

Operand	Operation Summary	Bytes	Cycles
EA,@WX	Load code byte from WX to EA	1	3
EA,@EA	Load code byte from EA to EA	1	3

Description: This instruction is used to load a byte from program memory into an extended accumulator. The address of the byte fetched is the five highest bit values in the program counter and the contents of an 8-bit working register (either WX or EA). The contents of the source are unaffected.

Operand	Binary Code								Operation Notation
EA,@WX	1	1	0	0	1	1	0	0	EA ← [PC13–8 + (WX)]
EA,@EA	1	1	0	0	1	0	0	0	EA ← [PC13–8 + (EA)]

Examples: 1. The following instructions will load one of four values defined by the define byte (DB) directive   to the extended accumulator:

```
            LD     EA,#00H
            CALL   DISPLAY
            JPS    MAIN
            ORG    0500H
            DB     66H
            DB     77H
            DB     88H
            DB     99H
            •
            •
            •
DISPLAY  LDC    EA,@EA      ;  EA ← address 0500H = 66H
            RET
```

If the instruction 'LD EA,#01H' is executed in place of 'LD EA,#00H', The content of 0501H (77H) is loaded to the EA register. If 'LD EA,#02H' is executed, the content of address 0502H (88H) is loaded to EA.

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LDC — Load Code Byte

LDC   (Continued)

Examples: 2.   The following instructions will load one of four values defined by the define byte (DB)
directive   to the extended accumulator:

```
                ORG    0500
                DB     66H
                DB     77H
                DB     88H
                DB     99H
                •
                •
                •
DISPLAY  LD     WX,#00H
                LDC    EA,@WX      ;  EA ← address 0500H = 66H
                RET
```

If the instruction 'LD WX,#01H' is executed in place of 'LD WX,#00H', then

EA ← address 0501H = 77H.

If the instruction 'LD WX,#02H' is executed in place of 'LD WX,#00H', then

EA ← address 0502H = 88H.

3.   Normally, the LDC EA, @EA and the LDC EA, @WX instructions reference the table data
on the page on which the instruction is located. If, however, the instruction is located at
address xxFFH, it will reference table data on the next page. In this example, the upper 4
bits of the address at location 0200H is loaded into register E and the lower 4 bits into
register A:

```
                ORG    01FDH
01FDH    LD     WX,#00H
01FFH    LDC    EA,@WX      ;  E ← upper 4 bits of 0200H address
                                      ;  A ← lower 4 bits of 0200H address
```

4.   Here is another example of page referencing with the LDC instruction:

```
                ORG    0100
                DB     67H
                SMB    0
                LD     HL,#30H     ;  Even number
                LD     WX,#00H
                LDC    EA,@WX      ;  E ← upper 4 bits of 0100H address
                                      ;  A ← lower 4 bits of 0100H address
                LD     @HL,EA      ;  RAM (30H) ← 7, RAM (31H) ← 6
```

LDD — **Load Data Memory and Decrement**

LDD   dst

Operation:

Operand	Operation Summary	Bytes	Cycles
A,@HL	Load indirect data memory contents to A; decrement register L contents and skip on borrow	1	2 + S

Description: The contents of a data memory location are loaded into the accumulator, and the contents of the register L are decremented by one. If a "borrow" occurs (e.g., if the resulting value in register L is 0FH), the next instruction is skipped. The contents of data memory and the carry flag value are not affected.

Operand	Binary Code								Operation Notation
A,@HL	1	0	0	0	1	0	1	1	A ← (HL), then L ← L–1; skip if L = 0FH

Example: In this example, assume that register pair HL contains 20H and internal RAM location 20H contains the value 0FH:

```
LD      HL,#20H
LDD     A,@HL                  ;   A ← (HL) and L ← L–1
JPS     XXX                    ;   Skip
JPS     YYY                    ;   H ← 2H and L ← 0FH
```

The instruction 'JPS XXX' is skipped because a "borrow" occurred after the 'LDD A,@HL' and instruction 'JPS YYY' is executed.

LDI — Load Data Memory and Increment

LDI   dst,src

Operation:

Operand	Operation Summary	Bytes	Cycles
A,@HL	Load indirect data memory to A; increment register L contents and skip on overflow	1	2 + S

Description: The contents of a data memory location are loaded into the accumulator, and the contents of the register L are incremented by one. If an overflow occurs (e.g., if the resulting value in register L is 0H), the next instruction is skipped. The contents of data memory and the carry flag value are not affected.

Operand			Binary Code						Operation Notation
A,@HL	1	0	0	0	1	0	1	0	A ← (HL), then L ← L+1; skip if L = 0H

Example: Assume that register pair HL contains the address 2FH and internal RAM location 2FH contains the value 0FH:

```
LD      HL,#2FH
LDI     A,@HL                ;  A ←  (HL) and L ← L+1
JPS     XXX                  ;  Skip
JPS     YYY                  ;  H ←  2H and L ← 0H
```

The instruction 'JPS XXX' is skipped because an overflow occurred after the 'LDI A,@HL' and the instruction 'JPS YYY' is executed.

NOP — No Operation

NOP

Operation:

Operand	Operation Summary	Bytes	Cycles
—	No operation	1	1

Description: No operation is performed by a NOP instruction. It is typically used for timing delays.

One NOP causes a 1-cycle delay: with a 1-µs cycle time, five NOPs would therefore cause a 5-µs delay. Program execution continues with the instruction immediately following the NOP. Only the PC is affected. At least three NOP instructions should follow a STOP or IDLE instruction.

Operand	Binary Code								Operation Notation
—	1	0	1	0	0	0	0	0	No operation

Example: Three NOP instructions follow the STOP instruction to provide a short interval for clock stabilization before power-down mode is initiated:

STOP
NOP
NOP
NOP

OR — Logical OR

OR   dst,src

Operation:

Operand	Operation Summary	Bytes	Cycles
A, #im	Logical-OR immediate data to A	2	2
A, @HL	Logical-OR indirect data memory contents to A	1	1
EA,RR	Logical-OR double register to EA	2	2
RRb,EA	Logical-OR EA to double register	2	2

Description: The source operand is logically ORed with the destination operand. The result is stored in the destination. The contents of the source are unaffected.

Operand	Binary Code								Operation Notation
A, #im	1	1	0	1	1	1	0	1	A ← A OR im
	0	0	1	0	d3	d2	d1	d0	
A, @HL	0	0	1	1	1	0	1	0	A ← A OR (HL)
EA,RR	1	1	0	1	1	1	0	0	EA ← EA OR RR
	0	0	1	0	1	r2	r1	0	
RRb,EA	1	1	0	1	1	1	0	0	RRb ← RRb OR EA
	0	0	1	0	0	r2	r1	0	

Example: If the accumulator contains the value 0C3H (11000011B) and register pair HL the value 55H (01010101B), the instruction

OR   EA,@HL

leaves the value 0D7H (11010111B) in the accumulator .

POP — Pop from Stack

POP   dst

Operation:

Operand	Operation Summary	Bytes	Cycles
RR	Pop to register pair from stack	1	1
SB	Pop SMB and SRB values from stack	2	2

Description: The contents of the RAM location addressed by the stack pointer is read, and the SP is incremented by two. The value read is then transferred to the variable indicated by the destination operand.

Operand	Binary Code								Operation Notation
RR	0	0	1	0	1	r2	r1	0	$RR_L \leftarrow (SP)$, $RR_H \leftarrow (SP+1)$ $SP \leftarrow SP+2$
SB	1	1	0	1	1	1	0	1	$(SRB) \leftarrow (SP)$, $SMB \leftarrow (SP+1)$, $SP \leftarrow SP+2$
	0	1	1	0	0	1	1	0	

Example: The SP value is equal to 0EDH, and RAM locations 0EFH through 0EDH contain the values 2H, 3H, and 4H, respectively. The instruction

POP   HL

leaves the stack pointer set to 0EFH and the data pointer pair HL set to 34H.

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PUSH — Push onto Stack

PUSH   src

Operation:

Operand	Operation Summary	Bytes	Cycles
RR	Push register pair onto stack	1	1
SB	Push SMB and SRB values onto stack	2	2

Description: The SP is then decremented by two and the contents of the source operand are copied into the RAM location addressed by the stack pointer, thereby adding a new element to the top of the stack.

Operand	Binary Code								Operation Notation
RR	0	0	1	0	1	r2	r1	1	$(SP-1) \leftarrow RR_H$, $(SP-2) \leftarrow RR_L$ $SP \leftarrow SP-2$
SB	1	1	0	1	1	1	0	1	$(SP-1) \leftarrow SMB$, $(SP-2) \leftarrow SRB$; $(SP) \leftarrow SP-2$
	0	1	1	0	0	1	1	1	

Example: As an interrupt service routine begins, the stack pointer contains the value 0FAH and the data pointer register pair HL contains the value 20H. The instruction

PUSH   HL

leaves the stack pointer set to 0F8H and stores the values 2H and 0H in RAM locations 0F9H and 0F8H, respectively.

RCF — Reset Carry Flag

RCF

Operation:

Operand	Operation Summary	Bytes	Cycles
—	Reset carry flag to logic zero	1	1

Description: The carry flag is cleared to logic zero, regardless of its previous value.

Operand	Binary Code								Operation Notation
—	1	1	1	0	0	1	1	0	$C \leftarrow 0$

Example: Assuming the carry flag is set to logic one, the instruction

RCF

resets (clears) the carry flag to logic zero.

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REF — Reference Instruction

REF   dst

Operation:

Operand	Operation Summary	Bytes	Cycles
memc	Reference code	1	3 *

* The REF instruction for a 16K CALL instruction is 4 cycles.

Description: The REF instruction is used to rewrite into 1-byte form, arbitrary 2-byte or 3-byte instructions (or two 1-byte instructions) stored in the REF instruction reference area in program memory. REF reduces the number of program memory accesses for a program.

Operand	Binary Code								Operation Notation
memc	t7	t6	t5	t4	t3	t2	t1	t0	PC13–0 = memc7–4, memc3–0 <1

TJP and TCALL are 2-byte pseudo-instructions that are used only to specify the reference area:

1. When the reference area is specified by the TJP instruction,

    memc.7–6 = 00
    P11–0 ← memc.3–0 + (memc + 1)

2. When the reference area is specified by the TCALL instruction,

    memc.7–6 = 01
    (SP–4) (SP–1) (SP–2) ← PC11–0
    SP–3 ← EMB, ERB, 0, 0
    PC11–0 ← memc.3–0 + (memc + 1)
    SP ← SP–4

When the reference area is specified by any other instruction, the 'memc' and 'memc + 1' instructions are executed.

Instructions referenced by REF occupy two bytes of memory space (for two 1-byte instructions or one 2-byte instruction) and must be written as an even number from 0020H to 007FH in ROM. In addition, the destination address of the TJP and TCALL instructions must be located with the 3FFFH address. TJP and TCALL are reference instructions for JP/JPS and CALL/CALLS.

If the instruction following a REF is subject to the 'redundancy effect', the redundant instruction is skipped. If, however, the REF follows a redundant instruction, it is executed.

On the other hand, the binary code of a REF instruction is 1 byte. The upper four bits become the higher address bits of the referenced instruction, and the lower four bits of the referenced instruction (x 1/2) becomes the lower address, producing a total of 8 bits or 1 byte (see Example 3 below).

REF — Reference Instruction

REF   (Continued)

Examples: 1.   Instructions can be executed efficiently using REF, as shown in the following example:

```
        ORG     0020H
AAA     LD      HL,#00H
BBB     LD      EA,#FFH
CCC     TCALL   SUB1
DDD     TJP     SUB2
        •
        •
        •
ORG 0080H
        REF     AAA         ;  LD     HL,#00H
        REF     BBB         ;  LD     EA,#FFH
        REF     CCC         ;  CALL   SUB1
        REF     DDD         ;  JP     SUB2
```

2.   The following example shows how the REF instruction is executed in relation to LD instructions that have a 'redundancy effect':

```
        ORG     0020H
AAA     LD      EA,#40H
        •
        •
        •
        ORG     0100H
        LD      EA,#30H
        REF     AAA         ;  Not skipped
        •
        •
        •
        REF     AAA
        LD      EA,#50H     ;  Skipped
        SRB     2
```

REF — Reference Instruction

REF   (Concluded)

Examples: 3. In this example the binary code of 'REF A1' at locations 20H–21H is 20H, for 'REF A2' at locations 22H–23H, it is 21H, and for 'REF A3' at 24H–25H, the binary code is 22H :

Opcode	Symbol	Instruction			
		ORG	0020H		
;					
83 00	A1	LD	HL,#00H		
83 03	A2	LD	HL,#03H		
83 05	A3	LD	HL,#05H		
83 10	A4	LD	HL,#10H		
83 26	A5	LD	HL,#26H		
83 08	A6	LD	HL,#08H		
83 0F	A7	LD	HL,#0FH		
83 F0	A8	LD	HL,#0F0H		
83 67	A9	LD	HL,#067H		
41 0B	A10	TCALL	SUB1		
01 0D	A11	TJP	SUB2		
		•			
		•			
		•			
		ORG	0100H		
;					
20		REF	A1	; LD	HL,#00H
21		REF	A2	; LD	HL,#03H
22		REF	A3	; LD	HL,#05H
23		REF	A4	; LD	HL,#10H
24		REF	A5	; LD	HL,#26H
25		REF	A6	; LD	HL,#08H
26		REF	A7	; LD	HL,#0FH
27		REF	A8	; LD	HL,#0F0H
30		REF	A9	; LD	HL,#067H
31		REF	A10	; CALL	SUB1
32		REF	A11	; JP	SUB2

RET — Return from Subroutine

RET

Operation:

Operand	Operation Summary	Bytes	Cycles
—	Return from subroutine	1	3

Description: RET pops the PC values successively from the stack, incrementing the stack pointer by six. Program execution continues from the resulting address, generally the instruction immediately following a CALL or CALLS.

Operand	Binary Code								Operation Notation
—	1	1	0	0	0	1	0	1	PC13–8 ← (SP+1) (SP) PC7–0 ← (SP+2) (SP+3) PSW ← EMB,ERB SP ← SP+6

Example: The stack pointer contains the value 0FAH. RAM locations 0FAH, 0FBH, 0FCH, and and 0FDH contain 1H, 0H, 5H, and 2H, respectively. The instruction

RET

leaves the stack pointer with the new value of 00H and program execution continues from location 0125H.

During a return from subroutine, PC values are popped from stack locations as follows:

SP →	PC11 – PC8			
SP + 1	0	0	PC13 – PC12	
SP + 2	PC3 – PC0			
SP + 3	PC7 – PC4			
SP + 4	0	0	EMB	ERB
SP + 5	0	0	0	0
SP + 6				

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RRC — Rotate Accumulator Right through Carry

RRC   A

Operation:

Operand	Operation Summary	Bytes	Cycles
A	Rotate right through carry bit	1	1

Description: The four bits in the accumulator and the carry flag are together rotated one bit to the right. Bit 0 moves into the carry flag and the original carry value moves into the bit 3 accumulator position.
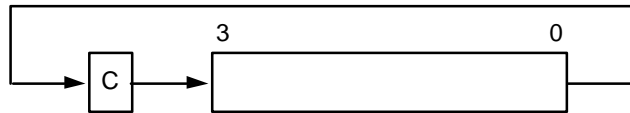
Operand	Binary Code								Operation Notation
A	1	0	0	0	1	0	0	0	$C \leftarrow A.0$, $A3 \leftarrow C$ $A.n{-}1 \leftarrow A.n$ (n = 1, 2, 3)

Example: The accumulator contains the value 5H (0101B) and the carry flag is cleared to logic zero. The instruction

RRC   A

leaves the accumulator with the value 2H (0010B) and the carry flag is set to logic one.

SBC — Subtract with Carry

SBC   dst,src

Operation:

Operand	Operation Summary	Bytes	Cycles
A,@HL	Subtract indirect data memory from A with carry	1	1
EA,RR	Subtract register pair (RR) from EA with carry	2	2
RRb,EA	Subtract EA from register pair (RRb) with carry	2	2

Description: SBC subtracts the source and carry flag value from the destination operand, leaving the result in the destination. SBC sets the carry flag if a borrow is needed for the most significant bit; otherwise it clears the carry flag. The contents of the source are unaffected.

If the carry flag was set before the SBC instruction was executed, a borrow was needed for the previous step in multiple precision subtraction. In this case, the carry bit is subtracted from the destination along with the source operand.

Operand	Binary Code								Operation Notation
A,@HL	0	0	1	1	1	1	0	0	C,A ← A − (HL) − C
EA,RR	1	1	0	1	1	1	0	0	C, EA ← EA −RR − C
	1	1	0	0	1	r2	r1	0	
RRb,EA	1	1	0	1	1	1	0	0	C,RRb ← RRb − EA − C
	1	1	0	0	0	r2	r1	0	

Examples: 1. The extended accumulator contains the value 0C3H, register pair HL the value 0AAH, and the carry flag is set to "1":

```
SCF                       ;  C ← "1"
SBC       EA,HL           ;  EA ← 0C3H − 0AAH − 1H, C ← "0"
JPS       XXX             ;  Jump to XXX; no skip after SBC
```

2. If the extended accumulator contains the value 0C3H, register pair HL the value 0AAH, and the carry flag is cleared to "0":

```
RCF                       ;  C ← "0"
SBC       EA,HL           ;  EA ← 0C3H − 0AAH − 0H  =  19H, C ← "0"
JPS       XXX             ;  Jump to XXX;  no skip after SBC
```

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SBC — Subtract with Carry

SBC (Continued)

Examples: 3. If SBC A,@HL is followed by an ADS A,#im, the SBC skips on 'no borrow' to the instruction immediately after the ADS. An 'ADS A,#im' instruction immediately after the 'SBC A,@HL' instruction does not skip even if an overflow occurs. This function is useful for decimal adjustment operations.

a. 8 − 6 decimal addition (the contents of the address specified by the HL register is 6H):

```
RCF                    ;  C ← "0"
LD      A,#8H          ;  A ← 8H
SBC     A,@HL          ;  A ← 8H − 6H − C(0) = 2H, C ← "0"
ADS     A,#0AH         ;  Skip this instruction because no borrow after SBC result
JPS     XXX
```

b. 3 − 4 decimal addition (the contents of the address specified by the HL register is 4H):

```
RCF                    ;  C ← "0"
LD      A,#3H          ;  A ← 3H
SBC     A,@HL          ;  A ← 3H − 4H − C(0) = 0FH, C ← "1"
ADS     A,#0AH         ;  No skip. A ← 0FH + 0AH = 9H
                       ;  (The skip function of 'ADS A,#im' is inhibited after a
                       ;  'SBC A,@HL' instruction even if an overflow occurs.)
JPS     XXX
```

SBS — Subtract

SBS   dst,src

Operation:

Operand	Operation Summary	Bytes	Cycles
A,@HL	Subtract indirect data memory from A; skip on borrow	1	1 + S
EA,RR	Subtract register pair (RR) from EA; skip on borrow	2	2 + S
RRb,EA	Subtract EA from register pair (RRb); skip on borrow	2	2 + S

Description: The source operand is subtracted from the destination operand and the result is stored in the destination. The contents of the source are unaffected. A skip is executed if a borrow occurs. The value of the carry flag is not affected.

Operand	Binary Code								Operation Notation
A,@HL	0	0	1	1	1	1	0	1	A ← A – (HL); skip on borrow
EA,RR	1	1	0	1	1	1	0	0	EA ← EA – RR; skip on borrow
	1	0	1	1	1	r2	r1	0	
RRb,EA	1	1	0	1	1	1	0	0	RRb ← RRb – EA; skip on borrow
	1	0	1	1	0	r2	r1	0	

Examples: 1.   The accumulator contains the value 0C3H, register pair HL contains the value 0C7H, and the carry flag is cleared to logic zero:

```
RCF                         ;  C ← "0"
SBS        EA,HL            ;  EA ← 0C3H – 0C7H, C ← "0"
                           ;  SBS instruction skips on borrow,
                           ;  but carry flag value is not affected
JPS        XXX             ;  Skip because a borrow occurred
JPS        YYY             ;  Jump to YYY is executed
```

2.   The accumulator contains the value 0AFH, register pair HL contains the value 0AAH, and the carry flag is set to logic one:

```
SCF                         ;  C ← "1"
SBS        EA,HL            ;  EA ← 0AFH – 0AAH, C ← "1"
JPS        XXX             ;  Jump to XXX
                           ;  JPS was not skipped because no "borrow" occurred after SBS
```

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SCF — Set Carry Flag

SCF

Operation:

Operand	Operation Summary	Bytes	Cycles
—	Set carry flag to logic one	1	1

Description: The SCF instruction sets the carry flag to logic one, regardless of its previous value.

Operand	Binary Code								Operation Notation
—	1	1	1	0	0	1	1	1	C ← 1

Example: If the carry flag is cleared to logic zero, the instruction

SCF

sets the carry flag to logic one.

SMB — Select Memory Bank

SMB   n

Operation:

Operand	Operation Summary	Bytes	Cycles
n	Select memory bank	2	2

Description: The SMB instruction sets the upper four bits of a 12-bit data memory address to select a specific memory bank. The constants 0, 1, and 15 are usually used as the SMB operand to select the corresponding memory bank. All references to data memory addresses fall within the following address ranges:

Please note that because data memory spaces differ for various devices in the SAM47 product family, the 'n' value of the SMB instruction will also vary.

Addresses	Register Areas	Bank	SMB
000H–01FH	Working registers	0	0
020H–0FFH	Stack and general-purpose registers		
100H–1DFH	General-purpose registers	1	1
1E0H–1FFH	Display registers		
F80H–FFFH	I/O-mapped hardware registers	15	15

The enable memory bank (EMB) flag must always be set to "1" in order for the SMB instruction to execute successfully for memory banks 0, 1, and 15.

Format	Binary Code								Operation Notation
n	1	1	0	1	1	1	0	1	SMB ← n (n = 0, 1, 15)
	0	1	0	0	d3	d2	d1	d0	

Example: If the EMB flag is set, the instruction

SMB   0

selects the data memory address range for bank 0 (000H–0FFH) as the working memory bank.

SRB — Select Register Bank

SRB n

Operation:

Operand	Operation Summary	Bytes	Cycles
n	Select register bank	2	2

Description: The SRB instruction selects one of four register banks in the working register memory area. The constant value used with SRB is 0, 1, 2, or 3. The following table shows the effect of SRB settings:

ERB Setting	SRB Settings				Selected Register Bank
	3	**2**	**1**	**0**	
0	0	0	x	x	Always set to bank 0
1	0	0	0	0	Bank 0
			0	1	Bank 1
			1	0	Bank 2
			1	1	Bank 3

NOTE: 'x' means don't care.

The enable register bank flag (ERB) must always be set for the SRB instruction to execute successfully for register banks 0, 1, 2, and 3. In addition, if the ERB value is logic zero, register bank 0 is always selected, regardless of the SRB value.

Operand	Binary Code								Operation Notation
n	1	1	0	1	1	1	0	1	SRB ← n (n = 0, 1, 2, 3)
	0	1	0	1	0	0	d1	d0	

Example: If the ERB flag is set, the instruction

SRB   3

selects register bank 3 (018H–01FH) as the working memory register bank.

SRET — Return from Subroutine and Skip

SRET

Operation:

Operand	Operation Summary	Bytes	Cycles
—	Return from subroutine and skip	1	3 + S

Description: SRET is normally used to return to the previously executing procedure at the end of a subroutine that was initiated by a CALL or CALLS instruction. SRET skips the resulting address, which is generally the instruction immediately after the point at which the subroutine was called. Then, program execution continues from the resulting address and the contents of the location addressed by the stack pointer are popped into the program counter.

Operand	Binary Code								Operation Notation
—	1	1	1	0	0	1	0	1	PC13–8 ← (SP + 1) (SP) PC7–0 ← (SP + 3) (SP + 2) EMB,ERB ← (SP + 5) (SP + 4) SP ← SP + 6

Example: If the stack pointer contains the value 0FAH and RAM locations 0FAH, 0FBH, 0FCH, and 0FDH contain the values 1H, 0H, 5H, and 2H, respectively, the instruction

SRET

leaves the stack pointer with the value 00H and the program returns to continue execution at location 0125H.

During a return from subroutine, data is popped from the stack to the PC as follows:

SP →	PC11 – PC8			
SP + 1	0	0	PC13 – PC12	
SP + 2	PC3 – PC0			
SP + 3	PC7 – PC4			
SP + 4	0	0	EMB	ERB
SP + 5	0	0	0	0
SP + 6				

STOP — Stop Operation

STOP

Operation:

Operand	Operation Summary	Bytes	Cycles
—	Engage CPU stop mode	2	2

Description: The STOP instruction stops the system clock by setting bit 3 of the power control register (PCON) to logic one. When STOP executes, all system operations are halted with the exception of some peripheral hardware with special power-down mode operating conditions.

In application programs, a STOP instruction should be immediately followed by at least three NOP instructions. This ensures an adequate time interval for the clock to stabilize before the next instruction is executed.

Operand	Binary Code								Operation Notation
—	1	1	1	1	1	1	1	1	PCON.3 ← 1
	1	0	1	1	0	0	1	1	

Example: Given that bit 3 of the PCON register is cleared to logic zero, and all systems are operational, the instruction sequence

STOP
NOP
NOP
NOP

sets bit 3 of the PCON register to logic one, stopping all controller operations (with the exception of some peripheral hardware). The three NOP instructions provide the necessary timing delay for clock stabilization before the next instruction in the program sequence is executed.

VENT — Load EMB, ERB, and Vector Address

VENTn   dst

Operation:

Operand	Operation Summary	Bytes	Cycles
EMB (0,1) ERB (0,1) ADR	Load enable memory bank flag (EMB) and the enable register bank flag (ERB) and program counter to vector address, then branch to the corresponding location.	2	2

Description: The VENT instruction loads the contents of the enable memory bank flag (EMB) and enable register bank flag (ERB) into the respective vector addresses. It then points the interrupt service routine to the corresponding branching locations. The program counter is loaded automatically with the respective vector addresses which indicate the starting address of the respective vector interrupt service routines.

The EMB and ERB flags should be modified using VENT before the vector interrupts are acknowledged. Then, when an interrupt is generated, the EMB and ERB values of the previous routine are automatically pushed onto the stack and then popped back when the routine is completed.

After the return from interrupt (IRET) you do not need to set the EMB and ERB values again. Instead, use BITR and BITS to clear these values in your program routine.

The starting addresses for vector interrupts and reset operations are pointed to by the VENTn instruction. These addresses must be stored in ROM locations 0000H–3FFFH. Generally, the VENTn instructions are coded starting at location 0000H.

The format for VENT instructions is as follows:

VENTn d1,d2,ADDR
EMB $\leftarrow$ d1 ("0" or "1")
ERB $\leftarrow$ d2 ("0" or "1")
PC $\leftarrow$ ADDR (address to branch
n = device-specific module address code (n = 0–n)

Operand	Binary Code								Operation Notation
EMB (0,1) ERB (0,1) ADR	E M B	E R B	a13	a12	a11	a10	a9	a8	ROM (2 x n) 7–6 $\leftarrow$ EMB, ERB ROM (2 x n) 5–4 $\leftarrow$ 0, PC13, PC12 ROM (2 x n) 3–0 $\leftarrow$ PC12–8 ROM (2 x n + 1) 7–0 $\leftarrow$ PC7–0 (n = 0, 1, 2, 3, 4, 5, 6, 7)
	a7	a6	a5	a4	a3	a2	a1	a0	

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VENT — Load EMB, ERB, and Vector Address

VENTn   (Continued)

Example: The instruction sequence

```
ORG     0000H
VENT0   1,0,RESET
VENT1   0,1,INTB
VENT2   0,1,INT0
VENT3   0,1,INTS
VENT4   0,1,INTT0
VENT5   0,1,INTT1
```

causes the program sequence to branch to the RESET routine labeled 'RESET,' setting EMB to "1" and ERB to "0" when RESET is activated. When a basic timer interrupt is generated, VENT1 causes the program to branch to the basic timer's interrupt service routine, INTB, and to set the EMB value to "0" and the ERB value to "1". VENT2 then branches to INT0, VENT3 to INTS, and so on, setting the appropriate EMB and ERB values.

XCH — Exchange A or EA with Nibble or Byte

XCH   dst,src

Operation:

Operand	Operation Summary	Bytes	Cycles
A,DA	Exchange A and data memory contents	2	2
A,Ra	Exchange A and register (Ra) contents	1	1
A,@RRa	Exchange A and indirect data memory	1	1
EA,DA	Exchange EA and direct data memory contents	2	2
EA,RRb	Exchange EA and register pair (RRb) contents	2	2
EA,@HL	Exchange EA and indirect data memory contents	2	2

Description: The instruction XCH loads the accumulator with the contents of the indicated destination variable and writes the original contents of the accumulator to the source.

Operand	Binary Code								Operation Notation
A,DA	0	1	1	1	1	0	0	1	A $\leftrightarrow$ DA
	a7	a6	a5	a4	a3	a2	a1	a0	
A,Ra	0	1	1	0	1	r2	r1	r0	A $\leftrightarrow$ Ra
A,@RRa	0	1	1	1	1	i2	i1	i0	A $\leftrightarrow$ (RRa)
EA,DA	1	1	0	0	1	1	1	1	A $\leftrightarrow$ DA,E $\leftrightarrow$ DA + 1
	a7	a6	a5	a4	a3	a2	a1	a0	
EA,RRb	1	1	0	1	1	1	0	0	EA $\leftrightarrow$ RRb
	1	1	1	0	0	r2	r1	0	
EA,@HL	1	1	0	1	1	1	0	0	A $\leftrightarrow$ (HL), E $\leftrightarrow$ (HL + 1)
	0	0	0	0	0	0	0	1	

Example: Double register HL contains the address 20H. The accumulator contains the value 3FH (00111111B) and internal RAM location 20H the value 75H (01110101B). The instruction

        XCH   EA,@HL

leaves RAM location 20H with the value 3FH (00111111B) and the extended accumulator with the value 75H (01110101B).

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XCHD — Exchange and Decrement

XCHD   dst,src

Operation:

Operand	Operation Summary	Bytes	Cycles
A,@HL	Exchange A and data memory contents; decrement contents of register L and skip on borrow	1	2 + S

Description: The instruction XCHD exchanges the contents of the accumulator with the RAM location addressed by register pair HL and then decrements the contents of register L. If the content of register L is 0FH, the next instruction is skipped. The value of the carry flag is not affected.

Operand	Binary Code								Operation Notation
A,@HL	0	1	1	1	1	0	1	1	A ↔ (HL), then L ← L–1; skip if L = 0FH

Example: Register pair HL contains the address 20H and internal RAM location 20H contains the value 0FH:

```
            LD    HL,#20H
            LD    A,#0H
            XCHD  A,@HL      ;  A ← 0FH and L ← L – 1, (HL) ← "0"
            JPS   XXX        ;  Skipped because a borrow occurred
            JPS   YYY        ;  H ← 2H, L ← 0FH
YYY         XCHD  A,@HL      ;  (2FH) ← 0FH, A ← (2FH), L ← L – 1  =  0EH
            •
            •
            •
```

The 'JPS YYY' instruction is executed because a skip occurs after the XCHD instruction.

XCHI — Exchange and Increment

XCHI   dst,src

Operation:

Operand	Operation Summary	Bytes	Cycles
A,@HL	Exchange A and data memory contents; increment contents of register L and skip on overflow	1	2 + S

Description: The instruction XCHI exchanges the contents of the accumulator with the RAM location addressed by register pair HL and then increments the contents of register L. If the content of register L is 0H, a skip is executed. The value of the carry flag is not affected.

Operand	Binary Code								Operation Notation
A,@HL	0	1	1	1	1	0	1	0	A ↔ (HL), then L ← L+1; skip if L = 0H

Example: Register pair HL contains the address 2FH and internal RAM location 2FH contains 0FH:

```
            LD     HL,#2FH
            LD     A,#0H
            XCHI   A,@HL      ;  A ← 0FH and L ← L + 1 = 0, (HL) ← "0"
            JPS    XXX        ;  Skipped because an overflow occurred
            JPS    YYY        ;  H ← 2H, L ← 0H
YYY         XCHI   A,@HL      ;  (20H) ← 0FH, A ← (20H), L ← L + 1  =  1H
            •
            •
            •
```

The 'JPS YYY' instruction is executed because a skip occurs after the XCHI instruction.

XOR — Logical Exclusive OR

XOR   dst,src

Operation:

Operand	Operation Summary	Bytes	Cycles
A,#im	Exclusive-OR immediate data to A	2	2
A,@HL	Exclusive-OR indirect data memory to A	1	1
EA,RR	Exclusive-OR register pair (RR) to EA	2	2
RRb,EA	Exclusive-OR register pair (RRb) to EA	2	2

Description: XOR performs a bitwise logical XOR operation between the source and destination variables and stores the result in the destination. The source contents are unaffected.

Operand	Binary Code								Operation Notation
A,#im	1	1	0	1	1	1	0	1	A ← A XOR im
	0	0	1	1	d3	d2	d1	d0	
A,@HL	0	0	1	1	1	0	1	1	A ← A XOR (HL)
EA,RR	1	1	0	1	1	1	0	0	EA ← EA XOR (RR)
	0	0	1	1	1	r2	r1	0	
RRb,EA	1	1	0	1	1	1	0	0	RRb ← RRb XOR EA
	0	0	1	1	0	r2	r1	0	

Example: If the extended accumulator contains 0C3H (11000011B) and register pair HL contains 55H (01010101B), the instruction

XOR   EA,HL

leaves the value 96H (10010110B) in the extended accumulator.

NOTES

Oscillator Circuits

Interrupts

Power-Down

RESET

I/O Ports

Timers and Timer/Counter

Comparator

Serial I/O Interface

Electrical Data

Mechanical Data

KS57P0504 OTP

Development Tools

6 OSCILLATOR CIRCUITS

OVERVIEW

The KS57C0502/C0504 has a system clock circuit. The CPU and peripheral hardware operate on the system clock frequency supplied through these on-chip circuits. Specifically, a clock is required by the following peripheral modules:

— Basic timer

— Timer/counter 0

— Watch timer

— Serial I/O interface

— Clock output circuit

The system clock frequency can be divided by 4, 8, or 64. By manipulating PCON bits 1 and 0, you can select one of the following frequencies as the cpu clock.

$$\frac{fx}{4}, \frac{fx}{8}, \frac{fx}{64}$$

When the PCON register is cleared to zero after RESET, the normal CPU operating mode is enabled, a system clock of fx/64 is selected.

Bits 3 and 2 of the PCON register can be manipulated by a STOP or IDLE instruction to engage stop or idle power-down mode.
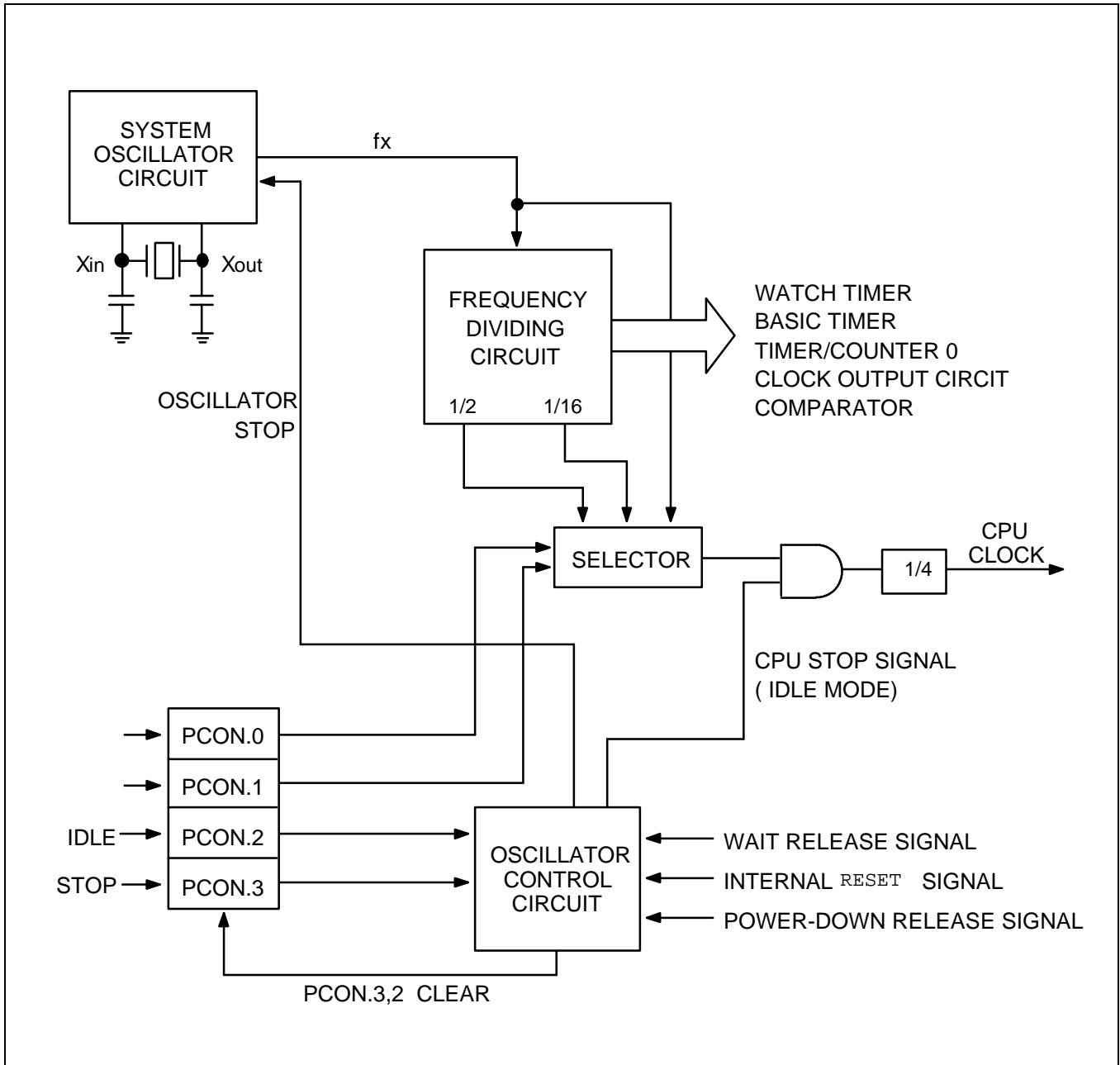
Figure 6–1. Clock Circuit Diagram

SYSTEM OSCILLATOR CIRCUITS
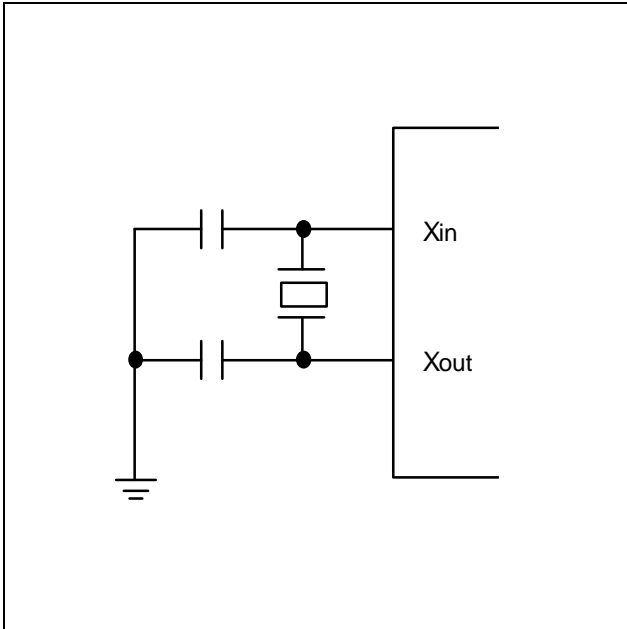
Figure 6–2. Crystal/Ceramic Oscillator
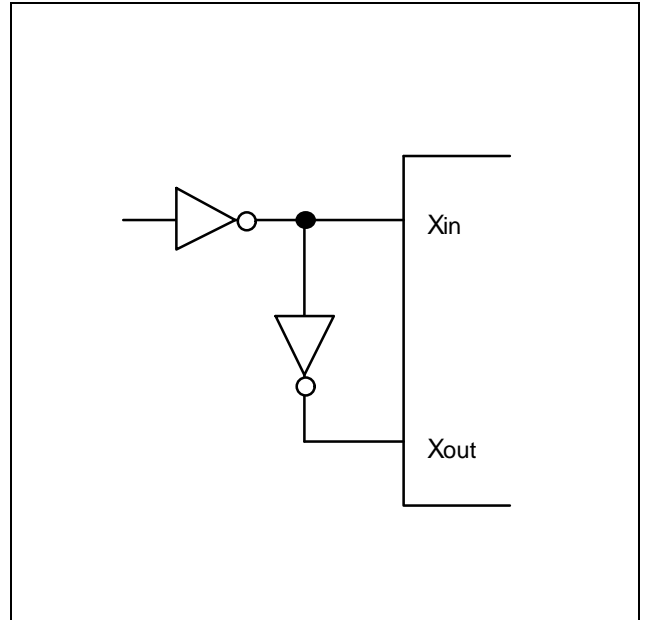
Figure 6–3. External Clock

POWER CONTROL REGISTER (PCON)

The power control register, PCON, is a 4-bit register that is used to select the CPU clock frequency and to control CPU operating and power-down modes. PCON is mapped to RAM address FB3H and can be addressed directly by 4-bit write instructions or by the instructions IDLE and STOP.

FB3H	PCON.3	PCON.2	PCON.1	PCON.0

PCON bits 3 and 2 are controlled by the STOP and IDLE instructions to engage the idle and stop power-down modes. Idle and stop modes can be initiated by these instruction despite the current value of the enable memory bank flag (EMB). PCON bits 1 and 0 are used to select a specific system clock frequency.

RESET sets PCON register values to logic zero. PCON.1 and PCON.0 divide the frequency (fx) by 64, 8, and 4. PCON.3 and PCON.2 enable normal CPU operating mode.

Table 6–1. Power Control Register (PCON) Organization

PCON Bit Settings		Resulting CPU Operating Mode
PCON.3	PCON.2	
0	0	Normal CPU operating mode
0	1	Idle power-down mode
1	0	Stop power-down mode

PCON Bit Settings		Resulting CPU Clock Frequency
PCON.1	PCON.0	
0	0	fx/64
1	0	fx/8
1	1	fx/4

☞ **PROGRAMMING TIP — Setting the CPU Clock**

To set the CPU clock to 0.95 µs at 4.19 MHz:

```
BITS      EMB
SMB       15
LD        A,#3H
LD        PCON,A
```

INSTRUCTION CYCLE TIMES

The unit of time that equals one machine cycle varies depending on how the oscillator clock signal is divided (by 4, 8, or 64). Table 6–2 shows corresponding cycle times in microseconds.

Table 6–2. Instruction Cycle Times for CPU Clock Rates

Selected CPU Clock	Resulting Frequency	Oscillation Source	Cycle Time (μsec)
fx/64	65.5 kHz		15.3
fx/8	524.0 kHz	fx = 4.19 MHz	1.91
fx/4	1.05 MHz		0.95

CLOCK OUTPUT MODE REGISTER (CLMOD)

The clock output mode register, CLMOD, is a 4-bit register that is used to enable or disable clock output to the CLO pin and to select the CPU clock source and frequency. CLMOD is mapped to RAM address FD0H and is addressable by 4-bit write instructions only.

FD0H	CLMOD.3	"0"	CLMOD.1	CLMOD.0

RESET clears CLMOD to logic zero, which automatically selects the CPU clock as the clock source (without initiating clock oscillation), and disables clock output.

CLMOD.3 is the enable/disable clock output control bit; CLMOD.1 and CLMOD.0 are used to select one of four possible clock sources and frequencies: normal CPU clock, fx/8, fx/16, or fx/64.

Table 6–3. Clock Output Mode Register (CLMOD) Organization

CLMOD Bit Settings		Resulting Clock Output	
CLMOD.1	CLMOD.0	Clock Source	Frequency
0	0	CPU clock (fx/4, fx/8, fx/64)	1.05 MHz, 524 kHz, 65.5 kHz
0	1	fx/8	524 kHz
1	0	fx/16	262 kHz
1	1	fx/64	65.5 kHz

CLMOD.3	Result of CLMOD.3 Setting
0	Clock output is disabled
1	Clock output is enabled

NOTE: Frequencies assume that fx = 4.19 MHz.

CLOCK OUTPUT CIRCUIT

The clock output circuit, used to output clock pulses to the CLO pin, has the following components:

— 4-bit clock output mode register (CLMOD)

— Clock selector

— Output latch

— Port mode flag

— CLO output pin (P3.2)
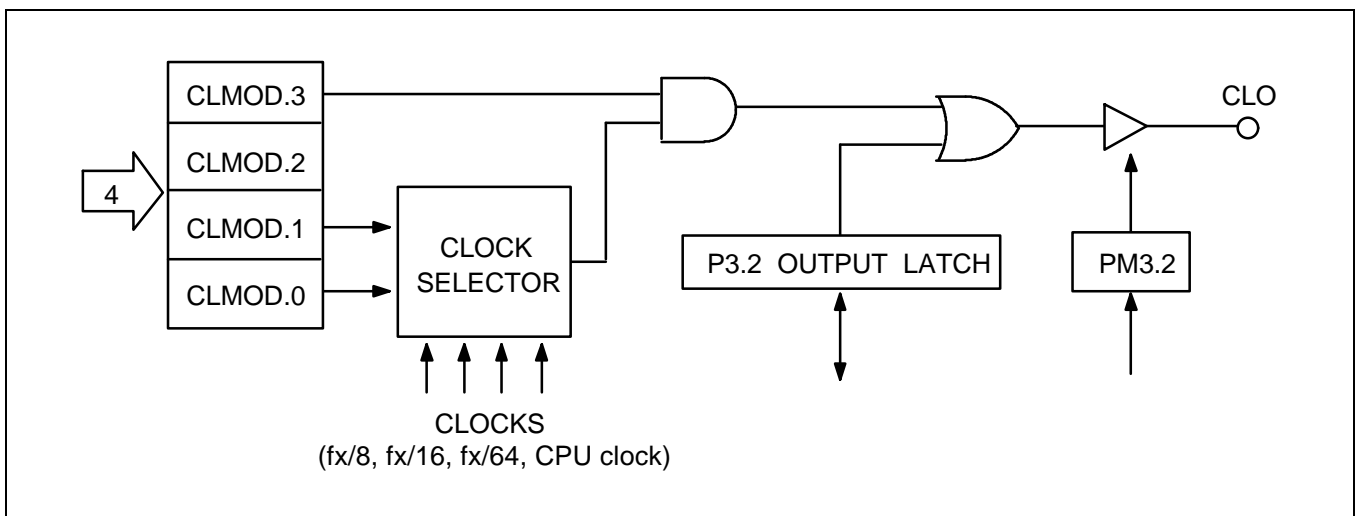
Figure 6–4. CLO Output Pin Circuit Diagram

CLOCK OUTPUT PROCEDURE

To output clock pulses to the CLO pin, follow this general procedure:

1. Disable clock output by clearing CLMOD.3 to logic zero.

2. Set the clock output frequency (CLMOD.1, CLMOD.0).

3. Load a "0" to the output latch of the CLO pin (P3.2).

4. Set the P3.2 mode flag (PM3.2) to output mode.

5. Enable clock output by setting CLMOD.3 to logic one.

☞ **PROGRAMMING TIP — CPU Clock Output to the CLO Pin**

To output the CPU clock to the CLO pin:

```
BITS    EMB                         ;    Or BITR EMB
SMB     15
LD      EA,#40H
LD      PMG1,EA                     ;    P3.2 ← Output mode
BITR    P3.2                        ;    Clear P3.2 output latch
LD      A,#9H
LD      CLMOD,A
```

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7 INTERRUPTS

OVERVIEW

KS57C0502/C0504 microcontrollers process three types of interrupts:

— Internal interrupts generated by on-chip processes

— External interrupts generated by external peripheral devices

— Quasi-interrupts used for edge detection and clock sources

Table 7–1. Interrupts and Corresponding I/O Pin(s)

Interrupt Type	Interrupt Name	I/O Port Pin(s)
External Interrupts	INT0, INT1	P1.0, P1.1
Internal Interrupts	INTB, INTT0, INTS	Not applicable
Quasi-interrupts	INTK	P6.0–P6.2 (KS0–KS2)
	INTW	Not applicable

The interrupt control circuit has four functional components:

— Interrupt enable flags (IEx)

— Interrupt request flags (IRQx)

— Interrupt priority registers (IME and IPR)

— Power-down release signal circuit

Vectored Interrupts

Interrupt requests may be processed as vectored interrupts in hardware, or they can be generated by program software. A vectored interrupt is generated when the following flags and register settings, corresponding to the specific interrupt, are enabled (set to logic one):

— Interrupt enable flag (IEx)

— Interrupt master enable flag (IME)

— Interrupt request flag (IRQx)

— Interrupt status flags (IS0, IS1)

— Interrupt priority register (IPR)

If all conditions are satisfied, the start address of the interrupt is loaded into the program counter and the program starts executing the service routine from this address.

Vectored Interrupts (Continued)

EMB and ERB flags for RAM memory and register banks are stored in the vector address area of the ROM during interrupt service routines. The flags are stored at the beginning of the program with the VENT instruction. Enable flag values are saved during the main routine, as well as during service routines. Any changes you make to enable flag values during a service routine are not stored in the vector address.

When an interrupt occurs, the enable flag values before the interrupt is initiated are saved along with the program status word (PSW), and the enable flag values for the interrupt is fetched from the respective vector address.

Then, if required, you can modify the enable flags during the interrupt service routine. When the interrupt service routine is returned to the main routine by the IRET instruction, however, the original values saved in the stack are restored and the main program continues program execution with these values.

Software-Generated Interrupts

To generate an interrupt request from software, the program manipulates the appropriate IRQx flag. When the interrupt request value in the IRQx flag is set, it is retained until all other conditions for the interrupt have been met, and the service routine can be initiated.

Multiple Interrupts

By manipulating the two interrupt status flags (IS0 and IS1), you can control service routine initialization and thereby process multiple interrupts simultaneously.

Power-Down Mode Release

An interrupt (with the exception of INT0) can be used to release power-down mode (stop or idle). Interrupts for power-down mode release are initiated by setting the corresponding interrupt enable flag. Even if the IME flag is cleared to zero, power-down mode will be released by an interrupt request signal when the interrupt enable flag has been set. In such cases, the interrupt routine will not be executed since IME = "0".

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Interrupt is generated (INT xx)

Request flag (IRQx) <-- 1

IEx = 1? — NO → Retain value until IEx = 1

YES

Generate corresponding vector interrupt
and release power-down mode

IME = 1? — NO → Retain value until IME = 1

YES

IS1,0 = 0,0? — YES

NO

Retain value until interrupt
service routine is completed

IS1,0 = 0,1 ? — NO →

YES

High-priority interrupt? — NO →

YES

IS1,0 = 0,1

IS1,0 = 1,0

Store contents of PC and PSW in the stack area;
set PC contents to corresponding vector address

Reset corresponding IRQx flag

Jump to interrupt start address

Figure 7−1. Interrupt Execution Flowchart
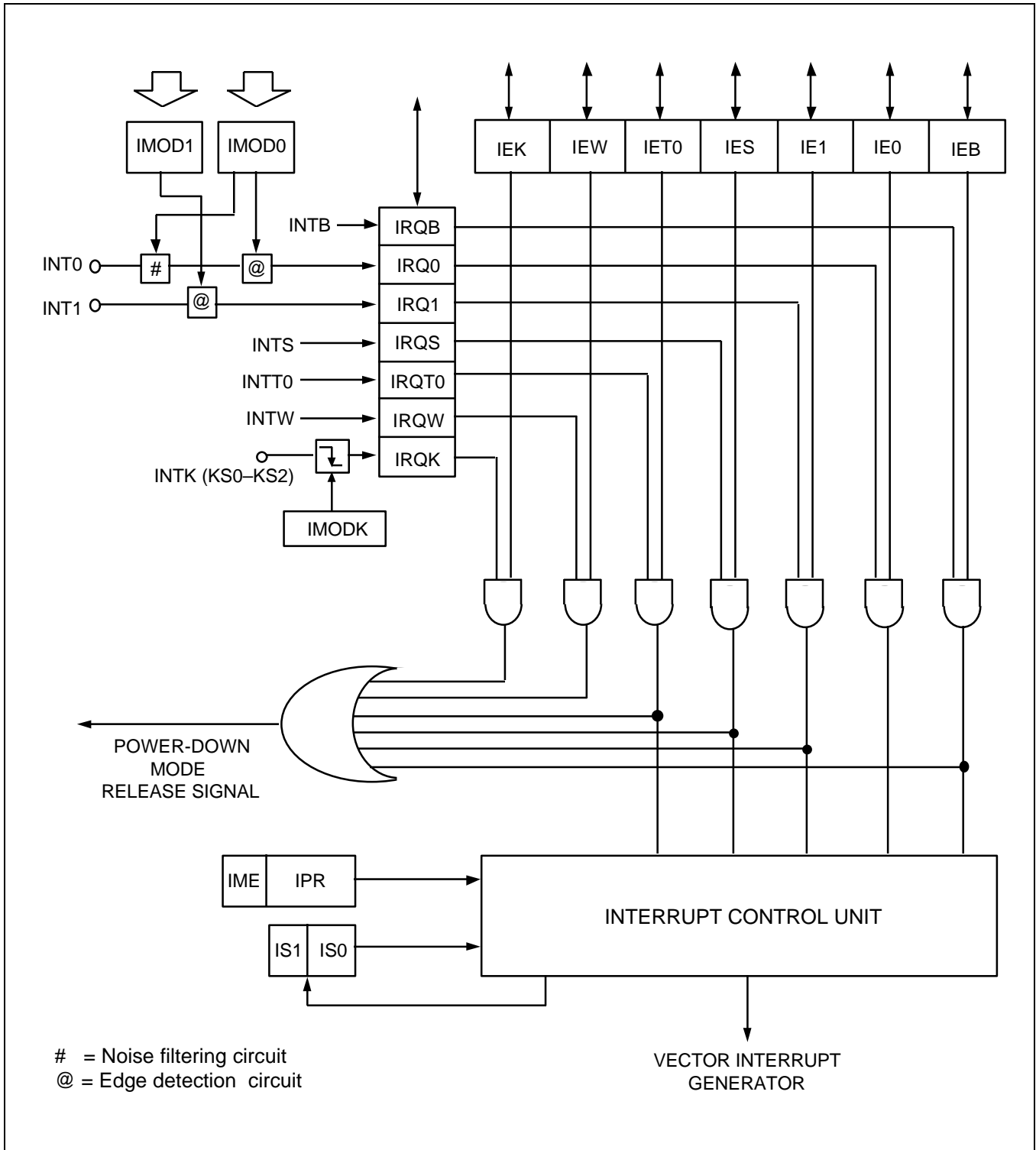
Figure 7–2. Interrupt Control Circuit Diagram

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MULTIPLE INTERRUPTS

The interrupt controller can service multiple interrupts in two ways: as two-level interrupts, where either all interrupt requests or only those of highest priority are serviced, or as multi-level interrupts, when the interrupt service routine for a lower-priority request is accepted during the execution of a higher priority routine.

Two-Level Interrupt Handling

Two-level interrupt handling is the standard method for processing multiple interrupts. When the IS1 and IS0 bits of the PSW (FB0H.3 and FB0H.2, respectively) are both logic zero, program execution mode is normal and all interrupt requests are serviced. See Figure 7–3.

Whenever an interrupt request is accepted, IS1 and IS0 are incremented by one ("0" → "1" or "1" → "0"), and the values are stored in the stack along with the other PSW bits. After the interrupt routine has been serviced, the modified IS1 and IS0 values are automatically restored from the stack by an IRET instruction.

IS0 and IS1 can be manipulated directly by 1-bit write instructions, regardless of the current value of the enable memory bank flag (EMB). Before you can modify an interrupt service flag, however, you must first disable interrupt processing with a DI instruction.

When you set IS1 to "0" and IS0 to "1", you inhibit all interrupt service routines except for the highest priority interrupt currently defined by the interrupt priority register (IPR).
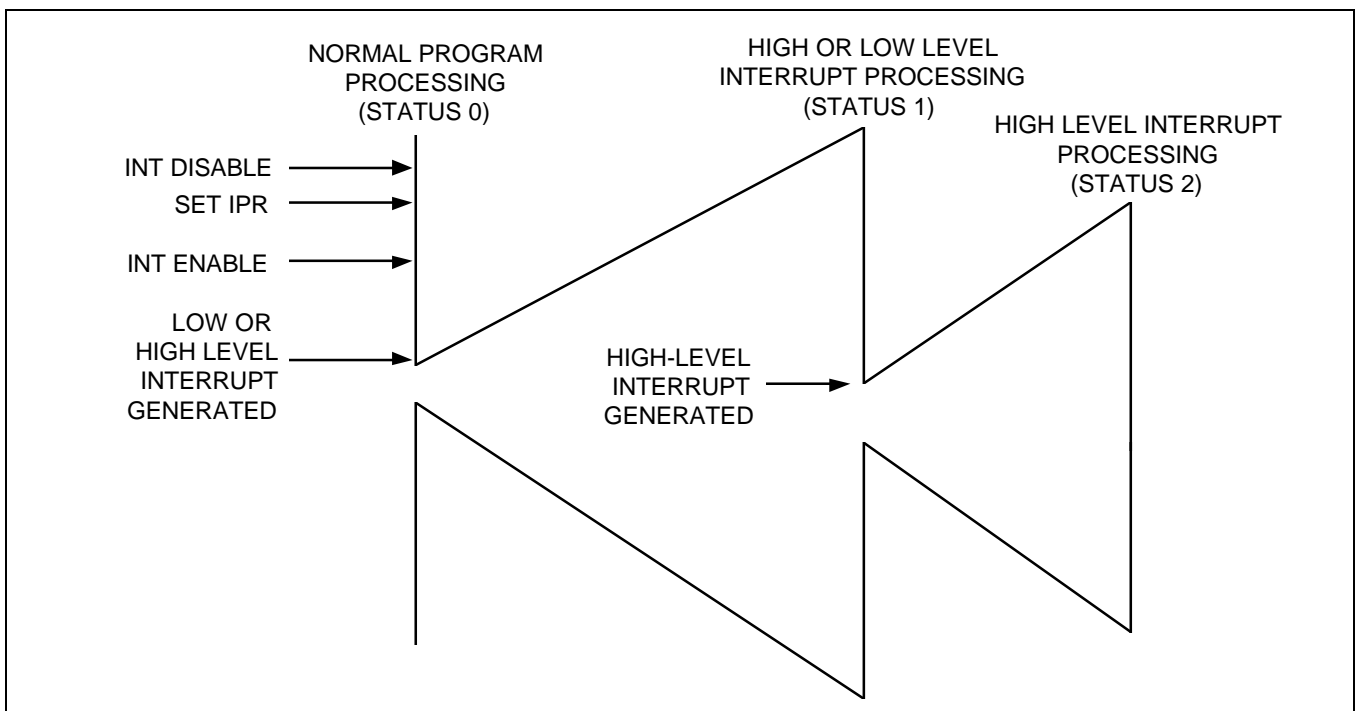
Figure 7–3. Two-Level Interrupt Handling

Multi-Level Interrupt Handling

With multi-level interrupt handling, a lower-priority interrupt request can be executed while a high-priority interrupt is being serviced. This is done by manipulating the interrupt status flags, IS0 and IS1. See Figure 7–4.

When an interrupt is requested during normal program execution, the interrupt status flags IS0 and IS1 are set to "0" and "1", respectively. This setting allows only highest-priority interrupts to be serviced. When a high-priority request is accepted, both interrupt status flags are then cleared to "0" by software so that a request of any priority level can be serviced. In this way, the high-priority and low-priority requests will be serviced in parallel.

Table 7–2. IS1 and IS0 Function

Process Status	Before INT		Effect of ISx Bit Setting	After INT ACK	
	IS1	IS0		IS1	IS0
0	0	0	All interrupt requests are serviced.	0	1
1	0	1	Only high-priority interrupts as determined by the current settings in the IPR register are serviced.	1	0
2	1	0	No additional interrupt requests will be serviced.	—	—
—	1	1	Value undefined	—	—
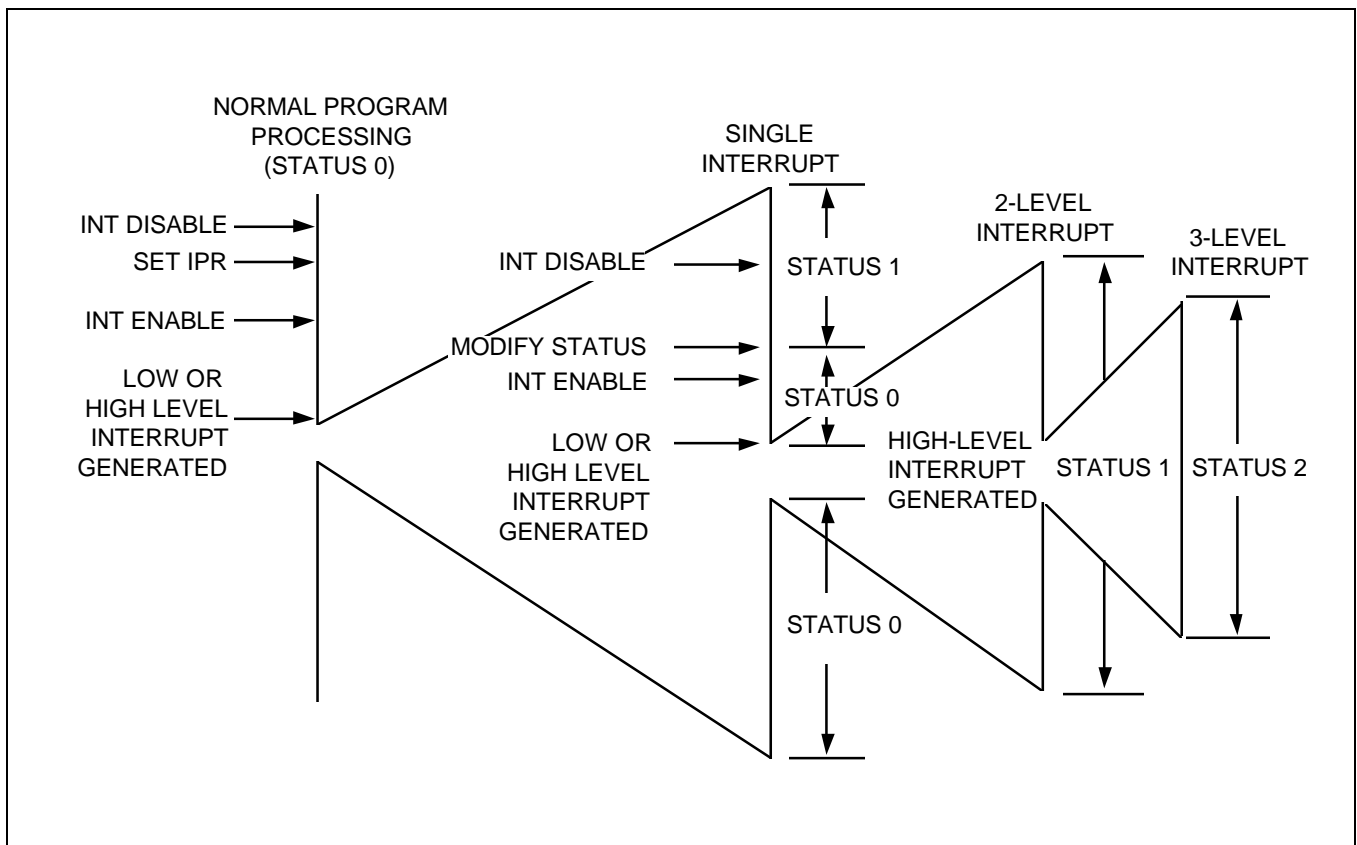
Figure 7–4. Multiple-Level Interrupt Handling

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INTERRUPT PRIORITY REGISTER (IPR)

The 4-bit interrupt priority register (IPR) is used to control multi-level interrupt handling. The IPR is mapped to RAM address FB2H, and its reset value is logic zero. Before the IPR can be modified by 4-bit write instructions, all interrupts must first be disabled by a DI instruction.

FB2H	IME	IPR.2	IPR.1	IPR.0

By manipulating the IPR settings, you can choose to process all interrupt requests with the same priority level, or you can select one type of interrupt for high-priority processing. A low-priority interrupt can itself be interrupted by a high-priority interrupt, but not by another low-priority interrupt. A high-priority interrupt cannot be interrupted by any other interrupt source.

Interrupt	Default Priority
INTB	1
INT0	2
INT1	3
INTS	4
INTT0	5

The MSB of the IPR, the interrupt master enable flag (IME), enables and disables all interrupt processing. Even if an interrupt request flag and its corresponding enable flag are set, a service routine cannot be executed until the IME flag is set to logic one.

The IME flag is mapped to FB2H.3 and can be directly manipulated by EI and DI instructions, regardless of the current enable memory bank (EMB) value.

Table 7–4. Interrupt Priority Register Settings

IPR.2	IPR.1	IPR.0	Result of IPR Bit Setting
0	0	0	Process all interrupt requests at low priority.
0	0	1	Process INTB interrupt only.
0	1	0	Process INT0 interrupts only.
0	1	1	Process INT1 interrupts only.
1	0	0	Process INTS interrupts only.
1	0	1	Process INTT0 interrupts only.

NOTE: When all interrupts are low priority (the lower three bits of the IPR register are logic zero), the interrupt generated first will become high priority. Therefore, the first generated interrupt cannot be superceded by any other interrupt. If two or more interrupt requests are received simultaneously, the priority level is determined according to the standard interrupt priorities in Table 7.4 (e.g., the default priority assigned by hardware when the lower three IPR bits = "0"). In this case, the higher-priority interrupt request is serviced and the other interrupt is inhibited. Then, when the high-priority interrupt is returned from its service routine by an IRET instruction, the inhibited interrupt service routine is started.

☞ **PROGRAMMING TIP — Setting the INT Interrupt Priority**

Set the INT1 interrupt to high priority:

```
BITS    EMB
SMB     15
DI                          ;   IPR.3 (IME) ← 0
LD      A,#3H
LD      IPR,A
EI                          ;   IPR.3 (IME) ← 1
```

EXTERNAL INTERRUPT MODE REGISTERS (IMOD0, IMOD1)

The following components are used to process external interrupts at the INT0 and INT1 pin:

— Noise filtering circuit for INT0

— Edge detection circuit

— Two mode registers, IMOD0 and IMOD1

The mode registers are used to control the triggering edge of the input signal. IMOD settings let you choose either the rising or falling edge of the incoming signal at the INT0 and INT1 pins as the interrupt request trigger.

FB4H	IMOD0.3	"0"	IMOD0.1	IMOD0.0
FB5H	"0"	"0"	"0"	IMOD1.0

IMOD0 and IMOD1 bits are mapped to RAM addresses FB4H (IMOD0) and FB5H (IMOD1), and are addressable by 4-bit write instructions. RESET clears all IMOD values to logic zero, selecting rising edges as the trigger for incoming interrupt requests.

Table 7–5. IMOD0 and IMOD1 Register Organization

IMOD0	IMOD0.3	0	IMOD0.1	IMOD0.0	Effect of IMOD0 Settings
	0				Select CPU clock for sampling
	1				Select fx/64 sampling clock
			0	0	Rising edge detection
			0	1	Falling edge detection
			1	0	Both rising and falling edge detection
			1	1	IRQ0 flag cannot be set to "1"

IMOD1	0	0	0	IMOD1.0	Effect of IMOD1 Settings
				0	Rising edge detection
				1	Falling edge detection

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EXTERNAL INTERRUPT 0 and 1 MODE REGISTERS (Continued)

When a sampling clock rate of fx/64 is used for INT0, an interrupt request flag must be cleared before 16 machine cycles have elapsed. Since the INT0 pin has a clock-driven noise filtering circuit built into it, please take the following precautions when you use it:

— To trigger an interrupt, the input signal width at INT0 must be at least two times wider than the pulse width of the clock selected by IMOD0. This is true even when the INT0 pin is used for general-purpose input.

— Since the INT0 input sampling clock does not operate during stop or idle mode, you cannot use INT0 to release power-down mode.
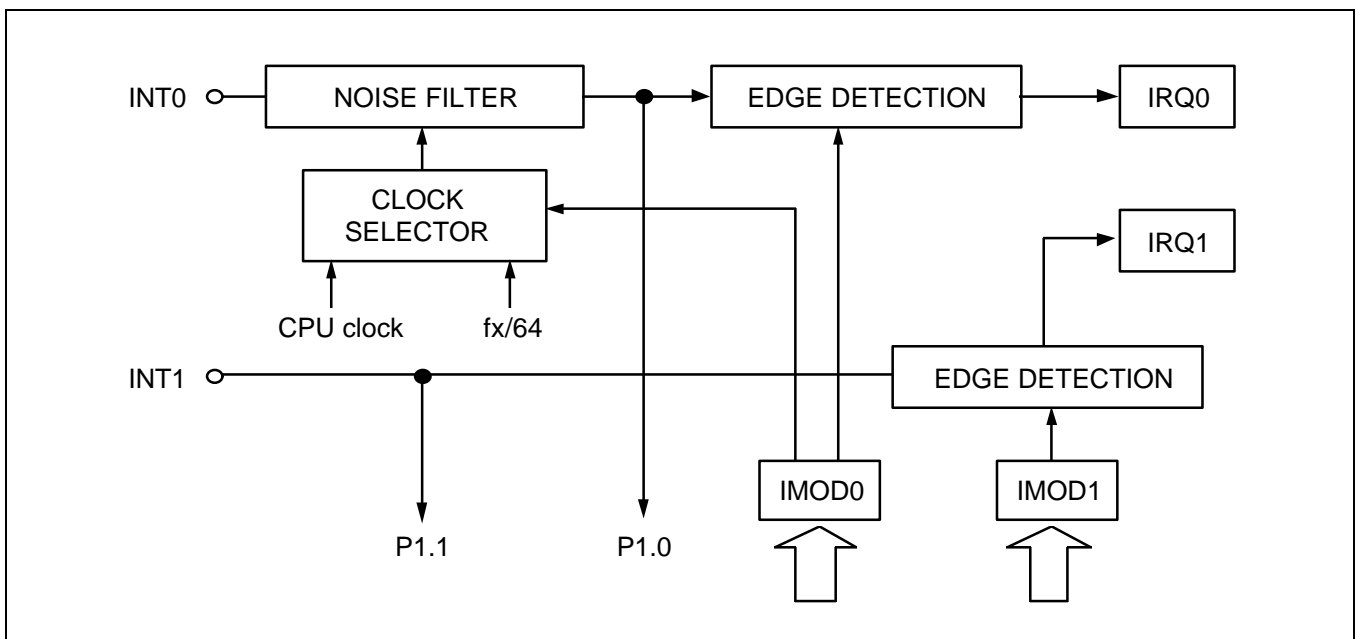
Figure 7–5. Circuit Diagram for INT0 and INT1 Pins

When modifying the IMOD0 and IMOD1 registers, it is possible to accidentally set an interrupt request flag. To avoid unwanted interrupts, take these precautions when writing your programs:

1. Disable all interrupts with a DI instruction.

2. Modify the IMOD0 or IMOD1 register.

3. Clear all relevant interrupt request flags.

4. Enable the interrupt by setting the appropriate IEx flag.

5. Enable all interrupts with an EI instructions.

KEY INTERRUPT MODE REGISTER (IMODK)

The mode register for external interrupts at the KS0–KS2 pins, IMODK, is a 4-bit register at RAM address FB6H. IMODK is addressable only by 4-bit write instructions. RESET clears all IMODK bits to logic zero.

FB6H	"0"	IMODK.2	IMODK.1	IMODK.0
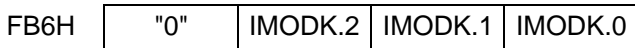
When bits in the IMODK register are set to logic one, INTK uses the falling edge of an incoming signal at corresponding pins as the interrupt request trigger. When a falling edge is detected at any one of the pins KS0–KS2, the IRQK flag is set to logic one and a release signal for power-down mode is generated.

Table 7–6. IMODK Register Bit Settings

IMODK	0	IMODK.2	IMODK.1	IMODK.0	Effect of IMODK Settings
		0	0	0	Disable key interrupt
		0	0	1	Select falling edge at KS0
		0	1	0	Select falling edge at KS1
		0	1	1	Select falling edge at KS0–KS1
		1	0	0	Select falling edge at KS2
		1	0	1	Select falling edge at KS0, KS2
		1	1	0	Select falling edge at KS1–KS2
		1	1	1	Select falling edge at KS0–KS2

NOTES:
1. To generate a key interrupt on a falling edge at KS0–KS2, all KS0–KS2 pins must be configured to input mode.
2. If anyone of the KS0-KS2 pins used for interrupt stays low, a key interrupt is not generated.
   Since all KS0-KS2 pins are ANDed, the falling edge detection circuit cannot detects a falling edge
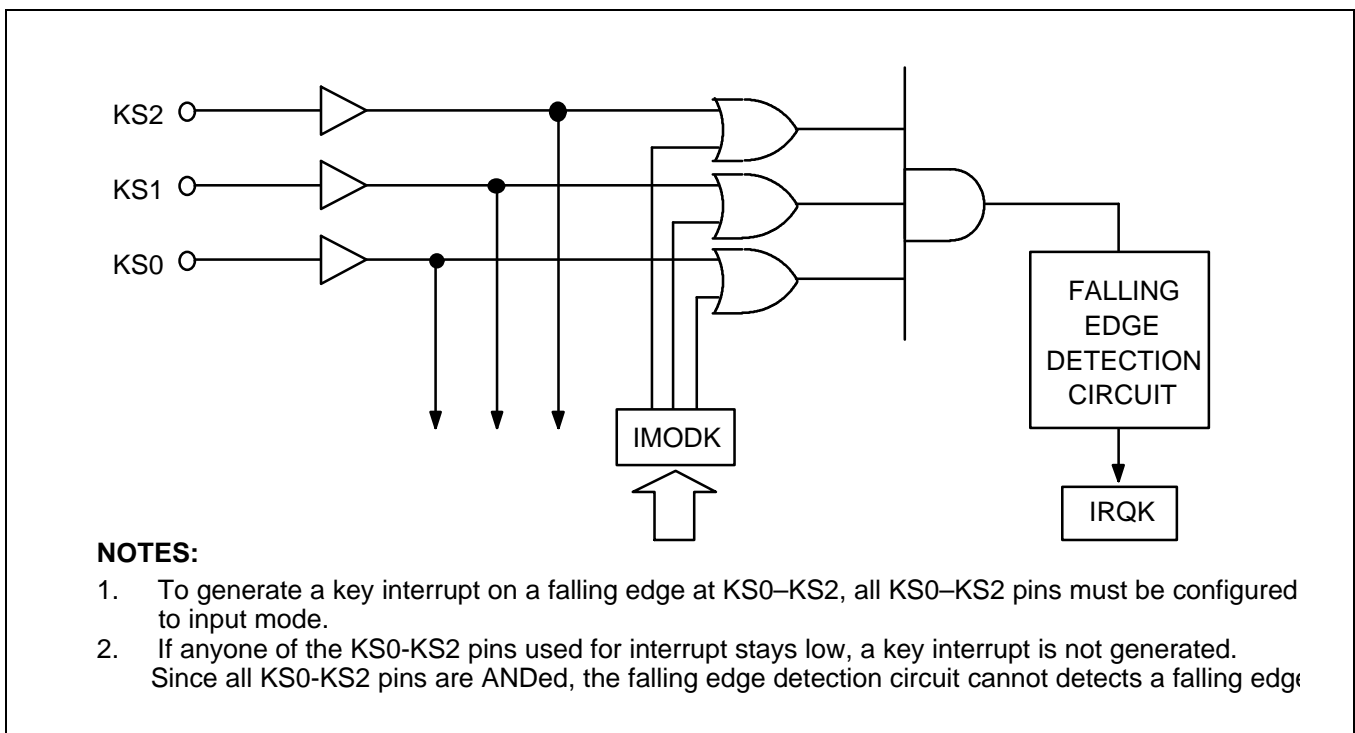
Figure 7–6. Circuit Diagram for KS0–KS2 Pins

☞ **PROGRAMMING TIP — Using INTK as a Key Input Interrupt**

When the INTK interrupt used as a key interrupt, the key interrupt pin must be set to input.

1.   When KS0–KS2 are selected:

```
BITS    EMB
SMB     15
LD      A,#3H
LD      IMODK,A          ;   (IMODK) ← #3H, KS0–KS2 falling edge select
LD      EA,#00H
LD      PMG3,EA          ;   P6 ← Input mode
LD      EA,#40H
LD      PUMOD,EA         ;   Enable P6 pull-up resistors
```

INTERRUPT FLAGS

There are three types of interrupt flags: interrupt request and interrupt enable flags that correspond to each interrupt, the interrupt master enable flag, which enables or disables all interrupt processing.

Interrupt Master Enable Flag (IME)

The interrupt master enable flag, IME, enables or disables all interrupt processing. Therefore, even when an IRQx flag is set and its corresponding IEx flag is enabled, the interrupt service routine is not executed until the IME flag is set to logic one.

The IME flag is located in the IPR register (IPR.3), and is mapped to bit address FB2H.3. It can be directly be manipulated by EI and DI instructions, regardless of the current value of the enable memory bank flag (EMB).

Interrupt Enable Flags (IEx)

IEx flags, when set to logic one, enable specific interrupt requests to be serviced. When the interrupt request flag is set to logic one, an interrupt will not be serviced until its corresponding IEx flag is also enabled.

Interrupt enable flags are mapped to the RAM address area FB8H–FBFH, and can be read, written, or tested directly by 1-bit instructions (BITS and BITR). IEx flags can be addressed directly at their specific RAM addresses, despite the current value of the enable memory bank (EMB) flag.

Interrupt Request Flags (IRQx)

Interrupt request flags, located in the RAM area FB8H-FBFH, are read/write addressable by 1-bit or 4-bit instructions. IRQx flags can be addressed directly at their specific RAM addresses, regardless of the current value of the enable memory bank (EMB) flag.

When a specific IRQx lag is set to logic one, the corresponding interrupt request is generated. The flag is then automatically cleared to logic zero by hardware when the interrupt has been serviced. Exceptions are the watch timer interrupt request flag, IRQW, and key interrupt request flag IRQK, which must be cleared by software after the interrupt service routine has executed. IRQx flags are also used to execute interrupt requests from software. In summary, follow these guidelines for using IRQx flags:

1. IRQx is set to request an interrupt when an interrupt meets the set condition for interrupt generation.

2. IRQx is set to "1" by hardware and then cleared by hardware when the interrupt has been serviced (with the exception of IRQW and IRQ2).

3. When IRQx is set to "1" by software, an interrupt is generated.

INTERRUPT MASTER ENABLE FLAG (IME)

The interrupt master enable flag, IME, inhibits or enables all interrupt processing. Therefore, even when an IRQx flag and its corresponding IEx flag is enabled, an interrupt request will not be serviced until the IME flag is set to logic one. The IME flag is the most significant bit of the 4-bit IPR register at RAM location FB2H.

IME	IPR.2	IPR.1	IPR.0	Effect of Bit Settings
0				Inhibit all interrupts
1				Enable all interrupts

You can manipulate the IME flag using EI and DI instructions, despite the current value of the enable memory bank (EMB) flag.

INTERRUPT ENABLE FLAGS (IEx)

Interrupt enable flags are used to control the execution of service routines for specific interrupt requests. The enable flag has priority over a request flag — even if the IRQx flag is enabled, the interrupt request will not be serviced until the corresponding IEx flag is set to logic one.

Using 1-bit or 4-bit instructions and direct addressing, you can read, write, or test IEx (and IRQx) flags despite the current enable memory bank (EMB) value. The IEx and IRQx flags are mapped to RAM area FB8H–FBFH.

Table 7–7. Interrupt Enable and Interrupt Request Flag Addresses

Address	Bit 3	Bit 2	Bit 1	Bit 0
FB8H	0	0	IEB	IRQB
FBAH	0	0	IEW	IRQW
FBBH	0	0	0	0
FBCH	0	0	IET0	IRQT0
FBDH	0	0	IES	IRQS
FBEH	IE1	IRQ1	IE0	IRQ0
FBFH	0	0	IEK	IRQK

NOTES:
1. IEx refers generically to all interrupt enable flags.
2. IRQx refers generically to all interrupt request flags.
3. IEx = 0 is interrupt disable mode.
4. IEx = 1 is interrupt enable mode.

INTERRUPT REQUEST FLAGS (IRQx)

When an interrupt request flag (IRQx) is set, a software-generated interrupt is enabled for the corresponding interrupt. IRQx flags can be written by 1- or 4-bit RAM control instructions. IRQx flags are then cleared automatically when the interrupt has been serviced. Exceptions to the general rule are the watch timer interrupt request flag, IRQW and key interrupt request flag, IRQK; they must be cleared by software after the interrupt service routine has executed.

Table 7–8. Interrupt Request Flag Conditions and Priorities

Interrupt Source	Internal / External	Pre-condition for IRQx Flag Setting	Interrupt Priority	IRQx Flag Name
INTB	I	Reference time interval signal from basic timer	1	IRQB
INT0	E	Rising or falling edge detected at INT0 pin	2	IRQ0
INT1	E	Rising or falling edge detected at INT1 pin	3	IRQ1
INTS	I	Completion signal for serial transmit-and-receive or receive-only operation	4	IRQS
INTT0	I	Signals for TCNT0 and TREF0 registers coincide	5	IRQT0
INTK ∗	E	Falling edge is detected at any one of the KS0–KS2 pins	—	IRQK
INTW ∗	I	Time interval of 0.5 secs or 3.19 msecs	—	IRQW

∗   INTK and INTW are quasi-interrupts and INTK is used only for testing incoming signals.

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8 POWER-DOWN

OVERVIEW

The KS57C0502/C0504 microcontroller has two power-down modes to reduce power consumption: idle and stop. Idle mode is initiated by the IDLE instruction and stop mode by the instruction STOP. (Several NOP instructions must always follow an IDLE or STOP instruction in a program.) In idle mode, the CPU clock stops while peripherals and the oscillation source continue to operate normally.

When RESET occurs during normal operation or during a power-down mode, a reset operation is initiated and the CPU enters idle mode. When the standard oscillation stabilization time interval (31.3 ms at 4.19 MHz) has elapsed, normal CPU operation resumes.

In stop mode, system clock oscillation is halted (assuming it is currently operating), and peripheral hardware components are powered-down. The effect of stop mode on specific peripheral hardware components — CPU, basic timer, serial I/O, timer/ counters 0, and watch timer — and on external interrupt requests, is detailed in Table 8–1.

NOTE

Do not use stop mode if you are using an external clock source because X_{in} input must be restricted internally to V_{SS} to reduce current leakage.

Idle or stop modes are terminated either by a RESET, or by an interrupt with the exception of INT0, which are enabled by the corresponding interrupt enable flag, IEx. When power-down mode is terminated by RESET input, a normal reset operation is executed. Assuming that both the interrupt enable flag and the interrupt request flag are set to "1", power-down mode is released immediately upon entering power-down mode.

When an interrupt is used to release power-down mode, the operation differs depending on the value of the interrupt master enable flag (IME):

— If the IME flag = "0", program execution is started immediately after the instruction which issues the request to enter power-down mode. The interrupt request flag remains set to logic one.

— If the IME flag = "1", two instructions are executed after the power-down mode release. Then, the vectored interrupt is initiated. However, when the release signal is caused by INTK or INTW, the operation is identical to the IME = 0 condition. That is, a vector interrupt is not generated.

Table 8–1. Hardware Operation During Power-Down Modes

Operation	Stop Mode (STOP)	Idle Mode (IDLE)
Clock oscillator	System clock oscillation stops	CPU clock oscillation stops (system clock oscillation continues)
Basic timer	Basic timer stops	Basic timer operates (with IRQB set at each reference interval)
Serial interface	Operates only if external SCK input is selected as the serial I/O clock	Operates if a clock other than the CPU clock is selected as the serial I/O clock
Timer/counter 0	Operates only if TCL0 is selected as the counter clock	Timer/counter 0 operates
Comparator	Comparator operation is stopped	Comparator operates
Watch timer	Watch timer operation is stopped	Watch timer operates
External interrupts	INT1 and INTK are acknowledged; INT0 is not serviced	INT1 and INTK are acknowledged; INT0 is not serviced
CPU	All CPU operations are disabled	All CPU operations are disabled
Power-down mode release signal	Interrupt request signals (except INT0) are enabled by an interrupt enable flag or by RESET input	Interrupt request signals (except INT0) are enabled by an interrupt enable flag or by RESET input

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IDLE MODE TIMING DIAGRAMS
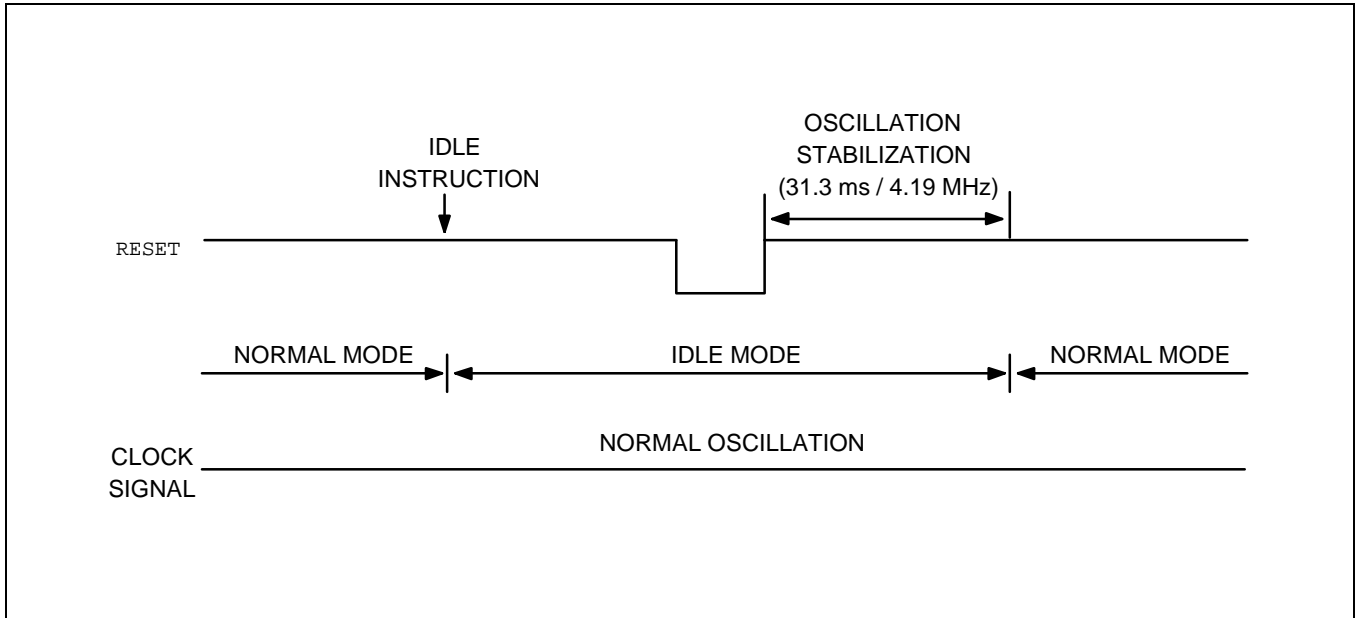
Figure 8–1. Timing When Idle Mode is Released by RESET
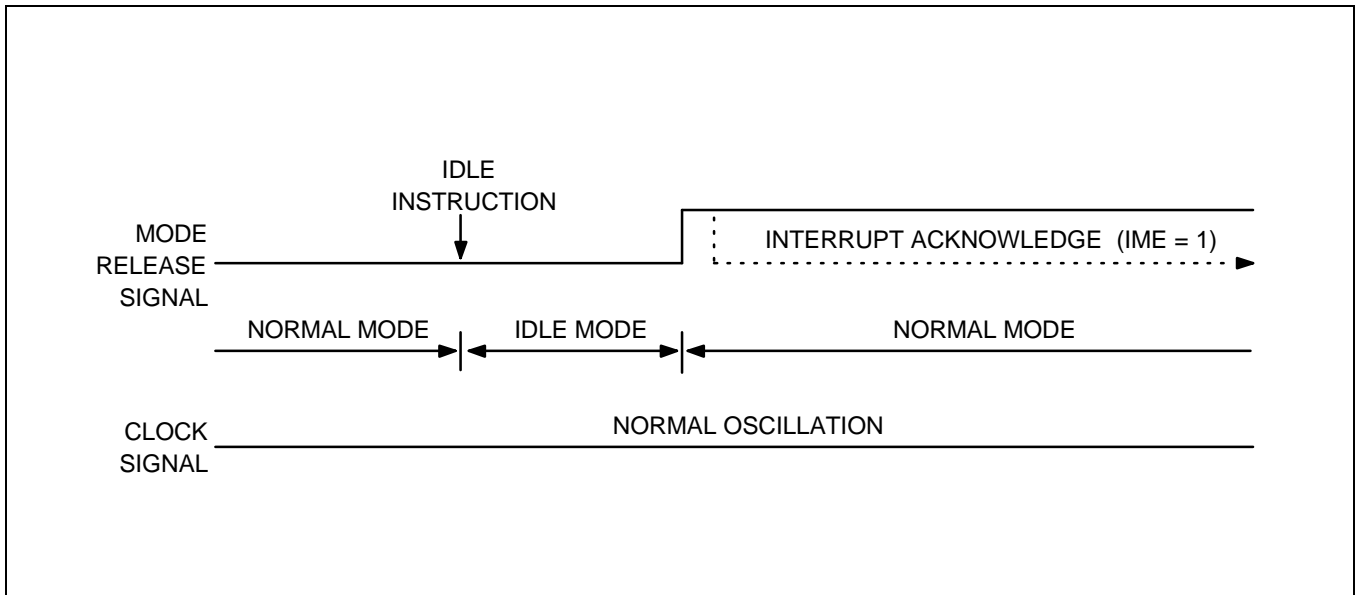
Figure 8–2. Timing When Idle Mode is Released by an Interrupt

STOP MODE TIMING DIAGRAMS
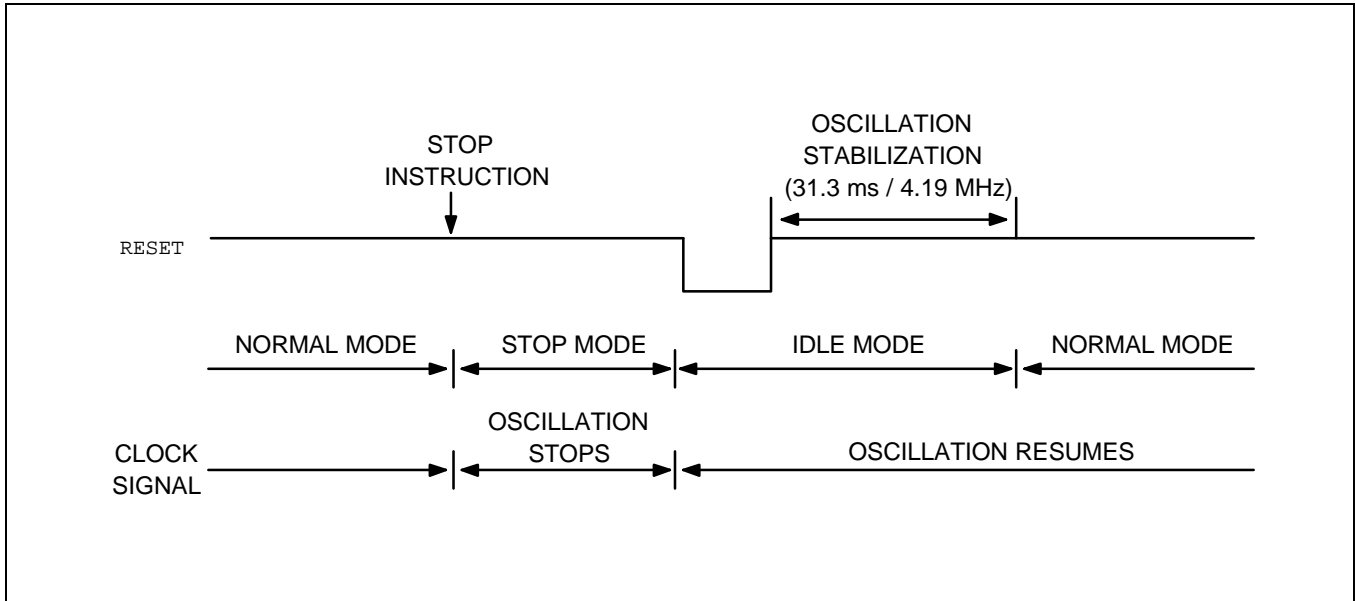
Figure 8–3. Timing When Stop Mode is Released by RESET
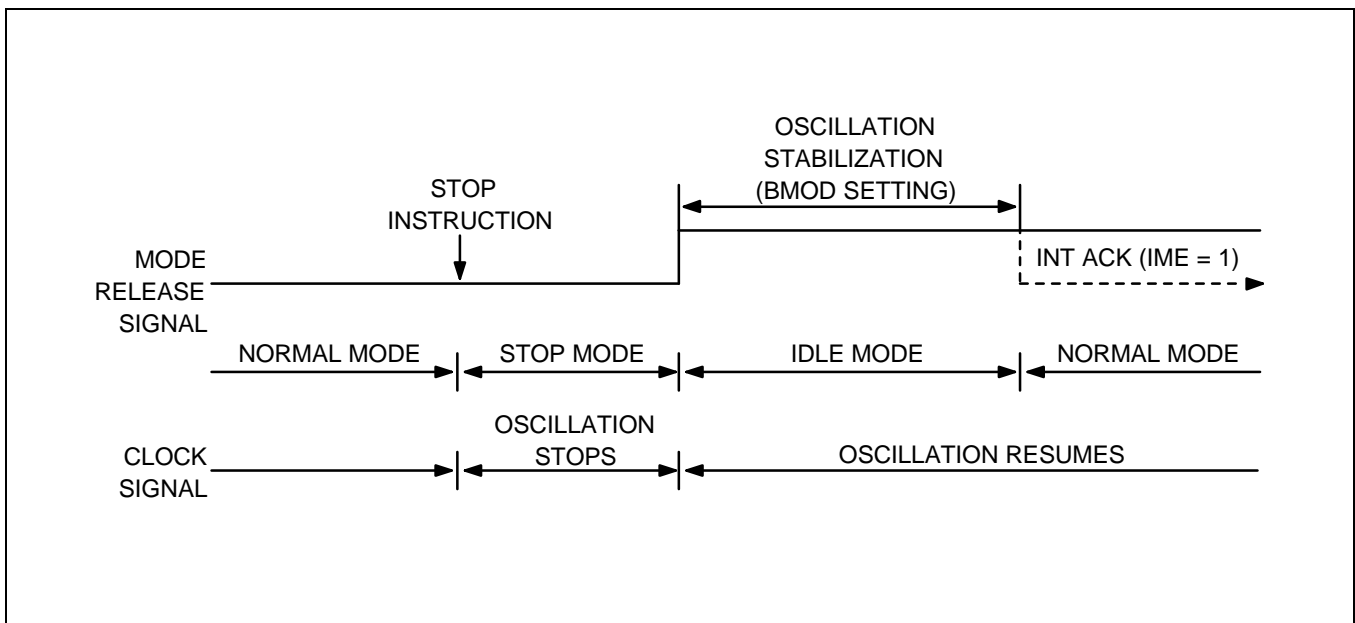
Figure 8–4. Timing When Stop Mode is Release by an Interrupt

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I/O PORT PIN CONFIGURATION FOR POWER-DOWN

The following method describes how to configure I/O port pins to reduce power consumption during power-down modes (stop, idle):

Condition 1:   If the microcontroller is not configured to an external device:

1. Connect unused port pins according to the information in Table 8–2.

2. Disable all pull-up resistors for output pins by making the appropriate modifications to the pull-up resistor mode register, PUMOD. Reason: If output goes low when the pull-up resistor is enabled, there may be un-expected surges of current through the pull-up.

3. Disable pull-up resistors for input pins configured to V_{DD} or V_{SS} levels in order to check the current input option. Reason: If the input level of a port pin is set to V_{SS} when a pull-up resistor is enabled, it will draw an unnecessarily large current.

Condition 2:   If the microcontroller is configured to an external device and the external device's V_{DD} source is turned off in power-down mode.

1. Connect unused port pins according to the information in Table 8–2.

2. Disable the pull-up resistors of output pins by making the appropriate modifications to the pull-up resistor mode register, PUMOD. Reason: If output goes low when the pull-up resistor is enabled, there may be un-expected surges of current through the pull-up.

3. Disable pull-up resistors for input pins configured to V_{DD} or V_{SS} levels in order to check the current input option. Reason: If the input level of a port pin is set to V_{SS} when a pull-up resistor is enabled, it will draw an unnecessarily large current.

4. Disable the pull-up resistors of input pins connected to the external device by making the necessary modifications to the PUMOD register.

5. Configure the output pins that are connected to the external device to low level. Reason: When the external device's V_{DD} source is turned off, and if the microcontroller's output pins are set to high level, V_{DD} – 0.7 V is supplied to the V_{DD} of the external device through its input pin. This causes the device to operate at the level V_{DD} – 0.7 V. In this case, total current consumption would not be reduced.

6. Determine the correct output pin state necessary to block current pass in according with the external transistors (PNP, NPN).

RECOMMENDED CONNECTIONS FOR UNUSED PINS

To reduce overall power consumption, please configure unused pins according to the guidelines described in Table 8–2.

Table 8–2. Unused Pin Connections for Reduced Power Consumption

Pin/Share Pin Names	Recommended Connection
P0.0 / SCK P0.1 / SO P0.2 / SI	Input mode: Connect to V_{DD} Output mode: Do not connect
P1.0 / INT0 – P1.1 / INT1	Connect to V_{DD}
P2.0 / CIN0 P2.1 / CIN1 P2.2 / CIN2 P2.3 / CIN3	Connect to V_{DD}
P3.0 / TCLO0 P3.1 / TCLO1 P3.2 / CLO P3.3 / BUZ P4.0–P4.3 P5.0–P5.3 P6.0 / KS0 – P6.3 / BUZ	Input mode: Connect to V_{DD} Output mode: Do not connect

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9 RESET

OVERVIEW

When a RESET signal is input during normal operation or power-down mode, a reset operation is initiated and the CPU enters idle mode. Then, when the standard oscillation stabilization interval of 31.3 ms at 4.19 MHz has elapsed, normal system operation resumes.

Regardless of when the RESET occurs — during normal operating mode or during power-down mode — the effect on most hardware register values is almost identical. The exceptions are as follows:

— Carry flag

— Data memory values

— General-purpose registers E, A, L, H, X, W, Z, and Y

— Serial I/O buffer register (SBUF)

If a RESET occurs during idle or stop mode, the current values in these registers are retained. Otherwise, their values are undefined.
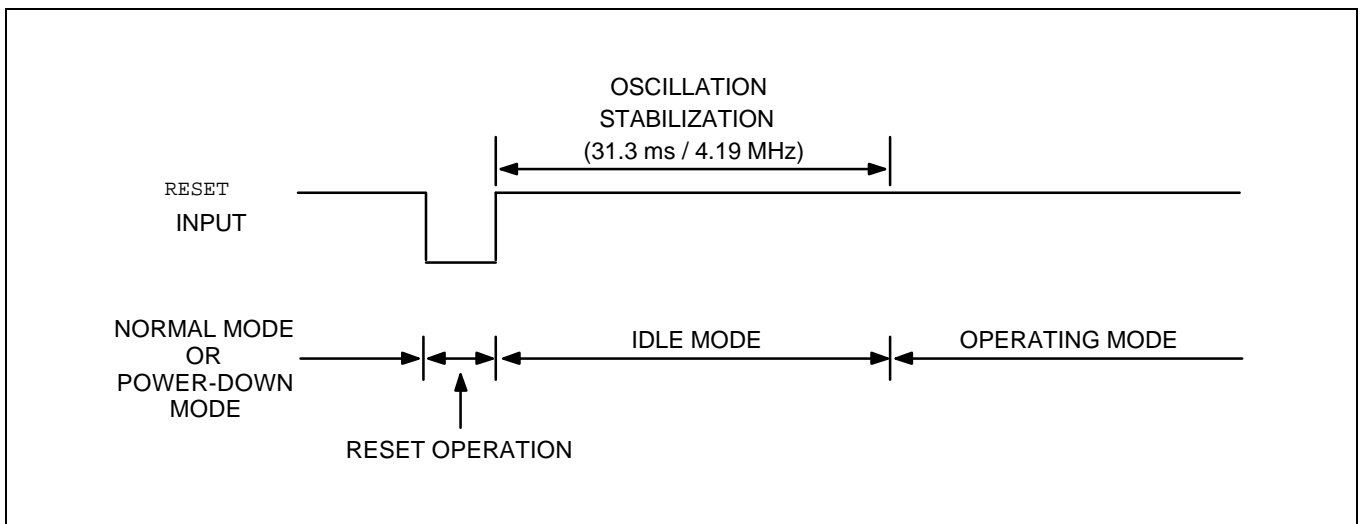
Figure 9–1. Timing for Oscillation Stabilization After RESET

HARDWARE REGISTER VALUES AFTER RESET

Table 9–1 gives you detailed information about hardware register values after a RESET occurs during power-down mode or during normal operation.

Table 9-1. Hardware Register Values After RESET

Hardware Component or Subcomponent	If RESET Occurs During Power-Down Mode	If RESET Occurs During Normal Operation
Program counter (PC)	Lower three bits of address 0000H are transferred to PC11-8, and the contents of 0001H to PC7-0.	Lower three bits of address 0000H are transferred to PC11-8, and the contents of 0001H to PC7-0.
Program Status Word (PSW):		
Carry flag (C)	Retained	Undefined
Skip flag (SC0-SC2)	0	0
Interrupt status flags (IS0, IS1)	0	0
Bank enable flags (EMB, ERB)	Bit 6 of address 0000H in program memory is transferred to the ERB flag, and bit 7 of the address to the EMB flag.	Bit 6 of address 0000H in program memory is transferred to the ERB flag, and bit 7 of the address to the EMB flag.
Stack pointer (SP)	Undefined	Undefined
Data Memory (RAM):		
General registers E, A, L, H, X, W, Z, Y	Values retained	Undefined
General-purpose registers	Values retained (Note)	Undefined
Bank selection registers (SMB, SRB)	0, 0	0, 0
BSC register (BSC0-BSC3)	0	0
Clocks:		
Power control register (PCON)	0	0
Clock output mode register (CLMOD)	0	0
Interrupts:		
Interrupt request flags (IRQx)	0	0
Interrupt enable flags (IEx)	0	0
Interrupt priority flag (IPR)	0	0
Interrupt master enable flag (IME)	0	0
INT0 mode register (IMOD0)	0	0
INT1 mode register (IMOD1)	0	0
INTK mode register (IMODK)	0	0

NOTE: The values of the 0F8H-0FDH are not retained when a RESET signal is input

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Table 9–1. Hardware Register Values After RESET (Continued)

Hardware Component or Subcomponent	If RESET Occurs During Power-Down Mode	If RESET Occurs During Normal Operation
I/O Ports:		
Output buffers	Off	Off
Output latches	0	0
Port mode flags (PM)	0	0
Pull-up resistor mode reg (PUMOD)	0	0
Port 2 mode register (PWMOD)	0	0
Port open-drain enable register (PNE)	0	0
Watch-dog Timer:		
WDT mode register (WDMOD)	A5H	A5H
WDT clear flag (WDTCF)	0	0
Basic Timer:		
Count register (BCNT)	Undefined	Undefined
Mode register (BMOD)	0	0
Timer/Counter 0:		
Count registers (TCNT0)	0	0
Reference registers (TREF0)	FFH, FFFFH	FFH, FFFFH
Mode registers (TMOD0)	0	0
Output enable flags (TOE0)	0	0
Watch Timer:		
Watch timer mode register (WMOD)	0	0
Comparator		
Comparator mode register (CMOD)	0	0
Comparison result register	Undefined	Undefined
Serial I/O Interface:		
SIO mode register (SMOD)	0	0
SIO interface buffer (SBUF)	Values retained	Undefined

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NOTES

10 I/O PORTS

OVERVIEW

The KS57C0502/C0504 has two input ports and five I/O ports. Pin addresses for all I/O ports are mapped to locations FF0H–FF6H in bank 15 of the RAM. The contents of I/O port pin latches can be read, written, or tested at the corresponding address using bit manipulation instructions.

There are total of 6 input pins and 18 configurable I/O pin, including 8 high current I/O pins for a maximum number of 24 I/O pins.

Port Mode Flags

Port mode flags (PM) are used to configure I/O ports 0 and 3 (port mode group 1), port 4 (port mode group 2), and ports 5 and 6 (port mode group 3) to input or output mode by setting or clearing the corresponding I/O buffer. PM flags are stored in three 8-bit registers in RAM area FE8H–FEDH, and are addressable by 8-bit write instructions only.

Port 2 Mode Register

Port 2 (P2.0–P2.3) can be used as either for analog input or for digital input. P2MOD register settings determines port 2 mode (analog or digital input) for specific port 2 pins.

Pull-Up Resistors

Pull-up resistors are assignable to input pins of ports 0, 1, 3, 4, 5 and 6. When a configurable I/O port pin serves as an output pin, its assigned pull-up resistor is automatically disabled, even though the pin's pull-up resistor is enabled by a corresponding bit setting in the pull-up resistor mode register (PUMOD).

PUMOD Control Register

The pull-up mode register (PUMOD) is an 8-bit register used to assign internal pull-up resistors by software to specific I/O ports.

When a configurable I/O port pin is used as an output pin, its assigned pull-up resistor is automatically disabled, even though the pin's pull-up is enabled by a corresponding PUMOD bit setting.

PUMOD is mapped to RAM address FDCH–FDDH and is addressable by 8-bit write instructions only. RESET clears PUMOD register values to logic zero, automatically disconnecting all software-assignable port pull-up resistors.

Table 10–1. I/O Port Overview

Port	I/O	Pins	Pin Names	Address	Function Description
0	I/O	3	P0.0–P0.2	FF0H	3-bit I/O port. 1-bit and 3-bit read/write and test is possible. Individual pins are software configurable as input or output. 3-bit pull-up resistors are assignable by software.
1	I	2	P1.0–P1.1	FF1H	2-bit input port. 1-bit and 2-bit read and test is possible. 2-bit pull-up resistors are software assignable.
2	I	4	P2.0–P2.3	FF2H	4-bit analog or digital input port. 1-bit or 4-bit read and test possible.
3	I/O	3	P3.0–P3.2	FF3H	Same as port 0.
4, 5	I/O	8	P4.0–P4.3 P5.0–P5.3	FF4H FF5H	4-bit I/O ports. 1-, 4-, and 8-bit read/write/test is possible. Pins are individually configurable as input or output. Ports 4 and 5 can be paired to support 8-bit data transfer. 4-bit pull-up registers are software assignable to input pins and are automatically disabled for output pins. The N-channel open drain or push-pull output can be selected by software (1-bit unit)
6	I/O	4	P6.0–P6.3	FF6H	4-bit I/O ports. Pins are individually software configurable as input or output. 1-bit and 4-bit read/write/test is possible. 4-bit pull-up resistors are software assignable.

Table 10–2. I/O Port Pin Status During Instruction Execution

Instruction Type	Example		Input Mode Status	Output Mode Status
1-bit test 1-bit input 4-bit input 8-bit input	BTST LDB LD LD	P0.1 C,P1.3 A,P6 EA,P4	Input or test data at each pin	Input or test data at output latch
1-bit output	BITR	P3.0	Output latch contents undefined	Output pin status is modified
4-bit output 8-bit output	LD LD	P2,A P6,EA	Transfer accumulator data to the output latch	Transfer accumulator data to the output pin

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PORT MODE FLAGS (PM FLAGS)

Port mode flags (PM) are used to configure I/O ports 0 and 3–6 to input or output mode by setting or clearing the corresponding I/O buffer. PM flags are stored in three 8-bit registers in RAM area FE8H–FEDH, and are addressable by 8-bit write instructions only.

For convenient program reference, PM flags are organized into three groups — PMG1, PMG2, and PMG3, as shown in Table 10–3.

Table 10–3. Port Mode Groups and Corresponding I/O Ports

Port Mode Group ID	Corresponding I/O Ports	Port Mode Group Address
PMG1	Ports 0 and 3	FE8H–FE9H
PMG2	Port 4	FEAH–FEBH
PMG3	Ports 5 and 6	FECH–FEDH

When a PM flag is "0", the port is set to input mode; when it is "1", the port is enabled for output. RESET clears all port mode flags to logic zero, automatically configuring the corresponding I/O ports to input mode.

Table 10–4. Port Mode Flag Map

PM Group ID	Address	Bit 3	Bit 2	Bit 1	Bit 0
PMG1	FE8H	"0"	PM0.2	PM0.1	PM0.0
	FE9H	"0"	PM3.2	PM3.1	PM3.0
PMG2	FEAH	PM4.3	PM4.2	PM4.1	PM4.0
	FEBH	"0"	"0"	"0"	"0"
PMG3	FECH	PM5.3	PM5.2	PM5.1	PM5.0
	FEDH	PM6.3	PM6.2	PM6.1	PM6.0

NOTE: If bit = "0", the corresponding I/O pin is set to input mode. If bit = "1", the pin is set to output mode. All flags are cleared to "0" following RESET.

☞ **PROGRAMMING TIP — Configuring I/O Ports as Input or Output**

Configure P0.0 and P3.0 as an output port and the other ports as input ports:

```
BITS      EMB
SMB       15
LD        EA,#11H
LD        PMG1,EA           ;    P0.0 and P3.0 ← Output
LD        EA,#00H
LD        PMG2,EA           ;    P4 ← Input
LD        EA,#00H
LD        PMG3,EA           ;    P5, P6 ← Input
```

PORT 2 MODE REGISTER (P2MOD)

P2MOD register settings determine if port 2 is used either for analog input or for digital input. P2MOD register is 4-bit write only register. P2MOD is mapped to address FE2H and initialized to zero by a RESET, configuring port 2 as an analog input port.

FE2H	P2MOD.3	P2MOD.2	P2MOD.1	P2MOD.0

When bit is set to "1", the corresponding pin is configured as a digital input pin. When set to "0", configured as an analog input pin: P2MOD.0 for P2.0, P2MOD.1 for P2.1, P2MOD.2 for P2.2, and P2MOD.3 for P2.3.

PULL-UP RESISTOR MODE REGISTER (PUMOD)

The pull-up resistor mode register (PUMOD) is an 8-bit register used to assign internal pull-up resistors by software to specific I/O ports. When a configurable I/O port pin is used as an output pin, its assigned pull-up resistor is automatically disabled, even though the pin's pull-up is enabled by a corresponding PUMOD bit setting.

PUMOD is mapped to RAM address FDCH–FDDH and is addressable by 8-bit write instructions only. RESET clears PUMOD register values to logic zero, automatically disconnecting all software-assignable port pull-up resistors.

Table 10–5. Pull-Up Resistor Mode Register (PUMOD) Organization

Address	Bit 3	Bit 2	Bit 1	Bit 0
FDCH	PUMOD.3	"0"	PUMOD.1	PUMOD.0
FDDH	"0"	PUMOD.6	PUMOD.5	PUMOD.4

NOTE: When bit = "1", a pull-up resistor is assigned to the corresponding I/O port: PUMOD.3 for port 3, PUMOD.6 for port 6, and so on.

N-CHANNEL OPEN-DRAIN ENABLE REGISTER (PNE)

	Address	Bit 3	Bit 2	Bit 1	Bit 0
PNE	FDAH	PNE4.3	PNE4.2	PNE4.1	PNE4.0
	FDBH	PNE5.3	PNE5.2	PNE5.1	PNE5.0

The N-channel, open-drain mode register, PNE, is used to configure ports 4 and 5 to n-channel, open-drain mode or as push-pull outputs.

When a bit in the PNE register is set to "1", the corresponding output pin is configured to n-channel, open-drain; when set to "0", the output pin is configured to push-pull; PNE4.3 for P4.3, PNE4.2 for P4.2, PNE4.1 for P4.1, PNE4.0 for P4.0, PNE5.3 for P5.3, PNE5.2 for P5.2, PNE5.1 for P5.1 and PNE5.0 for P5.0.

☞ **PROGRAMMING TIP — Enabling and Disabling I/O Port Pull-Up Resistors**

P6 enable pull-up resistors, P0, P1, P3, P4 and P5 disable pull-up resistors.

```
BITS      EMB
SMB       15
LD        EA,#40H
LD        PUMOD,EA          ;    P6 enable
```

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PORT 0 CIRCUIT DIAGRAM
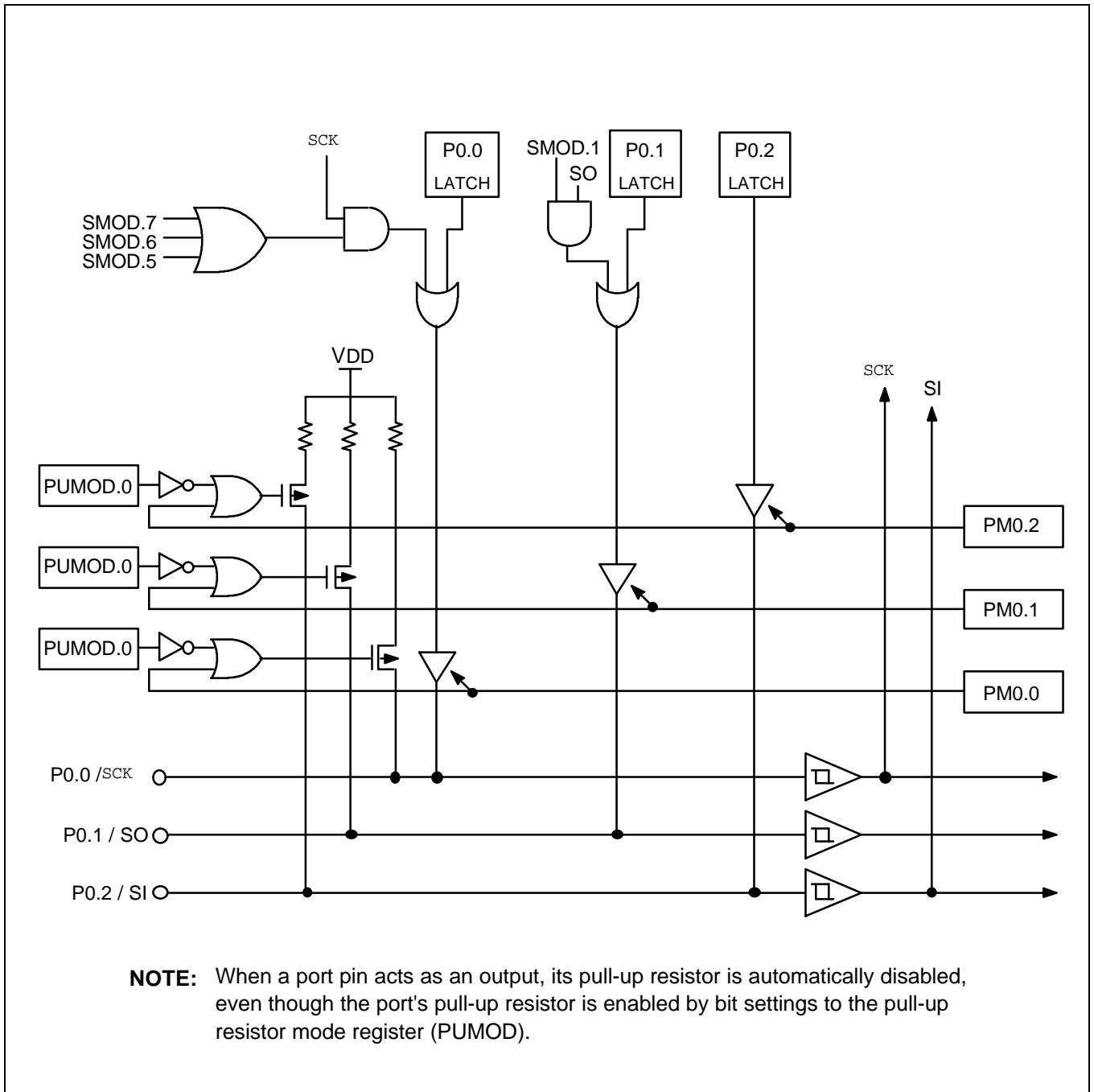
Figure 10–1. I/O Port 0 Circuit Diagram

NOTE: When a port pin acts as an output, its pull-up resistor is automatically disabled, even though the port's pull-up resistor is enabled by bit settings to the pull-up resistor mode register (PUMOD).

PORT 1 CIRCUIT DIAGRAM
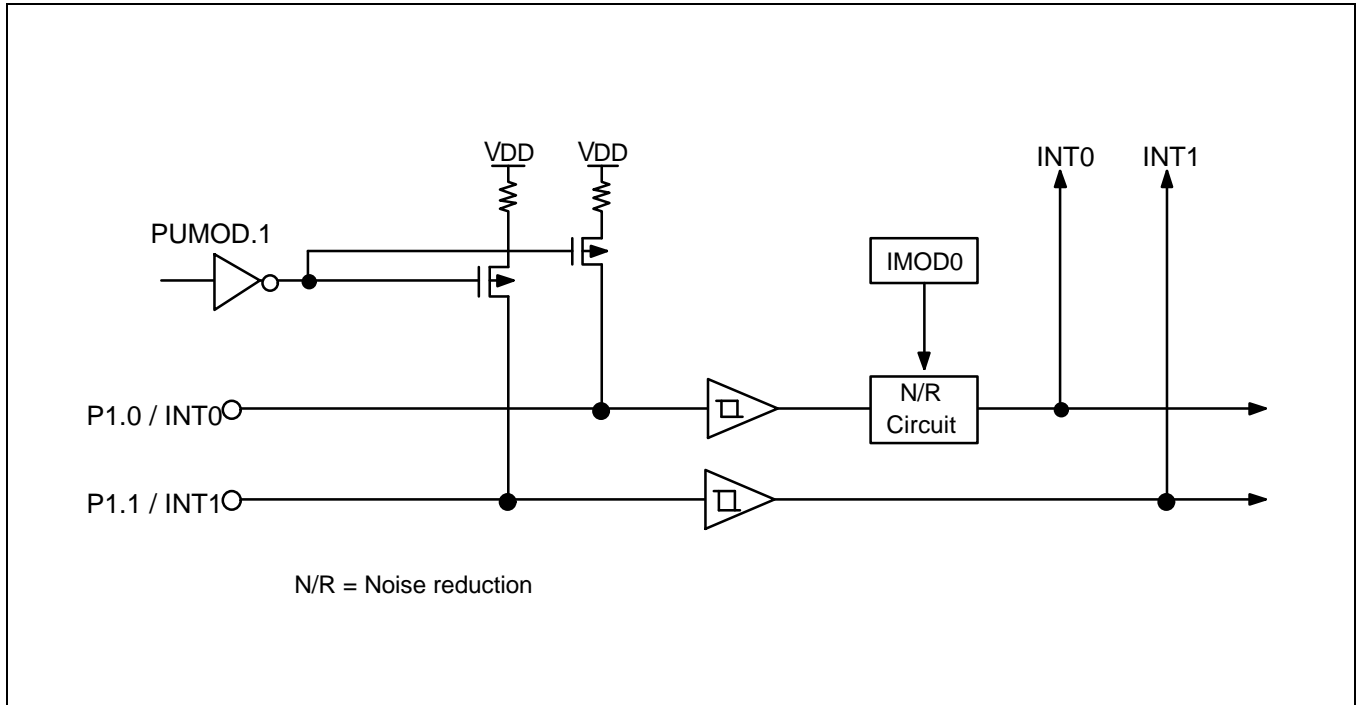
Figure 10–2. Input Port 1 Circuit Diagram

PORT 2 CIRCUIT DIAGRAM
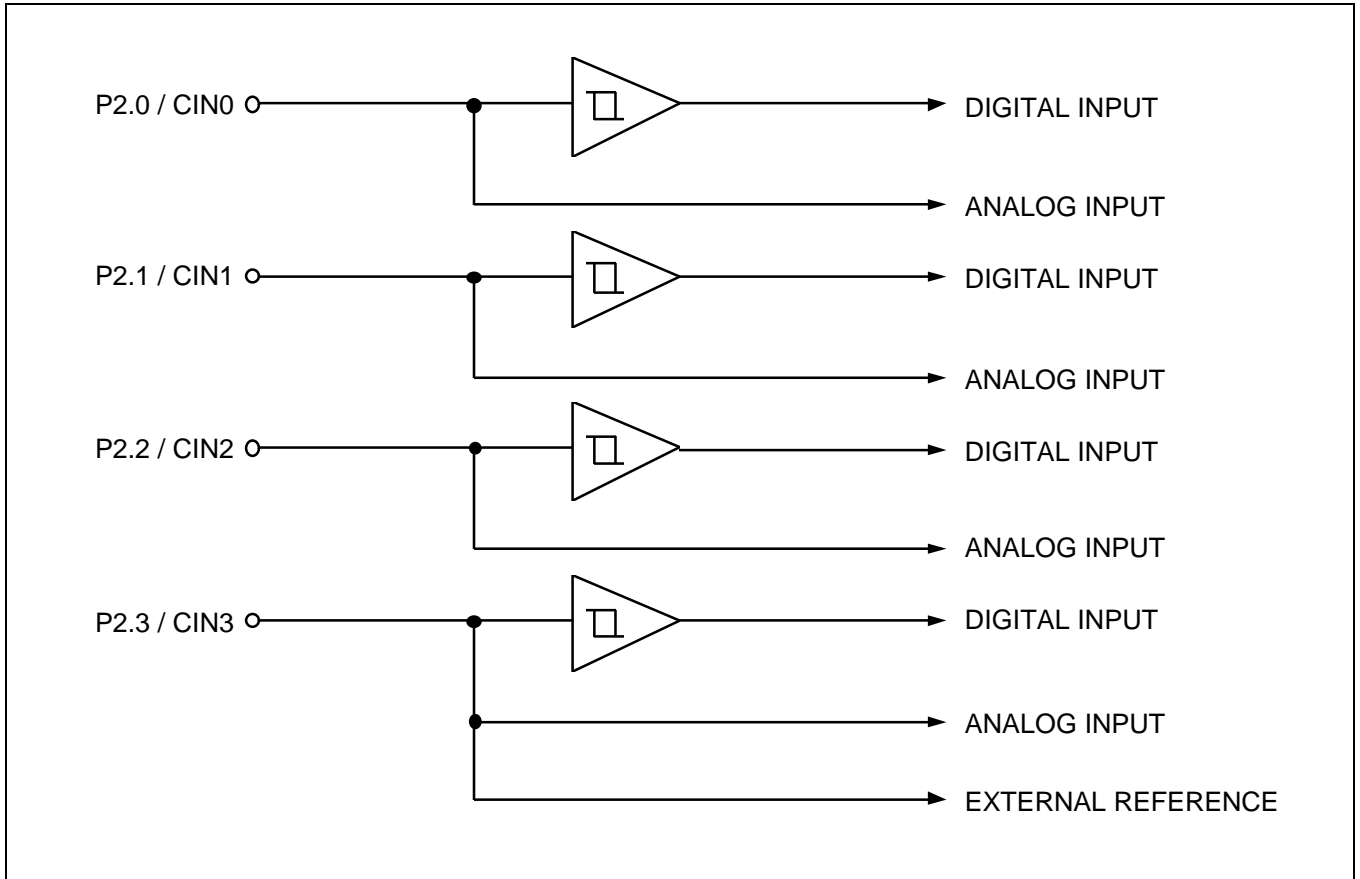
Figure 10–3. Port 2 Circuit Diagram

PORT 3 CIRCUIT DIAGRAM

NOTE: When a port pin acts as an output, its pull-up resistor is automatically disabled,
even though the port's pull-up resistor is enabled by bit settings to the pull-up
resistor mode register (PUMOD).
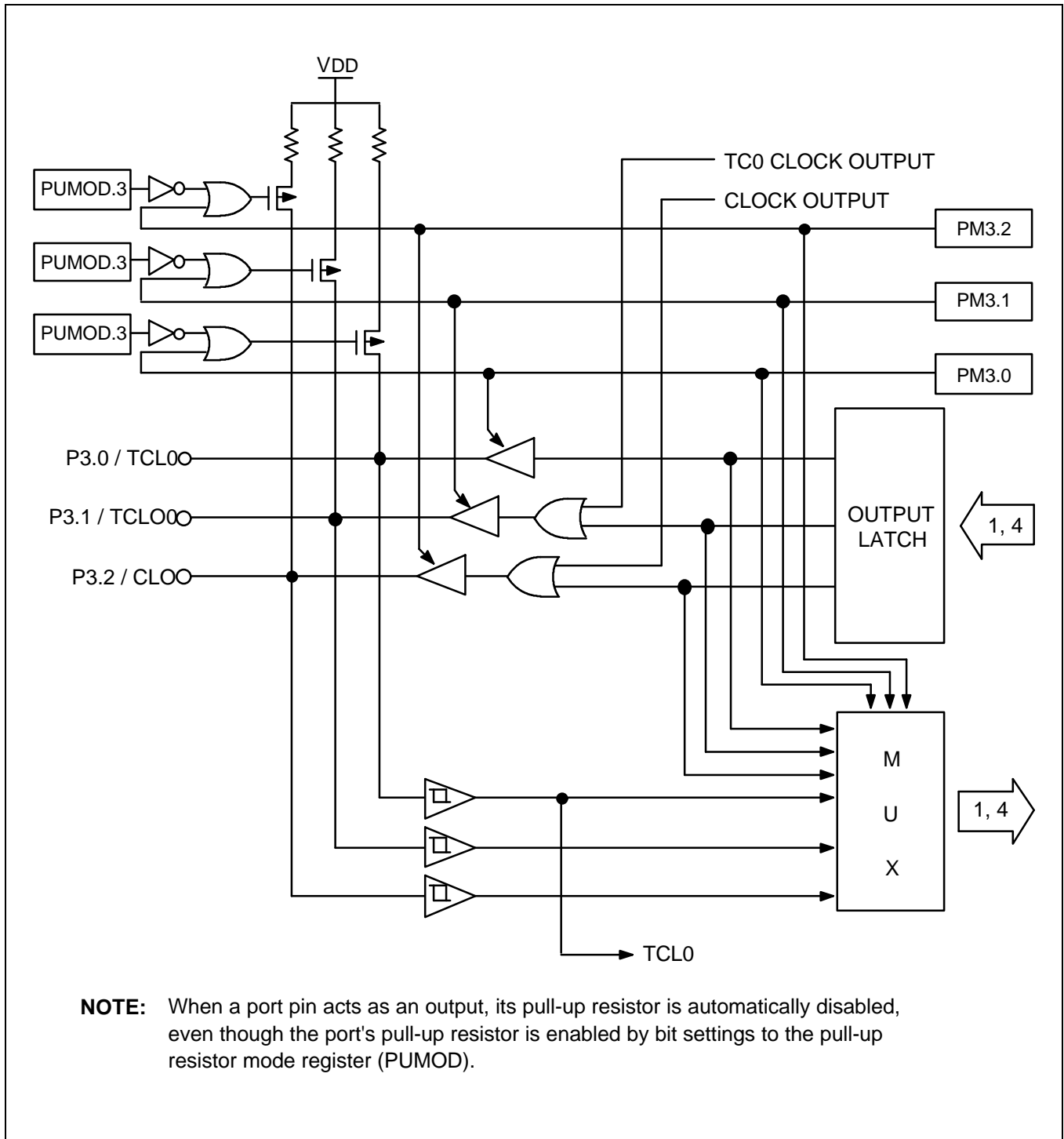
Figure 10–4. Port 3 Circuit Diagram

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PORTS 4 AND 5 CIRCUIT DIAGRAM
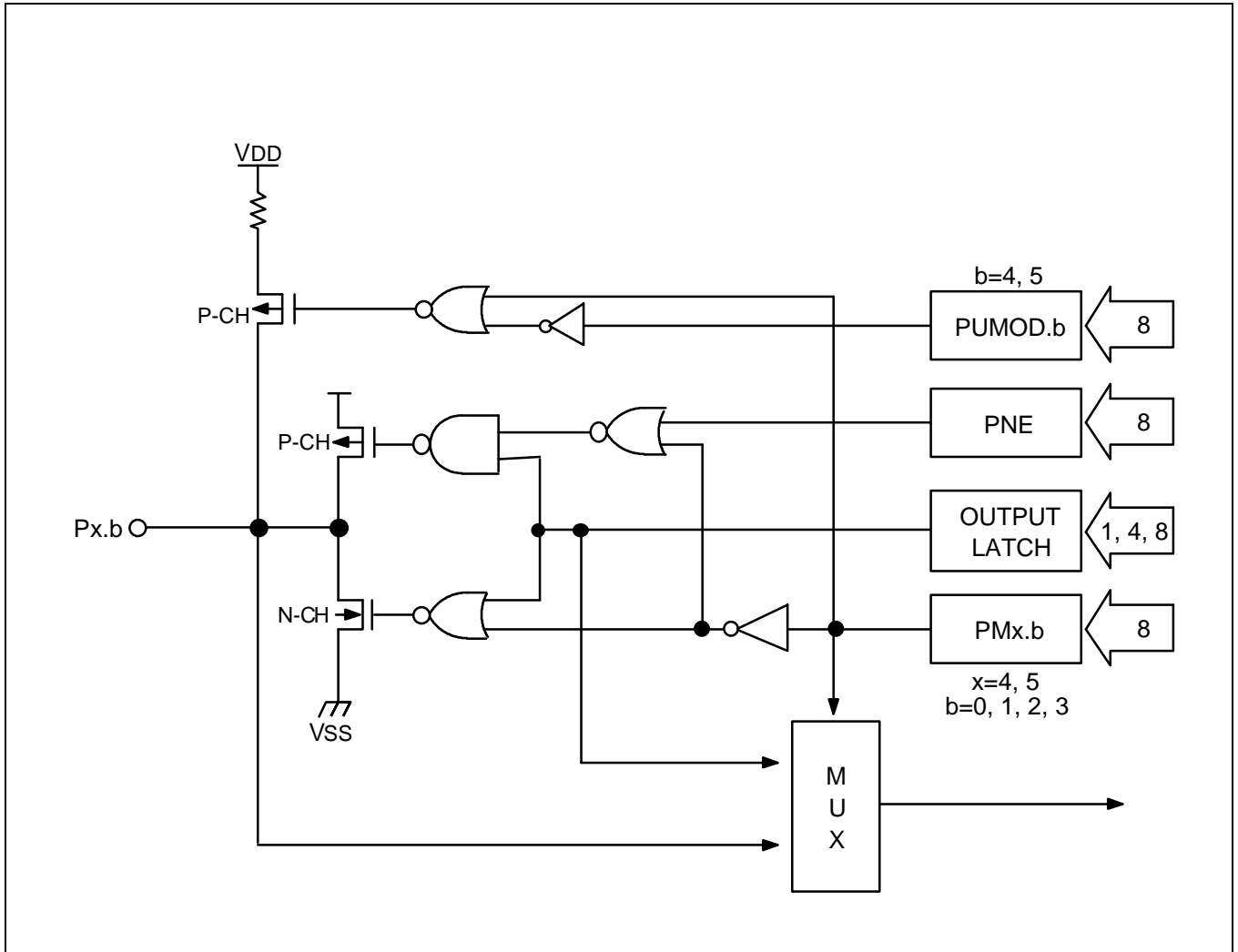
Figure 10–5. Circuit Diagram for Ports 4 and 5

PORT 6 CIRCUIT DIAGRAM
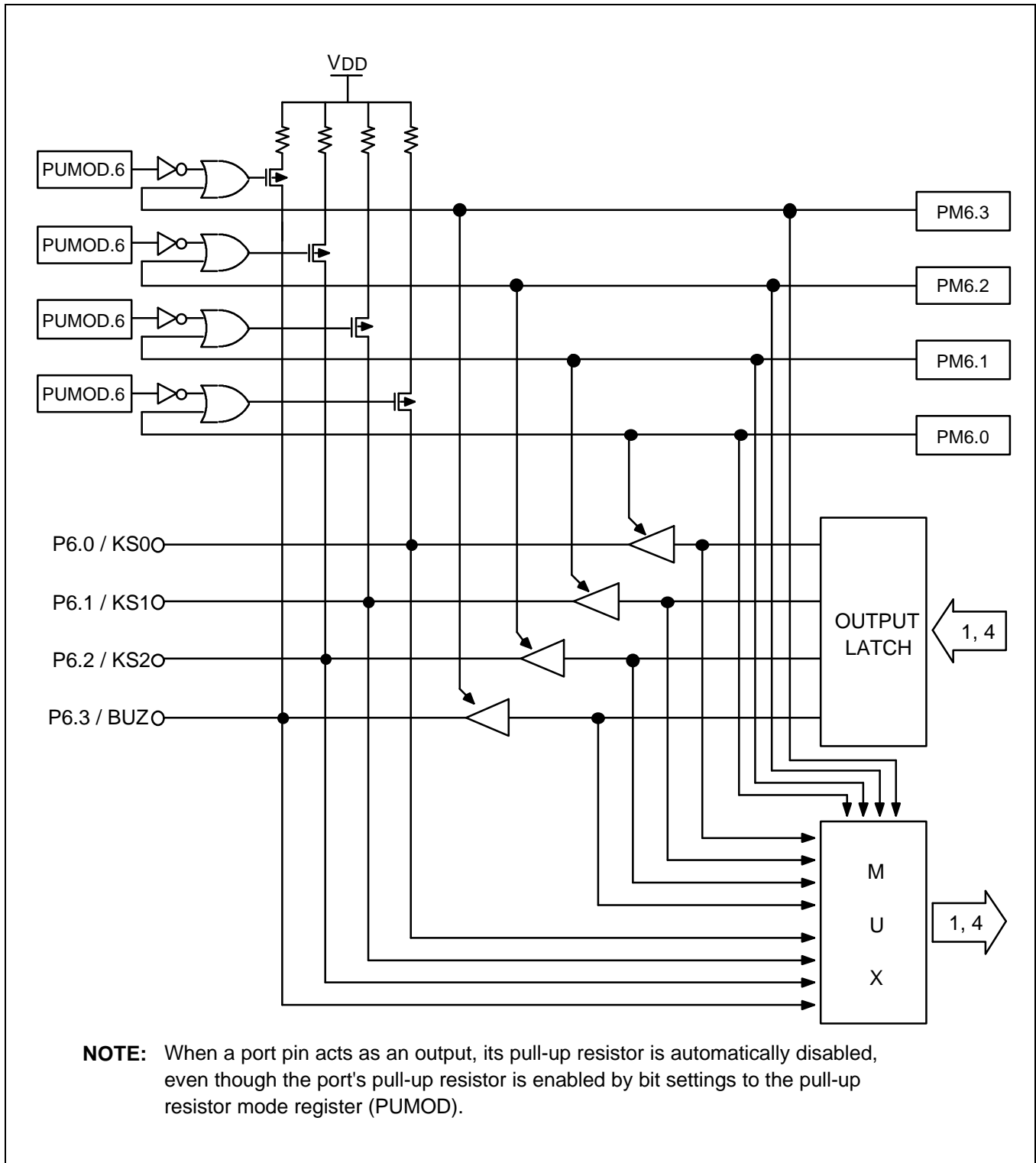
Figure 10–6. Port 6 Circuit Diagram

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11   TIMERS and TIMER/COUNTER

OVERVIEW

There are three timer and timer/counter function modules:

— 8-bit basic timer (BT)

— 8-bit timer/counter 0 (TC0)

— Watch timer (WT)

The 8-bit basic timer (BT) is the microcontroller's main interval timer. It generates a interrupt request at a fixed time interval by making the appropriate modification to the mode register.

The basic timer also functions as a 'watchdog' timer and is used to determine clock oscillation stabilization time when stop mode is released by an interrupt and after a RESET.

The 8-bit timer/counter 0 (TC0) is programmable timer/counter that is used primarily for event counting and for clock frequency modification and output. In addition, TC0 generates a clock signal that can be used by the serial I/O interface.

The watch timer (WT) module consists of an 8-bit watch timer mode register, a clock selector, and a frequency divider circuit. Watch timer functions include real-time and watch-time measurement, system clock interval timing, and generation of buzzer output.

BASIC TIMER (BT)

OVERVIEW

The 8-bit basic timer (BT) has four functional components:

— Clock selector logic

— 4-bit mode register (BMOD)

— 8-bit counter register (BCNT)

The basic timer generates interrupt requests at precise intervals, based on the frequency of the system clock.
You can use the basic timer as a "watchdog" timer for monitoring system events or use BT output to stabilize clock oscillation when stop mode is released by an interrupt and following RESET.
Use the basic timer mode register, BMOD, to turn the BT on and off, to select input clock frequency, and to control interrupt or stabilization intervals.

Interval Timer Function

The measurement of elapsed time intervals is the basic timer's primary function. The standard interval is 256 BT clock pulses.
To restart the basic timer, set bit 3 of the mode register BMOD to logic one. The input clock frequency and the interrupt and stabilization interval are selected by loading the appropriate bit values to BMOD.2–BMOD.0.
The 8-bit counter register, BCNT, is incremented each time a clock signal is detected that corresponds to the frequency selected by BMOD. BCNT continues incrementing as it counts BT clocks until an overflow occurs.
An overflow causes the BT interrupt request flag (IRQB) to be set to logic one to signal that the designated time interval has elapsed. An interrupt request is then generated, BCNT is cleared to logic zero, and counting continues from 00H.

Watchdog Timer Function

The basic timer can also be used as a "watch-dog" timer to detects inadvertent program loop, that is, system or program operation error. For this purpose, instruction that clear the watch-dog timer(*BITS   WDTCF*) should be executed at proper points in a program within a given period. If an instruction that clears the watch-dog timer is not executed within the period and the watch-dog timer overflows, reset signal is generated and system is restarted with reset status. An operation of watch-dog timer is as follows:

— Write some value(except #5AH) to Watch-Dog Timer Mode register, WDMOD.

— If WDCNT overflows, system reset is generated.

Oscillation Stabilization Interval Control

Bits 2–0 of the BMOD register are used to select the input clock frequency for the basic timer. This setting also determines the time interval (also referred to as 'wait time') required to stabilize clock signal oscillation when power-down mode is released by an interrupt. When a RESET signal is generated, the standard stabilization interval for system clock oscillation following a RESET is 31.3 ms at 4.19 MHz.

Table 11–1. Basic Timer Register Overview

Register Name	Type	Description	Size	RAM Address	Addressing Mode	Reset Value
BMOD	Control	Controls the clock frequency (mode) of the basic timer; also, the oscillation stabilization interval after power-down mode release or RESET	4-bit	F85H	4-bit write-only; BMOD.3: also 1-bit writeable	"0"
BCNT	Counter	Counts clock pulses matching the BMOD frequency setting	8-bit	F86H - F87H	8-bit read-only	U *
WDMOD	Control	Controls watch-dog timer operation.	8-bit	F98HÄF99H	8-bit write-only	A5H
WDTCF	Control	Clear the watch-dog timer's counter.	1-bit	F9AH.3	1-bit write-only	"0"

*   'U' means the value is undetermined after a RESET.
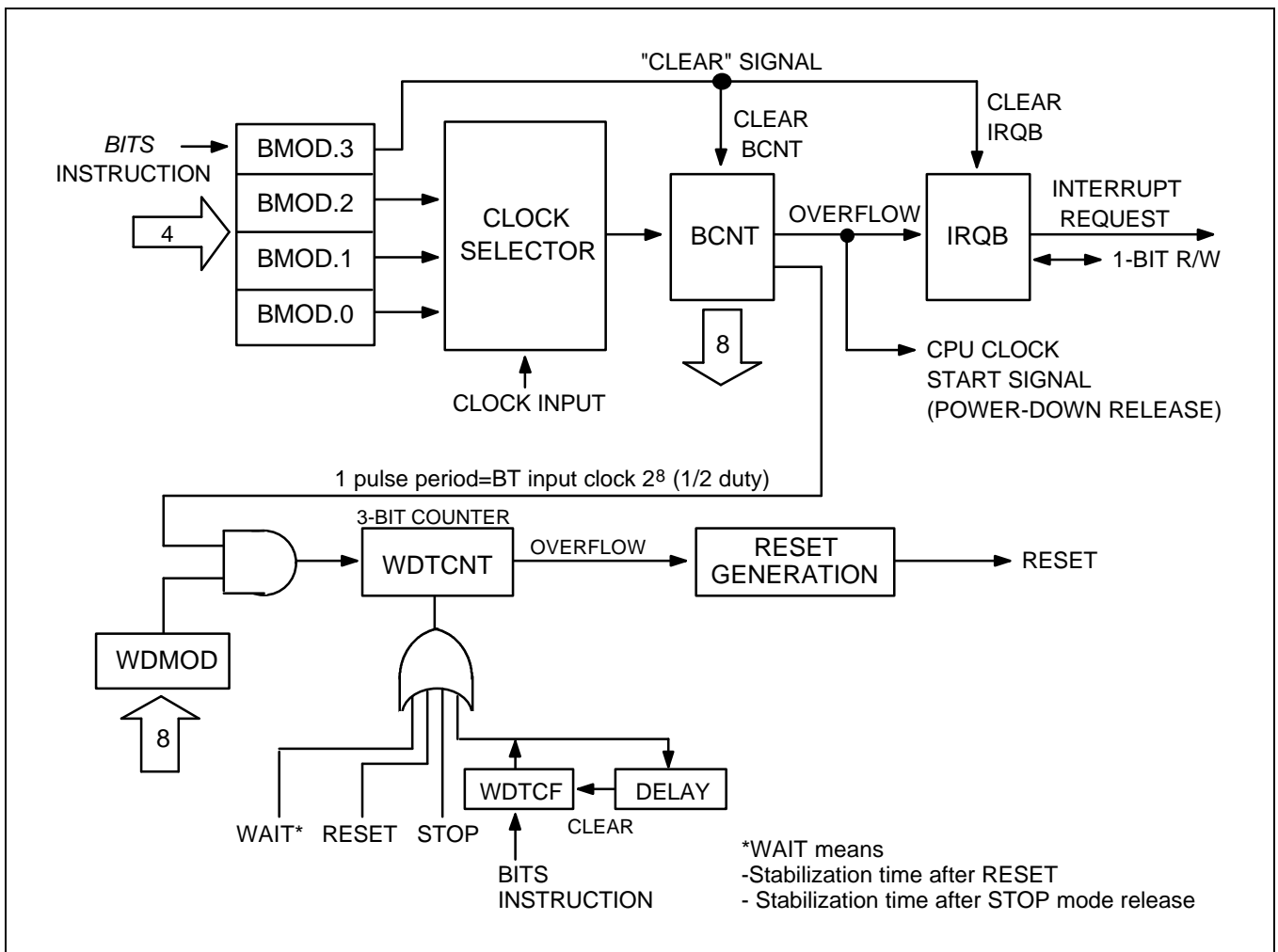
Figure 11–1. Basic Timer Circuit Diagram

BASIC TIMER MODE REGISTER (BMOD)

The basic timer mode register, BMOD, is a 4-bit write-only register located at RAM address F85H. Bit 3, the basic timer start control bit, is also 1-bit addressable. All BMOD values are set to logic zero following RESET and interrupt request signal generation is set to the longest interval. (BT counter operation cannot be stopped.) BMOD settings have the following effects:

— Restart the basic timer,

— Control the frequency of clock signal input to the basic timer, and

— Determine time interval required for clock oscillation to stabilize following the release of stop modes by an interrupt.

By loading different values into the BMOD register, you can dynamically modify the basic timer clock frequency during program execution. Four BT frequencies, ranging from $fx/2^{12}$ (1.02 kHz) to $fx/2^5$ (131 kHz), are selectable. Since BMOD's reset value is logic zero, the default clock frequency setting is $fx/2^{12}$. (kHz frequencies assume a system clock (fx) frequency of 4.19 MHz.)

The most significant bit of the BMOD register, BMOD.3, is used to start the basic timer again. When BMOD.3 is set to logic one (enabled) by a 1-bit write instruction, the contents of the BT counter register (BCNT) and the BT interrupt request flag (IRQB) are both cleared to logic zero, and timer operation is restarted.

The combination of bit settings in the remaining three registers — BMOD.2, BMOD.1, and BMOD.0 — determine the clock input frequency and oscillation stabilization interval.

Table 11–2. Basic Timer Mode Register (BMOD) Organization

BMOD.3	Basic Timer Enable/Disable Control Bit
1	Start basic timer; clear IRQB, BCNT, and BMOD.3 to "0"

BMOD.2	BMOD.1	BMOD.0	Basic Timer Input Clock	Oscillation Stabilization
0	0	0	$fx/2^{12}$ (1.02 kHz)	$2^{20}/fx$ (250 ms)
0	1	1	$fx/2^9$ (8.18 kHz)	$2^{17}/fx$ (31.3 ms)
1	0	1	$fx/2^7$ (32.7 kHz)	$2^{15}/fx$ (7.82 ms)
1	1	1	$fx/2^5$ (131 kHz)	$2^{13}/fx$ (1.95 ms)

NOTES:
1. Clock frequencies and stabilization intervals assume a system oscillator clock frequency (fx) of 4.19 MHz.
2. fx = system clock frequency.
3. Oscillation stabilization time is the time required to stabilize clock signal oscillation after stop mode is released.
4. The standard stabilization time for system clock oscillation following a RESET is 31.3 ms at 4.19 MHz.

BASIC TIMER COUNTER (BCNT)

BCNT is an 8-bit counter register for the basic timer. It is mapped to RAM addresses F86H–F87H and can be addressed by 8-bit read instructions.

RESET leaves the BCNT register value undetermined. BCNT is automatically cleared to logic zero whenever the BMOD register control bit (BMOD.3) is set to "1" to restart the basic timer. It is incremented each time a clock pulse of the frequency determined by the current BMOD bit settings is detected.

When BCNT has incremented to hexadecimal 'FFH' (256 clock pulses), it is cleared to '00H' and an overflow is generated. The overflow causes the interrupt request flag, IRQB, to be set to logic one. When the interrupt request is generated, BCNT immediately resumes counting incoming clock signals.

NOTE

Always execute a BCNT read operation twice to eliminate the possibility of reading unstable data while the counter is incrementing. If, after two consecutive reads, the BCNT values match, you can select the latter value as valid data. Until the results of the consecutive reads match, however, the read operation must be repeated until the validation condition is met.

BASIC TIMER OPERATION SEQUENCE

The basic timer's sequence of operations may be summarized as follows:

1. Set bit BMOD.3 to logic one to restart basic timer operation

2. BCNT is incremented by one after each clock pulse corresponding to BMOD selection

3. BCNT overflows if BCNT $\geq$ 255 (FFH)

4. When an overflow occurs, the IRQB flag is set to logic one by hardware

5. The interrupt request is generated

6. BCNT is automatically cleared to logic zero (BCNT = 00H)

7. BCNT resumes counting BT clock pulse

☞ **PROGRAMMING TIP — Using the Basic Timer**

1. To read the basic timer count register (BCNT):

```
            BITS      EMB
            SMB       15
BCNTR       LD        EA,BCNT
            LD        YZ,EA
            LD        EA,BCNT
            CPSE      EA,YZ
            JR        BCNTR
```

2. When stop mode is released by an interrupt, set the oscillation stabilization interval to 31.3 ms:

```
            BITS      EMB
            SMB       15
            LD        A,#0BH
            LD        BMOD,A          ;    Wait time is 31.3 ms
            STOP                      ;    Set stop power-down mode
            NOP
            NOP
            NOP
```
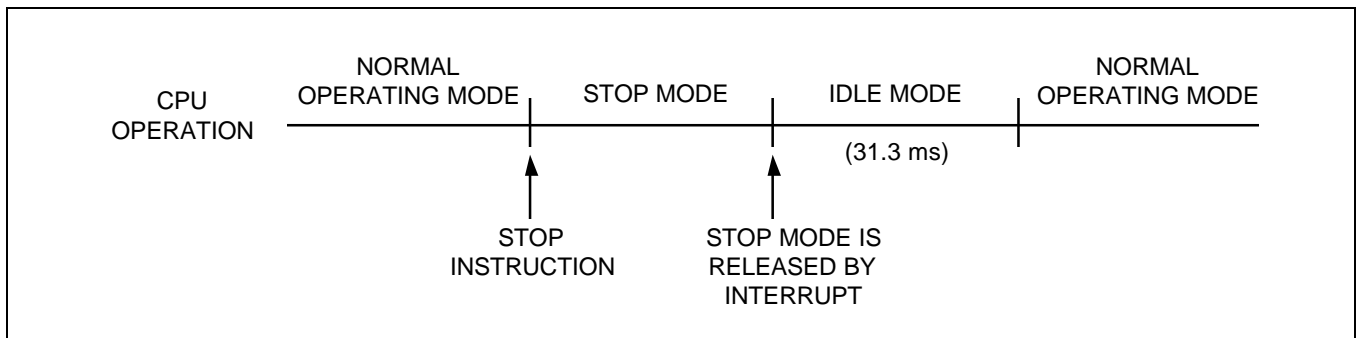

3. To set the basic timer interrupt interval time to 1.95 ms (at 4.19 MHz):

```
            BITS      EMB
            SMB       15
            LD        A,#0FH
            LD        BMOD,A
            EI
            BITS      IEB             ;    Basic timer interrupt enable flag is set to "1"
```

4. Clear BCNT and the IRQB flag and restart the basic timer:

```
            BITS      EMB
            SMB       15
            BITS      BMOD.3
```

WATCH-DOG TIMER MODE REGISTER (WDMOD)

The watch-dog timer mode register, WDMOD, is a 8-bit write-only register located at RAM address F98H - F99H. WDMOD register controls to enable or disable the watch-dog timer function. WDMOD values are set to logic "A5H" following RESET and this value enable the watch-dog timer, and watch-dog time's period is set to the longest interval because BT overflow signal is generated with the longest interval. (BT counter operation cannot be stopped.)

WDMOD - Watch–Dog Timer Mode Control Register **F99H,F98H**

Bit	3	2	1	0	3	2	1	0
Identifier	.7	.6	.5	.4	.3	.2	.1	.0
RESET Value	1	0	1	0	0	1	0	1
Read/Write	W	W	W	W	W	W	W	W

WDMOD	Watch-Dog Timer Enable/Disable Control
5AH	Disable Watch-dog timer function
Any other Value	Enable Watch-dog timer function

WATCH-DOG TIMER COUNTER (WDCNT)

WDCNT is an 3-bit counter. WDCNT is automatically cleared to logic zero whenever the WDTCF register control bit (WDTCF) is set to "1" to restart the WDCNT. Reset, stop, and wait signal clear the WDCNT to logic zero also. WDCNT is incremented each time a clock pulse of the overflow frequency determined by the current BMOD bit settings. When WDCNT has incremented to hexadecimal '07H' (8 BT overflow pulses), it is cleared to '00H' and an overflow is generated. The overflow causes the system reset. When the interrupt request is generated, BCNT immediately resumes counting incoming clock signals.

WATCH-DOG TIMER'S COUNTER CLEAR FLAG(WDTCF)

WDTCF(F9AH.3) setting clear the WDT's counter to zero and restart the WDT's counter.

Table 11-3. Watch-Dog Timer Interval Time

BMOD	BT Input Clock	WDCNT input clock	WDT interval time	Main clock
x000b	2^{12}/fx	2^{12}/fx $\times 2^8$	2^{12}/fx $\times 2^8 \times 2^3$	2 sec
x011b	2^9/fx	2^9/fx $\times 2^8$	2^9/fx $\times 2^8 \times 2^3$	250 msec
x101b	2^7/fx	2^7/fx $\times 2^8$	2^7/fx $\times 2^8 \times 2^3$	62.5 msec
x111b	2^5/fx	2^5/fx $\times 2^8$	2^5/fx $\times 2^8 \times 2^3$	15.6 msec

NOTES:
1. Clock frequencies assume a system oscillator clock frequency (fx) of : Main clock 4.19MHz
2. fx = system clock frequency.

8-BIT TIMER/COUNTER 0 (TC0)

Timer/counter 0 (TC0) is used to count system 'events' by identifying the transition (high-to-low or low-to-high) of incoming square wave signals. To indicate that an event has occurred, or that a specified time interval has elapsed, TC0 generates an interrupt request. By counting signal transitions and comparing the current counter value with the reference register value, TC0 can be used to measure specific time intervals.

TC0 has a reloadable counter that consists of two parts: an 8-bit reference register (TREF0) into which you write the counter reference value, and an 8-bit counter register (TCNT0) whose value is automatically incremented by counter logic.

An 8-bit mode register, TMOD0, is used to activate the timer/counter and to select the basic clock frequency to be used for timer/counter operations. You can modify the basic frequency dynamically by loading new values into TMOD0 during program execution.

TC0 FUNCTION SUMMARY

8-bit programmable timer	Generates interrupts at specific time intervals based on the selected clock frequency.
External event counter	Counts various system "events" based on edge detection of external clock signals at the TC0 input pin, TCL0. To start the event counting operation, TMOD0.2 is set to "1" and TMOD0.6 is cleared to "0".
Arbitrary frequency output	Outputs selectable clock frequencies to the TC0 output pin, TCLO0.
External signal divider	Divides the frequency of an incoming external clock signal according to a modifiable reference value (TREF0), and outputs the modified frequency to the TCLO0 pin.
Serial I/O clock source	Outputs a modifiable clock signal for use as the SCK clock source.

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TC0 COMPONENT SUMMARY

Mode register (TMOD0)   Activates the timer/counter and selects the internal clock frequency or the external clock source at the TCL0 pin.

Reference register (TREF0)   Stores the reference value for the desired number of clock pulses between interrupt requests.

Counter register (TCNT0)   Counts internal or external clock pulses based on the bit settings in TMOD0 and TREF0.

Clock selector circuit   Together with the mode register (TMOD0), lets you select one of four internal clock frequencies, or external clock frequency.

8-bit comparator   Determines when to generate an interrupt by comparing the current value of the counter register (TCNT0) with the reference value previously programmed into the reference register (TREF0).

Output latch (TOL0)   Where a TC0 interrupt request or clock pulse is stored pending output to the serial I/O circuit or to the TC0 output pin, TCLO0.

                                 When the contents of the TCNT0 and TREF0 registers coincide, the timer/counter interrupt request flag (IRQT0) is set to "1", the status of TOL0 is inverted, and an interrupt is generated.

Output enable flag (TOE0)   You must set this flag to logic one before the contents of the TOL0 latch can be output to TCLO0.

Interrupt request flag (IRQT0)   This flag is cleared when TC0 operation starts and the TC0 interrupt service routine is executed and is enabled whenever the counter value and reference value coincide.

Interrupt enable flag (IET0)   Must be set to logic one before the interrupt requests generated by timer/counter can be processed.

Table 11–4. TC0 Register Overview

Register Name	Type	Description	Size	RAM Address	Addressing Mode	Reset Value
TMOD0	Control	Controls TC0 restart (bit 2); clears and resumes counting operation (bit 3); sets input clock and clock frequency (bits 6–4)	8-bit	F90H–F91H	8-bit write-only; (TMOD0.3 is also 1-bit write-only)	"0"
TCNT0	Counter	Counts clock pulses matching the TMOD0 frequency setting	8-bit	F94H–F95H	8-bit read-only	"0"
TREF0	Reference	Stores reference value for the timer/counter 0 interval setting	8-bit	F96H–F97H	8-bit write-only	FFH
TOE0	Flag	Controls timer/counter 0 output to the TCLO0 pin	1-bit	F92H.2	1-bit write-only	"0"
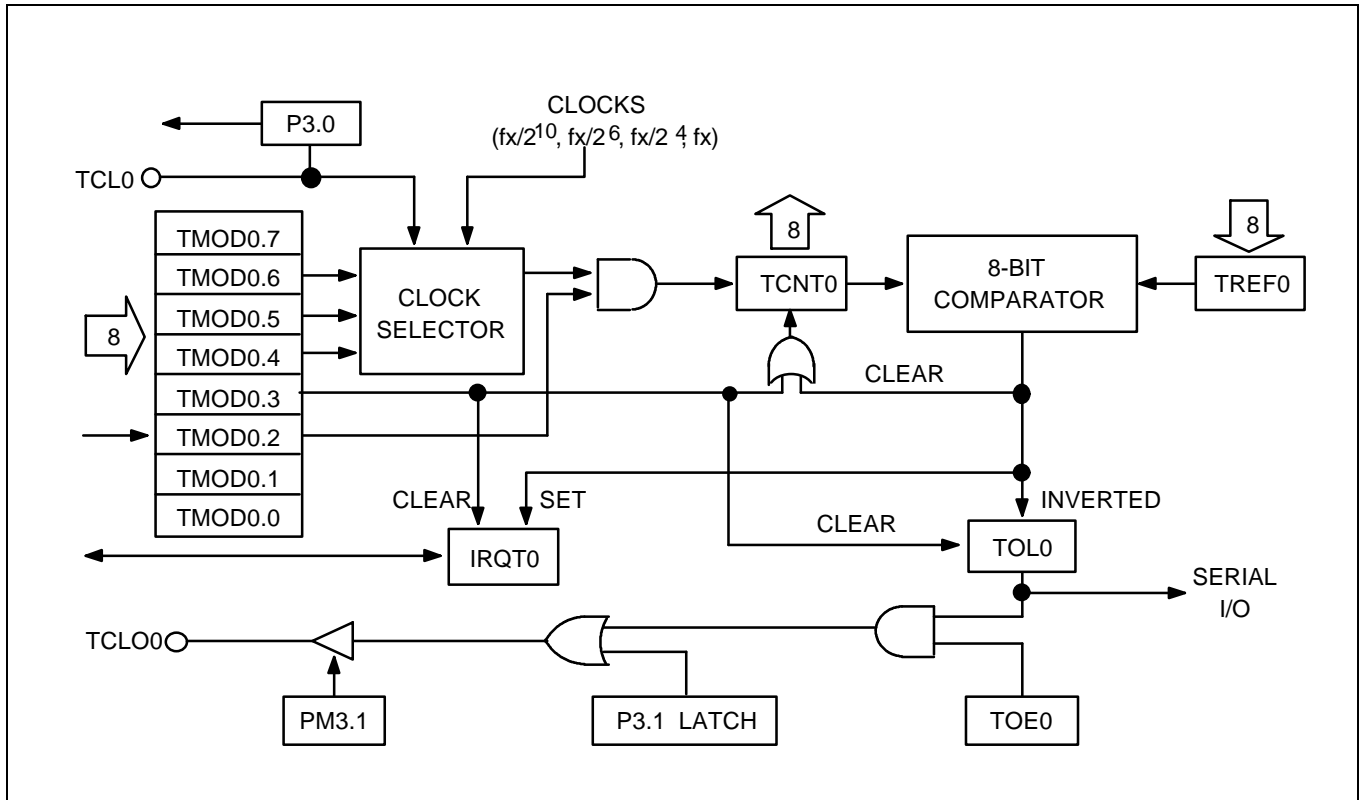
Figure 11–2. TC0 Circuit Diagram

TC0 ENABLE/DISABLE PROCEDURE

Enable Timer/Counter 0

— Set TMOD.2 to logic one (RAM address F90H.2)

— Set the TC0 interrupt enable flag IET0 to logic one (RAM address FBCH.1)

— Set TMOD0.3 to logic one (RAM address F90H.3)

TCNT0, IRQT0, and TOL0 are cleared to logic zero, and timer/counter operation starts.

Disable Timer/Counter

— Set TMOD0.2 to logic zero (RAM address F90H.2)

Clock signal input to the counter register TCNT0 is halted. The current TCNT0 value is retained and can be read if necessary.

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TC0 PROGRAMMABLE TIMER/COUNTER FUNCTION

Timer/counter 0 can be programmed to generate interrupt requests at various intervals, based on the system clock frequency you select.

The 8-bit TC0 mode register, TMOD0, is used to activate the timer/counter and to select the clock frequency. The reference register, TREF0, stores your value for the number of clock pulses to be generated between interrupt requests. The counter register, TCNT0, counts the incoming clock pulses, which are compared to the TREF0 value as TCNT0 is incremented. When there is a match (TREF0 = TCNT0), an interrupt request is generated.

To program timer/counter to generate interrupt requests at specific intervals, you choose one of four internal clock frequencies (divisions of the system clock, fx) and load your own counter reference value into the TREF0 register.

TCNT0 is incremented each time an internal counter pulse is detected with the reference clock frequency specified by TMOD0.4–TMOD0.6 settings. To generate an interrupt request, the TC0 interrupt request flag (IRQT0) is set to logic one, the status of TOL0 is inverted, and the interrupt is generated. The content of TCNT0 is then cleared to 00H, and TC0 continues counting.

The interrupt request mechanism for the programmable timer/counter consists of the TC0 interrupt enable flag IET0 and the TC0 interrupt request flag IRQT0.

TC0 OPERATION SEQUENCE

The general sequence of operations when using TC0 as a programmable timer/counter can be summarized as follows:

1. Set TMOD0.2 to "1" to enable TC0

2. Set TMOD0.6 to "1" to enable the system clock (fx) input

3. Set TMOD0.5 and TMOD0.4 bits to desired internal frequency (fx/2^n)

4. Load a value to TREF0 to specify the interval between interrupt requests

5. Set the TC0 interrupt enable flag (IET0) to "1"

6. Set TMOD0.3 bit to "1" to clear TCNT0, IRQT0, and TOL0, and start counting

7. TCNT0 increments with each internal clock pulse

8. When the comparator shows TCNT0 = TREF0, the IRQT0 flag is set to "1"

9. Output latch (TOL0) logic toggles high or low

10. Interrupt request is generated

11. TCNT0 is cleared to 00H and counting resumes

12. Programmable timer/counter operation continues until TMOD0.2 is cleared to "0".

TC0 EVENT COUNTER FUNCTION

Timer/counter 0 can be used to monitor or detect system 'events' by using the external clock input at the TCL0 pin (I/O port 3.0) as the counter source. The TC0 mode register is used to specify rising or falling edge detection for incoming clock signals. The counter register TCNT0 is incremented each time the selected state transition of the external clock signal occurs. To activate the TC0 event counter function,

— Set TMOD0.2 to "1" to enable TC0

— Clear TMOD0.6 to "0" to select the external clock source at the TCL0 pin

— Select TCL0 edge detection for rising or falling signal edges by loading the appropriate values to TMOD0.5 and TMOD0.4.

— P3.0 must be set to input mode.

Table 11–5. TMOD0 Settings for TCL0 Edge Detection

TMOD0.5	TMOD0.4	TCL0 Edge Detection
0	0	Rising edges
0	1	Falling edges

With the exception of the different TMOD0.4–TMOD0.6 settings, the operation sequence for TC's event counter function is identical to its programmable counter/timer function.

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TC0 CLOCK FREQUENCY OUTPUT

Using timer/counter, you can output a modifiable clock frequency to the TC0 clock output pin, TCLO0. To select the clock frequency, you load appropriate values to the TC0 mode register, TMOD0. The clock interval is determined by loading the desired reference value into the reference register TREF0. Then, to enable the output to the TCLO0 pin at I/O port 3.1, the following conditions must be met:

— TC0 output enable flag TOE0 must be set to "1"

— I/O mode flag for P3.1 (PM3.1) must be set to output mode ("1")

— Output latch value for P3.1 must be set to "0"

In summary, the operational sequence required to output a TC0-generated clock signal to the TCLO0 pin is as follows:

1. Load your reference value to TREF0

2. Set the clock frequency in TMOD0

3. Initiate TC0 clock output to TCLO0 (TMOD0.2 = "1")

4. Set port 3 mode flag (PM3.1) to "1"

5. Set P3.1 output latch to "0"

6. Set TOE0 flag to "1"

Each time TCNT0 overflows and an interrupt request is generated, the state of the output latch TOL0 is inverted and the TC0-generated clock signal is output to the TCLO0 pin.

☞ **PROGRAMMING TIPS — TC0 Signal Output to the TCLO0 Pin**

Output a 30 ms pulse width signal to the TCLO0 pin:

```
BITS      EMB
SMB       15
LD        EA,#79H
LD        TREF0,EA
LD        EA,#4CH
LD        TMOD0,EA
LD        EA,#20H
LD        PMG1,EA          ;   P3.1 ← Output mode
BITR      P3.1             ;   P3.1 clear
BITS      TOE0
```

TC0 SERIAL I/O CLOCK GENERATION

Timer/counter 0 can supply a clock signal to the clock selector circuit of the serial I/O interface for data shifter and clock counter operations. (These internal SIO operations are controlled in turn by the SIO mode register, SMOD). This clock generation function enables you to adjust data transmission rates across the serial interface.

Use TMOD0 and TREF0 register settings to select the frequency and interval of the TC0 clock signals to be used as SCK input to the serial interface. The generated clock signal is then sent directly to the serial I/O clock selector circuit — not through the port 3.1 latch and TCLO0 pin.

TC0 EXTERNAL INPUT SIGNAL DIVIDER

By selecting an external clock source and loading a reference value into the TC0 reference register, TREF0, you can divide the incoming clock signal by the TREF0 value and then output this modified clock frequency to the TCLO0 pin. The sequence of operations used to divide external clock input may be summarized as follows:

1. Load a signal divider value to the TREF0 buffer register

2. Clear TMOD0.6 to "0" to enable external clock input at the TCL0 pin

3. Set TMOD0.5 and TMOD0.4 to desired TCL0 signal edge detection

4. Set port 3.1 mode flag (PM3.1) to output ("1")

5. Set P3.1 output latch to "0"

6. Set TOE0 flag to "1" to enable output of the divided frequency

Divided clock signals are then output to the TCLO0 pin.

☞ PROGRAMMING TIP — External TCL0 Clock Output to the TCLO0 Pin

Output external TCL0 clock pulse to the TCLO0 pin (divide by four):
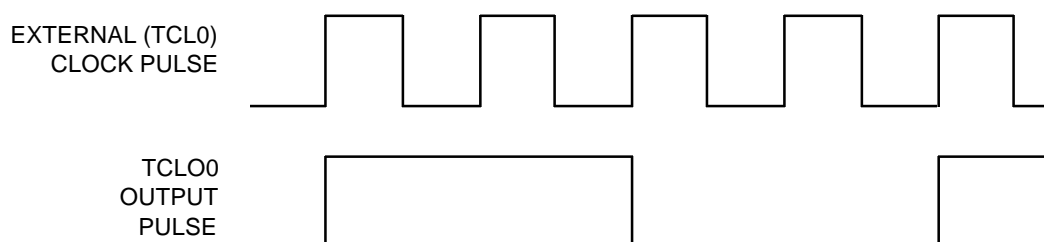

```
BITS      EMB
SMB       15
LD        EA,#01H
LD        TREF0,EA
LD        EA,#0CH
LD        TMOD0,EA
LD        EA,#20H
LD        PMG1,EA            ;   P3.1 ← Output mode
BITR      P3.1               ;   P3.1 clear
BITS      TOE0
```

TC0 MODE REGISTER (TMOD0)

TMOD0 is the 8-bit mode control register for timer/counter. It is located at RAM addresses F90H–F91H and is addressable by 8-bit write instructions. One bit, TMOD0.3, is also 1-bit writeable. RESET clears all TMOD0 bits to logic zero and disables TC0 operations.

F90H	TMOD0.3	TMOD0.2	"0"	"0"
F91H	"0"	TMOD0.6	TMOD0.5	TMOD0.4

TMOD0.2 is the enable/disable bit for timer/counter. When TMOD0.3 is set to "1", the contents of TCNT0, IRQT0, and TOL0 are cleared, counting starts from 00H, and TMOD0.3 is automatically reset to "0" for normal TC0 operation. When TC0 operation stops (TMOD0.2 = "0"), the contents of the TC0 counter register, TCNT0, are retained until TC0 is re-enabled.

Use TMOD0.6, TMOD0.5, and TMOD0.4 bit settings together to select the TC0 clock source. This selection involves two variables:

— Synchronization of timer/counter operations with either the rising edge or the falling edge of the clock signal input at the TCL0 pin, and

— Selection of one of four frequencies, based on division of the incoming system clock frequency, for use in internal TC0 operation.

Table 11–6. TC0 Mode Register (TMOD0) Organization

Bit Name	Setting	Resulting TC0 Function	Address
TMOD0.7	0	MSB value always logic zero	F91H
TMOD0.6			F91H
TMOD0.5	0,1	Specify input clock edge and internal frequency	
TMOD0.4			
TMOD0.3	1	Clear TCNT0, IRQT0, and TOL0 and resume counting immediately (This bit is automatically cleared to logic zero immediately after counting resumes.)	F90H
TMOD0.2	0	Disable timer/counter; retain TCNT0 contents	
	1	Enable timer/counter	
TMOD0.1	0	Value always logic zero	
TMOD0.0	0	LSB value always logic zero	

Table 11–7. TMOD0.6, TMO0.5, and TMOD0.4 Bit Settings

TMOD0.6	TMOD0.5	TMOD0.4	Resulting Counter Source and Clock Frequency
0	0	0	External clock input (TCL0) on rising edges
0	0	1	External clock input (TCL0) on falling edges
1	0	0	$fx/2^{10}$ = 4.09 kHz
1	0	1	$fx/2^6$ = 65.5 kHz
1	1	0	$fx/2^4$ = 262 kHz
1	1	1	fx = 4.19 MHz

NOTE: 'fx' = system clock

☞ **PROGRAMMING TIP — Restarting TC0 Counting Operation**

1. Set TC0 timer interval to 4.09 kHz:

```
BITS      EMB
SMB       15
LD        EA,#4CH
LD        TMOD0,EA
EI
BITS      IET0
```

2. Clear TCNT0, IRQT0, and TOL0 and restart TC0 counting operation:

```
BITS      EMB
SMB       15
BITS      TMOD0.3
```

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TC0 COUNTER REGISTER (TCNT0)

The 8-bit counter register for timer/counter, TCNT0, is mapped to RAM addresses F94H–F95H. It is read-only and can be addressed by 8-bit RAM control instructions. RESET sets all TCNT0 register values to logic zero (00H).

Whenever TMOD0.3 are enabled, TCNT0 is cleared to logic zero and counting begins. The TCNT0 register value is incremented each time an incoming clock signal is detected that matches the signal edge and frequency setting of the TMOD0 register (specifically, TMOD0.6, TMOD0.5, and TMOD0.4).

Each time TCNT0 is incremented, the new value is compared to the reference value stored in the TC0 reference register, TREF0. When TCNT0 = TREF0, an overflow occurs in the TCNT0 register, the interrupt request flag, IRQT0, is set to logic one, and an interrupt request is generated to indicate that the specified timer/counter interval has elapsed.
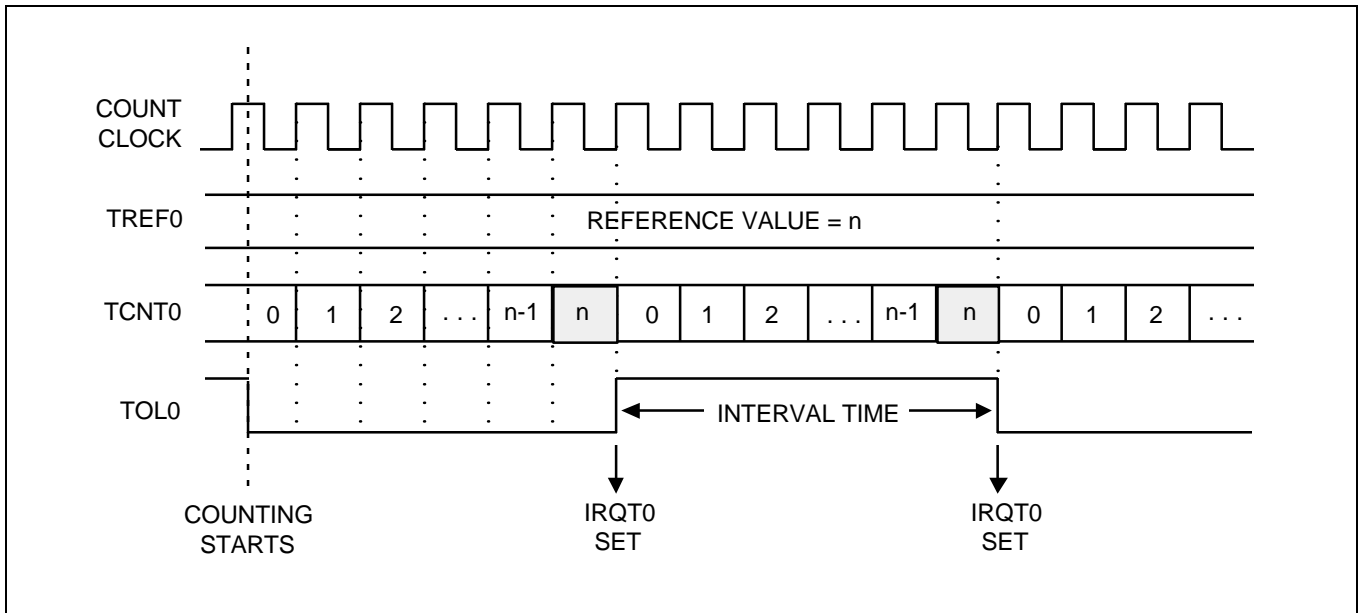
Figure 11–3. TC0 Timing Diagram

TC0 REFERENCE REGISTER (TREF0)

The TC0 reference register TREF0 is an 8-bit write-only register that is mapped to RAM locations F96H and F97H. It is addressable by 8-bit RAM control instructions. RESET initializes the TREF0 value to 'FFH'.

TREF0 is used to store a reference value to be compared to the incrementing TCNT0 register in order to identify an elapsed time interval. Reference values will differ depending upon the specific function that TC0 is being used to perform — as a programmable timer/counter, event counter, clock signal divider, or arbitrary frequency output source.

During timer/counter operation, the value loaded into the reference register compared to the TCNT0 value. When TCNT0 = TREF0, the TC0 output latch (TOL0) is inverted and an interrupt request is generated to signal the interval or event.

The TREF0 value, together with the TMOD0 clock frequency selection, determines the specific TC0 timer interval. Use the following formula to calculate the correct value to load to the TREF0 reference register:

$$\text{TC0 timer interval} = (\text{TREF0 value} + 1) \times \frac{1}{\text{TMOD0 frequency setting}}$$

$$(\text{ assuming a TREF0 value} \neq 0)$$

TC0 OUTPUT ENABLE FLAG (TOE0)

The 1-bit timer/counter 0 output enable flag TOE0 controls output from timer/counter 0 to the TCLO0 pin. TOE0 is mapped to RAM location F92H.2 and is addressable by 1-bit read and write instructions.

	Bit 3	**Bit 2**	Bit 1	Bit 0
F92H	0	**TOE0**	0	0

When you set the TOE0 flag to "1", the contents of TOL0 can be output to the TCLO0 pin. Whenever a RESET occurs, TOE0 is automatically set to logic zero, disabling all TC0 output. Even when the TOE0 flag is disabled, timer/counter can continue to output an internally-generated clock frequency, via TOL0, to the serial I/O clock selector circuit.

TC0 OUTPUT LATCH (TOL0)

TOL0 is the output latch for timer/counter. When the 8-bit comparator detects a correspondence between the value of the counter register TCNT0 and the reference value stored in the TREF0 buffer, the TOL0 value is inverted — the latch toggles high-to-low or low-to-high.

Whenever the state of TOL0 is switched, the TC0 signal is output. TC0 output may be directed to the TCLO0 pin at P3.1, or it can be output directly to the serial I/O clock selector circuit as the SCK signal.

Assuming TC0 is enabled, when bit 3 of the TMOD0 register is set to "1", the TOL0 latch is cleared to logic zero, along with the counter register TCNT0 and the interrupt request flag, IRQT0, and counting resumes immediately. When TC0 is disabled (TMOD0.2 = "0"), the contents of the TOL0 latch are retained and can be read, if necessary.

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☞ **PROGRAMMING TIP — Setting a TC0 Timer Interval**

To set a 30 ms timer interval for TC0, given fx $=$ 4.19 MHz, follow these steps.

1. Select the timer/counter mode register with a maximum setup time of 62.5 ms (assume the TC0 counter clock $=$ fx/2^{10}, and TREF0 is set to FFH):

2. Calculate the TREF0 value:

$$30 \text{ ms} = \frac{\text{TREF0 value} + 1}{4.09 \text{ kHz}}$$

$$\text{TREF0} + 1 = \frac{30 \text{ ms}}{244 \text{ μs}} = 122.9 = 7AH$$

$$\text{TREF0 value} = 7AH - 1 = 79H$$

3. Load the value 79H to the TREF0 register:

```
BITS    EMB
SMB     15
LD      EA,#79H
LD      TREF0,EA
LD      EA,#4CH
LD      TMOD0,EA
```

WATCH TIMER

OVERVIEW

The watch timer is a multi-purpose timer consisting of three basic components:

— 8-bit watch timer mode register (WMOD)

— Clock selector

— Frequency divider circuit

Watch timer functions include real-time and watch-time measurement and interval timing for the system clock. It is also used as a clock source for generating buzzer output.

Real-Time and Watch-Time Measurement

To start watch timer operation, set bit 2 of the watch timer mode register, WMOD.2, to logic one. The watch timer starts, the interrupt request flag IRQW is automatically set to logic one, and interrupt requests commence in 0.5-second intervals.

Since the watch timer functions as a quasi-interrupt instead of a vectored interrupt, the IRQW flag should be cleared to logic zero by program software as soon as a requested interrupt service routine has been executed.

Using a System Clock Source

The watch timer can generate interrupts based on the system clock frequency. The system clock (fx) is used as the signal source, according to the following formula:

$$\text{Watch timer clock (fw)} \quad = \quad \frac{\text{System clock (fx)}}{128} \quad = \text{32.768 kHz}$$

$$\text{(assuming fx = 4.19 MHz)}$$

Buzzer Output Frequency Generator

The watch timer can generate a steady 2 kHz, 4 kHz, 8 kHz, or 16 kHz signal to the BUZ pin. To select the BUZ frequency you want, load the appropriate value to the WMOD register. This output can then be used to actuate an external buzzer sound. To generate a BUZ signal, three conditions must be met:

— The WMOD.7 register bit at F89H.3 is set to "1"

— The output latch for I/O port 6.3 is cleared to "0"

— The port 6.3 output mode flag (PM6.3) set to 'output' mode

Timing Tests in High-Speed Mode

By setting WMOD.1 (F88H.1) to "1", the watch timer will function in high-speed mode, generating an interrupt every 3.91 ms. At its normal speed (WMOD.1 = '0'), the watch timer generates an interrupt request every 0.5 seconds. High-speed mode is useful for timing events for program debugging sequences.

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WATCH TIMER CIRCUIT
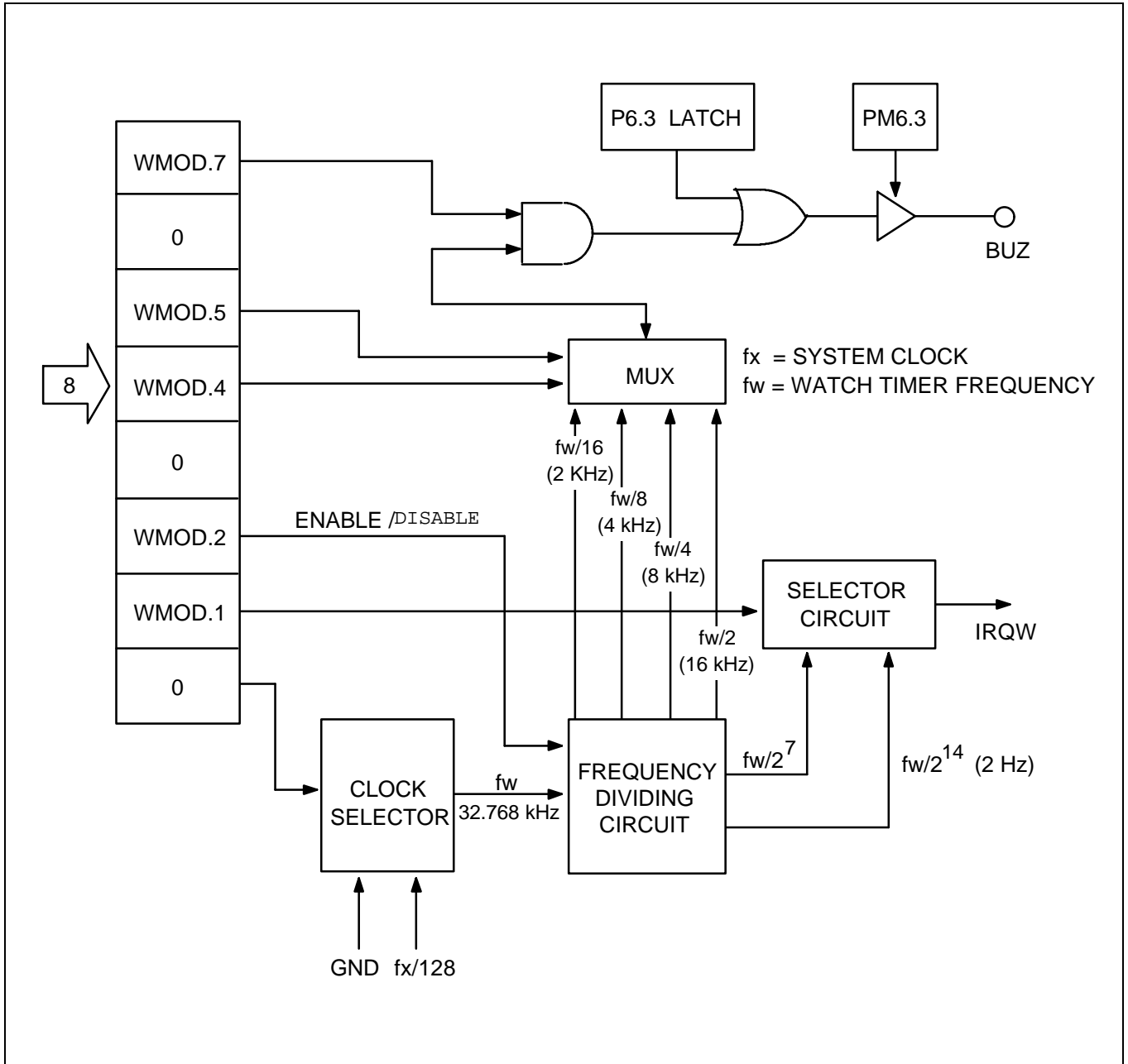
Figure 11–4. Watch Timer Circuit Diagram

WATCH TIMER MODE REGISTER (WMOD)

The watch timer mode register WMOD is used to select specific watch timer operations. It is mapped to RAM locations F88H–F89H and is 8-bit write-only addressable.
RESET sets all WMOD bits to logic zero.

F88H	"0"	WMOD.2	WMOD.1	"0"
F89H	WMOD.7	"0"	WMOD.5	WMOD.4

In brief, WMOD settings control the following watch timer functions:

— Watch timer speed control   (WMOD.1)

— Enable/disable watch timer   (WMOD.2)

— Buzzer frequency selection   (WMOD.4)

                                   (WMOD.5)

— Enable/disable buzzer output   (WMOD.7)

Table 11–8. Watch Timer Mode Register (WMOD) Organization

Bit Name	Values		Function	Address
WMOD.7	0		Disable buzzer (BUZ) signal output	
	1		Enable buzzer (BUZ) signal output	
WMOD.6	"0"		Always logic zero	
WMOD.5 – .4	0	0	2 kHz buzzer (BUZ) signal output	F89H
	0	1	4 kHz buzzer (BUZ) signal output	
	1	0	8 kHz buzzer (BUZ) signal output	
	1	1	16 kHz buzzer (BUZ) signal output	
WMOD.3	"0"		Always logic zero	
WMOD.2	0		Disable watch timer; clear frequency dividing circuits	
	1		Enable watch timer	F88H
WMOD.1	0		Normal mode; sets IRQW to 0.5 seconds	
	1		High-speed mode; sets IRQW to 3.91 ms	
WMOD.0	0		Always logic zero	

NOTE: System clock frequency (fx) is assumed to be 4.19 MHz.

☞ **PROGRAMMING TIP — Using the Watch Timer**

1. Select a 0.5 second interrupt, and 2 kHz buzzer enable:

```
            BITS    EMB
            SMB     15
            LD      EA,#80H
            LD      PMG3,EA         ;   P6.3 ← Output mode
            BITR    P6.3            ;   Clear P6.3 output latch
            LD      EA,#84H
            LD      WMOD,EA
            BITS    IEW
```

2. Sample real-time clock processing method:

```
CLOCK       BTSTZ   IRQW            ;   0.5 second check
            RET                     ;   No, return
            •                       ;   Yes, 0.5 second interrupt generation
            •
            •                       ;   Increment HOUR, MINUTE, SECOND
```

NOTES

12 COMPARATOR

OVERVIEW

Port 2 can be used as a analog input port for a comparator. The reference voltage for the 4-channel comparator can be supplied either internally or externally at P2.3. When internal reference voltage is used, four channels (P2.0–P2.3) are used for analog inputs and the internal reference voltage is varies at 16 levels. If an external reference voltage is input at P2.3, the other three pins (P2.0–P2.2) in port 2 are used for analog input. Unused port 2 pins must be connected to V_{DD}.

When a conversion is completed, the result is saved in the comparison result register CMPREG. The initial values of the CMPREG are undefined and the comparator operation is disabled by a RESET. The comparator has following components:

— Comparator

— Internal reference voltage generator (4-bit resolution)

— External reference voltage source at P2.3

— Comparator mode register (CMOD)

— Comparison result register (CMPREG)
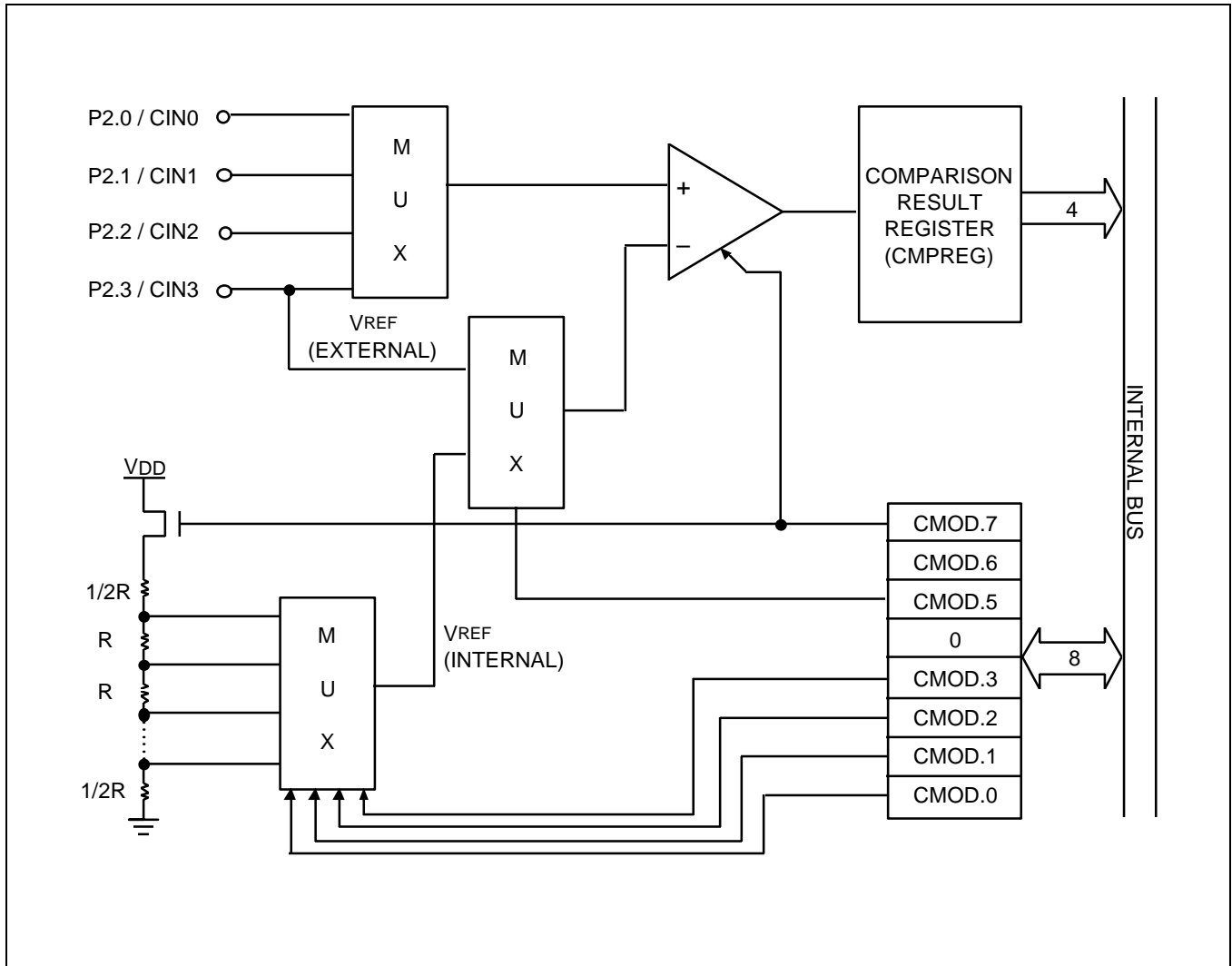
Figure 12–1. Comparator Circuit Diagram

COMPARATOR MODE REGISTER (CMOD)

The comparator mode register CMOD is an 8-bit register that is used to set the operation mode of the comparator. It is mapped to addresses FD6H–FD7H and can be manipulated using 8-bit memory instructions. Based on the CMOD.5 bit setting, an internal or an external reference voltage is input for the comparator, as follows:

When CMOD.5 is set to logic zero:

— A reference voltage is selected by the CMOD.0 to CMOD.3 bit settings.

— P2.0 to P2.3 are used as analog input pins.

— The internal digital to analog converter generates 16 reference voltages.

— The comparator can detect 150 mV difference between the reference voltage and the analog input voltages.

— Comparator results are written into 4-bit comparison result register (CMPREG).

When CMOD.5 is set to logic one:

— An external reference voltage is supplied from P2.3/CIN3.

— P2.0 to P2.2 are used as the analog input pins.

— The comparator can detect 150 mV difference between the reference voltage and the analog input voltages.

— Bits 0–2 in the CMPREG register contain the results; the content of bit 3 is not used.

Bit 6 in the CMOD register controls conversion time while bit 7 enables or disables comparator operation to reduce power consumption. A RESET signal clears all bits to logic zero, causing the comparator operation to enter stop mode.

CMOD.7	CMOD.6	CMOD.5	0	CMOD.3	CMOD.2	CMOD.1	CMOD.0	FD6H–FD7H

Reference voltage (V_{REF}) selection:
$VDD \times (n + 0.5)/16$, n = 0 to 15

1: CIN3; external reference, CIN0–2; analog input
0: Internal reference, CIN0–3; analog input

1: Conversion time (4 x 2^4 /fx, 15.2 μs @4.19MHz)
0: Conversion time (4 x 2^7 /fx, 121.6 μs @4.19MHz)

1: Comparator operation enable
0: Comparator operation disable
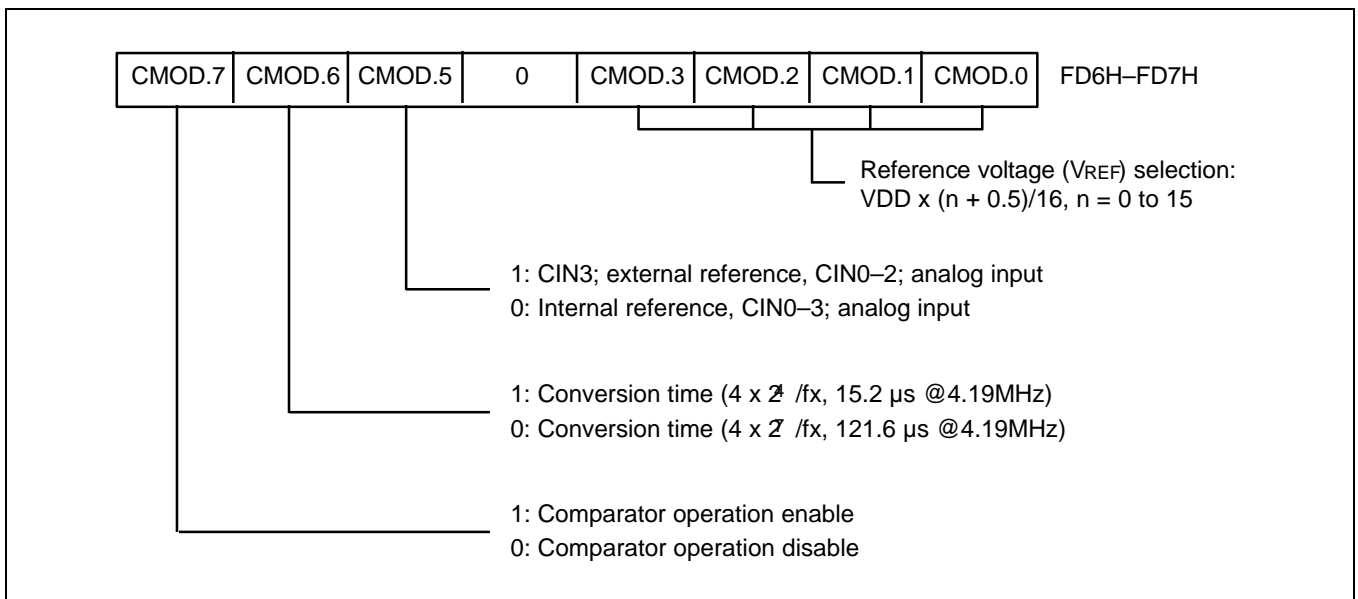
Figure 12–2. Comparator Mode Register Organization

PORT 2 MODE REGISTER (P2MOD)

P2MOD register settings determine if port 2 is used for analog or digital input. The P2MOD register is 4-bit write only register. P2MOD is mapped to address FE2H and initialized to logic zero by a RESET, which configures port 2 as an analog input port.
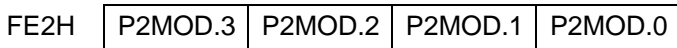
FE2H	P2MOD.3	P2MOD.2	P2MOD.1	P2MOD.0

When bit is set to "1", the corresponding pin is configured as a digital input pin. When set to "0", configured as an analog input pin: P2MOD.0 for P2.0, P2MOD.1 for P2.1, P2MOD.2 for P2.2, and P2MOD.3 for P2.3.

COMPARATOR OPERATION

The comparator compars analog voltage input at CIN0–CIN3 with an external or internal reference voltage (V_{REF}) that is selected by CMOD register. The result is written to the comparison result register CMPREG at address FD4H. The comparison result is calculated as follows.

If "1" Analog input voltage $\geq V_{REF} + 150$ mV

If "0" Analog input voltage $\leq V_{REF} - 150$ mV

To obtain a comparison result, the data must be read out from the CMPREG register after V_{REF} is updated by changing the CMOD value after a conversion time has elapsed.
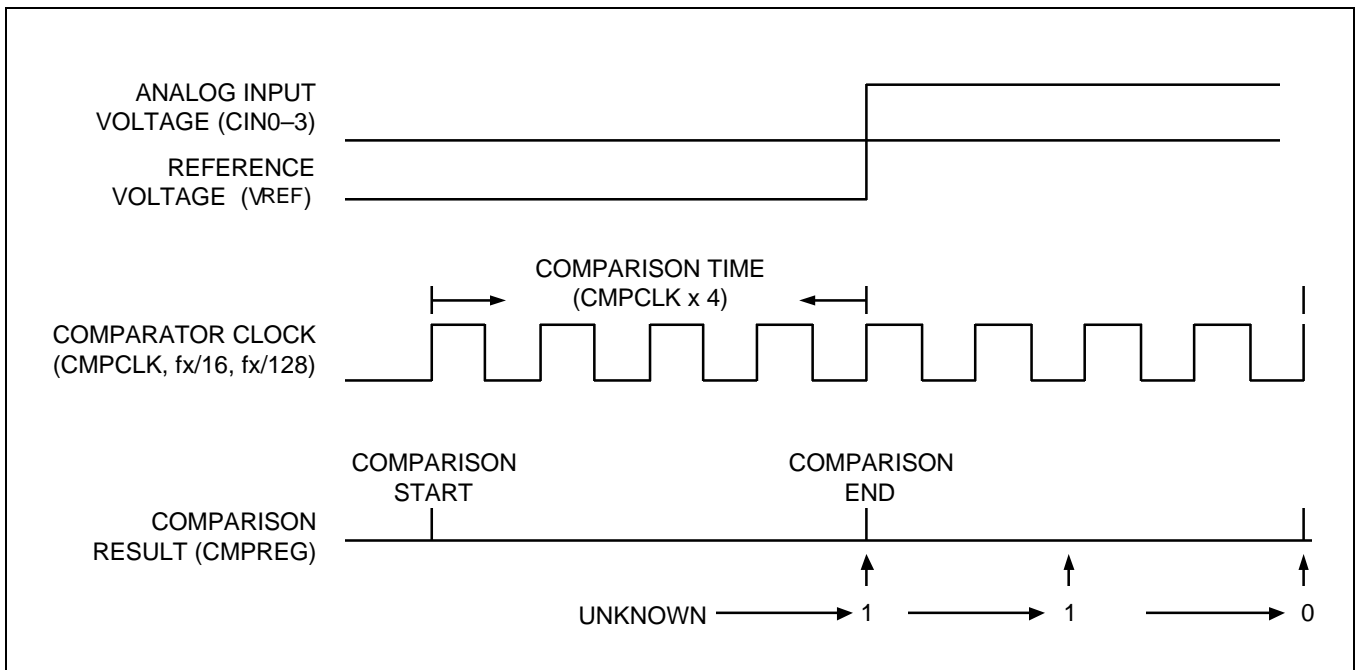
Figure 12–3. Conversion Characteristics

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☞ **PROGRAMMING TIP — Programming the Comparator**

The following code converts the analog voltage input at CIN0–CIN2 pins into 4-bit digital code.

```
        BITR    EMB
        LD      A,#0H
        LD      P2MOD,A         ;   Analog input selection (CIN0–CIN3)
        LD      EA,#8XH         ;   x = 0–F, comparator enable
                                ;   Internal reference, conversion time (121.6 µs)
        LD      CMOD,EA
WAIT    LD      A,#0H
        INCS    A
        JR      WAIT
        LD      A,CMPREG        ;   Read the result
        LD      P4,A            ;   Output the result from port 4
```

NOTES

13 SERIAL I/O INTERFACE

OVERVIEW

The serial I/O interface (SIO) has the following functional components:

— 8-bit mode register (SMOD)

— Clock selector circuit

— 8-bit buffer register (SBUF)

— 3-bit serial clock counter

Using the serial I/O interface, you can exchange 8-bit data with an external device. You control the transmission frequency by the appropriate bit settings to the SMOD register.

The serial interface can run off an internal or an external clock source, or the TOL0 signal that is generated by the 8-bit timer/counter 0, TC0. If you use the TOL0 clock signal, you can modify its frequency to adjust the serial data transmission rate.

SIO OPERATION SEQUENCE

The general sequence of operations for the serial I/O interface may be summarized as follows:

1. Set SIO mode to transmit-and-receive or to receive-only.

2. Select MSB-first or LSB-first transmission mode.

3. Set the SCK clock signal in the mode register, SMOD.

4. Set SIO interrupt enable flag (IES) to "1".

5. Initiate SIO transmission by setting bit 3 of the SMOD to "1".

6. When the SIO operation is complete, IRQS flag is set and an interrupt is generated.
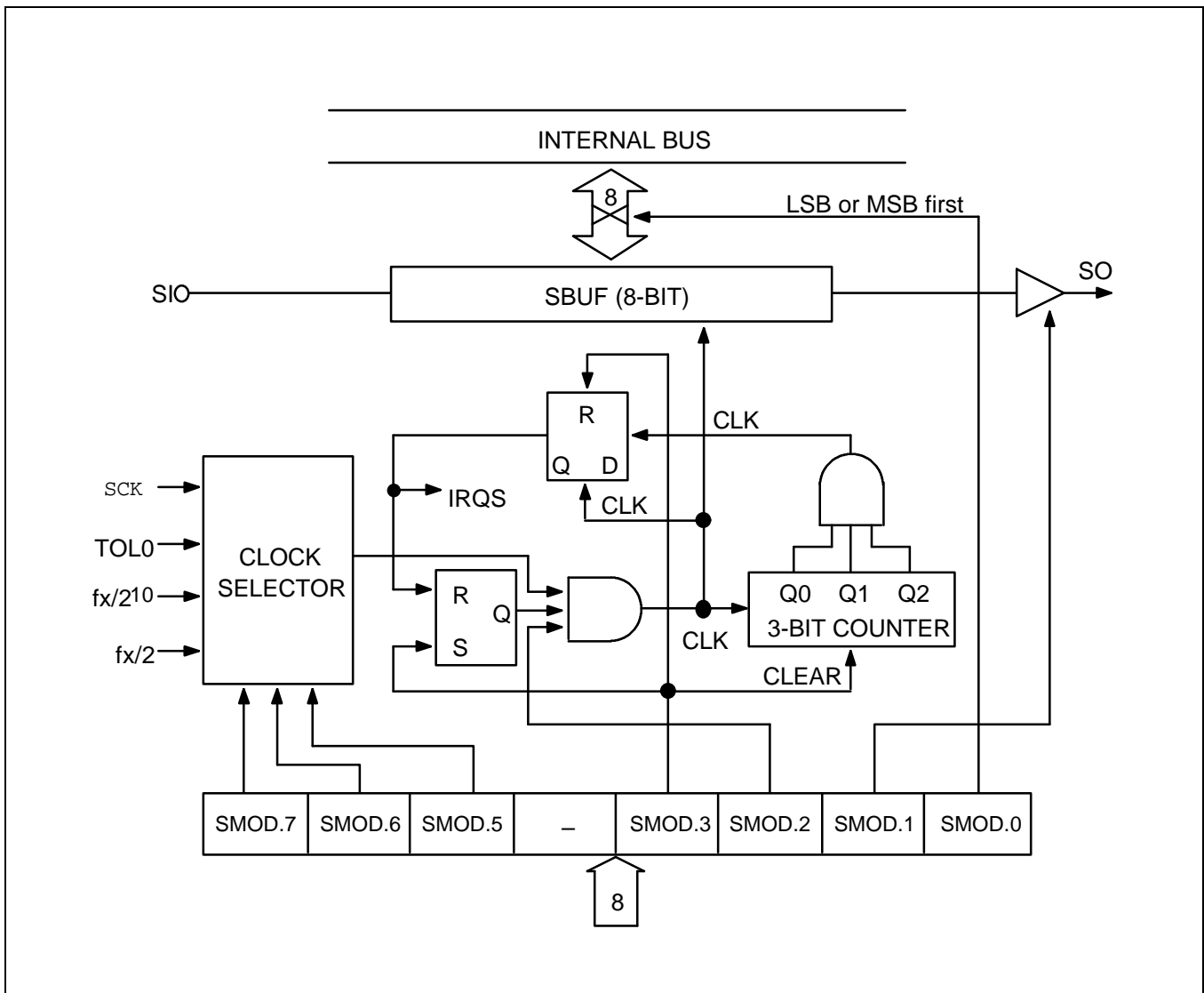
Figure 13–1. Serial I/O Interface Circuit Diagram

SERIAL I/O MODE REGISTER (SMOD)

The serial I/O mode register, SMOD, is an 8-bit register that specifies the operation mode of the serial interface. SMOD is mapped to RAM address FE0H–FE1H and its reset value is logic zero. SMOD is organized in two 4-bit registers, as follows:

FE0H	SMOD.3	SMOD.2	SMOD.1	SMOD.0
FE1H	SMOD.7	SMOD.6	SMOD.5	0

SMOD register settings enable you to select either MSB-first or LSB-first serial transmission, and to operate in transmit-and-receive mode or receive-only mode.

SMOD is a write-only register and can be addressed only by 8-bit RAM control instructions. One exception to this is SMOD.3, which can be written by a 1-bit RAM control instruction. When SMOD.3 is set to 1, the contents of the serial interface interrupt request flag, IRQS, and the 3-bit serial clock counter are cleared, and SIO operations are initiated. When the SIO transmission starts, SMOD.3 is cleared to logic zero.

Table 13–1. SIO Mode Register (SMOD) Organization

SMOD.0	0	Most significant bit (MSB) is transmitted first
	1	Least significant bit (LSB) is transmitted first
SMOD.1	0	Receive-only mode; output buffer is off
	1	Transmit-and-receive mode
SMOD.2	0	Disable the data shifter and clock counter; retain contents of IRQS flag when serial transmission is halted
	1	Enable the data shifter and clock counter; set IRQS flag to "1" when serial transmission is halted
SMOD.3	1	Clear IRQS flag and 3-bit clock counter to "0"; initiate transmission and then reset this bit to logic zero
SMOD.4	0	Bit not used; value is always "0"

SMOD.7	SMOD.6	SMOD.5	Clock Selection	R/W Status of SBUF
0	0	0	External clock at SCK pin	SBUF is enabled when SIO operation is halted or when SCK goes high.
0	0	1	Use TOL0 clock from TC0	
0	1	x	CPU clock: $f_x/4$, $f_x/8$, $f_x/64$	Enable SBUF read/write
1	0	0	4.09 kHz clock: $f_x/2^{10}$	SBUF is enabled when SIO operation is halted or when SCK goes high.
1	1	1	262 kHz clock: $f_x/2^4$	

NOTES:
1. 'fx' = system clock; 'x' means 'don't care.'
2. kHz frequency ratings assume a system clock (fx) running at 4.19 MHz.
3. The SIO clock selector circuit cannot select a $f_x/2^4$ clock if the CPU clock is $f_x/64$.

SERIAL I/O TIMING DIAGRAMS
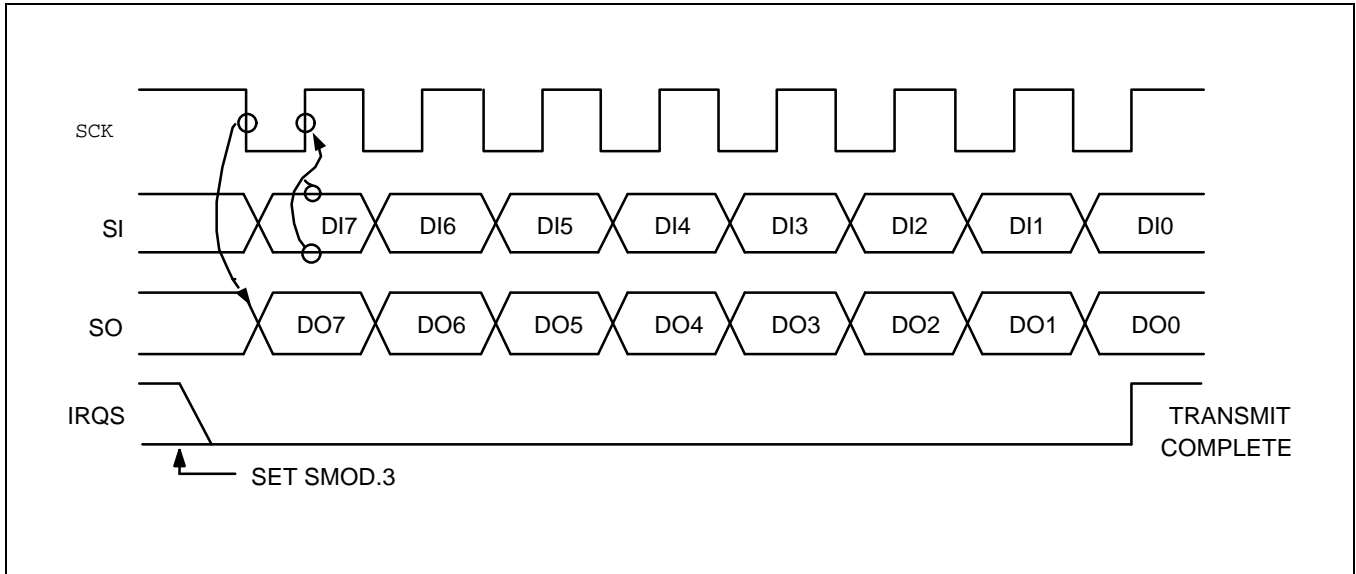
Figure 13–2. SIO Timing in Transmit/Receive Mode
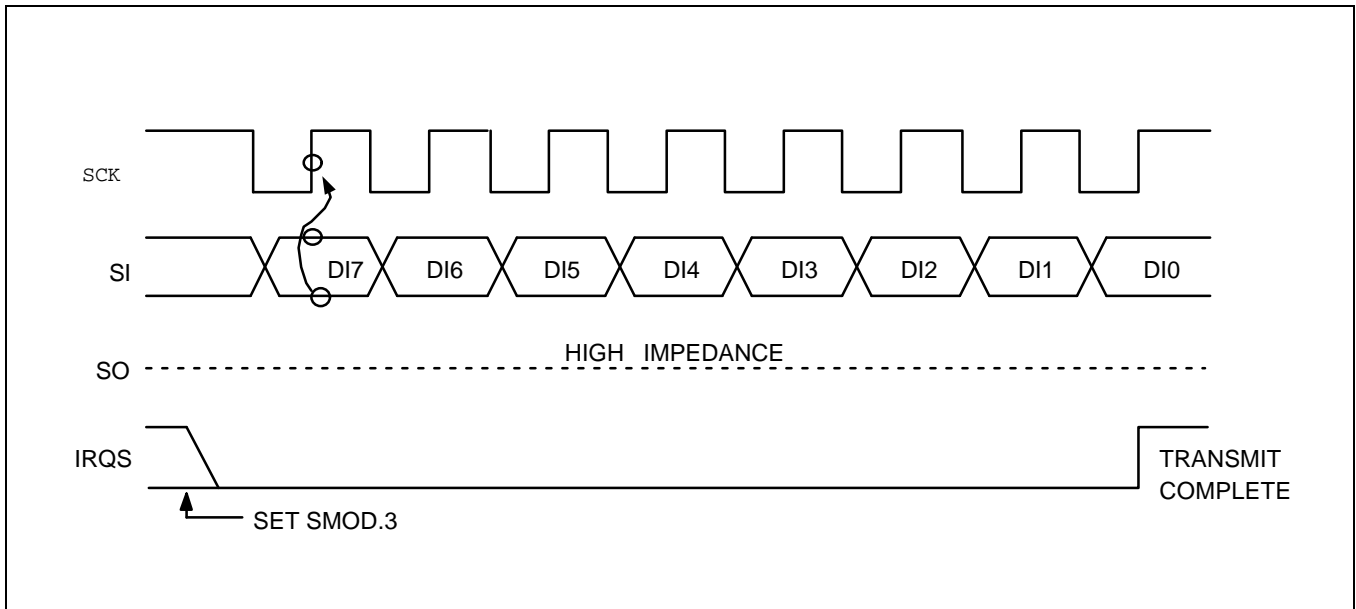
Figure 13–3. SIO Timing in Receive-Only Mode

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SERIAL I/O BUFFER REGISTER (SBUF)

When the serial interface operates in transmit-and-receive mode (SMOD.1 = "1"), transmit data in the SIO buffer register are output to the SO pin (P0.1) at the rate of one bit for each falling edge of the SIO clock. Receive data is simultaneously input from the SI pin (P0.2) to SBUF at the rate of one bit for each rising edge of the SIO clock.

When receive-only mode is used, incoming data is input to the SIO buffer at the rate of one bit for each rising edge of the SIO clock.

SBUF can be read or written using 8-bit RAM control instructions. It is mapped to addresses FE4H–FE5H. Following a RESET, the value of SBUF is undetermined.

☞ **PROGRAMMING TIP — Setting Transmit/Receive Modes for Serial I/O**

1. Transmit the data value 48H through the serial I/O interface using an internal clock frequency of $fx/2^4$
and   in MSB-first mode:

```
           BITS    EMB
           SMB     15
           LD      EA,#03H
           LD      PMG1,EA          ;   P0.0 / SCK and P0.1 / SO ← Output
           LD      EA,#48H          ;
           LD      SBUF,EA          ;
           LD      EA,#0EEH
           LD      SMOD,EA          ;   SIO data transfer
```

```
┌─────────────────────┐              ┌─────────────────┐
│                     │              │                 │
│   SCK   / P0.0      │─────────────▶│    EXTERNAL      │
│                     │              │                 │
│    SO / P0.1        │─────────────▶│    DEVICE        │
│                     │              │                 │
│                     │              │                 │
└─────────────────────┘              └─────────────────┘
```
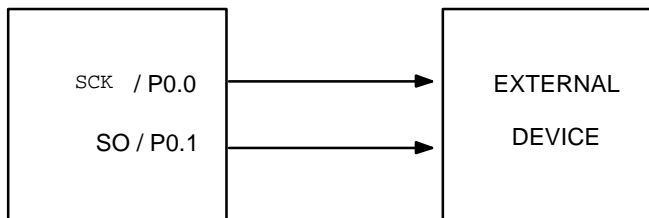
2. Use CPU clock to transfer and receive serial data at high speed:

```
           BITS    EMB
           SMB     15
           LD      EA,#03H
           LD      PMG1,EA          ;   P0.0 / SCK and P0.1 / SO ← Output, P0.2 / SI ← Input
           LD      EA,TDATA
           LD      SBUF,EA
           LD      EA,#4FH
           LD      SMOD,EA          ;   SIO start
           BITR    IES
STEST      BTSTZ   IRQS
           JR      STEST
           LD      EA,SBUF
           SMB     0
           LD      RDATA,EA
```

☞ **PROGRAMMING TIP — Setting Transmit/Receive Modes for Serial I/O (Continued)**

3. Transmit and receive an internal clock frequency of 4.09 kHz (at 4.19 MHz) in LSB-first mode:

```
            BITS    EMB
            SMB     15
            LD      EA,#03H
            LD      PMG1,EA         ;   P0.0 / SCK and P0.1 / SO ← Output, P0.2/SI ← Input
            LD      EA,TDATA
            LD      SBUF,EA
            LD      EA,#8FH
            LD      SMOD,EA         ;   SIO start
            EI
            BITS    IES
                      •
                      •
INTS        PUSH    SB              ;   Store SMB, SRB
            PUSH    EA              ;   Store EA
            LD      EA,TDATA        ;   EA ← Transmit data
            SMB     15
            XCH     EA,SBUF         ;   EA ← Receive data
            SMB     0
            LD      RDATA,EA        ;   RDATA ← Receive data
            BITS    SMOD.3          ;   SIO start
            POP     EA
            POP     SB
            IRET
```

```
            SCK  / P0.0  ───────────►  ┌──────────┐
            SO / P0.1    ───────────►  │ EXTERNAL │
            SI / P0.2    ◄───────────  │  DEVICE  │
                                       └──────────┘
```
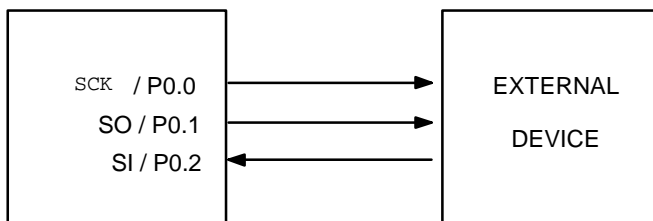
☞ **PROGRAMMING TIP — Setting Transmit/Receive Modes for Serial I/O (Continued)**

4. Transmit and receive an external clock in LSB-first mode:

```
            BITS    EMB
            SMB     15
            LD      EA,#02H
            LD      PMG1,EA         ;   P0.1 / SO ← Output, P0.0 / SCK and P0.2 / SI ← Input
            LD      EA,TDATA
            LD      SBUF,EA
            LD      EA,#0FH
            LD      SMOD,EA         ;   SIO start
            EI
            BITS    IES
                    •
                    •
INTS        PUSH    SB              ;   Store SMB, SRB
            PUSH    EA              ;   Store EA
            LD      EA,TDATA        ;   EA ← Transmit data
            SMB     15
            XCH     EA,SBUF         ;   EA ← Receive data
            SMB     0
            LD      RDATA,EA        ;   RDATA ← Receive data
            BITS    SMOD.3          ;   SIO start
            POP     EA
            POP     SB
            IRET
```

SCK / P0.0 ←——— EXTERNAL

SO / P0.1 ———→ DEVICE

SI / P0.2 ←———
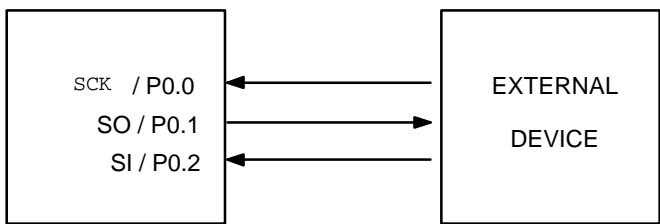
High Speed SIO Transmission

☞ **PROGRAMMING TIP — Setting Transmit/Receive Modes for Serial I/O (Concluded)**

Use CPU clock to transfer and receive serial data at high speed:

```
            BITS      EMB
            SMB       15
            LD        EA,#03H
            LD        PMG1,EA          ;   P0.0 / SCK and P0.1 / SO ← Output, P0.2 / SI ← Input
            LD        EA,TDATA
            LD        SBUF,EA
            LD        EA,#4FH
            LD        SMOD,EA          ;   SIO start
            BITR      IES
STEST       BTSTZ     IRQS
            JR        STEST
            LD        EA,SBUF
            SMB       0
            LD        RDATA,EA
```

14 ELECTRICAL DATA

Table 14–1. Absolute Maximum Ratings

$(T_A = 25 \,^{\circ}C)$

Parameter	Symbol	Conditions	Rating	Units
Supply Voltage	V_{DD}	–	-0.3 to $+6.5$	V
Input Voltage	V_I	All I/O ports	-0.3 to $V_{DD} + 0.3$	V
Output Voltage	V_O	–	-0.3 to $V_{DD} + 0.3$	V
Output Current High	I_{OH}	One I/O port active	-5	mA
		All I/O ports active	-15	
Output Current Low	I_{OL}	Ports 0, 3, and 6	5	mA
		Ports 4 and 5	30	
		All ports, total	$+100$	
Operating Temperature	T_A	–	-40 to $+85$	$^{\circ}C$
Storage Temperature	T_{stg}	–	-65 to $+150$	$^{\circ}C$

Table 14–2. D.C. Electrical Characteristics

$(T_A = -40 \,^{\circ}C$ to $+85 \,^{\circ}C$, $V_{DD} = 1.8$ V to 5.5 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Input High Voltage	V_{IH1}	Ports 4 and 5	$0.7V_{DD}$	–	V_{DD}	V
	V_{IH2}	Ports 0, 1, 2, 3, 6, and RESET	$0.8V_{DD}$	–	V_{DD}	
	V_{IH3}	X_{in} and X_{out}	$V_{DD} - 0.1$	–	V_{DD}	
Input Low Voltage	V_{IL1}	Ports 4 and 5	–	–	$0.3V_{DD}$	V
	V_{IL2}	Ports 0, 1, 2, 3, 6, and RESET			$0.2V_{DD}$	
	V_{IL3}	X_{in} and X_{out}			0.1	
Output High Voltage	V_{OH}	$V_{DD} = 4.5$ V to 5.5 V $I_{OH} = -1$ mA Ports 0, 3, 4, 5, 6	$V_{DD} - 1.0$	–	–	V

Table 14–2. D.C. Electrical Characteristics (Continued)

(T_A = $-$ 40 $^\circ$C to $+$ 85 $^\circ$C, V_{DD} = 1.8 V to 5.5 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Output Low Voltage	V_{OL}	V_{DD} = 4.5 V to 5.5 V I_{OL} = 15 mA Ports 4, 5	–	–	2	V
		V_{DD} = 4.5V to 5.5 V I_{OL} = 4.0mA All output pins except Ports 4, 5		–	2	
Input High Leakage Current	I_{LIH1}	V_{IN} = V_{DD} All input pins except X_{in} and X_{out}	–	–	3	μA
	I_{LIH2}	V_{IN} = V_{DD} X_{in} and X_{out}			20	
Input Low Leakage Current	I_{LIL1}	V_{IN} = 0 V All input pins except X_{in}, X_{out} and RESET	–	–	$-$ 3	μA
	I_{LIL2}	V_{IN} = 0 V X_{in} and X_{out}			$-$ 20	
Output High Leakage Current	I_{LOH}	V_O = V_{DD} All output pins	–	–	3	μA
Output Low Leakage Current	I_{LOL}	V_O = 0 V	–	–	$-$ 3	μA
Pull-Up Resistor	R_{L1}	V_I = 0 V; V_{DD} = 5 V Port 0, 1, 3, 4, 5, 6	25	50	100	kΩ
		V_{DD} = 3 V	50	100	200	
	R_{L2}	V_{DD} = 5 V; V_I = 0 V; RESET	100	250	400	
		V_{DD} = 3 V	200	500	800	

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Table 14–2. D.C. Electrical Characteristics (Concluded)

$(T_A = -40\ ^{\circ}C$ to $+85\ ^{\circ}C$, $V_{DD} = 1.8\ V$ to $5.5\ V)$

Parameter	Symbol	Conditions		Min	Typ	Max	Units
Supply Current [1]	I_{DD1}	Run mode; $V_{DD} = 5.0\ V \pm 10\%$	6.0MHz	–	3.0	8.0	mA
		Crystal oscillator; C1=C2=22pF	4.19MHz		2.0	5.5	
		$V_{DD} = 3\ V \pm 10\%$	6.0MHz		1.3	4.0	
			4.19MHz		1.0	3.0	
	I_{DD2}	Idle mode; $V_{DD} = 5.0\ V \pm 10\%$	6.0MHz	–	0.8	2.5	mA
		Crystal oscillator; C1=C2=22pF	4.19MHz		0.6	1.8	
		$V_{DD} = 3\ V \pm 10\%$	6.0MHz		0.6	1.5	
			4.19MHz		0.4	1.0	
	I_{DD3}	Stop mode; $V_{DD} = 5.0\ V \pm 10\%$		–	0.5	3.0	μA
		Stop mode; $V_{DD} = 3.0\ V \pm 10\%$			0.3	2.0	

NOTES:
1. D.C. electrical values for Supply current (I_{DD1} to I_{DD3}) do not include current drawn through internal pull-up registers, output port drive currents and comparator.
2. The supply current assumes a CPU clock of fx/4.

Figure 14–1. Standard Operating Voltage Range

Table 14–3. Oscillators Characteristics

$(T_A = -40\ ^\circ C\ +85\ ^\circ C,\ V_{DD} = 1.8\ V\ to\ 5.5\ V)$

Oscillator	Clock Configuration	Parameter	Test Condition	Min	Typ	Max	Units
Ceramic Oscillator	Xin Xout C1 C2	Oscillation frequency [1]	$V_{DD} = 2.7\ V$ to $5.5\ V$	0.4	–	6.0	MHz
			$V_{DD} = 1.8\ V$ to $5.5\ V$	0.4	–	4.2	
		Stabilization time [2]	$V_{DD} = 3.0\ V$	–	–	4	ms
Crystal Oscillator	Xin Xout C1 C2	Oscillation frequency [1]	$V_{DD} = 2.7\ V$ to $5.5\ V$	0.4	–	6.0	MHz
			$V_{DD} = 1.8\ V$ to $5.5\ V$	0.4	–	4.2	
		Stabilization time [2]	$V_{DD} = 3.0\ V$	–	–	10	ms
External Clock	Xin Xout	X_{in} input frequency [1]	$V_{DD} = 2.7\ V$ to $5.5\ V$	0.4	–	6.0	MHz
			$V_{DD} = 1.8\ V$ to $5.5\ V$	0.4	–	4.2	
		X_{in} input high and low level width (t_{XH}, t_{XL})	–	83.3	–	1250	ns

NOTES:
1. Oscillation frequency and X_{in} input frequency data are for oscillator characteristics only.
2. Stabilization time is the interval required for oscillating stabilization after a power-on occurs, or when stop mode is terminated.

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Table 14–4. Input/Output Capacitance

(T_A = 25 $^\circ$C, V_{DD} = 0 V)

Parameter	Symbol	Condition	Min	Typ	Max	Units
Input Capacitance	C_{IN}	f = 1 MHz; Unmeasured pins are returned to V_{SS}	–	–	15	pF
Output Capacitance	C_{OUT}				15	pF
I/O Capacitance	C_{IO}				15	pF

Table 14–5. Comparator Electrical Characteristics

(T_A = – 40 $^\circ$C to + 85 $^\circ$C, V_{DD} = 4.0 V to 5.5V, V_{SS} = 0 V)

Parameter	Symbol	Condition	Min	Typ	Max	Units
Input Voltage Range	–	–	0	–	V_{DD}	V
Reference Voltage Range	V_{REF}	–	0	–	V_{DD}	V
Input Voltage Accuracy	V_{CIN}	–	–	–	$\pm$150	mV
Input Leakage Current	I_{CIN}, I_{REF}	–	– 3	–	3	μA

Table 14–6. A.C. Electrical Characteristics

(T_A = – 40 $^\circ$C to + 85 $^\circ$C, V_{DD} = 1.8 V to 5.5 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Instruction Cycle Time	t_{CY}	V_{DD} = 2.7 V to 5.5 V	0.67	–	64	μs
		V_{DD} = 1.8 V to 5.5 V	0.95			
TCL0 Input Frequency	f_{TI}	V_{DD} = 2.7 V to 5.5 V	0	–	1.5	MHz
		V_{DD} = 1.8 V to 5.5 V			1	MHz
TCL0 Input High, Low Width	t_{TIH}, t_{TIL}	V_{DD} = 2.7 V to 5.5 V	0.48	–	–	μs
		V_{DD} = 1.8 V to 5.5 V	1.8			
SCK Cycle Time	t_{KCY}	V_{DD} = 2.7 V to 5.5 V External SCK source	800	–	–	ns
		Internal SCK source	670			
		V_{DD} = 1.8 V to 5.5 V External SCK source	3200			
		Internal SCK source	3800			

Table 14–6. A.C. Electrical Characteristics (Concluded)

($T_A = -40\ °C$ to $+85\ °C$, V_{DD} = 1.8 V to 5.5 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
SCK High, Low Width	t_{KH}, t_{KL}	V_{DD} = 2.7 V to 5.5 V External SCK source	335	–	–	ns
		Internal SCK source	$t_{KCY}/2 - 50$			
		V_{DD} = 1.8 V to 5.5 V External SCK source	1600			
		Internal SCK source	$t_{KCY}/2 - 150$			
SI Setup Time to SCK High	t_{SIK}	V_{DD} = 2.7 V to 5.5 V External SCK source	100	–	–	ns
		Internal SCK source	150			
		V_{DD} = 1.8 V to 5.5 V External SCK source	150			
		Internal SCK source	500			
SI Hold Time to SCK High	t_{KSI}	V_{DD} = 2.7 V to 5.5 V External SCK source	400	–	–	ns
		Internal SCK source	400			
		V_{DD} = 1.8 V to 5.5 V External SCK source	600			
		Internal SCK source	500			
Output Delay for SCK to SO	t_{KSO} [1]	V_{DD} = 2.7 V to 5.5 V External SCK source	–	–	300	ns
		Internal SCK source			250	
		V_{DD} = 1.8 V to 5.5 V External SCK source			1000	
		Internal SCK source			1000	
Interrupt Input High, Low Width	t_{INTH}, t_{INTL}	INT0	(2)	–	–	μs
		INT1, KS0 - KS2	10			
RESET Input Low Width	t_{RSL}	Input	10	–	–	μs

NOTES:
1. R(1Kohm) and C (100pF) are the load resistance and load capacitance of the SO output line.
2. Minimum value for INT0 is based on a clock of $2t_{CY}$ or 128 / fx as assigned by the IMOD0 register setting.

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Table 14-7. RAM Data Retention Supply Voltage in Stop Mode

$(T_A = - 40 \,^{\circ}C \; to \; + 85 \,^{\circ}C)$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Data retention supply voltage	V_{DDDR}	–	1.8	–	5.5	V
Data retention supply current	I_{DDDR}	V_{DDDR} = 1.8 V	–	0.1	10	µA
Release signal set time	t_{SREL}	–	0	–	–	µs
Oscillator stabilization wait time [1]	t_{WAIT}	Released by RESET	–	2^{17} / fx	–	ms
		Released by interrupt	–	(2)	–	ms

NOTES:
1.   During oscillator stabilization wait time, all CPU operations must be stopped to avoid instability during oscillator start-up.
2.   Use the basic timer mode register (BMOD) interval timer to delay execution of CPU instructions during the wait time.

TIMING WAVEFORMS
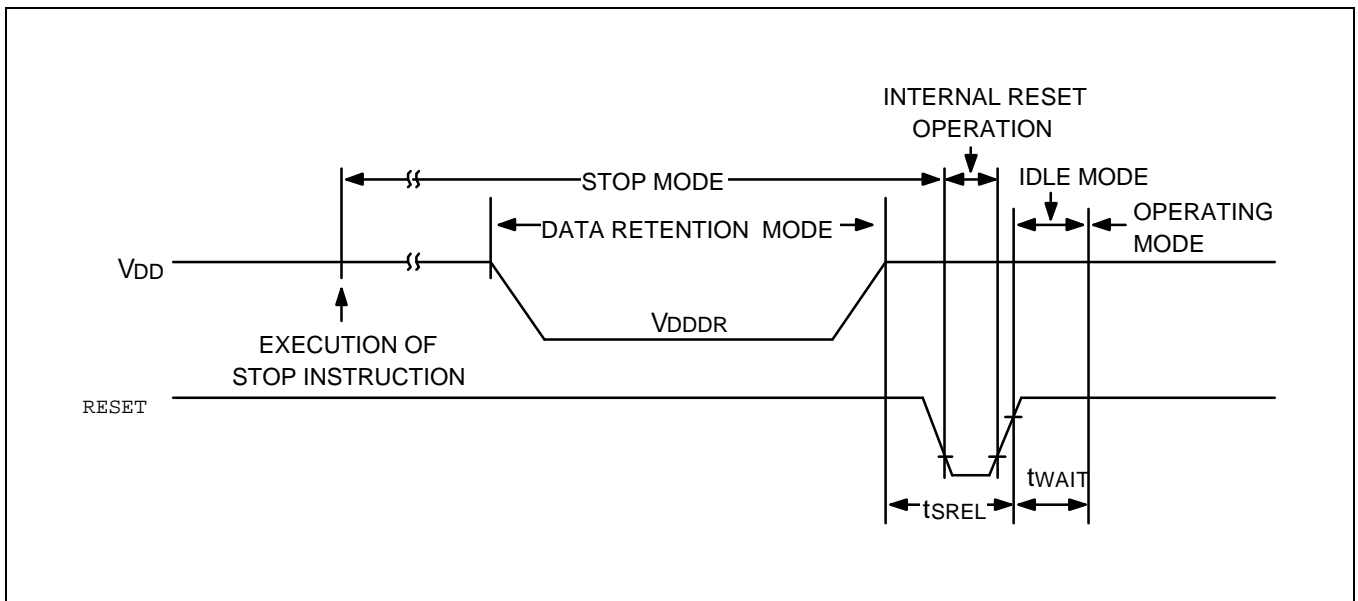
Figure 14–2. Stop Mode Release Timing When Initiated By RESET
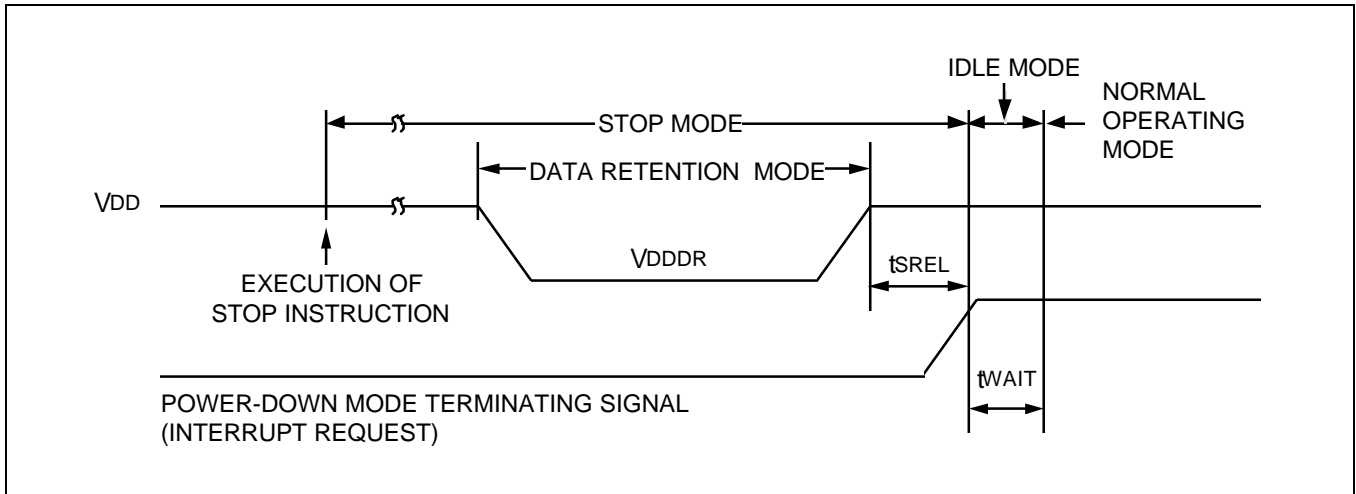
Figure 14–3. Stop Mode Release Timing When Initiated By Interrupt Request
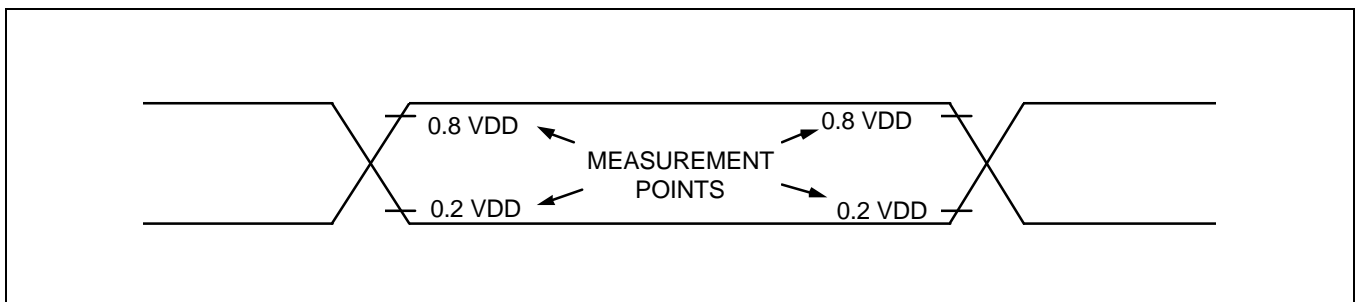
Figure 14–4. A.C. Timing Measurement Points (Except for X$_{in}$)
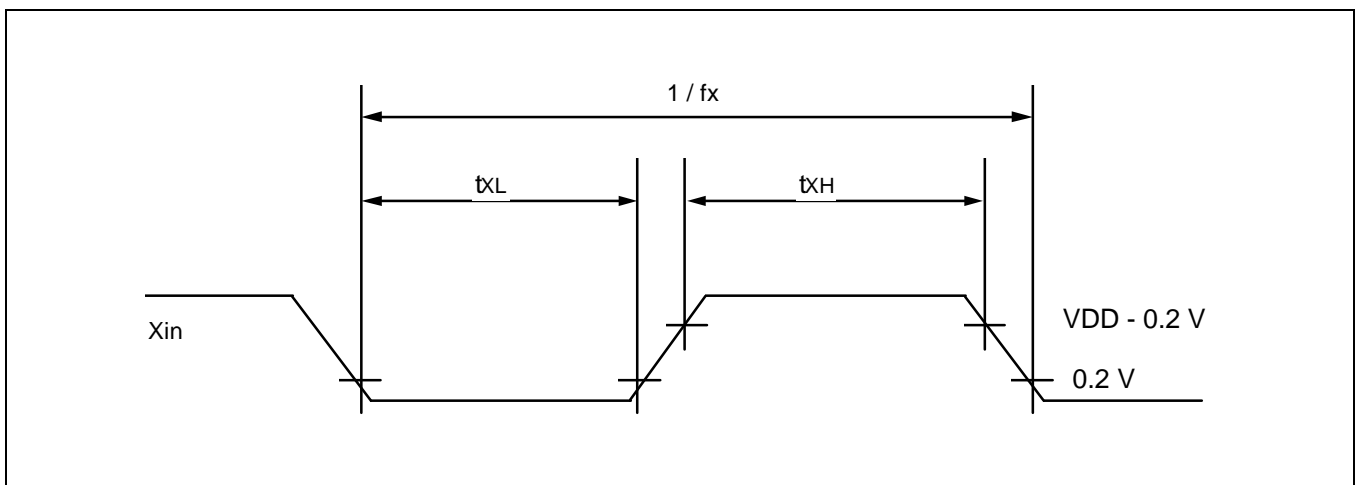
Figure 14–5. Clock Timing Measurement at X$_{in}$

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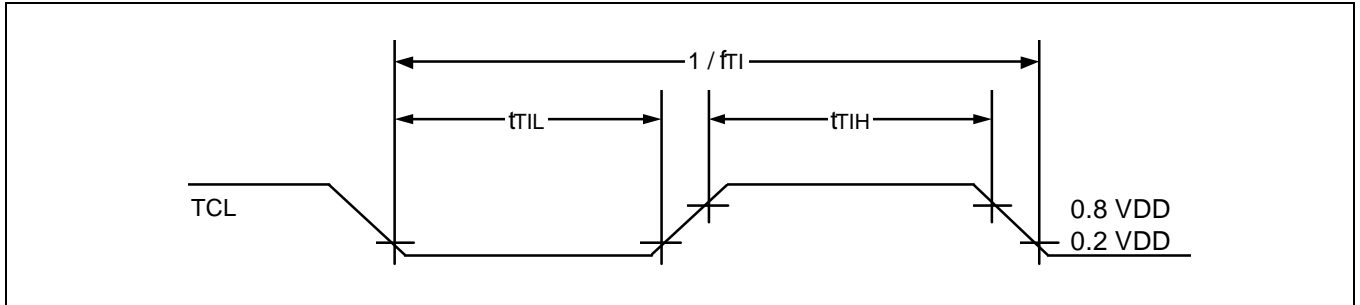
Figure 14–6. TCL Timing
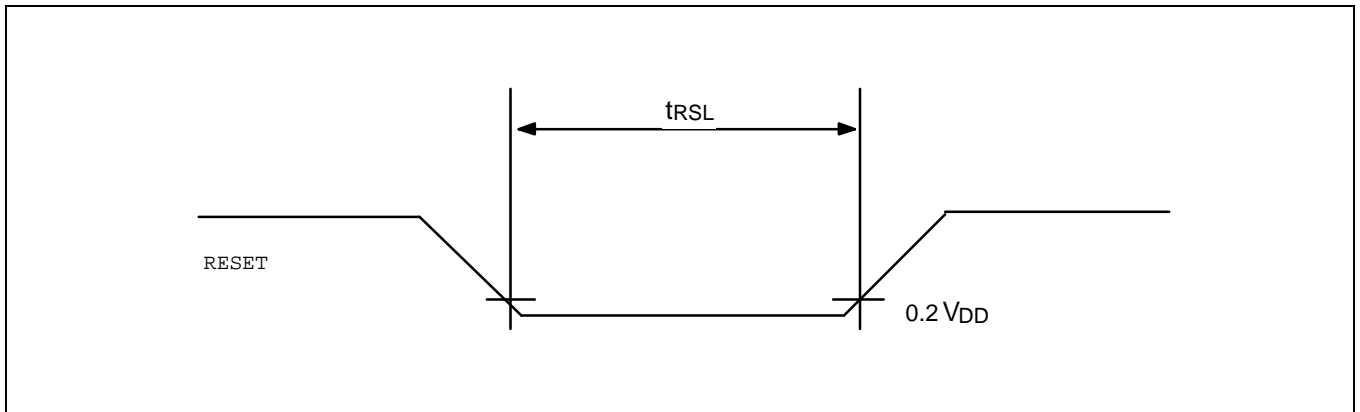
Figure 14–7. Input Timing for RESET Signal
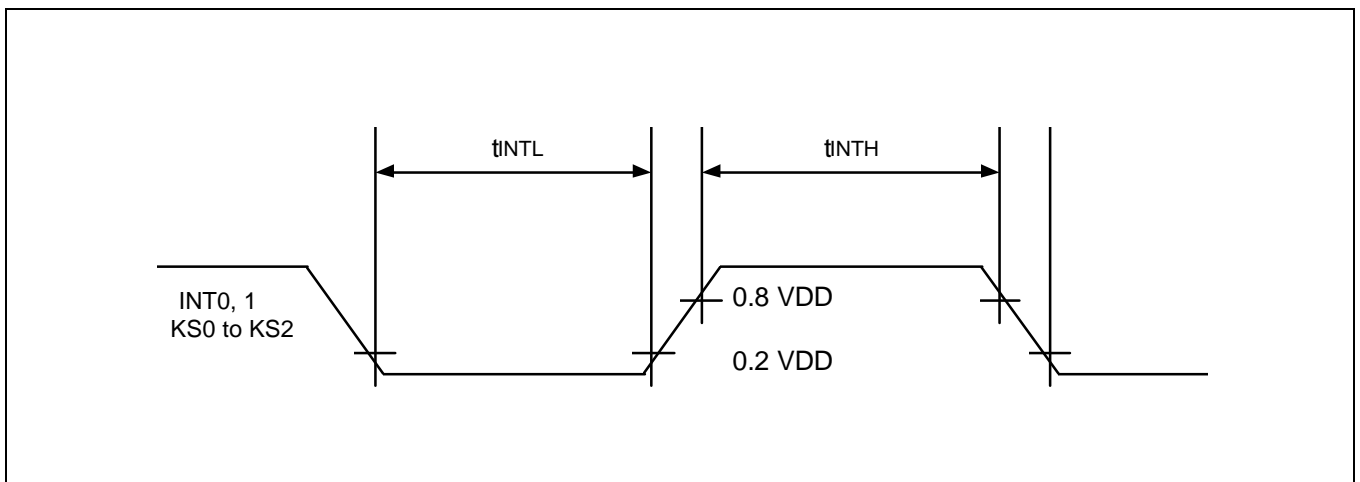
Figure 14–8. Input Timing for External Interrupts
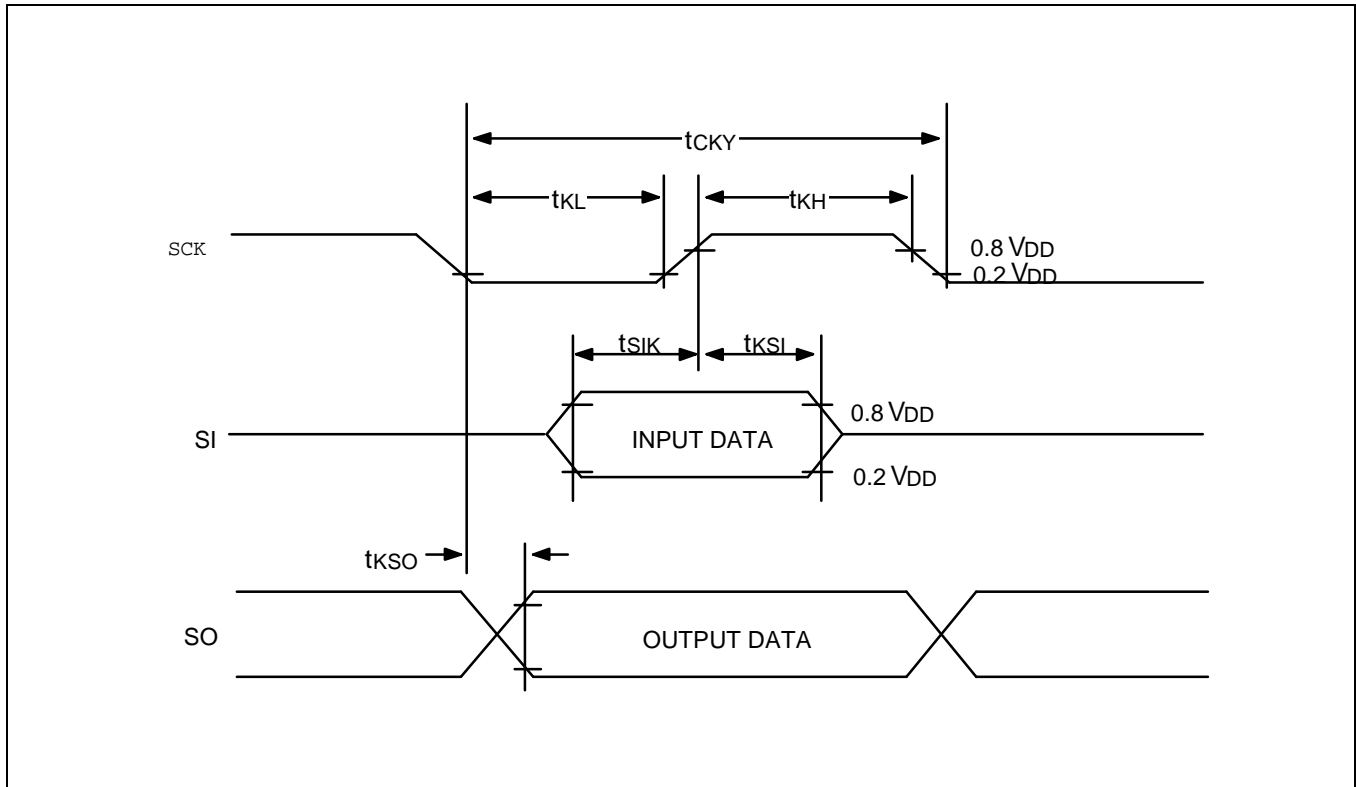
Figure 14–9. Serial Data Transfer Timing

15 MECHANICAL DATA

This section contains the following information about the device package:

— Package dimensions in millimeters

— Pad diagram

— Pad/pin coordinate data table

NOTE: Typical dimensions are in millimeters.
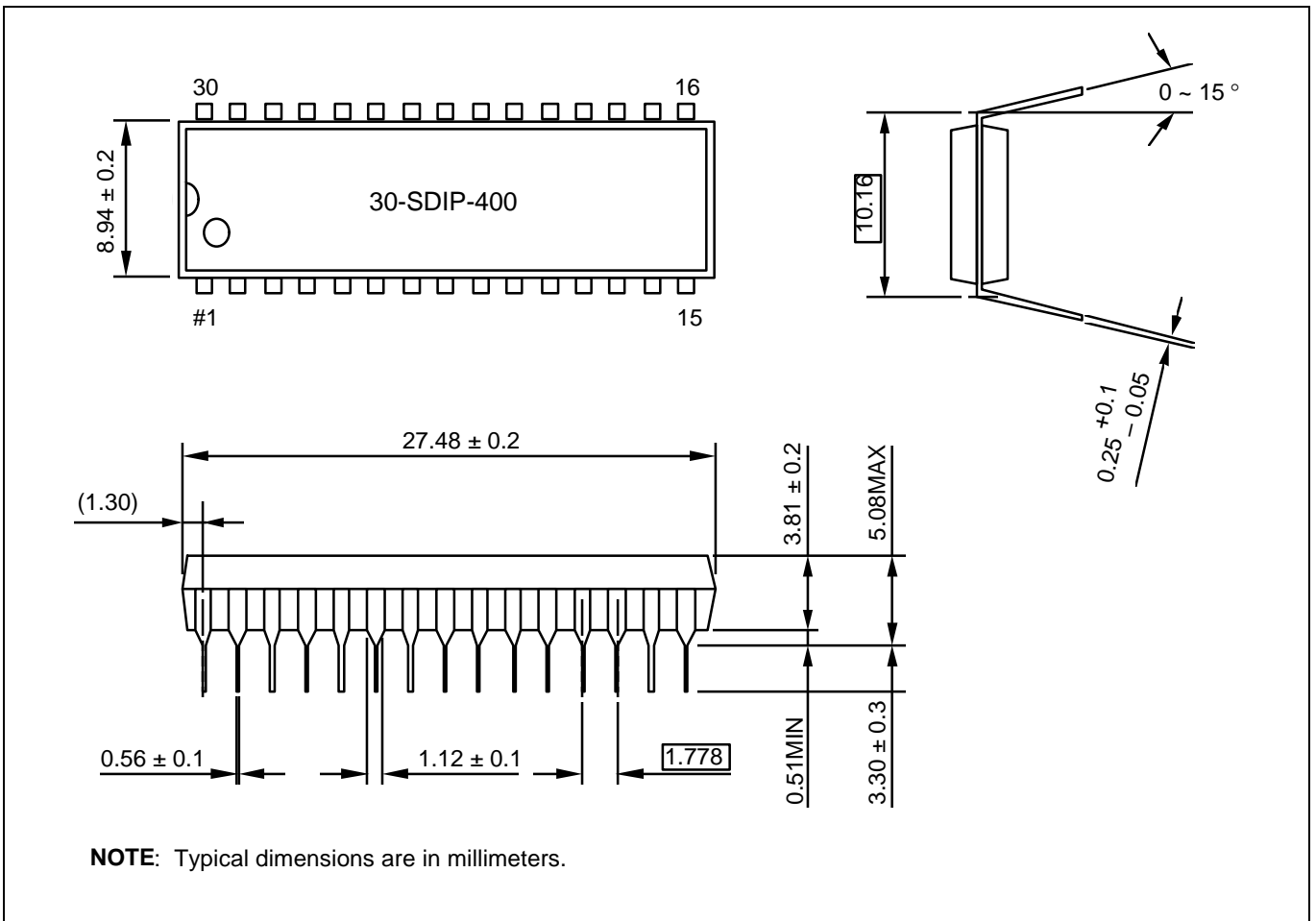
Figure 15–1. 30-SDIP-400 Package Dimensions

16 KS57P0504 OTP

OVERVIEW

The KS57P0504 single-chip CMOS microcontroller is the OTP (One Time Programmable) version of the KS57C0502/C0504 microcontroller. It has an on-chip OTP ROM instead of masked ROM. The EPROM is accessed by serial data format.

The KS57P0504 is fully compatible with the KS57C0502/C0504, both in function and in pin configuration. Because of its simple programming requirements, the KS57P0504 is ideal for use as an evaluation chip for the KS57C0502/C0504.

VSS / VSS	1	30	VDD / **VDD**
Xout	2	29	P6.3 / BUZ / **SCLK**
Xin	3	28	P6.2 / KS2 / **SDAT**
TEST/ TEST	4	27	P6.1 / KS1
P1.0 / INT0	5	26	P6.0 / KS0
P1.1 / INT1	6	25	P5.3
RESET / RESET	7	24	P5.2
P0.0 / SCK	8	23	P5.1
P0.1 / SO	9	22	P5.0
P0.2 / SI	10	21	P4.3
P2.0 / CIN0	11	20	P4.2
P2.1 / CIN1	12	19	P4.1
P2.2 / CIN2	13	18	P4.0
P2.3 / CIN3	14	17	P3.2 / CLO
P3.0 / TCL0	15	16	P3.1 / TCLO0

KS57P0504
(30-SDIP)

NOTE: The bolds indicate an OTP pin name.
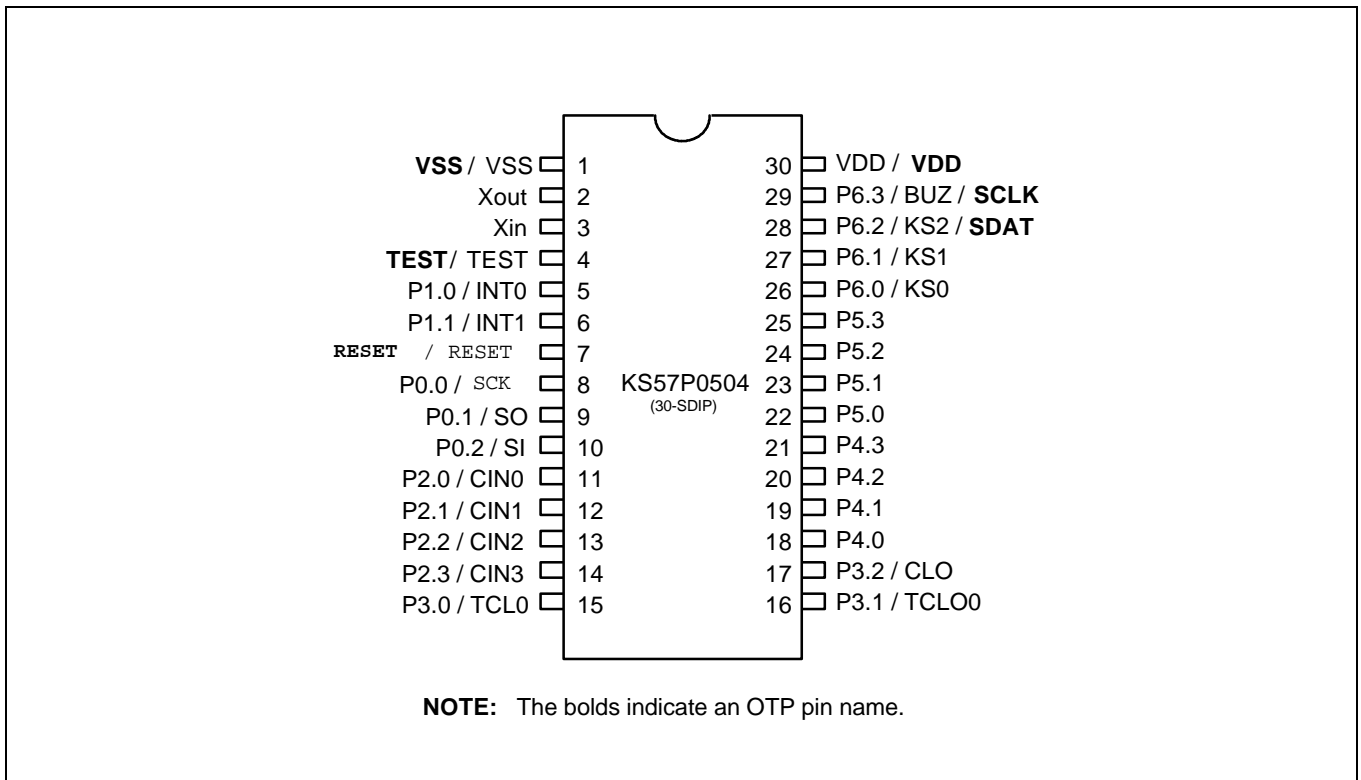
Figure 16–1. KS57P0504 Pin Assignments (30-SDIP Package)
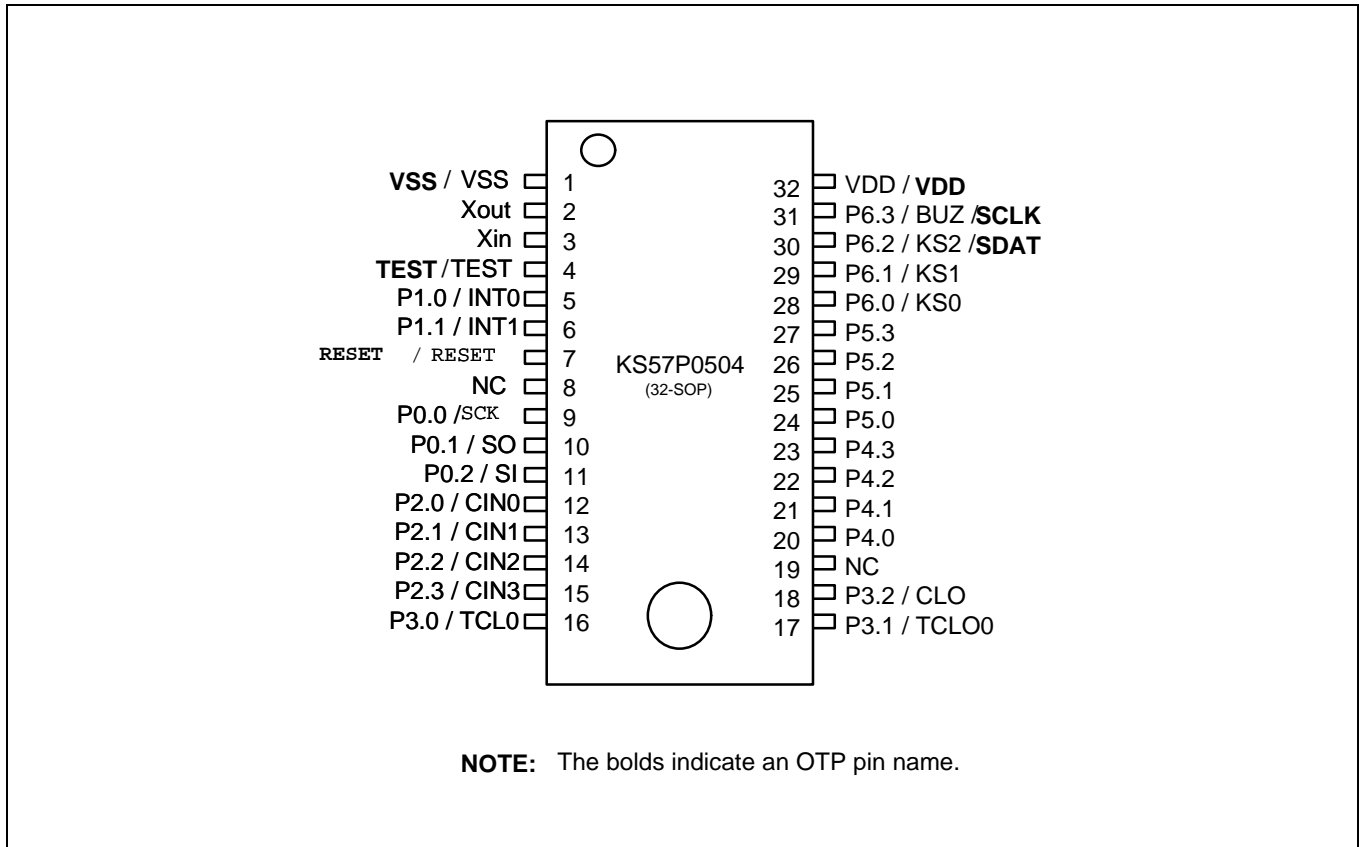
Figure 16–2. KS57P0504 Pin Assignments (32-SOP Package)

Table 16–1. Descriptions of Pins Used to Read/Write the EPROM

Main Chip Pin Name	During Programming			
	Pin Name	Pin No.	I/O	Function
P6.2	SDAT	28 (30)	I/O	Serial data pin. Output port when reading and input port when writing. Can be assigned as a Input / push-pull output port.
P6.3	SCLK	29 (31)	I/O	Serial clock pin. Input only pin.
TEST	V_{PP}(TEST)	4 (4)	I	Power supply pin for EPROM cell writing (indicates that OTP enters into the writing mode). When 12.5 V is applied, OTP is in writing mode and when 5 V is applied, OTP is in reading mode. (Option)
RESET	RESET	7 (7)	I	Chip initialization
V_{DD} / V_{SS}	V_{DD} / V_{SS}	30/1 (32/1)	I	Logic power supply pin. VDD should be tied to +5 V during programming.

NOTE: ( ) means the 32-SOP OTP pin number.

Table 16–2. Comparison of KS57P0504 and KS57C0502/C0504 Features

Characteristic	KS57P0504	KS57C0502/C0504
Program Memory	4 K-byte EPROM	2 K-byte mask ROM: KS57C0502 4 K-byte mask ROM: KS57C0504
Operating Voltage (V_{DD})	2.0 V to 5.5 V	1.8 V to 5.5V
OTP Programming Mode	V_{DD} = 5 V, V_{PP}(TEST)=12.5V	–
Pin Configuration	30 SDIP, 32 SOP	30 SDIP, 32 SOP
EPROM Programmability	User Program one time	Programmed at the factory

OPERATING MODE CHARACTERISTICS

When 12.5 V is supplied to the V_{PP}(TEST) pin of the KS57P0504, the EPROM programming mode is entered. The operating mode (read, write, or read protection) is selected according to the input signals to the pins listed in Table 16–3 below.

Table 16–3. Operating Mode Selection Criteria

V_{DD}	VPP (TEST)	REG/ MEM	ADDRESS (A15-A0)	R/W	MODE
5 V	5 V	0	0000H	1	EPROM read
	12.5 V	0	0000H	0	EPROM program
	12.5 V	0	0000H	1	EPROM verify
	12.5 V	1	0E3FH	0	EPROM read protection

NOTE: "0" means Low level; "1" means High level.

OTP ELECTRICAL DATA

Table 16–4. Absolute Maximum Ratings

$(T_A = 25 \, ^{\circ}C)$

Parameter	Symbol	Conditions	Rating	Units
Supply Voltage	V_{DD}	–	-0.3 to $+6.5$	V
Input Voltage	V_I	All I/O ports	-0.3 to $V_{DD} + 0.3$	V
Output Voltage	V_O	–	-0.3 to $V_{DD} + 0.3$	V
Output Current High	I_{OH}	One I/O port active	-5	mA
		All I/O ports active	-15	
Output Current Low	I_{OL}	Ports 0, 3, and 6	5	mA
		Ports 4 and 5	30	
		All ports, total	$+100$	
Operating Temperature	T_A	–	-40 to $+85$	$^{\circ}C$
Storage Temperature	T_{stg}	–	-65 to $+150$	$^{\circ}C$

Table 16–5. D.C. Electrical Characteristics

$(T_A = -40 \, ^{\circ}C$ to $+85 \, ^{\circ}C, V_{DD} = 2.0 \, V$ to $5.5 \, V)$

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Input High Voltage	V_{IH1}	Ports 4 and 5	$0.7V_{DD}$	–	V_{DD}	V
	V_{IH2}	Ports 0, 1, 2, 3, 6, and RESET	$0.8V_{DD}$	–	V_{DD}	
	V_{IH3}	X_{in} and X_{out}	$V_{DD} - 0.1$	–	V_{DD}	
Input Low Voltage	V_{IL1}	Ports 4 and 5	–	–	$0.3V_{DD}$	V
	V_{IL2}	Ports 0, 1, 2, 3, 6, and RESET			$0.2V_{DD}$	
	V_{IL3}	X_{in} and X_{out}			0.1	
Output High Voltage	V_{OH}	$V_{DD} = 4.5 \, V$ to $5.5 \, V$ $I_{OH} = -1 \, mA$ Ports 0, 3, 4, 5, 6	$V_{DD} - 1.0$	–	–	V

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Table 16–5. D.C. Electrical Characteristics (Continued)

$(T_A = -40\ °C$ to $+85\ °C$, $V_{DD} = 2.0$ V to 5.5 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Output Low Voltage	V_{OL}	$V_{DD} = 4.5$ V to 5.5 V $I_{OL} = 15$ mA Ports 4, 5	–	–	2	V
		$V_{DD} = 4.5$V to 5.5 V $I_{OL} = 4.0$mA All output pins except Ports 4, 5		–	2	
Input High Leakage Current	I_{LIH1}	$V_{IN} = V_{DD}$ All input pins except X_{in} and X_{out}	–	–	3	µA
	I_{LIH2}	$V_{IN} = V_{DD}$ X_{in} and X_{out}			20	
Input Low Leakage Current	I_{LIL1}	$V_{IN} = 0$ V All input pins except X_{in}, X_{out} and RESET	–	–	– 3	µA
	I_{LIL2}	$V_{IN} = 0$ V X_{in} and X_{out}			– 20	
Output High Leakage Current	I_{LOH}	$V_O = V_{DD}$ All output pins	–	–	3	µA
Output Low Leakage Current	I_{LOL}	$V_O = 0$ V	–	–	– 3	µA
Pull-Up Resistor	R_{L1}	$V_I = 0$ V; $V_{DD} = 5$ V Port 0, 1, 3, 4, 5, 6	25	50	100	kΩ
		$V_{DD} = 3$ V	50	100	200	
	R_{L2}	$V_{DD} = 5$ V; $V_I = 0$ V; RESET	100	250	400	
		$V_{DD} = 3$ V	200	500	800	

Table 16–5. D.C. Electrical Characteristics (Concluded)

($T_A = -40\ ^\circ C$ to $+85\ ^\circ C$, $V_{DD} = 2.0$ V to 5.5 V)

Parameter	Symbol	Conditions		Min	Typ	Max	Units
Supply Current [1]	I_{DD1}	Run mode; $V_{DD} = 5.0$ V $\pm$ 10%	6.0MHz	–	3.0	8.0	mA
		Crystal oscillator; C1=C2=22pF	4.19MHz		2.0	5.5	
		$V_{DD} = 3$ V $\pm$ 10%	6.0MHz		1.3	4.0	
			4.19MHz		1.0	3.0	
	I_{DD2}	Idle mode; $V_{DD} = 5.0$ V $\pm$ 10%	6.0MHz	–	0.8	2.5	mA
		Crystal oscillator; C1=C2=22pF	4.19MHz		0.6	1.8	
		$V_{DD} = 3$ V $\pm$ 10%	6.0MHz		0.6	1.5	
			4.19MHz		0.4	1.0	
	I_{DD3}	Stop mode; $V_{DD} = 5.0$ V $\pm$ 10%		–	0.5	3.0	µA
		Stop mode; $V_{DD} = 3.0$ V $\pm$ 10%			0.3	2.0	

NOTES:
1. D.C. electrical values for Supply current (I_{DD1} to I_{DD3}) do not include current drawn through internal pull-up registers, output port drive currents and comparator.
2. The supply current assumes a CPU clock of fx/4.

Figure 16–3. Standard Operating Voltage Range

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Table 16–6. Oscillators Characteristics

$(T_A = -40\ ^{\circ}C\ +85\ ^{\circ}C,\ V_{DD} = 2.0\ V\ to\ 5.5\ V)$

Oscillator	Clock Configuration	Parameter	Test Condition	Min	Typ	Max	Units
Ceramic Oscillator	Xin Xout C1 C2	Oscillation frequency [1]	$V_{DD} = 2.7\ V\ to\ 5.5\ V$	0.4	–	6.0	MHz
			$V_{DD} = 2.0\ V\ to\ 5.5\ V$	0.4	–	4.2	
		Stabilization time [2]	$V_{DD} = 3.0\ V$	–	–	4	ms
Crystal Oscillator	Xin Xout C1 C2	Oscillation frequency [1]	$V_{DD} = 2.7\ V\ to\ 5.5\ V$	0.4	–	6.0	MHz
			$V_{DD} = 2.0\ V\ to\ 5.5\ V$	0.4	–	4.2	
		Stabilization time [2]	$V_{DD} = 3.0\ V$	–	–	10	ms
External Clock	Xin Xout	X_{in} input frequency [1]	$V_{DD} = 2.7\ V\ to\ 5.5\ V$	0.4	–	6.0	MHz
			$V_{DD} = 2.0\ V\ to\ 5.5\ V$	0.4	–	4.2	
		X_{in} input high and low level width (t_{XH}, t_{XL})	–	83.3	–	1250	ns

NOTES:

1. Oscillation frequency and X_{in} input frequency data are for oscillator characteristics only.
2. Stabilization time is the interval required for oscillating stabilization after a power-on occurs, or when stop mode is terminated.

Table 16–7. Input/Output Capacitance

(T_A = 25 $°$C, V_{DD} = 0 V)

Parameter	Symbol	Condition	Min	Typ	Max	Units
Input Capacitance	C_{IN}	f = 1 MHz; Unmeasured pins are returned to V_{SS}	–	–	15	pF
Output Capacitance	C_{OUT}				15	pF
I/O Capacitance	C_{IO}				15	pF

Table 16–8. Comparator Electrical Characteristics

(T_A = $-$ 40 $°$C to + 85 $°$C, V_{DD} = 4.0 V to 5.5V, V_{SS} = 0 V)

Parameter	Symbol	Condition	Min	Typ	Max	Units
Input Voltage Range	–	–	0	–	V_{DD}	V
Reference Voltage Range	V_{REF}	–	0	–	V_{DD}	V
Input Voltage Accuracy	V_{CIN}	–	–	–	±150	mV
Input Leakage Current	I_{CIN}, I_{REF}	–	$-$ 3	–	3	µA

Table 16–9. A.C. Electrical Characteristics

(T_A = $-$ 40 $°$C to + 85 $°$C, V_{DD} = 2.0 V to 5.5 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Instruction Cycle Time	t_{CY}	V_{DD} = 2.7 V to 5.5 V	0.67	–	64	µs
		V_{DD} = 2.0 V to 5.5 V	0.95			
TCL0 Input Frequency	f_{TI}	V_{DD} = 2.7 V to 5.5 V	0	–	1.5	MHz
		V_{DD} = 2.0 V to 5.5 V			1	MHz
TCL0 Input High, Low Width	t_{TIH}, t_{TIL}	V_{DD} = 2.7 V to 5.5 V	0.48	–	–	µs
		V_{DD} = 2.0 V to 5.5 V	1.8			
SCK Cycle Time	t_{KCY}	V_{DD} = 2.7 V to 5.5 V External SCK source	800	–	–	ns
		Internal SCK source	670			
		V_{DD} = 2.0 V to 5.5 V External SCK source	3200			
		Internal SCK source	3800			

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Table 16–9. A.C. Electrical Characteristics (Concluded)

$(T_A = -40\ ^{\circ}C$ to $+85\ ^{\circ}C$, $V_{DD} = 2.0\ V$ to $5.5\ V)$

Parameter	Symbol	Conditions	Min	Typ	Max	Units
SCK High, Low Width	t_{KH}, t_{KL}	$V_{DD} = 2.7\ V$ to $5.5\ V$ External SCK source	335	–	–	ns
		Internal SCK source	$t_{KCY}/2$ - 50			
		$V_{DD} = 2.0\ V$ to $5.5\ V$ External SCK source	1600			
		Internal SCK source	$t_{KCY}/2$ - 150			
SI Setup Time to SCK High	t_{SIK}	$V_{DD} = 2.7\ V$ to $5.5\ V$ External SCK source	100	–	–	ns
		Internal SCK source	150			
		$V_{DD} = 2.0\ V$ to $5.5\ V$ External SCK source	150			
		Internal SCK source	500			
SI Hold Time to SCK High	t_{KSI}	$V_{DD} = 2.7\ V$ to $5.5\ V$ External SCK source	400	–	–	ns
		Internal SCK source	400			
		$V_{DD} = 2.0\ V$ to $5.5\ V$ External SCK source	600			
		Internal SCK source	500			
Output Delay for SCK to SO	t_{KSO} [1]	$V_{DD} = 2.7\ V$ to $5.5\ V$ External SCK source	–	–	300	ns
		Internal SCK source			250	
		$V_{DD} = 2.0\ V$ to $5.5\ V$ External SCK source			1000	
		Internal SCK source			1000	
Interrupt Input High, Low Width	t_{INTH}, t_{INTL}	INT0	(2)	–	–	µs
		INT1, KS0 - KS2	10			
RESET Input Low Width	t_{RSL}	Input	10	–	–	µs

NOTES:
1. R(1Kohm) and C (100pF) are the load resistance and load capacitance of the SO output line.
2. Minimum value for INT0 is based on a clock of $2t_{CY}$ or 128 / fx as assigned by the IMOD0 register setting.

Table 16–10. RAM Data Retention Supply Voltage in Stop Mode

$(T_A = -40 \,^{\circ}C \text{ to } +85 \,^{\circ}C)$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Data retention supply voltage	V_{DDDR}	–	2.0	–	5.5	V
Data retention supply current	I_{DDDR}	$V_{DDDR} = 2.0$ V	–	0.1	10	μA
Release signal set time	t_{SREL}	–	0	–	–	μs
Oscillator stabilization wait time [1]	t_{WAIT}	Released by RESET	–	2^{17} / fx	–	ms
		Released by interrupt	–	(2)	–	ms

NOTES:
1. During oscillator stabilization wait time, all CPU operations must be stopped to avoid instability during oscillator start-up.
2. Use the basic timer mode register (BMOD) interval timer to delay execution of CPU instructions during the wait time.

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START

Address= First Location

V_{DD}=5V, V_{PP}=12.5V

x = 0

Program One 1ms Pulse

Increment X

YES   x = 10   NO

FAIL   Verify Byte   Verify 1 Byte   FAIL

Last Address   NO   Increment Address

$V_{DD} = V_{PP}$= 5 V

FAIL   Compare All Byte

PASS

Device Failed   Device Passed

Figure 16–4. OTP Programming Algorithm

NOTES

17 Development Tools

OVERVIEW

Samsung provides a powerful and easy-to-use development support system in turnkey form. The development support system is configured with a host system, debugging tools, and support software. For the host system, any standard computer that operates with MS-DOS as its operating system can be used. One type of debugging tool including hardware and software is provided: the sophisticated and powerful in-circuit emulator, SMDS2+, for KS57, KS86, KS88 families of microcontrollers. The SMDS2+ is a new and improved version of SMDS2. Samsung also offers support software that includes debugger, assembler, and a program for setting options.

SHINE

Samsung Host Interface for In-Circuit Emulator, SHINE, is a multi-window based debugger for SMDS2+. SHINE provides pull-down and pop-up menus, mouse support, function/hot keys, and context-sensitive hyper-linked help. It has an advanced, multiple-windowed user interface that emphasizes ease of use. Each window can be sized, moved, scrolled, highlighted, added, or removed completely.

SAMA ASSEMBLER

The Samsung Arrangeable Microcontroller (SAM) Assembler, SAMA, is a universal assembler, and generates object code in standard hexadecimal format. Assembled program code includes the object code that is used for ROM data and required SMDS program control data. To assemble programs, SAMA requires a source file and an auxiliary definition (DEF) file with device specific information.

SASM57

The SASM57 is an relocatable assembler for Samsung's KS57-series microcontrollers. The SASM57 takes a source file containing assembly language statements and translates into a corresponding source code, object code and comments. The SASM57 supports macros and conditional assembly. It runs on the MS-DOS operating system. It produces the relocatable object code only, so the user should link object file. Object files can be linked with other object files and loaded into memory.

HEX2ROM

HEX2ROM file generates ROM code from HEX file which has been produced by assembler. ROM code must be needed to fabricate a microcontroller which has a mask ROM. When generating the ROM code (.OBJ file) by HEX2ROM, the value 'FF' is filled into the unused ROM area upto the maximum ROM size of the target device automatically.

TARGET BOARDS

Target boards are available for all KS57-series microcontrollers. All required target system cables and adapters are included with the device-specific target board.

OTPs

One time programmable microcontroller (OTP) for the KS57C0502/C0504 microcontroller and OTP programmer (Gang) are now available.
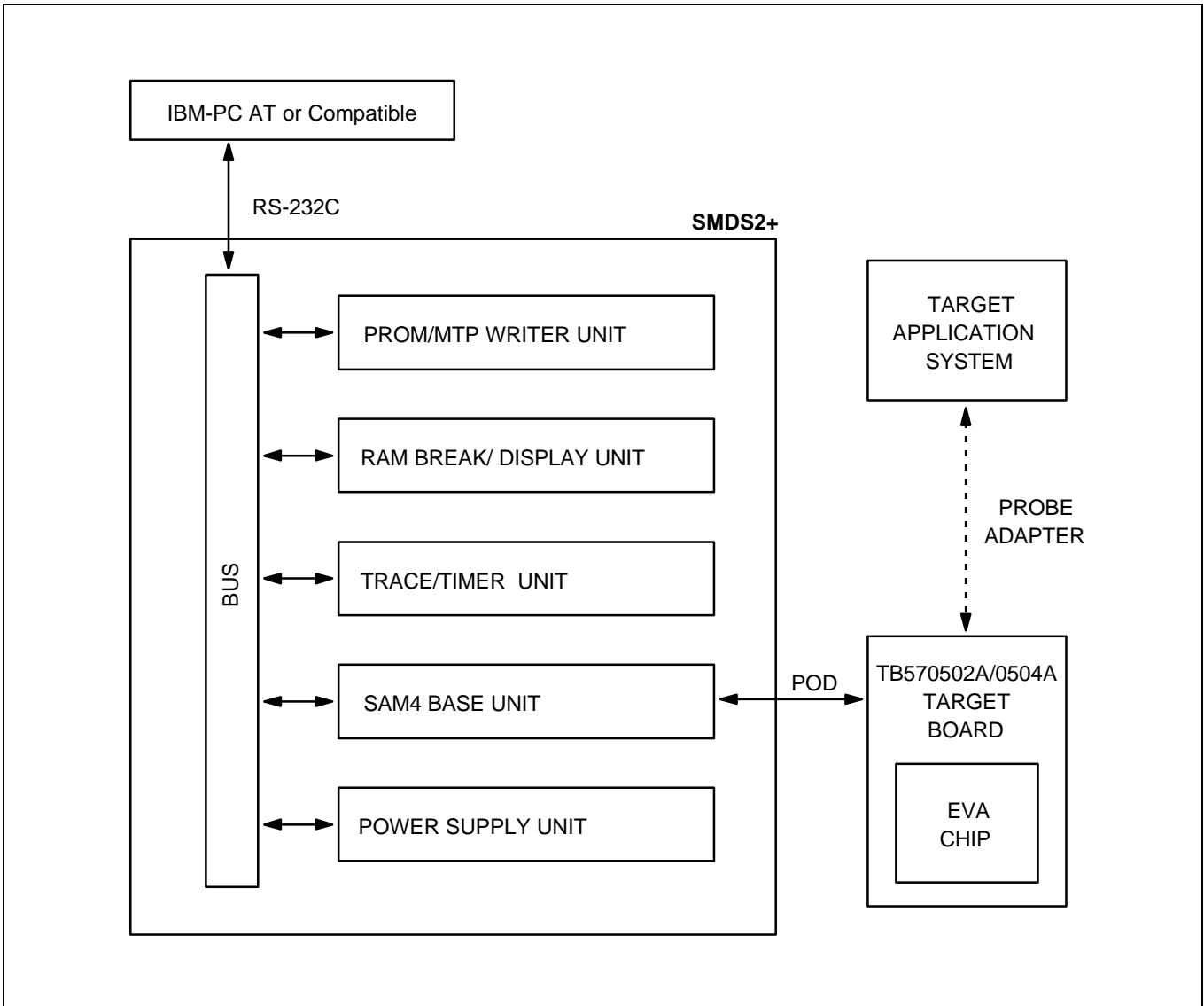
Figure 17–1. SMDS Product Configuration (SMDS2+)

TB570502A/0504A TARGET BOARD

The TB570502A/0504A target board is used for the KS57C0502/C0504/P0504 microcontroller. It is supported by the SMDS2+ development system.
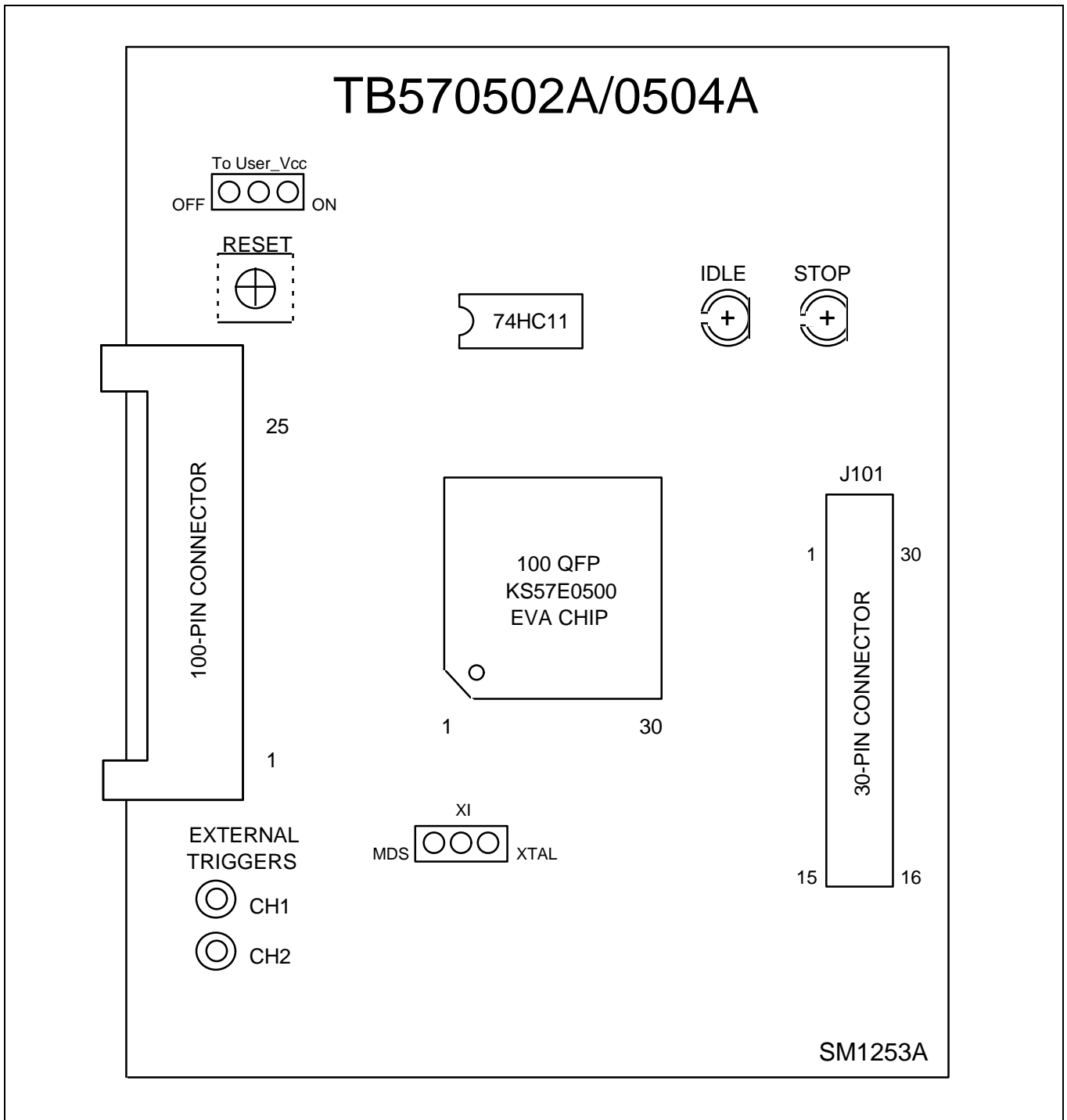

Figure 17–2. TB570502A/TB570504A Target Board Configuration

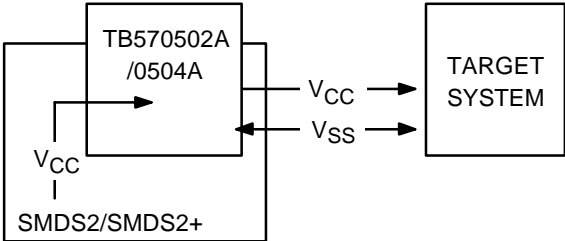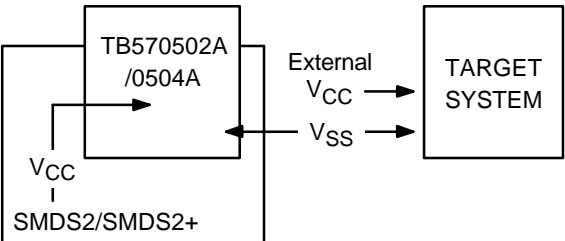**Table 17–1. Power Selection Settings for TB570502A/TB570504A**

'To User_Vcc' Settings	Operating Mode	Comments
To User_Vcc OFF ⬤⬤ ON		The SMDS2/SMDS2+ supplies V_{CC} to the target board (evaluation chip) and the target system.
To User_Vcc OFF ⬤⬤ ON		The SMDS2/SMDS2+ supplies V_{CC} only to the target board (evaluation chip). The target system must have its own power supply.

Table 17–2. Clock Selection Settings for TB570502A/TB570504A
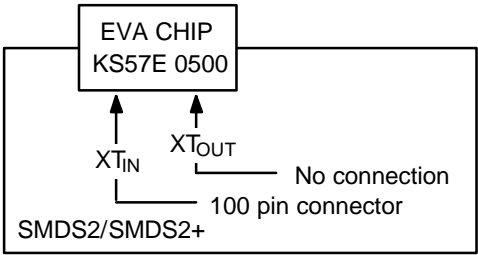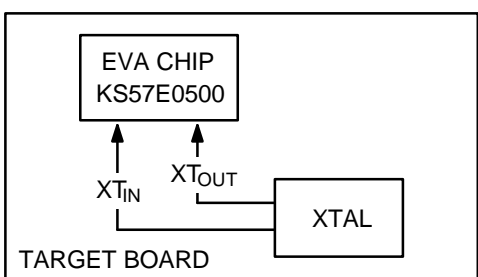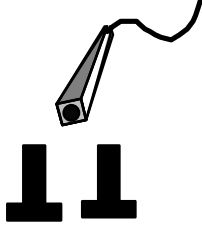
Sub Clock Setting	Operating Mode	Comments
XTI MDS ⬤⬤ XTAL		Set the XTI switch to "MDS" when the target board is connected to the SMDS2/SMDS2+.
XTI MDS ⬤⬤ XTAL		Set the XTI switch to "XTAL" when the target board is used as a standalone unit, and is not connected to the SMDS2/SMDS2+.

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Table 17–3. Using Single Header Pins as the Input Path for External Trigger Sources

Target Board Part	Comments
EXTERNAL TRIGGERS ◎ CH1 ◎ CH2	Connector from external trigger sources of the application system You can connect an external trigger source to one of the two external trigger channels (CH1 or CH2) for the SMDS2+ breakpoint and trace functions.

IDLE LED

This LED is ON when the evaluation chip (KS57E0500) is in idle mode.

STOP LED

This LED is ON when the evaluation chip (KS57E0500) is in stop mode.

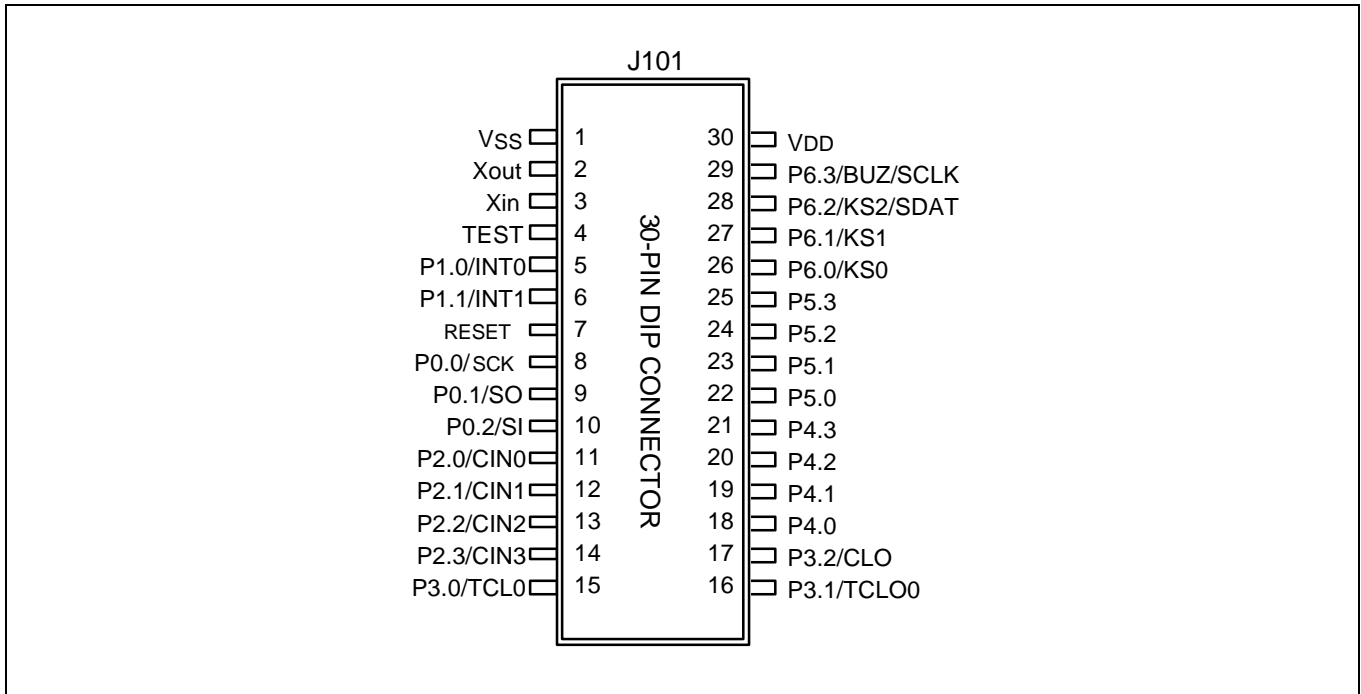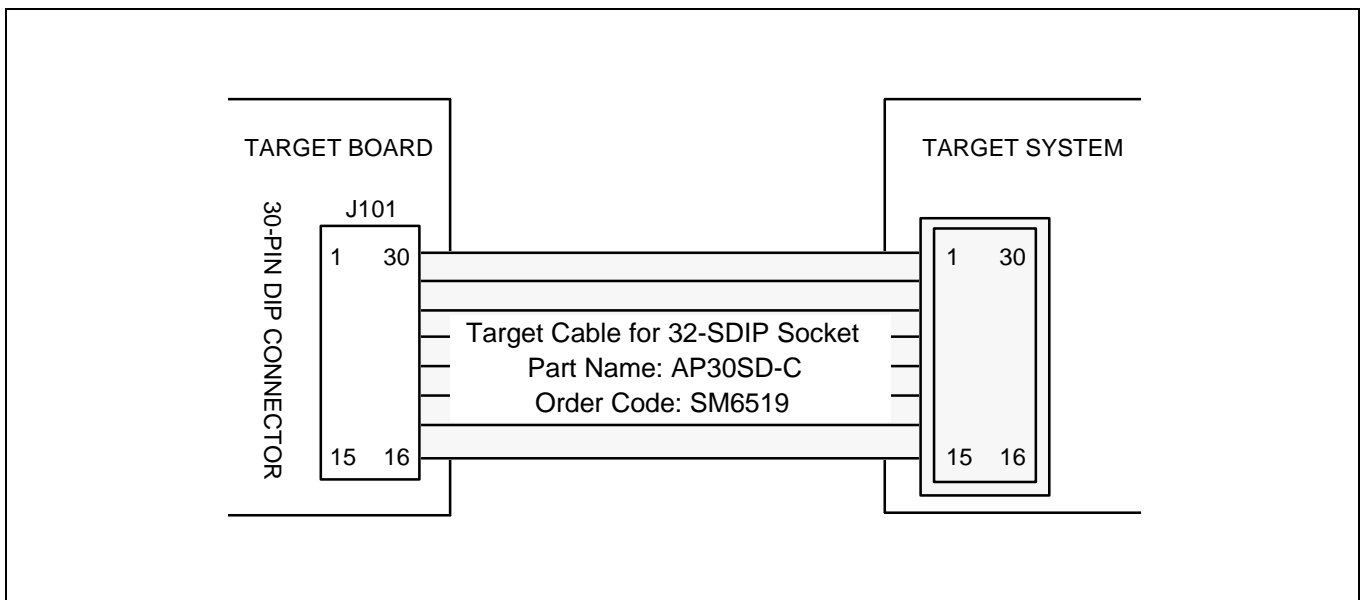**Figure 17–3. 30-Pin Connector for TB570502A/TB570504A**

Figure 17–4. TB570502A/TB570504A Adapter Cable for 30-SDIP Package (KS57C0502/C0504/P0504)